

MPD-ITS Technical Design Report - v1.0

2022
February

Contents

1	Introduction	6
1.1	Nuclear matter physics at NICA (by P. Senger)	6
1.1.1	High-density QCD matter in the cosmos and in the laboratory	6
1.1.1.1	Dense QCD matter in compact stellar objects	6
1.1.1.2	Laboratory experiments exploring dense QCD matter	7
1.1.1.2.1	The nuclear matter equation-of-state	7
1.1.1.2.2	The QCD phase diagram	9
1.1.2	Conclusions and outlook	10
1.2	The MPD experiment	11
1.2.1	Perspectives for the research program of the MPD experiment	12
1.3	The ALICE ITS2 first tracker totally based on MAPS technology	13
1.4	MPD tracking system	15
1.4.1	The TPC	15
1.4.2	The ITS	16
2	The Pixel Chips	22
2.1	The MAPS chips from the ALICE ITS2	22
2.2	Detector technology	23
2.3	Principle of operation	25
2.3.1	Particle detection	25
2.3.2	Read-out	25
3	Detector Layout	28
3.1	The two stages construction scenario	29
3.2	Stage-1: The Outer Barrel	29
3.2.1	Outer Barrel Staves	29
3.2.2	Supporting mechanics	31
3.2.2.1	Material budget	33
3.2.3	Cooling system	34
3.2.3.1	Integrated leakless water cooling system	35
3.2.3.2	Integrated gas cooling system	37
3.2.4	Outer barrel FPC	39
3.2.5	Pixel Chip to FPC connection	40
3.2.6	Assembly procedures	41
3.2.6.1	Outer barrel HIC assembly	41
3.2.6.1.1	HIC Test and characterization	42
3.2.6.2	Outer Barrel Stave assembly	44
3.2.6.2.1	Stave Test and characterization	46
3.2.7	The necessity for CMIS	48
3.3	The MPD-ITS finalization after NICA LS1 (Stage-2: the Inner Barrel)	49
3.3.1	Possible variants for mechanics based on ALICE ITS3 modules developed at CERN	51
3.3.2	Mechanics and cooling system of the Inner Barrel	52

3.3.3	Cooling system features of the MPD-ITS Inner Barrel	54
3.3.4	Back-up scenario for Stage-2 of the ITS construction	56
4	Support Structure and System Integration	59
4.1	Services	59
4.1.1	Cooling system for the MPD-ITS	59
4.1.1.1	General description	59
4.1.1.2	ALICE cooling plant	59
4.1.1.3	Concept of leakless cooling	59
4.1.1.4	The MPD ITS objects for cooling and the description of the cooling lines	60
4.1.1.4.1	Leakless operation	61
4.1.1.4.2	Operational modes	61
4.1.1.4.3	Alarms	64
4.2	The beam pipe	64
4.3	Installation and removal	64
4.3.1	Basic system requirements	65
4.3.2	Assembly operations sequence	66
4.3.3	MPD Inner Tracking System installation procedure	67
5	The DAQ System	72
5.1	Radiation environment	72
5.1.1	Radiation levels in the detector regions	73
5.2	Sensors layout and interconnections	74
5.2.1	Inner Layers	74
5.2.2	Outer Layers	76
5.2.3	Links and connections	77
5.3	Readout Electronics	78
5.3.1	Overview	78
5.3.2	NICA-MPD ITS Readout Unit	80
5.3.2.1	Structure of NICA-MPD ITS Outer Layer readout electronics	80
5.3.2.2	RU module design	81
5.3.2.2.1	Technical approach	81
5.3.2.2.2	ALTAI data readout	82
5.3.2.2.3	ALTAI control	83
5.3.2.2.4	Configuration and Scrubbing of FPGA	83
5.3.2.2.5	High-speed data interface	84
5.3.3	NICA-MPD ITS Power Unit	86
5.3.3.1	Structure of the power system in ITS Outer Layer of NICA	86
5.3.3.2	Functionality of the PU	86
5.3.3.3	PB module design	87
5.3.4	NICA ASICs	89
5.3.4.1	NICA_ROC	89
5.3.4.1.1	Data Capture block	90
5.3.4.1.2	xBar block	91
5.3.4.1.3	sDACT Capture block	91
5.3.4.1.4	TTC Capture block	92
5.3.4.2	NICA_GBTx and NICA_LD/TIA	92
5.3.4.2.1	NICA_GBTx	92
5.3.4.2.2	NICA_LD	93

5.3.4.2.3	NICA_TIA	95
6	The detector control system of ITS	97
6.1	Tasks of the ITS management and control system	97
6.2	Architecture of the ITS management and control system	98
6.3	Main components of the ITS DCS	98
6.3.1	Low Level Interfaces (DIM, OPC)	98
6.3.2	Control of the ITS Power Supply System	99
6.3.3	Control of the ITS Frontend Electronics	100
6.3.4	Control of the ITS Cooling System	101
6.3.5	Alert System	101
6.3.6	ITS monitoring system	102
6.3.7	Databases (Condition DB, Configuration DB)	102
6.3.8	System Access (remote and local) and access control.	103
7	Detector Performance	105
7.1	The MPD TPC in a nutshell	105
7.2	Simulations of the TPC-ITS tracking system	107
7.2.1	ITS Pointing resolution for different beam pipe diameters	107
7.2.2	ITS momentum resolution	108
7.2.3	ITS+TPC simulation tools	109
7.2.4	ITS+TPC track reconstruction efficiency	110
7.2.5	Phase space coverage for protons and pions	111
7.2.6	Vector finder algorithm for TPC+ITS track reconstruction	112
7.3	Conclusions	117
8	Physics Performance	119
8.1	Simulation methods	119
8.2	First stage ITS simulation: Outer Barrel + Beam Pipe $\varnothing 64$ mm	120
8.2.1	Λ -hyperons	121
8.2.2	Ξ^- -hyperons	121
8.2.3	Ω^- -hyperons	122
8.3	Project ITS simulation: Outer Barrel + Inner Barrel	123
8.3.1	Strange particle reconstruction with a beam pipe diameter of 40 mm	123
8.3.1.1	Λ -hyperons	123
8.3.1.2	Ξ^- -hyperons	123
8.3.1.2.1	Ω^- -hyperons	125
8.3.2	Reconstruction of charmed particles.	126
8.3.2.1	Reconstruction of D -mesons by the TC method.	126
8.3.2.1.1	D^0 -mesons.	126
8.3.2.1.2	D^+ -mesons.	128
8.3.2.2	Reconstruction of D -mesons by the MVA method	129
8.3.2.2.1	D^0 -mesons	130
8.3.2.2.2	D^+ -mesons	130
8.3.2.3	Transverse momentum spectra of reconstructed D mesons	131
8.3.2.4	Yield of strange and charmed particles	132
8.3.3	Strange and charmed particle reconstruction for a beam pipe diameter of 64 mm	133
8.3.4	Charmed particle reconstruction using Vector Finder tracking mechanism	135

8.4	Conclusions	136
9	Project Organization and Time Lines	139
.1	Appendix A - ALICE ITS2 leakless cooling system	142
.2	Appendix B - Possibilities for the reduction of the beam pipe diameter	143

1 Introduction

1.1 Nuclear matter physics at NICA (by P. Senger)

1.1.1 High-density QCD matter in the cosmos and in the laboratory

Recent astronomical observations, such as the discovery of massive neutron stars, the determination of radii and masses of neutron stars, and the detection of gravitational waves emitted from mergers of compact stars, opened new opportunities for the exploration of the fundamental properties of dense nuclear matter, including the equation-of-state (EOS), and the elementary degrees-of-freedom, which are expected to emerge at those high densities. Complementary information is obtained from laboratory experiments with energetic heavy-ion collisions, which also offer the possibility to explore the high-density EOS and to investigate new phases of strongly interacting matter, which may feature characteristic structures such as a first-order phase transition with a region of phase coexistence and a critical endpoint. The experimental discovery of these prominent landmarks of the QCD phase diagram would be a major breakthrough in our understanding of the fundamental properties of strongly interacting matter, with consequences for our knowledge on the structure of neutron stars and the dynamics of neutron star collisions. Equally important is quantitative experimental information on the properties of hadrons in dense matter, which may shed light on chiral symmetry restoration and the origin of hadron masses. Worldwide, substantial efforts at the major heavy-ion accelerators are devoted to the clarification of these fundamental questions, and new dedicated experiments are under construction at future facilities like FAIR in Darmstadt and NICA in Dubna.

1.1.1.1 Dense QCD matter in compact stellar objects

From astronomical observations of masses and radii of massive neutron stars together with the detection of gravitational waves emitted from neutron star mergers, constraints on the EOS of neutron matter have been extracted up to densities of $4 \rho_0$ [1]. These observations provide information on the thermodynamic properties of dense QCD matter, but not on its microscopic degrees-of-freedom. Various microscopic model calculations based on different assumptions are able to produce a stiff EOS at high densities, which is required to stabilize neutron stars with 2 solar masses. Calculations based on chiral effective field theory, which assume nucleonic degrees-of-freedom up to about $4 \rho_0$, introduce repulsive 2-body ΛN and 3-body ΛNN interactions in order to increase the Λ chemical potential, and to prevent the decay of neutrons into Λ hyperons. These interactions avoid the appearance of Λ hyperons and provide a stiff EOS at high densities, which is a prerequisite for the existence of massive neutron stars [2].

Model calculations based on the concept of quark-hadron continuity predict a gradual appearance of quark degrees-of-freedom with increasing density and partial restoration of chiral symmetry according to a smooth crossover [3]. For densities below $2 \rho_0$, the dominant interactions occur via a few meson or quark exchanges and the matter can be described in terms of interacting nucleons. For densities in the range from $2 \rho_0$ to about $5 \rho_0$, many-quark exchanges dominate, and the system gradually changes from hadronic to quark matter. For densities beyond about $5 \rho_0$, nucleons percolate, start to melt and to dissolve into their

42 constituents, which do not longer belong to particular nucleons. Calculations based on a non-
 43 local 3-flavor Nambu Jona-Lasinio model predict a first order phase transition with a mixed
 44 phase, where nucleons, hyperons and quarks coexist in the core of a 2 solar mass neutron star
 45 above densities of 4 - 5 ρ_0 [4]. In this model, repulsive vector interactions among the quarks
 46 are introduced to prevent a softening of the EOS, which otherwise would happen due to the
 47 appearance of quarks and hyperons. Pure quark matter is predicted above densities of 8 ρ_0 .

48 Densities up to 4 ρ_0 are also expected to be reached also in neutron star mergers as
 49 illustrated in Figure 1.1, which depicts a snapshot of the equatorial plane illustrating the
 50 evolution of a neutron star merger with a total mass of 2.8 solar masses calculated with a
 51 Chiral Mean Field model [5]. The left part of the plot displays the temperature T , while the
 52 right part presents the quark fraction Y_{quark} . The green lines represent contours of constant
 53 baryon density in units of the nuclear saturation density ρ_0 . The calculation predicts a phase
 54 transition to pure quark matter at a density of 4 ρ_0 and at a temperature of about 50 MeV.
 55 This phase transition occurs shortly before the high-mass neutron star collapses into a black
 hole.

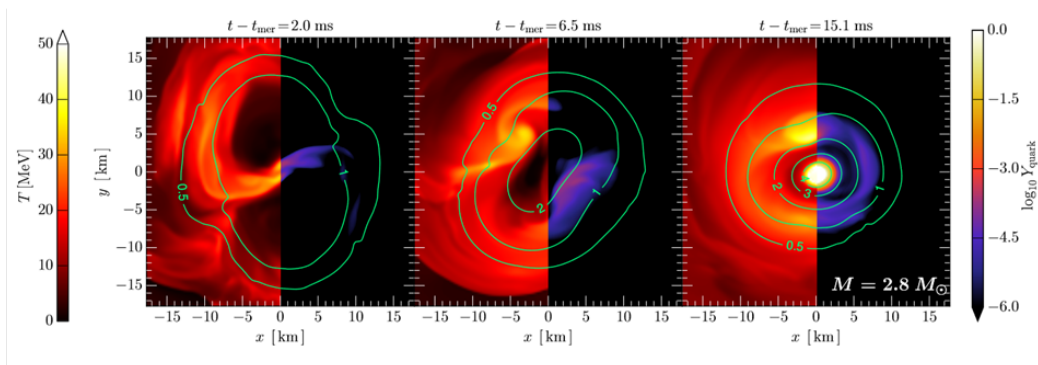


Figure 1.1: Three snapshots of the evolution of two merging neutron stars with a total mass of 2.8 solar masses. The scales at the left and at the right indicate the temperature and the \log_{10} of the quark fraction Y_{quark} , respectively. The green lines represent contours of constant net-baryon density in units of ρ_0 [5].

56

57 In conclusion, very different models can provide a stiff EOS at high density, which
 58 is required to stabilize massive neutron stars, although they are based on very different
 59 assumptions on the forces and the microscopic degrees-of-freedom in dense matter: pure
 60 nucleons, a smooth crossover or a 1st order phase transition from hadronic to quark matter.
 61 Future laboratory experiments with heavy-ion beams at FAIR and NICA will substantially
 62 contribute to further constrain the EOS and to unravel the fundamental degrees-of-freedom
 63 at neutron star core densities.

64 1.1.1.2 Laboratory experiments exploring dense QCD matter

65 Heavy-ion collision experiments play a crucial role in the investigation of both the EOS of
 66 nuclear matter and the QCD phase diagram. The present status of these experiments is
 67 briefly reviewed below.

68 1.1.1.2.1 The nuclear matter equation-of-state

69

70 Pioneering experiments at the Bevalac in Berkeley in the 1980s discovered the collective
 71 flow of protons. It indicated that a new form of equilibrated and dense matter is created

72 in heavy-ion collisions at beam energies around 1A GeV [6]. Moreover, the multiplicity of
 73 pions emitted from this fireball was used to extract the EOS of nuclear matter [7]. More
 74 quantitative information on the EOS was obtained by the next generation of experiments
 75 in the same beam energy range, which have been performed in the 1990s at GSI. The
 76 FOPI collaboration measured the elliptic flow of protons, deuterons, tritons and 3He in
 77 Au+Au collisions at energies from 0.4A to 1.5A GeV [8]. IQMD transport calculations could
 78 reproduce the experimental results using a soft EOS and momentum-dependent interactions.
 79 The flow data are sensitive to the EOS because the collective flow of nucleons is driven by
 80 the pressure gradient in the collision zone. Another EOS-sensitive observable was found to
 81 be subthreshold strangeness production. According to microscopic transport calculations,
 82 for example K^+ mesons are produced in secondary collisions of pions and nucleons in
 83 heavy-ion collisions, if the kinetic beam energy is below the K^+ production threshold in
 84 nucleon-nucleon collisions, which is 1.6 GeV. These multi-step processes are enhanced at
 85 high density and, therefore, are sensitive to the EOS. The KaoS collaboration measured
 86 subthreshold K^+ production in a very heavy and light collision system at different beam
 87 energies [9]. The kaon data could only be reproduced by RQMD model calculations when
 88 assuming a soft EOS and taking into account in-medium effects [10]. The data of both
 89 the FOPI and the KaoS experiment support values of the nuclear incompressibility of the
 90 order of 200 MeV, corresponding to a soft EOS for nuclear matter densities around twice
 91 saturation density. The FOPI and ASY-EOS collaborations at GSI have also studied the
 92 symmetry energy at baryon densities above saturation density in Au+Au collisions 400A
 93 MeV by measuring the elliptic flow of neutrons and protons. By comparing the FOPI data
 94 to the results of UrQMD transport calculations, a value of about $E_{sym} = 60 \pm 10$ MeV was
 95 found for $2 \rho_0$ [11]. From the ASY-EOS data a value of about $E_{sym} = 55 \pm 5$ MeV at $2 \rho_0$
 96 was extracted [12].

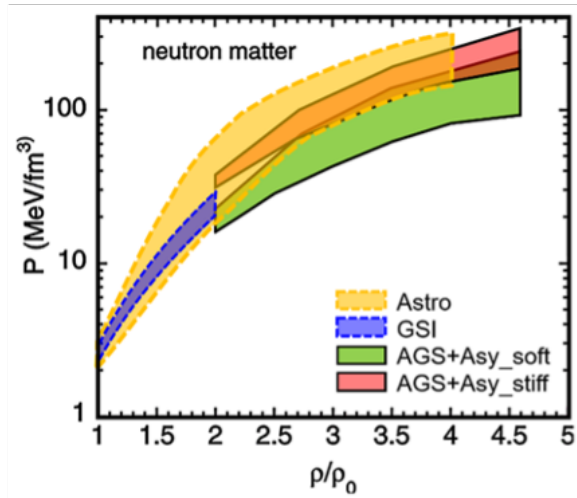


Figure 1.2: EOS for cold neutron matter plotted as pressure versus density. Orange area: Analysis of masses and radii of neutron stars measured by NICER, including mass measurements of the most massive neutron stars, and the tidal deformability estimate from the GW170817 [1]. Blue area: Analysis of the GSI flow and kaon data [8–12]. Pink and green area: analysis of AGS flow data [13, 14] after adding the pressure from asymmetry terms with strong and weak density dependences, respectively

97 Starting in the 1990s, experiments with gold beams were performed at the AGS in
 98 Brookhaven at beam energies between 2A and 11A GeV, i.e. at higher nuclear matter

99 densities. The excitation function of the proton collective flow measured by the EOS
 100 collaboration [13] has been analyzed using transport calculations with respect to the high-
 101 density EOS [14]. However, the result of this analysis only ruled out very soft or extremely
 102 hard EOS. The reason is, that the directed flow data could be explained better by a soft EOS
 103 (nuclear incompressibility ($K_{nm} = 210$ MeV)), while the data on the elliptic flow pointed
 104 towards a stiff EOS ($K_{nm} = 300$ MeV).

105 The present constraints of the equation-of-state for neutron matter, i.e. a combination of
 106 information from astronomical observations and from heavy-ion collisions, are illustrated in
 107 Figure 1.2. The blue area represents the results of the GSI experiments, which constrain the
 108 EOS up to about $2 \rho_0$ [8–12]. The green and pink areas correspond to the analysis of the AGS
 109 flow data, after adding the symmetry energy with a strong and a weak density dependence,
 110 respectively [13, 14]. The orange area reflects the results of astronomical observations,
 111 including mass and radii of neutron stars [1], masses of massive neutron stars [15–17], and
 112 gravitational waves emitted from neutron star mergers [18].

113 As illustrated in Figure 1.2, the heavy-ion results constrain the EOS up to $2 \rho_0$, while
 114 at higher densities the measured masses of the most massive neutron stars exclude a soft
 115 EOS as represented by the green area. New measurements of radii and masses of neutron
 116 stars together with future laboratory experiments at FAIR and NICA are required to further
 117 constrain the EOS at neutron star core densities.

118 1.1.1.2.2 The QCD phase diagram

119

120 The currently available information on the QCD phase diagram is depicted in Figure
 121 1.3, which summarizes experimental data, results of lattice Quantum-Chromo-Dynamics
 122 (LQCD) calculations, and QCD based model predictions. The left panel of Figure 1.3 depicts
 123 the QCD phase diagram as function of temperature T versus baryon chemical potential
 124 μ_B [19]. The various colored symbols represent the freeze-out conditions as extracted by
 125 statistical hadronization models from particle yields measured at different energies. For LHC
 126 collision energies, a freeze-out temperature of $T = 156.5 \pm 1.5$ MeV and a baryon chemical
 127 of $\mu_B = 0.7 \pm 3.8$ MeV was determined from the data [20]. For similar values of T and μ_B ,
 128 LQCD calculations found a smooth chiral crossover from the Quark-Gluon Plasma (QGP)
 129 to hadronic matter, and obtained a pseudocritical temperature. The HotQCD collaboration
 130 determined a pseudo-critical temperature of $T_c = 156.5 \pm 1.5$ MeV at vanishing μ_B , and
 131 extrapolated the crossover region up to $\mu_B \approx 300$ MeV, as indicated by the orange band [21].
 132 The WB collaboration found a pseudo-critical temperature of $T_c = 158.0 \pm 0.6$ MeV with a
 133 width of $\Delta T = 15 \pm 1$ MeV at $\mu_B = 0$, and extrapolated the crossover region from imaginary
 134 to real chemical potentials up to $\mu_B \approx 400$ MeV, as illustrated by the green band [22]. Figure
 135 1.3 (left panel) also presents results of Dyson-Schwinger Equations (DSE) and Functional
 136 Renormalization Group (FRG), which agree to the LQCD results at $\mu_B = 0$, and predict
 137 the location of a 1st order phase transition for larger values of μ_B together with a critical
 138 endpoint [19]. The most recent DSE-FRG calculation for 2+1 flavor QCD represented by
 139 the blue-dashed line ends up in a critical endpoint at a temperature of $T_{cep} = 93$ MeV and a
 140 baryon-chemical potential of $\mu_{Bcep} = 672$ MeV.

141 The right panel of Figure 1.3 depicts the results of LQCD calculations as function of
 142 temperature, baryon chemical potential, and masses of the light quarks u and d . The
 143 calculations have been performed at $\mu_B = 0$, where LQCD is applicable. In addition to
 144 the pseudo-critical temperature of the smooth chiral crossover at $T_{pc} \approx 156$ MeV, also the
 145 upper limit for the temperature of a hypothetical critical point of a chiral phase transition
 146 has been determined at $T_c = 133+2-6$ MeV for a baryon-chemical potential of $\mu_B = 0$ and
 147 for zero quark masses [23, 24]. The red and blue lines show the temperature of a tri-critical

148 point T_{tri} at finite μ_B should be lower, and the critical endpoint at finite baryon-chemical
 149 potential μ_B and non-zero light quark masses T_{cep} should be even lower, if it exists at all.
 150 This LQCD result corroborates the prediction of the DSE-FRG calculations, and restricts
 151 the temperature of the critical endpoint of a hypothetical chiral phase transition to values
 152 $T_{cep} < \approx 130$ MeV. According to the freeze-out conditions illustrated in the left panel of Figure
 153 1.3, such a temperature confines the location of a possible critical endpoint to baryon chemical
 154 potentials of $\mu_B < \approx 550$ MeV, corresponding to heavy-ion collision energies of $\sqrt{S_{NN}} < \approx$
 155 5 GeV, which are covered by the FAIR and NICA facilities.

156 The left panel Figure 1.3 also shows that the only experimental data in the QCD phase
 157 diagram are the freeze-out temperatures and baryon chemical potentials for various beam
 158 energies. These points characterize the situation, where the hadrons in the fireball cease
 159 to interact inelastically, which happens below saturation density ρ_0 . At vanishing baryon
 160 chemical potential, this freeze-out temperature coincides with the pseudocritical temperature
 161 of a chiral crossover transition calculated by LQCD. For larger values of μ_B the QCD phase
 162 diagram essentially is Terra Incognita, and the exploration of this region is in the focus of
 163 heavy-ion experiments worldwide. In the following, some promising diagnostic probes will
 164 be discussed, which will be measured by the MPD experiment at NICA with unprecedented
 165 precision, and, therefore, provide a unique potential for the discovery of structures in the
 QCD phase diagram.

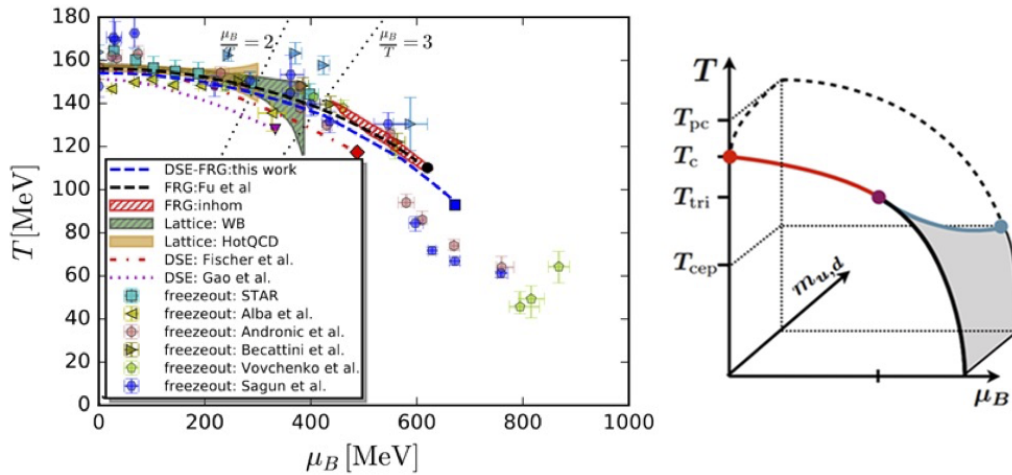


Figure 1.3: Left: Two-dimensional phase diagram for $N_f = 2+1$ flavor QCD in comparison to other theoretical approaches and phenomenological freeze-out data. For details see [19]. The DSE-FRG calculation represented by the blue-dashed line predicts a critical endpoint of a 1st order chiral phase transition at $T_{cep} = 93$ MeV and $\mu_{Bcep} = 672$ MeV. Right: Three-dimensional phase diagram as function of temperature T , baryon-chemical potential μ_B and mass of the light quarks $m_{u,d} = 0$ as calculated by LQCD. Red dot: upper temperature limit $T_c = 132+3-6$ MeV for the critical endpoint of a first-order chiral phase transition at $\mu_B = 0$ and $m_{u,d} = 0$ [23, 24]. Pink dot: Tri-critical point at $\mu_B = 0$ and $m_{u,d} = 0$. Blue dot: upper limit for the temperature of a critical endpoint for finite μ and physical light quark masses taken from [24].

166

167 1.1.2 Conclusions and outlook

168 The beam energies and luminosities available at NICA perfectly fit the worldwide landscape
 169 of heavy-ion accelerators. Situated between FAIR SIS100 and the low RHIC energies, NICA

170 covers the energy range where the highest net-baryon densities can be created in laboratory
 171 experiments. This offers the opportunity to produce and to study QCD matter at neutron
 172 star core densities and to address fundamental questions related to the high-density EOS,
 173 phase structure of strongly interacting matter, to confinement and chiral symmetry.

174 As a modern heavy-ion experiment, the Multi-Purpose Detector (MPD) at NICA [25]
 175 is designed to measure a variety of diagnostic probes as discussed in the previous sections.
 176 This feature allows the investigation of different observables, related to the same physics
 177 topic. For example, the high density EOS can be studied by (i) the elliptic flow of identified
 178 particles, and (ii) the production of multi-strange (anti-)hyperons. A deconfined phase should
 179 leave its traces in several observables, including (i) the collective flow, (ii) the high invariant
 180 mass slope of dileptons, and (iii) charm production. The order of the phase transition can be
 181 determined by the (i) caloric curve determined with dileptons, the (ii) critical point measured
 182 with event-by-event fluctuations, and by (iii) the onset of deconfinement extracted from the
 183 excitation function of multi-strange hyperons.

184 The successful execution of these measurements with MDP at NICA will achieve
 185 a breakthrough in our understanding of the properties of QCD matter under extreme
 186 conditions. This is particularly true if the different results form a consistent picture, for
 187 example if the caloric curve obtained from dilepton measurements ends at the same energy,
 188 where event-by-event fluctuations exhibit a maximum, indicating the critical endpoint.
 189 Such a concordant scenario would tremendously increase the persuasive power of the single
 190 observations and could be regarded as the experimental discovery of a first order phase
 191 transition in dense baryonic matter. The experiments with MPD at NICA will complement
 192 the observations made by the beam-energy scan of STAR and will be complemented towards
 193 lower energies by the CBM experiment at FAIR. At even lower energies, the BM@N
 194 experiment at NICA will contribute to the progress in the field, although with a reduced
 195 set of observables.

196 The experimental program requires high-statistics measurements of the relevant
 197 observable over a large phase space, with particle identification and event characterization
 198 capabilities. The core detector of the MPD is a Time-Projection-Chamber (TPC) inside
 199 a solenoid magnet providing tracking and particle identification via dE/dx measurements.
 200 Particle identification will be improved by a Time-of-Flight (TOP) detector based on
 201 Multigap Resistive Plate Chambers (MRPC). These two detector systems, together with an
 202 Electromagnetic Calorimeter (ECAL) will also provide electron identification. A Zero Degree
 203 Calorimeter (ZDC) will be used to determine the collision centrality and the orientation of
 204 the reaction plane.

205 The TPC will be complemented by an Inner Tracking System (ITS) in order to provide
 206 precise tracking, momentum determination and vertex reconstruction. This upgrade will
 207 improve the identification of hyperons via the topology of their weak decays ($\Lambda \rightarrow p \pi$,
 208 $\Xi \rightarrow \Lambda \pi$, $\Omega \rightarrow \Lambda K$). Due to the short decay lengths of $c\tau = 7.89$ cm (Λ), $c\tau = 4.91$ cm
 209 (Ξ^-) and $c\tau = 2.46$ cm (Ω^-) the track measurement should start close to the primary vertex
 210 where the track density is high. In particular, the ITS will be required for the identification
 211 of D mesons via their hadronic decay into pions and kaons (decay length of $c\tau = 123$ μm for
 212 D^0 , and $c\tau = 312$ μm for D^\pm), and Λ_c^+ hyperons via their decay into $pK^-\pi^+$ with a decay
 213 length of only 60 μm . The layout, the technical realization and the performance of the ITS
 214 are described in the following.

215 1.2 The MPD experiment

216 The MPD experiment is projected to study the hot and dense baryonic matter in collisions of
 217 heavy ions over the atomic mass range $A = 1-197$ at a centre-of-mass energy up to $\sqrt{S_{NN}} =$

218 11 GeV (for $^{197}_{79}\text{Au}^+$). The experiment will be setup at the future JINR accelerator complex
 219 facility for heavy ions – the Nuclotron-based Ion Collider fAcility (NICA), that is designed
 220 to reach the required parameters with an average luminosity of $L=10^{27}\text{ cm}^{-2}\text{ s}^{-1}$.

221 The MPD apparatus has been designed as a 4π spectrometer capable of detecting of
 222 charged hadrons, electrons and photons at high luminosity. To reach this goal, the detector
 223 will comprise a precise 3-D tracking system (ITS+TPC) and a high-performance particle
 224 identification (PID) system based on the time-of-flight measurements and calorimetry. Since
 225 the average transverse momentum of the particles produced in a collision at NICA energies
 226 is below 500 MeV/c, the detector design requires a very low material budget. The general
 227 layout of the MPD apparatus is shown in Figure 1.4. The whole detector setup includes a
 228 Central Detector section (CD) covering ± 2 units in pseudorapidity (η).

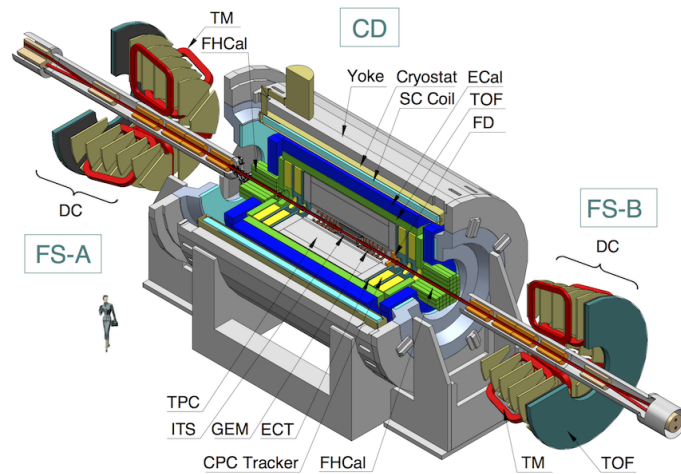


Figure 1.4: 3-D design image of the MPD.

229 1.2.1 Perspectives for the research program of the MPD experiment

230 One of the key requirements the future experimental MPD installation must meet is to
 231 solve the very challenging task of the high precision registration of strange, multi-strange
 232 and charmed particles formed in the relativistic heavy-ion collisions at the energies of NICA
 233 collider.

234 Studies in relativistic heavy-ion collisions of such rare processes as heavy-flavour
 235 production, in particular, detection of the short-lived D_0 and D^+ -mesons, with an average
 236 path of $\sim 120\ \mu\text{m}$ and $\sim 310\ \mu\text{m}$ respectively, as well as the search for exotic particles decay and
 237 hyper-nuclei formation at the MPD require the use of fast, high granularity detectors capable
 238 to increase the accuracy of secondary vertices reconstruction. It is also essential to expand
 239 into the soft region the p_T range of registration of charged particles required, in particular, to
 240 increase the efficiency of charmed mesons detection. Details of physics motivation and model
 241 simulations for MPD studies could be found in Chapter 8 of the present Technical Design
 242 Report (TDR).

243 The physics performance requirements are imposing the highest demands on the event-
 244 by-event determination of secondary vertexes in case of registration of short-life charmed
 245 particles ($c\tau \sim 100\ \mu\text{m}$). A resolution accuracy below $\sim 10\ \mu\text{m}$ will be required here.

246 It is a well known fact that in order to get the best resolution in accuracy of tracking
 247 of charged particle to the primary and secondary vertexes the optimisation of the spatial
 248 (geometrical resolution) and of the multiple scattering factors is required. These demands of

249 rare processes registration are making a very challenging tasks for the MPD Inner Tracking
250 System design to implement the best state-of-the-art solutions and technologies available.
251 Therefore, first of all, the application of fast and high granularity pixel sensors surrounding
252 the interaction point (IP) is required. A considerable reduction of the material budget of
253 all Inner Tracking System (ITS) components working in a sensitive region, especially for the
254 innermost layers is also a must to be considered.

255 More detailed stringent specific requirements to the novel MPD Inner Tracking System
256 with the high accuracy of secondary vertices reconstruction are listed below:

- 257 1. The application of the fast, high granularity CMOS pixel sensors with low noise level
258 is needed.
- 259 2. The spatial resolution of track coordinate registration by sensors has to be ensured at
260 the level of $\sim 5\text{--}10\ \mu\text{m}$.
- 261 3. The position of the very 1st sensor layer at the closest distance to the IP has to be
262 provided; therefore, the application of the possible smallest diameter beam-pipe is to
263 be considered for the MPD at the 2nd stage of the MPD development.
- 264 4. The considerable reduction of the material budget of the ITS has to be achieved by the
265 application in the construction of only low-Z materials.
- 266 5. The assembly procedure of the ITS within the limited space inside the main tracking
267 MPD device – the TPC, should be developed with the account of the beam-pipe support,
268 the additional FFD system [26] and also of all cable and cooling ducts services of the
269 ITS and the FFD.

270 1.3 The ALICE ITS2 first tracker totally based on MAPS 271 technology

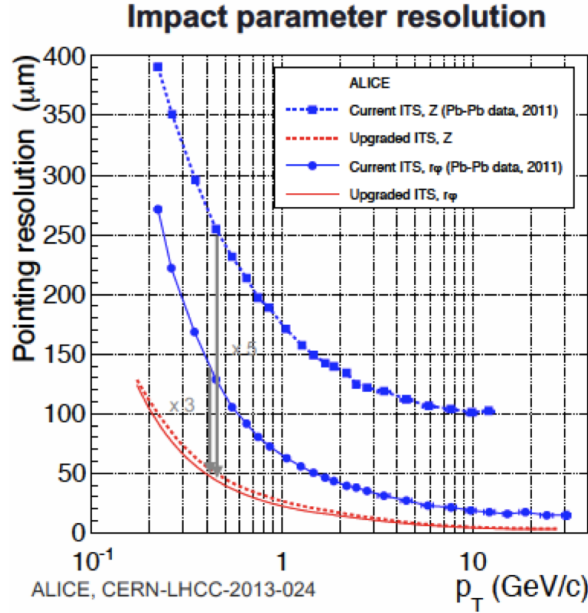
272 The most advanced and well proven ALICE technologies are being used at present as a
273 baseline for the design of the ITS of the MPD at NICA. In this section a brief description is
274 provided about the current state-of-the art Inner Tracking System prepared by the ALICE
275 Collaboration for the Run-3 at the LHC [33].

276 The goals of the ALICE Collaboration for the upgrade of the installation for high-
277 intensity Run-3 were to develop a fast and efficient tracking system capable to work over
278 an extended transverse momentum range of charged particles, with a special emphasis on
279 very low momenta and very precise reconstruction of secondary vertices from decaying charm
280 and beauty hadrons. In order to meet these challenges a custom-designed chip was developed
281 by the ALICE collaboration [32] basing on the 180nm CMOS Imaging Sensor process of
282 TowerJazz¹. This technology of Monolithic Active Pixel Sensors (MAPS) provides the full
283 charge collection efficiency ensured by a continuously active low-power front-end placed into
284 each pixel and giving peaking time of around $\sim 2\ \mu\text{s}$ and a spatial resolution of around $\sim 5\ \mu\text{m}$.
285 Therefore, it opens the possibility to considerably expand the ALICE physics program to the
286 high-precision area of rare processes with heavy flavor production in relativistic nucleus-
287 nucleus collisions.

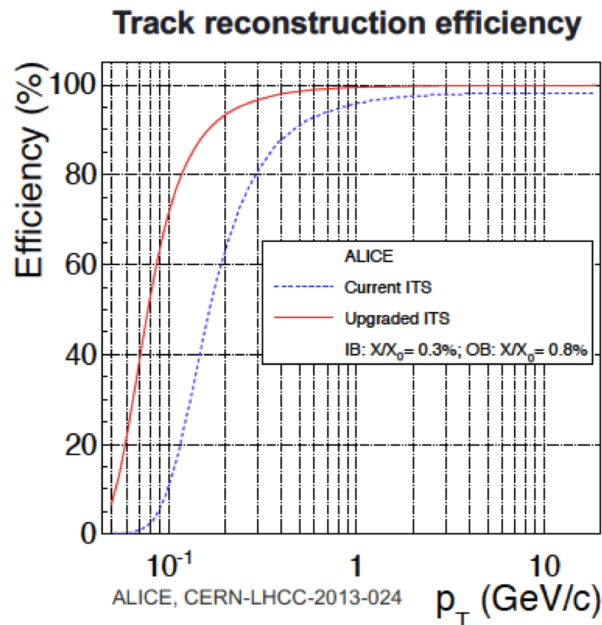
288 Results of estimates done by the ALICE collaboration of the expected impact parameter
289 resolution of the upgraded ITS compared to the old ITS used in the period 2008–2018 are
290 shown in Figure 1.5a The track reconstruction efficiency expected for the upgraded ALICE

¹ <https://towerjazz.com>

291 ITS is shown in Figure 1.5b. It can be seen the results of the improvements of impact
 292 parameter resolution in case of the upgraded ALICE ITS due to the decreasing of multiple
 293 scatterings in the soft region of charged particles spectra.



(a) Impact parameter resolution.



(b) Track reconstruction efficiency.

Figure 1.5: Upgraded ALICE-ITS performance estimates vs precedent ITS [33].

294 At the moment the present TDR is being written the new ALICE Inner Tracking System
 295 has been completed, installed and commissioned at Point 2. The ITS of ALICE is based
 296 on seven concentric layers of the MAPS chips. The application of very thin high granularity
 297 MAPS chips for its Inner ($\sim 50 \mu\text{m}$) and Outer ($\sim 100 \mu\text{m}$) barrels, combined with the state-of-
 298 the-art extra-lightweight carbon fibre composite structures with integrated cooling, ensures

the required precise, thermo- and mechanically- stable positioning, support and efficient cooling of the large arrays of chips. The condition of minimal mass budget in the sensitive tracking region is met by the current design ensuring the overall relative radiation length per layer at the level $X/X_0 \sim 0.3\%$ for the Inner Barrel and $X/X_0 \sim 0.8\%$ for the Outer Barrel of the ITS [33].

These integrated super modules composed of MAPS sensors and the extra-lightweight carbon fiber composite cooling and support structures are called *Staves* and were developed and tested earlier [28–31]. They ensured considerable decrease of the multiple scattering in the soft region of charged particles spectra and allowed the ALICE Collaboration to produce the most transparent for radiation vertex detector used nowadays in the HEP experiments.

The characteristics of the pixel sensors and the solutions for the current Inner Tracking System developed by ALICE are meeting the requirements of the MPD and they could be used for the registration of rare processes in heavy-ion collisions at NICA. Namely, the current ALICE developments [32, 33] will provide the following capabilities which are suitable for consideration by the MPD:

- sensor thickness: 50 μm /100 μm for the Inner/Outer Barrel layers;
- sensor dimensions: 15 \times 30 mm^2 ;
- spatial resolution: 5 μm ;
- readout link bandwidth: up to 1.2 Gb/s;
- power density: 40 nW/ cm^2 ;
- high track reconstruction efficiency for charged particles (see Fig. 1.5b);
- improved impact parameter resolution and extended charged-particle p_T coverage down to 100 MeV/c (see Fig. 1.5a and Fig. 1.5b);
- material overall budget per layer is at the level of $X/X_0 \sim 0.3\%$ for the innermost 3 layers, and at the level of $X/X_0 \sim 0.8\%$ for the outer layers No. 4 and 5.

1.4 MPD tracking system

1.4.1 The TPC

The Time-Projection Chamber (TPC) is the main tracking detector of the MPD central barrel. It is a gas detector for 3-dimensional tracking and particle identification for high multiplicity events [34–36].

The track reconstruction is based on drift time and R- φ coordinate measurement of primary ionization clusters. The track point resolution in X-Y (R- φ) plane is about 600 μm and about 1 mm - in Z. In total up to 52 points are on a track in the pseudorapidity range, $\eta \leq 1.2$.

The TPC performance in heavy ion collisions has studied by means of detailed Monte-Carlo (MC) simulations. These studies were performed within the dedicated software framework MpdRoot, which includes interfaces to several event generators (UrQMD, HSD, LAQGSM, etc.), description of the detector geometry, particle propagation with the GEANT 3 and 4 packages, detailed detector response simulation, as well as event reconstruction and analysis algorithms [37].

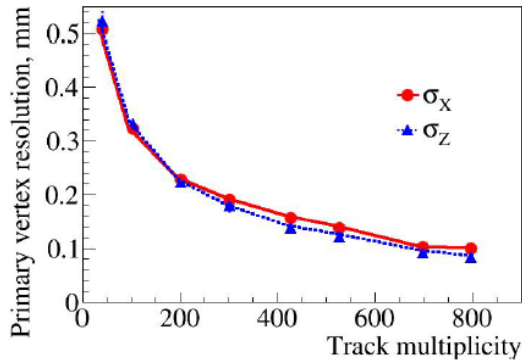


Figure 1.6: The primary vertex position resolution along transverse and longitudinal directions as a function of primary track multiplicity.

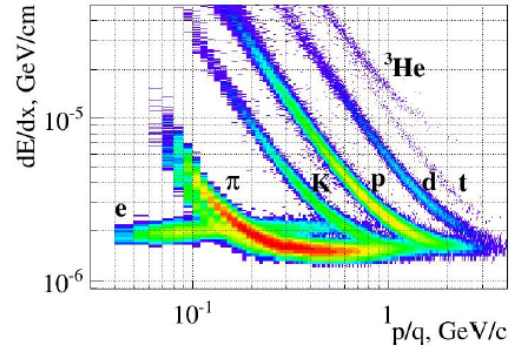


Figure 1.7: Specific energy loss vs magnetic rigidity for electrons, hadrons and light nuclei.

339 It was found that the transverse momentum resolution $\Delta p_T/p$ as a function of p_T is less
 340 than 2% over the transverse momentum interval $0.2 < p_T < 1$ GeV/c. Although at larger η
 341 values the tracking performance degrades sharply for the TPC alone.

342 The primary vertex position resolution along transverse and longitudinal directions as a
 343 function of primary track multiplicity is shown in Fig. 1.6. The primary vertex was found by
 344 the extrapolating of all primary tracks reconstructed in the TPC back to the origin and its
 345 resolution is defined as the r.m.s. of the distribution of the whole sample of primary track
 346 extrapolations at the origin.

347 To identify charge particle for every track reconstructed in the TPC the specific energy
 348 loss dE/dx is calculated as a truncated mean of charges of the TPC hits assigned to the track.
 349 The truncation level of 70% was chosen. As shown in Fig. 1.7 kaons can be discriminated
 350 from pions up to momentum of 0.7 GeV/c and protons discriminated from π - and K-mesons
 351 up to a momentum of 1.3 GeV/c.

352 An example of the reconstruction of strange mesons and hyperons in the MPD detector
 353 is shown in Fig. 1.8 and Fig. 1.9 [38]. The reconstruction have been done by combining
 354 charged tracks reconstructed in the TPC using the secondary vertex finding technique with
 355 an optimized set of topological and track quality cuts in order to guarantee that track
 356 combinations are associated to real decays. To ensure that the charged tracks are secondary
 357 ones, distinct cuts are applied on the minimum value of the impact parameters to the primary
 358 vertex. In addition, a pair of tracks is rejected if the distance of closest approach in space
 359 between the two opposite charged tracks is larger than a given value. Once the secondary
 360 vertex position is defined, only those falling within a fiducial region starting from a given
 361 distance from the main vertex are kept. Finally, the invariant mass is calculated under the
 362 proper hypothesis.

363 An accurate determination of the primary events vertex position essentially improves the
 364 momentum resolution and the secondary vertices finding efficiency.

365 1.4.2 The ITS

366 One of the main Physics goals of the MPD experiment is to study the properties of hot and
 367 dense nuclear matter produced in central collisions of heavy nuclei at the energies of NICA
 368 collider. By theoretical predictions [39] heavy quarks (c , b) in such reactions are born in the
 369 initial hard collisions of nucleons and carry the information about the excited nuclear medium
 370 at an early stage of its formation. The interaction between heavy quarks and the nuclear

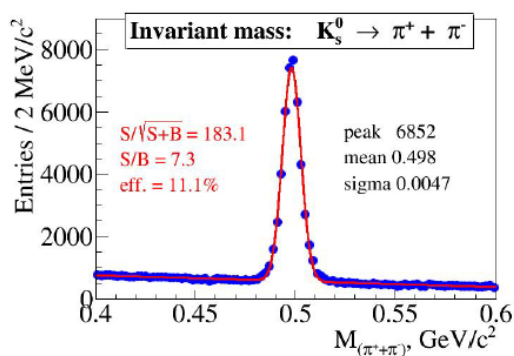


Figure 1.8: Reconstructed invariant mass of π^+ and π^- spectrum.

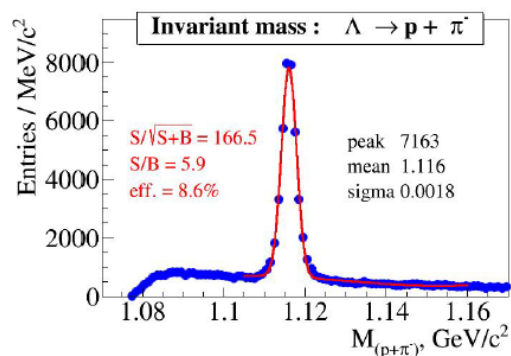


Figure 1.9: reconstructed invariant mass of protons and π^- spectrum.

371 medium is sensitive to the dynamics of the medium; therefore, heavy quarks are considered
 372 perspective probes for studying the properties of strongly interacting QCD matter [40–42].

373 The yields of particles with heavy flavor which include charmed particles, depend on
 374 the phase of excited nuclear matter. This is due to the different properties of the charm
 375 carriers at different phases. In the hadron phase D -mesons are carriers of charm, while in the
 376 deconfinement phase the carriers are charmed quarks. Producing a D ($anti$ - D) pair requires
 377 an energy of 1.1 GeV more than producing a quark-antiquark pair c ($anti$ - c). Thus, a higher
 378 yield of charm is expected in the deconfinement phase than in the hadron phase. Therefore
 379 similar to strangeness [43], a change in the dependence of the average number of charmed
 380 quarks on the energy of colliding nuclei can be a signal of the beginning of deconfinement
 381 phase.

382 To clarify the formation of heavy quarks mechanisms in relativistic nucleus – nucleus
 383 models, it is necessary to know the average number of quark – antiquark pairs generated in
 384 the full phase volume. Predictions obtained by various dynamic and statistical models [44–47]
 385 differ from each other in almost two orders of magnitude. Thus, obtaining accurate data on
 386 the cross sections for the formation of charmed particles will narrow the spectrum of possible
 387 theoretical models.

388 To detect charmed particles whose average ranges λ are several hundred micrometers (for
 389 example, $\lambda(D^0) = 123 \mu\text{m}$, $\lambda(D^+) = 312 \mu\text{m}$), it is necessary to use vertex detectors with
 390 high spatial resolution, located as close to the particle formation point as possible. That
 391 is the reason why the TPC, as the main tracker detector of the MPD experiment, will be
 392 supplemented by the ITS vertex detector.

393 The vertex detectors of modern experiments [48–53] are multilayer systems of
 394 semiconductor coordinate-sensitive detectors which play a key role in the reconstruction of
 395 short-lived particles (multistrange hyperons, charmed mesons, hypernuclei) from the invariant
 396 mass of their decay products. Using vertex tracking detector will provide the following
 397 advantages:

- 398 • improving the accuracy of the the secondary decay vertices coordinates reconstruction
 399 of short-lived particles;
- 400 • decreasing detection threshold of charged particles with small transverse momentum.

401 ITS will be built on the basis of modern silicon pixel sensors. The new generation pixel
 402 detectors MAPS have the best spatial resolution at a high count rate [48], and the high level
 403 of their segmentation into pixels allows this type of detector to be installed at distances of
 404 several centimeters from the interaction point without the risk to be overloaded. Therefore

405 the combination of TPC and ITS vertex detectors will allow to detect short-lived products
406 of nucleus-nucleus interactions at the MPD facility with maximum efficiency.

407 Bibliography

- 408 [1] M.C. Miller et al., ApJ. Lett. 887 (2019) L24
- 409 [2] W. Weise, PS Conf. Proc. (2019) 011002
- 410 [3] G. Baym et al., Rep. Prog. Phys. 81 (2018) 056902
- 411 [4] M. Orsaria et al., Phys. Rev. C89 (2014)015806
- 412 [5] E. Most E et al., Phys. Rev. Lett. (2019) 122 061101
- 413 [6] H.H. Gutbrod, A.M. Poskanzer and H.G. Ritter, Rep. Prog. Phys. 52,10
- 414 [7] J. W. Harris et al., Phys. Lett. B 153 (1985) 377-381
- 415 [8] A. Le Fevre A et al., (The FOPI Collaboration) Nucl. Phys. A 945 (2016) 112
- 416 [9] C. Sturm et al., (The KaoS Collaboration) Phys. Rev. Lett. 86 (2001) 39
- 417 [10] C. Fuchs et al., Phys. Rev. Lett. 86 (2001) 1974
- 418 [11] Y. Leifels et al., (The FOPI Collaboration) 1993 Phys. Rev. Lett. 71 963
- 419 [12] P. Russotto et al., (The ASY-EOS Collaboration) 2016 Phys. Rev. C 94 034608
- 420 [13] C. Pinkenburg et al, Phys. Rev. Lett. 83 (1999) 1295
- 421 [14] P. Danielewicz, R. Lacey, and W.G. Lynch, W.G. Science 298 (2002) 1592
- 422 [15] H. T. Cromartie et al. 2020 Nature Astronomy 4 72
- 423 [16] J. Antoniadis et al., Science 340 (2013) 448
- 424 [17] Z. Arzoumanian et al., ApJ 859 (2018) 47
- 425 [18] LIGO and Virgo Collaborations, ApJ. Lett. 848 (2017) L12
- 426 [19] F. Gao and J. M. Pawłowski, Phys. Rev. D 102 (2020) 034027
- 427 [20] A. Andronic et al., Nature 2018, 561, 321
- 428 [21] A. Bazavov A et al., (HotQCD Collaboration) Phys. Lett. B (2019) 795 15
- 429 [22] S. Borsanyi et al., (WB collaboration) Phys. Rev. Lett. 125 (2020) 052001
- 430 [23] H. T. Ding et al., (HotQCD Collaboration) Phys. Rev. Lett. 123 (2019) 062002
- 431 [24] F. Karsch, arXiv:1905.03936
- 432 [25] <https://nica.jinr.ru/projects/mpd.php>
- 433 [26] V. Yurevich, O. I. Batenkov, A. S. Veschikov, A. A. Povtoreyko, "Fast forward detector
434 for MPD/NICA project: Concept, simulation, and prototyping", Physics of Particles
435 and Nuclei Letters 10(3), 2013.

- 436 [27] B.Abelev et al., The ALICE Collaboration, Upgrade of the ALICE Inner
437 Tracking System - Technical Design Report, *J. Phys. G.* 41 (2014) 087002,
438 <http://iopscience.iop.org/0954-3899/41/8/087002/> .
- 439 [28] S.N.Igolkin, G.A.Feofilov, V.M.Dobulevich, O.I.Stolyarov, "Method for the manufacture
440 of carbon composite products of complex shape and device for its implementation"
441 (valid). St.Petersburg State University, Patent of the Russian Federation, No. 2396168,
442 B29C53 / 56, SPbSU, 2008132278/12, 07/31/2008, 08/10/2010.
- 443 [29] S.N.Igolkin, G.A.Feofilov, V.M.Dobulevich, O.I.Stolyarov, "Device for manufacturing
444 carbon composite products of complex shape" (valid). St.Petersburg State University,
445 Patent of the Russian Federation No. 79268, Certificate of the Russian Federation for
446 utility model B29C53 / 56, St. Petersburg State University, 2008132135/22, 08/01/2008,
447 12/27/2008.
- 448 [30] V.I. Zhrebchevsky, S.N. Igolkin, E.B Krymov, N.A. Maltsev, N.A. Makarov,
449 G.A. Feofilov, "Extra lightweight mechanical support structures with the integrated
450 cooling system for a new generation of vertex detectors", *Instruments and*
451 *Experimental Techniques*, Volume 57, Issue 3, May 2014, Pages 356-360,
452 <http://www.maik.ru/ru/journal/pribory/> .
- 453 [31] V.I. Zhrebchevsky, I.G. Altsybeev, G.A. Feofilov, A. Francescon, C. Gargiulo,
454 S.N. Igolkin, E.B. Krymov, E. Laudi, T.V. Lazareva, N.A. Maltsev, "Experimental
455 investigation of new ultra-lightweight support and cooling structures for the new Inner
456 Tracking System of the ALICE Detector", 2018, *JINST*, 13, T08003.
- 457 [32] M.Mager, On behalf of the ALICE Collaboration, "ALPIDE, the Monolithic Active
458 Pixel Sensor for the ALICE ITS upgrade", *NIM Volume 824*, 11 July 2016, Pages 434-
459 438. <https://doi.org/10.1016/j.nima.2015.09.057>.
- 460 [33] B.Abelev et al., The ALICE Collaboration, Upgrade of the ALICE Inner
461 Tracking System - Technical Design Report, *J. Phys. G.* 41 (2014) 087002,
462 <http://iopscience.iop.org/0954-3899/41/8/087002/> .
- 463 [34] A.Averyanov et al., "Time Projection Chamber for Multi Purpose Detector at NICA,
464 Technical Design Report, rev.07.", Laboratory of High Energy Physics JINR, Dubna,
465 2019.
- 466 [35] Averyanov A. et. al., "Readout system of TPC/MPD NICA project.", *Nuclear Physics*
467 *and Engineering, Physics of Atomic Nuclei*, 2015, Vol.78, No.13, pp. 1556-1562.
- 468 [36] Sergey Movchan on behalf of the MPD collaboration, "MPD/NICA TPC status
469 (25.02.2020)", International Conference "Instrumentation for Colliding Beam Physics"
470 (INSTR20), Novosibirsk, Russia, 24-28 Feb., 2020.
- 471 [37] V. Kireyeu, V. Kolesnikov, V. Vasendina, and A. Zinchenko for the MPD Collaboration,
472 "Towards a realistic Monte Carlo simulation of the MPD detector.", *VBLHEP JINR*,
473 Dubna, Russia, 2015
- 474 [38] M.A.Ilieva et al., "Evaluation of the MPD detector capabilities for study of the
475 strangeness production at the NICA collider.", *Physics of elementary particles and*
476 *atomic nuclei, letters*, Vol. 12, No.2(193) 2015, pp.543-559.
- 477 [39] Mueller B. Hadronic signals of deconfinement at RHIC // *Nucl. Phys. A.* 2005. V.750.
478 P. 84-97.

- 479 [40] Moore G.D. and Teaney D. How much do heavy quarks thermalize in a heavy ion
480 collision? // Phys. Rev. C. 2005. V.71. P.064904.
- 481 [41] Hees H. and Rapp R. Thermalization of heavy quarks in the quark-gluon plasma //Phys.
482 Rev. C. 2005. V. 71. P. 034907.
- 483 [42] Uphoff J., Fochler O., Xu, Z., Greiner "C. Heavy-quark production in ultrarelativistic
484 heavy-ion collisions within a partonic transport model", Phys. Rev.C. 2010. V.82.
485 P.044906.
- 486 [43] J. Rafelski and B. Muller Phys. Rev. Lett. 48 (1982) 1066. [Erratum: Phys. Rev.
487 Lett.56,2334(1986)].
- 488 [44] P.Braun-Munzinger and J.Stachel Phys. Lett. B490 (2000) 196–202, arXiv:nucl-
489 th/0007059[nucl-th].
- 490 [45] O. Linnyk, E. L. Bratkovskaya, and W. Cassing Int. J. Mod. Phys. E17 (2008)
491 1367–1439, arXiv:0808.1504 [nucl-th].
- 492 [46] A. P. Kostyuk, M. I. Gorenstein, H. Stoecker, and W. Greiner Phys. Lett. B531 (2002)
493 195–202, arXiv:hep-ph/0110269 [hep-ph].
- 494 [47] P.Levai, T.S. Biro, P.Csizmadia, T.Csorgo, and J. Zimanyi J. Phys. G27 (2001) 703–706,
495 arXiv:nucl-th/0011023 [nucl-th].
- 496 [48] B. Abelev et al., “Technical design report for the upgrade of the ALICE inner tracking
497 system”. Journal of Physics G: Nuclear and Particle Physics. Volume 41, Issue 8, 2014,
498 08700.
- 499 [49] K. Aamodt et al. “The ALICE experiment at the CERN LHC”, JINST3 (2008) 1-245.
- 500 [50] <https://atlas.cern/discover/detector/inner-detector>
- 501 [51] <http://cms.web.cern.ch/news/silicon-pixels>
- 502 [52] F. Videbaek. For the STAR collaboration Brookhaven National Lab.
503 <https://sss.slideserve.com/shaw/the-star-heavy-flavor-tracker>
- 504 [53] G.Xie (for the STAR Collaboration). <https://arxiv.org/pdf/1704.04353.pdf> XXVth
505 International Conference on Ultrarelativistic Nucleus-Nucleus Collisions, (Quark Matter
506 2017)

2 The Pixel Chips

The sensors that will be used for the construction of the outer barrel of the MPD-ITS, are based on ALTAI Monolithic Active Pixel Sensors (MAPS). This type of chip is similar to the one originally developed for the construction of the new Inner Tracking System (ALICE-ITS2) of the ALICE experiment at CERN. ALICE is the first experiment at LHC implementing a large silicon tracker ($\sim 10\text{m}^2$) with this technology [1]. ALICE-ITS2 has been already completed and is currently undergoing the commissioning phase at CERN.

The sensor was optimized through extensive R&D [2,3] in order to handle collisions rates up to 50 kHz for Pb-Pb and 200 kHz for pp collisions improving the impact parameter resolution the standalone tracking efficiency and p_T resolution. For instance, the impact parameter resolution which should be achieved at 400 MeV/c is 50 μm in both $r\phi$ and z directions [2]. In addition, a power consumption well below 100 mW/cm² allows a material budget for the outer barrel of 0.8% X_0 [4].

2.1 The MAPS chips from the ALICE ITS2

The ALTAI chip is based on the 15 mm \times 30 mm large MAPS used for the ALICE-ITS2 project implemented in a 180 nm CMOS imaging sensor process by TowerJazz [4]. For the outer barrel layers, 100 μm thick sensors were employed. The novel implementation of deep p-well in the process allows full CMOS circuitry within the pixel matrix (Fig. 2.1) still keeping full charge collection efficiency [1,5]. A very low power consumption of less than 40 mW/cm² is achieved by the integration of continuously active low-power front-end into each pixel and in-matrix zero suppression circuit (Priority encoder).

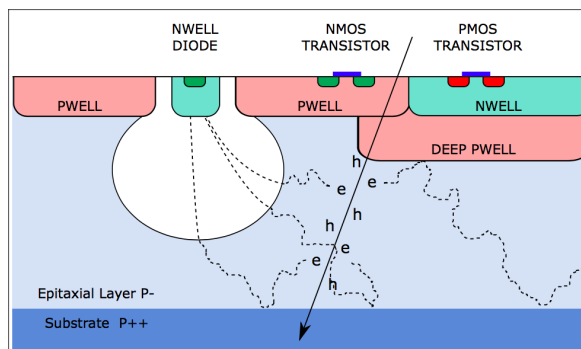


Figure 2.1: Schematic cross section of a MAPS pixel in the TowerJazz 0.18 μm imaging CMOS with the deep p-well feature.

The sensor is segmented in 512 \times 1024 pixels of 29 μm \times 27 μm (Fig. 2.2); a periphery circuit region of 1.2 mm \times 30 mm implements analog biasing, control, readout and interfacing functionalities (Fig. 2.3). Each pixel contains an n-well sensing diode ($\sim 2\mu\text{m}$ diameter), an amplifying and shaping stage, a discriminator and a digital section (Fig. 2.4) with three-hits storage register (Multi-Event Buffer), and two single bit registers for masking and pulsing logic, respectively. The Pulse register allows testing functions: each pixel can be forced

534 to produce a hit using both a test charge injection capacitor (analogue pulsing) or directly
 535 setting the pixel state register (digital pulsing).

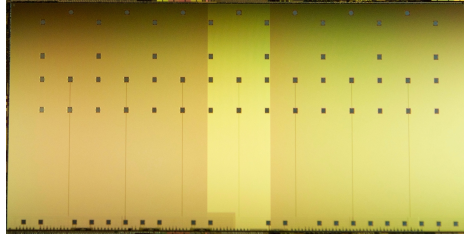


Figure 2.2: ALICE-ITS2 MAPS chip. The interconnection pads size, visible as dark square in the image, is $300\ \mu\text{m}$; pads in the bottom “digital periphery” are used for clock, control and readout signals, while all others distributed over the sensitive surface are used for digital and analogue power supply, ground and bias connections.

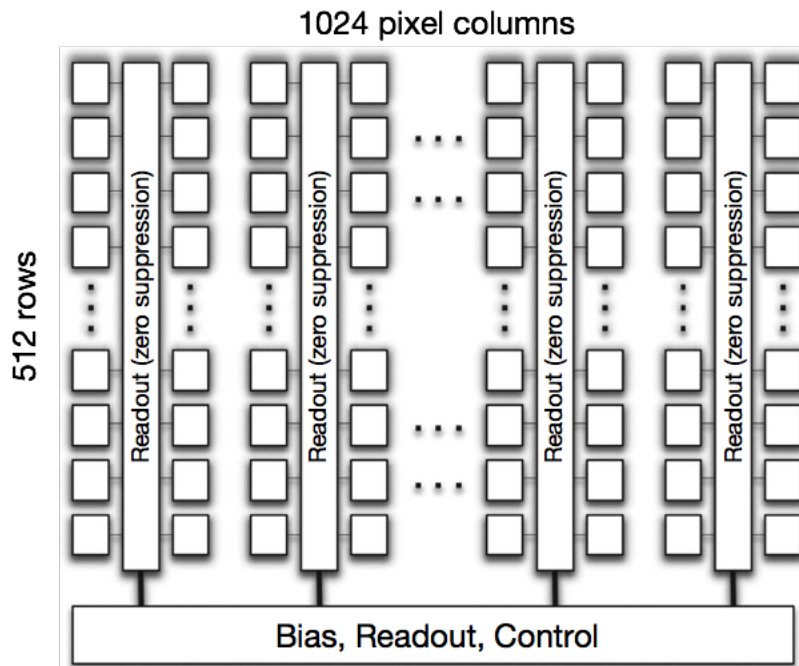


Figure 2.3: Architecture of the ALICE-ITS2 MAPS chip.

536 There are 512 Priority Encoders, one or every two pixels columns. They implement the
 537 buffering of readout and configuration signals to the pixels and provide the periphery with
 538 the pixel addresses over threshold which is the only information produced as readout data.
 539 The circuits are fabricated on a high resistivity ($>1\ \text{k}\Omega\ \text{cm}$) P-type epitaxial layer ($25\ \mu\text{m}$
 540 thick) on P-type substrate ($75\ \mu\text{m}$ thick for the outer barrel). A reverse back-bias voltage V_{bb}
 541 of $-3\ \text{V}$ is applied to the substrate in order to increase the depletion volume and reduce the
 542 capacitance which both contribute to increase the S/N ratio.

543 2.2 Detector technology

544 The $0.18\ \mu\text{m}$ CMOS technology by TowerJazz, selected for the implementation of the outer
 545 barrel layers, has distinguished features that make it suitable and in some respect unique for

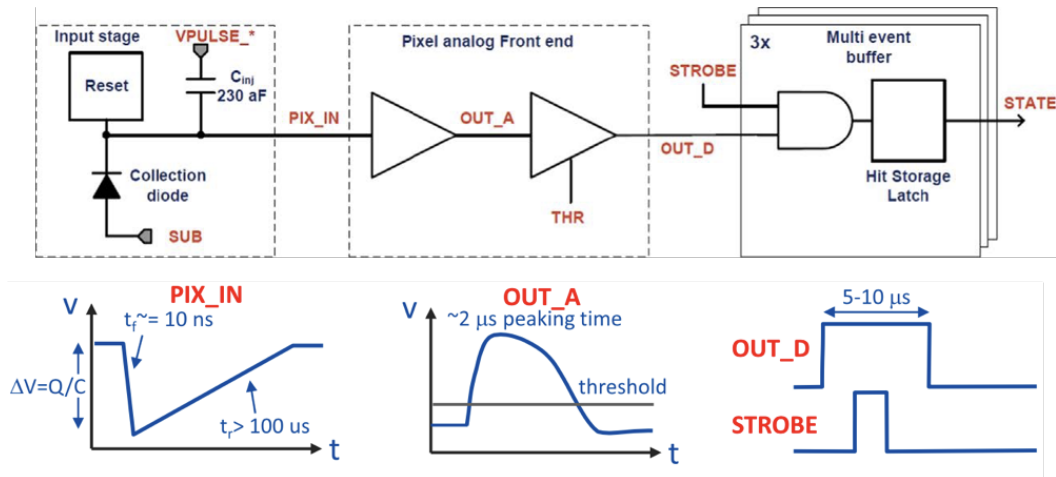


Figure 2.4: Block diagram of the ALICE-ITS2 MAPS chip pixel cell.

546 the implementation of the MPD-ITS Pixel Chip. As reported in [4]:

- 547
- 548
- 549
- 550
- 551
- 552
- 553
- 554
- 555
- 556
- 557
- 558
- 559
- 560
- 561
- The feature size and the number of metal layers available (up to six) are adequate to implement high density and low power digital circuits. This is essential since a large part of the digital circuitry (e.g. memories) will be located at the periphery of the pixel matrix and its area must be minimized to reduce the insensitive area as much as possible.
 - It is possible to produce the chips on wafers with an epitaxial layer of up to 40 μm thickness and with a resistivity between 1 $\text{k}\Omega\text{cm}$ and 6 $\text{k}\Omega\text{cm}$. With such resistivity, a sizeable part of the epitaxial layer can be depleted. This increases the signal-to-noise ratio and may improve the resistance to non-ionizing irradiation effects.
 - The access to stitching technology allows the production of sensors with dimensions exceeding those of a reticle and enables the manufacturing of die sizes up to a single die per 200 mm diameter wafer. As a result, insensitive gaps between neighboring chips disappear and the alignment of sensors on a Stave is facilitated.
 - The availability of a deep p-well option allows the production of pixel structures with significantly enhanced functionality.

562 The last point is a unique feature of this process and can be key to enable low-power
 563 readout architectures. In standard implementations, the sensing diode is an n-well diode,
 564 normally used as the substrate for PMOS transistors. As a consequence, only NMOS
 565 transistors can be used in the pixel area. In fact, any PMOS transistor requires an additional
 566 nwell that competes with the sensing diode in collecting the signal charge. The front-end
 567 electronics located in the pixel must fully rely on NMOS devices, so only simple, low-gain
 568 amplifiers or source followers can be implemented. Hit discrimination, which requires more
 569 sophisticated signal processing, cannot be performed at the pixel level and the full matrix
 570 must be scanned during the read-out phase. A few alternatives have been proposed to
 571 allow the use of PMOS in the pixel, like the use of deep n-well and of high voltage CMOS
 572 technologies. However, both options lead to a significant increase in the capacitance of the
 573 sensing electrode. Therefore, the power consumption in the front-end must be increased
 574 accordingly to preserve an adequate signal-to-noise ratio. This problem is circumvented due
 575 to the use of a deep p-well in the region where the front-end electronics is foreseen.

576 The n-wells that accommodate the PMOS transistors are fabricated on top of the deep
577 p-well. The signal electrons are reflected by the electric potential at the junction between the
578 epitaxial layer and the deep p-well and can be collected only by the sensing diode. Its size
579 can then be tailored to optimize the charge collection efficiency and the signal-to-noise ratio,
580 while full CMOS front-end electronics can be put in the pixel. The effectiveness of the deep
581 p-well approach has already been demonstrated and circuits with complex front ends similar
582 to those used for hybrid sensors read-out have already been produced.

583 2.3 Principle of operation

584 2.3.1 Particle detection

585 As indicated in Figure 2.1, when a charged particle traverses the silicon sensor's active volume,
586 it liberates charge carriers (electrons and holes) in the semiconductor material.

587 The released charge is then collected by electrodes that reveal not only the presence of a
588 particle but also — due to a fine segmentation — its impinging point onto the sensor. The
589 nature and quantitative behavior of the charge collection mechanism are functions of the
590 material properties (resistivity or doping level/profile) and geometry (thickness of sensitive
591 material, pixel pitch, electrode shape) as well as the electric field configuration (electrode
592 potential and geometry) of the sensor. The amount of deposited charge depends on the
593 particle species and its momentum (Bethe-Bloch). Minimum ionizing particles (MIPs, e.g.
594 0.5 GeV/c pions) which define the requirement on the minimal detectable charge, typically
595 release some 60 electrons per 1 μm path length in thin silicon layers [6].

596 A charged particle crossing the sensor liberates free charge carriers in the material by
597 ionization. The electrons released in the epitaxial layer can diffuse laterally while they remain
598 vertically confined by potential barriers at the interfaces with the overlying p-wells and the
599 underlying p-type substrate. The signal sensing elements are n-well diodes ($\sim 2 \mu\text{m}$ diameter)
600 with an area typically 100 times smaller than the pixel cell area. The electrons that reach the
601 depletion volume of a diode (or carriers that are released directly inside it) induce a current
602 signal at the input of the pixel front-end [1].

603 2.3.2 Read-out

604 As described in [7], the sensor pixels are read-out in a binary hit/no-hit fashion. It combines
605 a continuously active, low-power, in-pixel discriminating front-end with a fully asynchronous,
606 hit-driven combinatorial circuit. Figures 2.5 and 2.6 depict schematically the discriminator
607 circuit and the functioning of the ALTAI in-pixel front-end circuitry, respectively.

608 The in-pixel circuitry consists of a continuously active discriminating amplifier and a
609 multiple-event memory into which data may be strobed. The rise time of the amplifier is
610 below 2 μs and defines the event time resolution while its shaping time is longer and makes
611 it act as an analogue delay line. This allows data to be discriminated and strobed with a
612 trigger latency of some 2 μs into the in-pixel buffers in a global shutter mode of operation.
613 Strobbing can also be done with fixed spacing and over longer periods making the circuit
614 record data continuously.

615 The in-pixel multiple-event memory is read-out asynchronously by means of a priority
616 encoder circuit in each double column. This is both fast and power efficient as the expected
617 occupancies are low and only hit pixels are read-out in a hit-driven fashion [8]. Data is
618 collected at the periphery and shipped off the detector by means of a high-speed serial link.
619 The chip also supports a mode where data of six adjacent chips is collected by one sensor
620 acting as a master [9].

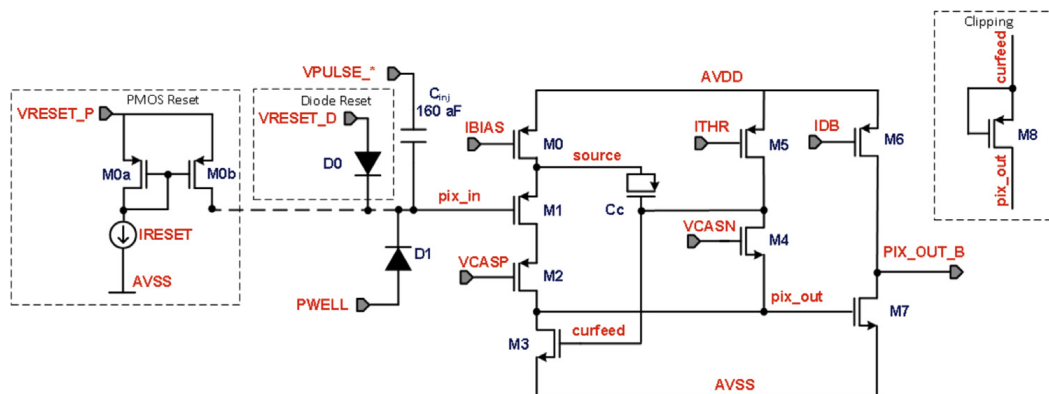


Figure 2.5: Reset, amplification and discrimination circuit of the sensor.

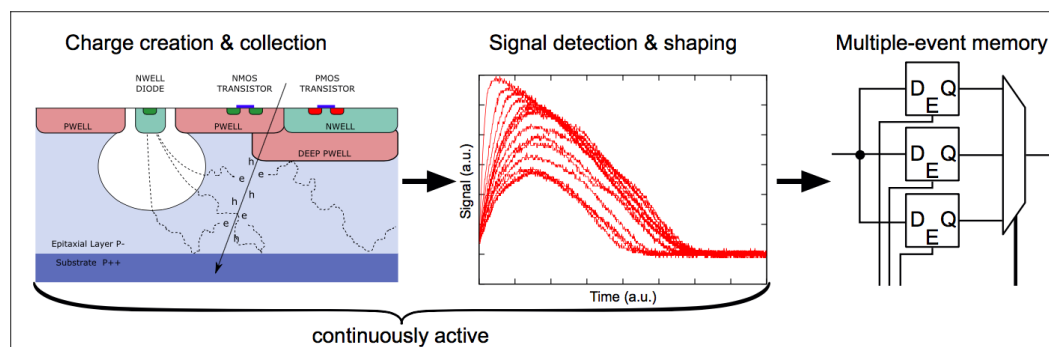


Figure 2.6: Principle of operation of sensor's in-pixel circuitry.

621 Bibliography

- 622 [1] G. Aglieri Rinella, et. al., The ALPIDE pixel sensor chip for the upgrade of the ALICE
623 Inner Tracking System, Nucl. Instr. Methods Phys. Res. A: Accel. Spectromet. Detect.
624 Assoc. Equip. 845 (2017) 583–587
- 625 [2] P. Yang, et. al., MAPS development for the ALICE ITS upgrade, Pixel 2014 International
626 Workshop, September 1-5, Niagara Falls, Canada.
- 627 [3] Sabyasachi Siddhanta, et.al., The upgrade of the Inner Tracking System of ALICE, Nucl.
628 Phys. A: Nucl. Hadr. Phys. 931 (2014) 1147–1151
- 629 [4] B. Abelev, et al., The ALICE Collaboration, Technical design report for the up- grade
630 of the ALICE inner tracking system, J. Phys. G: Nucl. Part. Phys. 41 (2014) 087002
- 631 [5] M. Suljic, ALPIDE: the Monolithic Active Pixel Sensor for the ALICE ITS upgrade, J.
632 Instrum. 11 (2016) C11025
- 633 [6] H. Bichsel, Stragglings in thin silicon detectors, Rev. Mod. Phys. 60, 663–699 (1988)
- 634 [7] M. Mager, et. al., ALPIDE, the Monolithic Active Pixel Sensor for the ALICE ITS
635 upgrade, Nucl. Instr. Methods Phys. Res. A: : Accel. Spectromet. Detect. Assoc. Equip.
636 824 (2016) 434–438
- 637 [8] P. Yang, et al., Low-power priority Address-Encoder and Reset-Decoder data-driven
638 readout for Monolithic Active Pixel Sensors for tracker system, Nucl. Instr. Methods
639 Phys. Res. A: Accel. Spectromet. Detect. Assoc. Equip. 785 (2015) 61.
- 640 [9] A. Szczepankiewicz, et. al., Readout of the upgraded ALICE-ITS, Nucl. Instr. Methods
641 Phys. Res. A: Accel. Spectromet. Detect. Assoc. Equip. 824 (2016) 465–469.
- 642 [10] A. Di Mauro, et. al., The new inner tracking system for the ALICE upgrade at the LHC,
643 Nucl. Instr. Methods Phys. Res. A: Accel. Spectromet. Detect. Assoc. Equip. 936 (2019)
644 625–629.
- 645 [11] ALICE Collaboration, Upgrade of the ALICE Experiment: Letter of Intent, J. Phys. G
646 41 (8) (2014) 087001.
- 647 [12] P. Martinego, et. al., The new Inner Tracking System of the ALICE experiment, Nucl.
648 Instr. Methods Phys. Res. A: Accel. Spectromet. Detect. Assoc. Equip. 967 (2017) 900-
649 903.

3 Detector Layout

651 The MPD-ITS conceptual layout (Fig. 3.1) repeats the scheme used in ALICE-ITS2 but
652 with a decreased number of MAPS layers from seven (ALICE-ITS2) to five (MPD-ITS). This
653 is due to the significantly smaller internal diameter of the TPC chamber 500 mm of MPD
654 installation. The MPD-ITS will consist of two coaxial cylinders (“barrels”), Inner (IB) and
655 Outer (OB) with layers of different thicknesses and with a completely different design of the
656 supporting structure and cooling system.

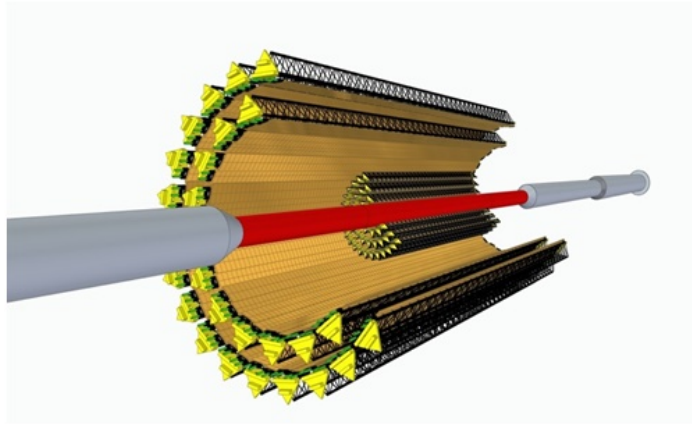


Figure 3.1: MPD-ITS conceptual layout around thin beryllium beam pipe of MPD setup

657 The Inner Barrel IB contains three layers of detectors and the Outer Barrel OB
658 contains two. Detecting layers are segmented in the azimuthal direction into independent
659 supermodules blocks or “Staves”.

660 The spatial position of the Staves in the layer is determined by the requirement of full
661 coverage of the cylindrical surface. Therefore, taking into account the fact that on the side
662 of the detector plate there is a so-called “dead zone” in which reading and buffering circuits
663 from a position-sensitive matrix are located, the design assumes a certain amount of detectors
664 overlapping in the layer.

665 The design of the mechanics of the tracker was carried out for two diameter variants
666 of the MPD beam pipe; diameters *project* 40 mm and *initial* 64 mm. This copes with the
667 existing plans for NICA collider to be launched with an “initial” beam pipe diameter 64 mm,
668 which after the adjustment of the machine should be replaced with a “project” beam pipe
669 of a smaller diameter. Appendix .2 exposes the possibilities for the reduction of the beam
670 pipe diameter. It is important to note that with all the provided replacements for the beam
671 pipe, the mechanical structure of the tracker itself remains universal, and the structure and
672 parameters of the Outer Barrel are unchanged. Therefore, the main goal of the first stage of
673 the MPD-ITS project is to design and manufacture the mechanical structure of the tracker
674 and the Outer Barrel of the system. This strategy is explained in details in section 3.1. For
675 this reason, the present chapter is mainly devoted to the aspects related to the assembly,
676 testing and installation of the Outer Barrel of the MPD-ITS. Finally, in section 3.3 the plans
677 for the completion of the Inner Barrel are presented. Three possible variants of the IB are
678 presented here, which include the most-desired design using the novel ALICE-ITS3 ultrathin

679 sensors currently under R&D and two backup variants using the existing ALICE-ITS2 IB
680 sensors depending on the effective diameter of the beam pipe.

681 3.1 The two stages construction scenario

682 The existing natural constraints on the minimal diameter of the beam-pipe, coming from
683 the NICA accelerator beam tuning and performance, are to be taken into account for the
684 design of the ITS. At present, two options of the beam-pipe are being considered for the MPD
685 installation with a diameter of 64 mm and 40 mm, respectively. The final choice will be made
686 by the NICA accelerator team after the start of operation. Therefore, two-stages scenario is
687 adopted for the ITS development.

688 The Stage-1 of the project foresees to start with the development of the so-called Outer
689 Barrel of the ITS based on the ALTAI chip using 180 nm technology from the TowerJazz.
690 Two external layers of CMOS sensors will be built following the existing design of the ALICE
691 ITS [33].

692 One of the important tasks is the design of the overall assembly procedure of the Inner
693 Tracking System and the long and fragile beam-pipe section. They should be installed inside
694 the limited space of the MPD TPC together with additional FFD [26] detector, the read-out
695 and power supply cables, liquid cooling tubes and air-ducts. These issues are presented in
696 Chapter 4.

697 At the Stage-2 the innermost layers of the ITS will be constructed for the MPD expecting
698 to have the small diameter beam-pipe. Thus, it is planned to use the most advanced
699 developments of the Inner Barrel by ALICE Collaboration. The ongoing R&D for the future
700 ALICE Inner Barrel of the ITS-3 [1], [2], is based on the 65 nm TowerJazz technology.
701 The 20 μm -thick sensors could be up to 280 mm long and 94 mm wide in Stitching Chip
702 manufacturing and, owing to the flexible nature of silicon at these thickness, they could
703 be bent in case of ALICE ITS3 into half-cylinders of radii of 18 mm, 24 mm and 30 mm
704 respectively to form the new concentric layers of the Inner Barrel [3].

705 These very thin, $\sim 20 \mu\text{m}$, large area wafers with sensors will be used together with the
706 novel extremely light mechanical and cooling systems for the implementation of the MPD-ITS
707 Inner Barrel. The new detector would reach an unprecedented low material budget below
708 $X/X_0 \sim 0.05\%$ per layer.

709 On the other hand, taking into account that this 65 nm technology is currently under
710 R&D, a back-up solution for the Stage-2 will be based on the design of the MPD Inner Barrel
711 based on the well proven 180 nm technology.

712 3.2 Stage-1: The Outer Barrel

713 The sensors of the Outer Barrel will be arranged on two concentric Layers (layers 4 and 5)
714 with a total of 42 elements called *Staves* (described in section 3.2.1) that follow the existing
715 design from the Outer Barrel of ALICE-ITS at the LHC presented in the Technical Design
716 Report [33].

717 The cross section of the layout of layers 4 and 5 that conform the Outer Barrel of the
718 MPD-ITS is shown in figures 3.2 and 3.3 (detail), while figure 3.4 shows its side view.

719 3.2.1 Outer Barrel Staves

720 This section is dedicated to the description of the Outer Barrel Staves including supporting
721 mechanics, cooling system and assembly process. A large part of the information presented

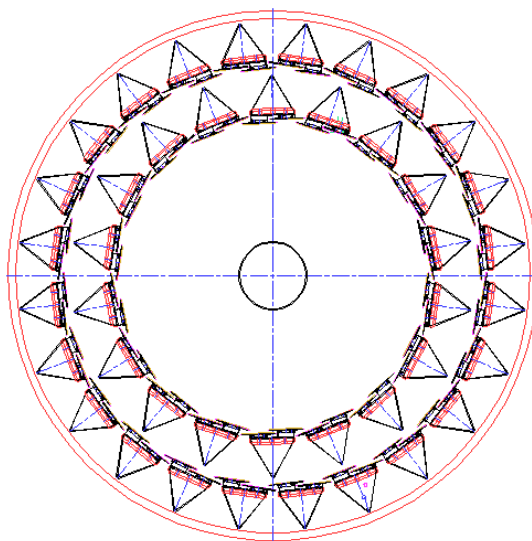


Figure 3.2: Outer Barrel of the MPD Inner Tracking System: cross-section. See parameters of layers 4,5 in the Table 3.7

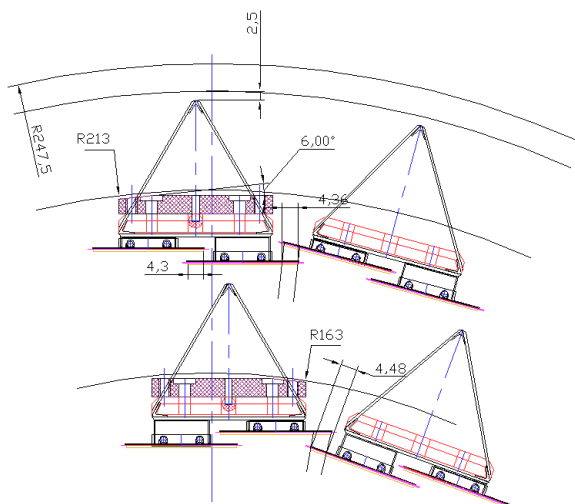


Figure 3.3: Detail of the cross section of the Outer Layers of the MPD Inner Tracking System

722 here comes from the R&D process carried out by the ALICE Collaboration for the production
 723 of the ITS2 detector, as reported in [6].

724 Each Stave is a segment of a Layer in the azimuthal direction, and it extends over the whole
 725 length of the respective layer. The Stave contains all structural and functional components
 726 making it the smallest operable part of the detector and the basic detector unit (Fig. 3.5). The
 727 Staves are azimuthally split themselves into two Half-Staves which are further fragmented
 728 longitudinally in seven HIC (Hybrid Integrated Circuits) modules. Figure 3.6 shows a bottom
 729 view of an actual Stave from the ALICE-ITS2 which are geometrically the same as the ones
 730 that will be produced for MPD-ITS.

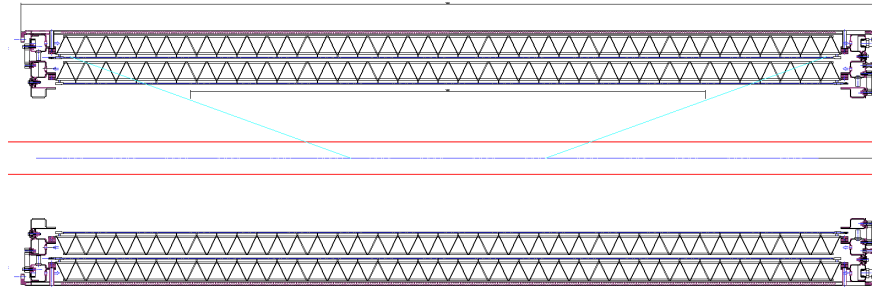


Figure 3.4: Side view of the ITS layers 4 and 5 to be installed at the Stage-1

731 The detailed composition of the OB Staves is as follows:

- 732 • **Space Frame:** lightweight trihedral cross-section structures made of high modulus
733 carbon fibers and an epoxy resin. It provides the mechanical support and the necessary
734 stiffness to the Half-Staves throughout the entire operation period;
- 735 • **Ending elements:** structures having precision holes that are fixed at the edges of
736 the Space Frames. They provide high-precision positioning of the Half-Staves during
737 technological transitions of its assembly with detectors blocks and, subsequently, as
738 part of the ITS detection layer;
- 739 • **Cold Plate:** a sheet of carbon fiber laminate with high-thermal conductivity values
740 from 800 to $1500 \text{ W m}^{-1} \text{ K}^{-1}$ with embedded polyimide cooling pipes. They are in
741 thermal contact with the Pixel Chips to remove the generated heat. The Cold Plates
742 are connected to the Space Frame by U-shaped connectors;
- 743 • **Hybrid Integrated Circuit (HIC):** an assembly of a polyimide Flexible Printed
744 Circuit (FPC) on which 14 Pixel Chips are bonded. On each module of the Outer
745 Barrel there are 14 sensors that readout the address of the pixel info hit by a particle.
746 This *modules* can be individually replaced in case of defects during the testing of the
747 assembly;
- 748 • **Half-Stave:** the OB Staves are further segmented in azimuth in two halves, called
749 Half-Staves. Each Half-Stave extending over the full length of the Stave consists of a
750 Cold Plate on which a seven HICs are glued.

751 In order to achieve a nearly full coverage, the two Cold Plates of a Stave overlap in the $r\varphi$
752 direction, as shown by the Stave cross section in figure 3.5, and each of them overlaps with
753 the nearest Cold Plate of the neighbouring Staves. The sizes of overlapping dead zones are
754 optimized taking into account the spatial position of the detector Half-Staves in each layer.
755 Actual size of dead zones for the Outer Barrel layers is shown in Figure 3.3.

756 3.2.2 Supporting mechanics

757 The Stave mechanical support must fulfil stringent requirements in terms of minimum mass
758 and highest stiffness. Its design is inherently linked to the layout of the cooling system that
759 will be adopted to remove the heat dissipated by the silicon sensors since the cooling system
760 is integrated in the mechanical structure. Each OB Stave is 1524 mm in length with 1474 mm
761 covered by the sensors. The layout of the OB Stave mechanics and cooling consists of a
762 Space Frame and two Cold Plates, one for each Half-Stave. The Cold Plate is made of a

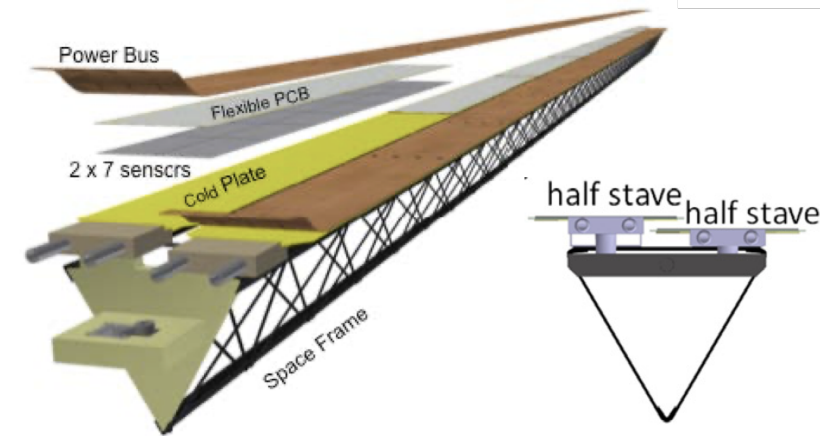


Figure 3.5: Schematic exploded view and cross section of the OB Stave.

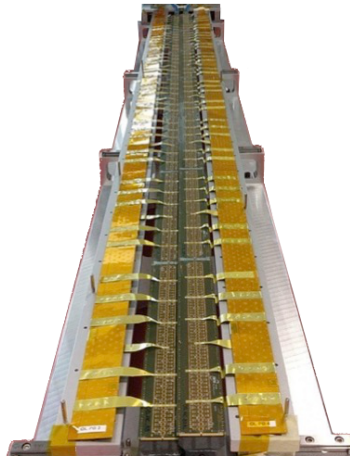


Figure 3.6: Bottom-view of an actual Stave from ALICE-ITS2 showing the two Half-Staves structures and the composing HIC modules.

763 high thermal conductive carbon fibre laminate with embedded cooling pipes on top of which
 764 the silicon chips are glued. The heat is conducted into the cooling pipes by the carbon fibre
 765 structure and is removed by the coolant flowing in the pipes. For mechanical stability the
 766 Cold Plate is stiffened by the Space Frame, a light filament wound carbon structure with a
 767 triangular cross section. A mechanical connector at each of the two ends of a Stave provides
 768 the precise positioning of the Stave in the Layer configuration.

769 A general view of the Cold Plate is shown in Figure 3.7. The approved Cold Plate length
 770 for layers 4 and 5 is 1502 mm.

771 The composite structure of the Cold Plate is shown in Figure 3.8. It consists of:

- 772 • a substrate made of heat-conducting carbon fiber brand M55J with thermal
 773 conductivity along the fiber $155.6 \text{ W m}^{-1} \text{ K}^{-1}$ and a thickness of $70 \mu\text{m}$, laid
 774 perpendicular to the longitudinal axis;
- 775 • two polyimide tubes with an inner (outer) diameter of 2.024 mm (2.074 mm);
- 776 • thermal graphite foil FGS-003 with thermal conductivity $1500 \text{ W m}^{-1} \text{ K}^{-1}$ and a
 777 thickness of $30 \mu\text{m}$ laid on top of the tubes and transferring heat from the Plate to
 778 the tubes;

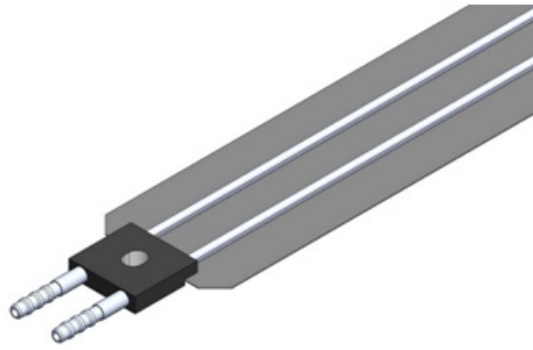


Figure 3.7: Cold Plate of the Outer Barrel Staves of MPD-ITS.

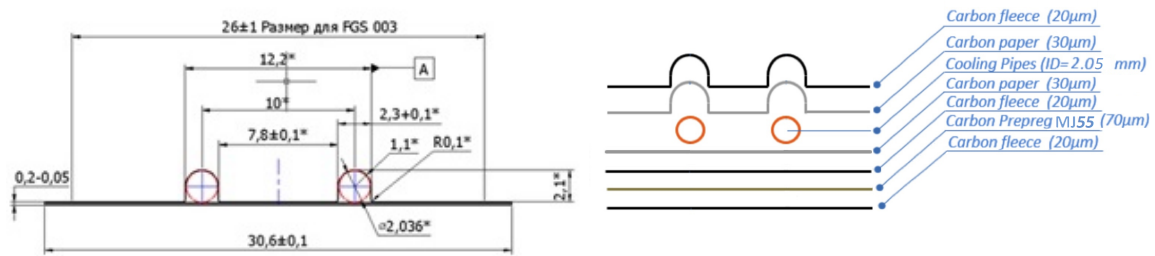


Figure 3.8: Cross section (left) of the Cold Plate and the content of its inner structure (right).

- 779 • carbon fleece with a density of 8 g/m^2 and thickness of $20 \mu\text{m}$.

780 To ensure the solidity of the Plate an epoxy compound is used. Complete assembly
 781 of the Cold Plate includes edge elements with precision holes that provide solutions to the
 782 technological problems of assembly and positioning of the Plates when setting on Half-Staves.
 783 The edge elements also contain fittings and transitional connections for supplying and coolant
 784 diversion.

785 On the other hand, Outer Barrel Staves (layers No. 4 and 5) have a total length of
 786 1556 mm in order to ensure the required acceptance of particles detection. Therefore in order
 787 to achieve the required rigidity the cross section of the Space Frame (Fig. 3.9) is such that
 788 makes it possible to place two paired Cold Plates with Hybrid Integrated Circuit (HICs).
 789 The width of the Plate allows to place Hybrid Integrated Circuit (HICs) stacked along the
 790 Half-Staves of the Outer Barrel. The gap between the detector chips does not exceed $100 \mu\text{m}$.
 791 To place them and close the “dead zone” on the sensors, the Cold Plates are staggered at
 792 different heights (see Figs. 3.3 and 3.5). The Plates are fastened to the Space Frame through
 793 U-legs of different lengths.

794 3.2.2.1 Material budget

795 Table 3.1 reports the estimated contributions of the OB Stave to the material budget. The
 796 estimated overall material budget is within reach of the required $0.8\% X_0$. The detailed
 797 description of the azimuthal distribution of the material across the Outer Layer Stave is
 798 shown in figure 3.10. The neighbouring Half-Staves are partially superimposed to ensure the
 799 detector hermeticity, thus giving rise to the peaks around $1.25\% X_0$. The highest peaks are

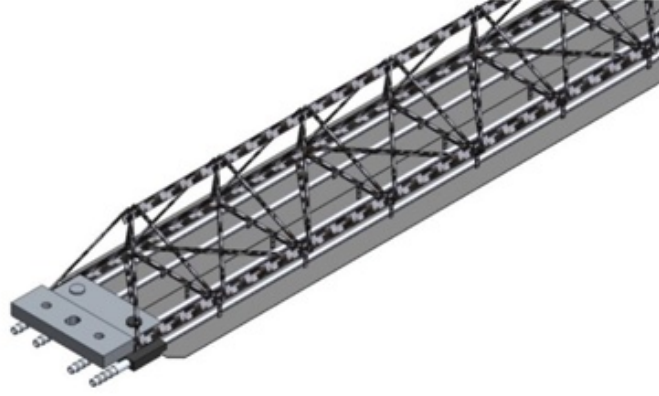


Figure 3.9: Outer Barrel Space Frame with Cold Plates. To complete the first stage of the MPD-ITS a total of 42 Staves plus spares are needed.

800 due to the polyimide cooling pipes embedded in the Cold Plate assuming they are fully filled
801 with water.

Table 3.1: Estimated contributions of the Outer Layer Stave to the material budget.

Stave element	Component	Material	Thickness (μm)	X_0 (cm)	X_0 (%)
Module	FPC Metal layers	Aluminium	50	8.896	0.056
	FPC Insulating layers	Polyimide	100	28.41	0.035
	Module plate	Carbon fibre	120	26.08	0.046
	Pixel Chip	Silicon	50	9.369	0.053
	Glue	Eccobond 45	100	44.37	0.023
Power Bus	Metal layers	Aluminium	200	8.896	0.225
	Insulating layers	Polyimide	200	28.41	0.070
	Glue	Eccobond 45	100	44.37	0.023
Cold Plate		Carbon fleece	40	106.80	0.004
		Carbon paper	30	26.56	0.011
	Cooling tube wall	Polyimide	64	28.41	0.013
	Cooling fluid	Water		35.76	0.105
	Carbon plate	Carbon fibre	120	26.08	0.046
	Glue	Eccobond 45	100	44.37	0.023
Space Frame		Carbon rowing		0.080	
Total					0.813

802 3.2.3 Cooling system

803 The cooling system of the ITS includes water- and gas-cooling sub-systems. Its main goal is to
804 provide precise temperature control of the detectors, electronics and mechanical components
805 of the detector. In particular, the system should:

- 806 • remove all heat generated inside the detector by chips and service elements;
- 807 • maintain chips at appropriate temperatures for various operating conditions;
- 808 • avoid leakage of coolant and condensation inside and outside the detector;
- 809 • avoid heat exchange with surrounding detectors;
- 810 • be compatible with the equipment planned for installation;

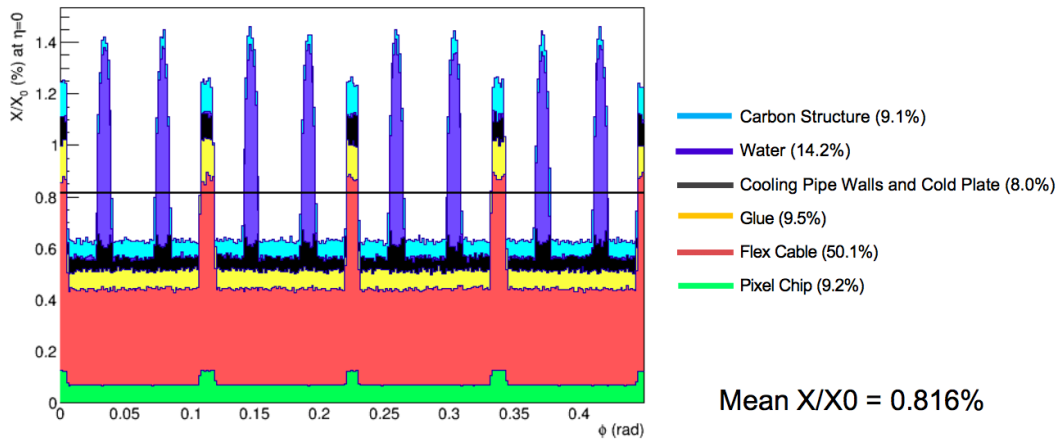


Figure 3.10: The azimuthal distribution of the Outer Layer Stave material traversed by the particles at $\eta = 0$. The highest peaks correspond to the polyimide cooling pipes embedded in the Cold Plate fully filled of water and the others to the Half-Stave overlaps to ensure the detector hermiticity.

- 811 • interface with the Detector Control System (DCS) and locking system;
- 812 • comply with the safety rules of JINR.

813 Table 3.2 shows the requirements for the detector and service electronics stable
814 functioning.

Table 3.2: Detector and service electronics requirements

Requirement	Detector	Service electronics
T_{max} Pixel chip working	30 °C	40 °C
ΔT_{max} (uneven)	≤ 5 °C	
Settings	Magnetic field	500 mT*
	Temperature	T=20 °C RH=35% $T_{Dew\ point}=4$ °C
Stability	Temporary (it will not be possible to calibrate) detector positioning ≤ 5 μ m	
Installation/ Removal	Ability to move non-functioning boards (3 months)	Ability to move non-functioning boards (3 months)
System access	Detector installation and maintenance available on both sides	Detector installation and maintenance available on both sides

(*)Simulation parameters.

(**)Magnet is ON.

815 3.2.3.1 Integrated leakless water cooling system

816 The power density of the pixel chips is about 28 mW/cm² for all five layers of the ITS. An
817 additional heat load, about 30 % of the chip load, coming from the power regulators should
818 be considered for each Stave.

819 For each OB Half-Stave the chips cover a total area of $14 \times 7 \times 1.5 \times 3.0 \text{ cm}^2 = 441 \text{ cm}^2$,
820 with a total heat release of 28 mW/cm² + 50 % (14 mW), this amounts to $441 \times 0.042 = 18.5 \text{ W}$
821 or 4.4 cal/s for a single Half Stave of the OB. To remove this heat at a water ΔT of 2 °C, 4.4
822 : 2 = 2.2 g/s of water flow or 7.9 l/h will be required.

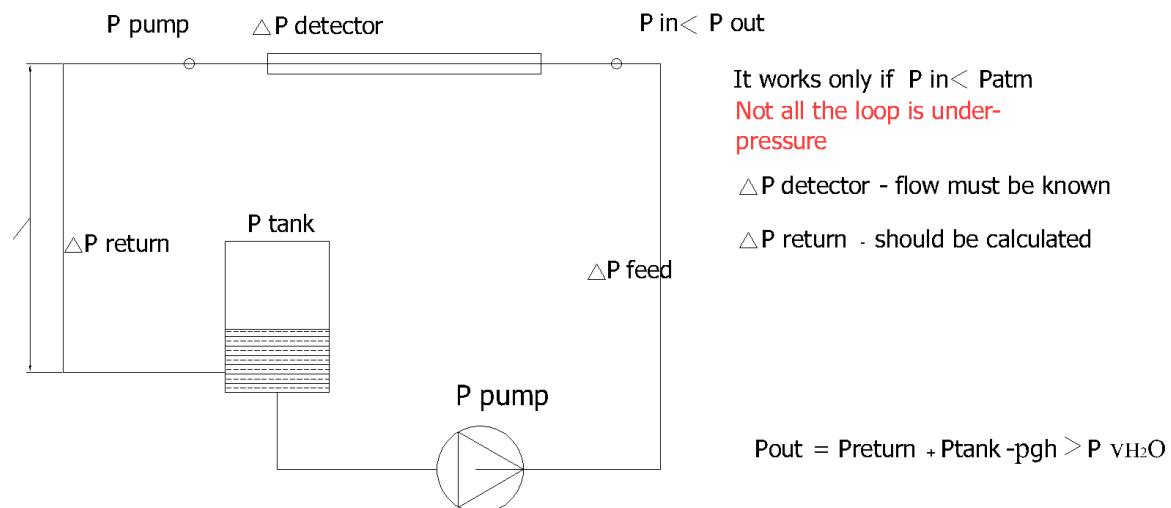
823 Table 3.3 shows the cooling requirements for the Staves and the related electronics.

Table 3.3: Technical requirements for Staves and electronics

Technical specifications	Detector Staves	RU Electronics
Power load	OB: 84 pcs (Half Staves)	
	From the detector 1555 W*	7.5 kW
	Bus 63 W Power Cable 22 W	
Stave pressure difference and water consumption	OB: $\Delta P=0.2 \text{ Kg/cm}^2$ $Q=6.31/\text{h}$ $\Sigma 5301/\text{h}$	OB: 0.3 Kg/cm^2 Stave $Q=111/\text{h}$
Chip / valid temperature Range	20 °C to 30 °C	20 °C to 40 °C
Chip / working temperature	22 °C \pm 1 °C	30 °C \pm 5 °C

(*)Calculation based on Alpid 4; OB = 28 mW/cm² + 50%.

824 To remove the bulk of the heat, a leakless liquid cooling system using demineralized water
825 is used (Fig. 3.11).

**Figure 3.11:** Schematic of the leakless water cooling system.

826 The layout of the Stave mechanics and cooling for the OB consists of a Space Frame
827 and two Cold Plates. The Cold Plate is made of a high thermal conductive carbon fiber
828 laminate, with embedded cooling pipes, on top of which the silicon chips are glued. The
829 heat is conducted into the cooling pipes by the carbon fiber structure and is removed by the
830 coolant flowing in the pipes that are joint at one end. For mechanical stability the Cold Plate
831 is stiffened by the Space Frame, a light filament wound carbon structure with a triangular
832 cross section. A mechanical connector at each of the two ends of a Stave provides the precise
833 positioning of the Stave in the Layer configuration.

834 This design has been inherited from the ALICE-ITS2 project. The Staves are connected to
835 the cooling system by blocks. The modularity of the connection allows reducing the number
836 of supply and draining pipes. The breakdown schemes of the cooling system into modules
837 are shown in figure 3.12.

838 The connection of the panels in the modules and the bore sections of the tubes are shown
839 in figure 3.13.

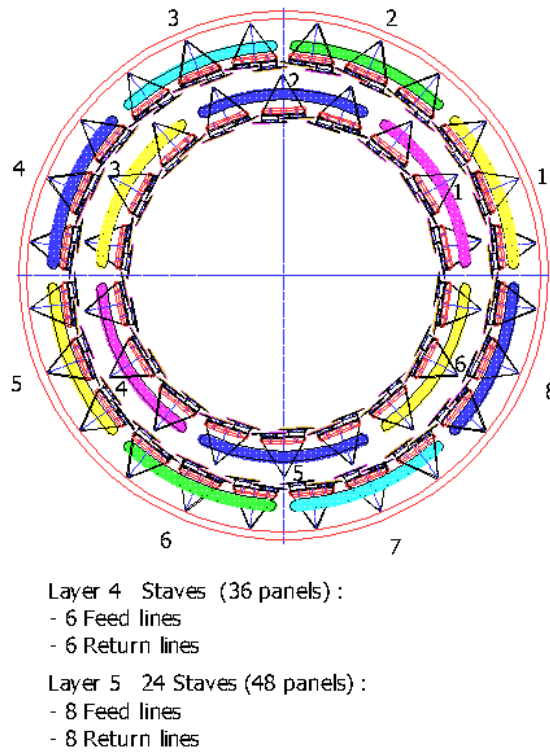


Figure 3.12: Schematic of the water cooling system for the OB Staves.

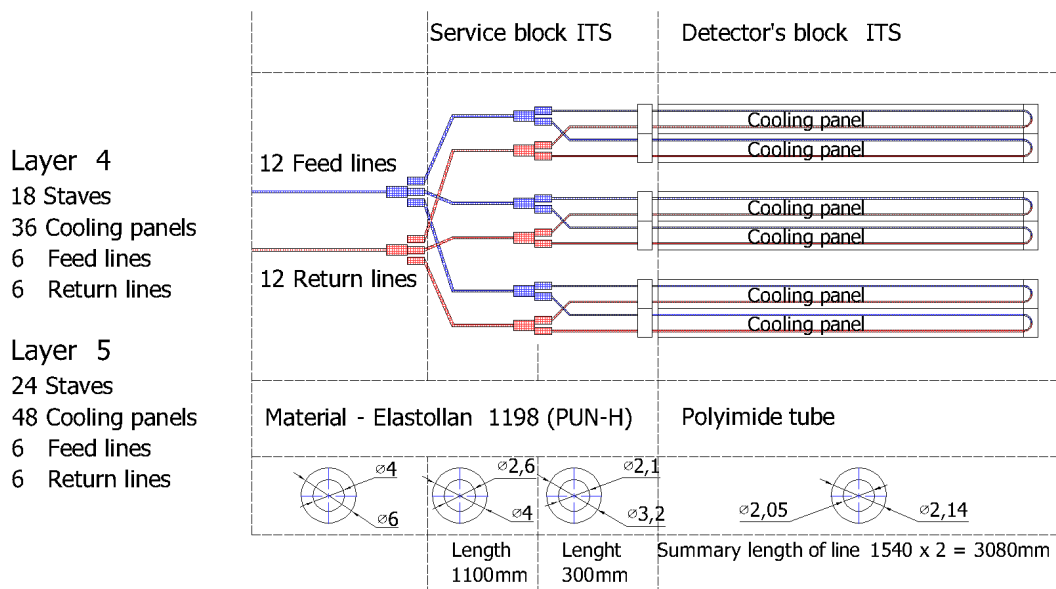


Figure 3.13: Modularity specification of the ITS OB Layers.

840 **3.2.3.2 Integrated gas cooling system**

841 The ITS gas-flow system eliminates the temperature gradient along the vertical axis of the
 842 housing and additionally provides humidity control inside the system. An air-flow system is
 843 integrated into the support system of the detector Staves with the characteristics shown in

844 table 3.4.

Table 3.4: ITS air cooling sysms basic characteristics.

Parameter	Air circulation
Air flow	$Q=30\text{ m}^3/\text{h}\pm 6\text{ m}^3/\text{h}$ OB airflow: $20\text{ m}^3/\text{h}$ Service unit: $7\text{ m}^3/\text{h}$
Temperature	$T_{in}=20\text{ }^\circ\text{C}$
Humidity	$\text{RH}_{out}=10\% \text{ to } 35\%$ (RH to be set in this range)
Flow direction in the layers*	Layer 5 from A to C Layer 4 from C to A
Flow rate	$<2\text{ m/s}$ (Detector housing)

(*)See figures 3.14 and 3.15.

845 The hollow support end-wheels of the Staves are used as collectors of the distribution
846 system. To do this, cooled and drained air is supplied to the volume of half of the end-wheel
847 from one side of the Stave, through the 5 mm-diameter nozzles on the fittings (Fig. 3.16) from
848 which air flows into the ITS volume directly to the Stave. The extraction of heated air is
849 carried-out in the opposite end-wheel acting as a manifold for sucking in the heated air and
850 discharging it through a pipe system.

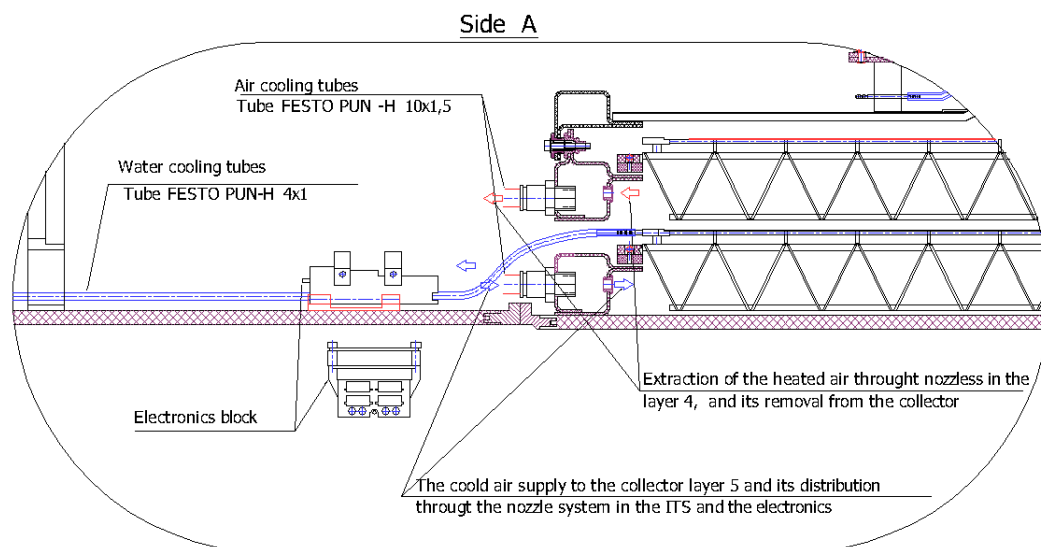


Figure 3.14: Air flow direction in layers 4 and 5 from side A.

851 The amount of air supplied is regulated by the outlet temperature control system. The
852 estimated air velocity is about 2 m/s. Total air flow in the body volume $Q=30\text{ m}^3/\text{hour}$.

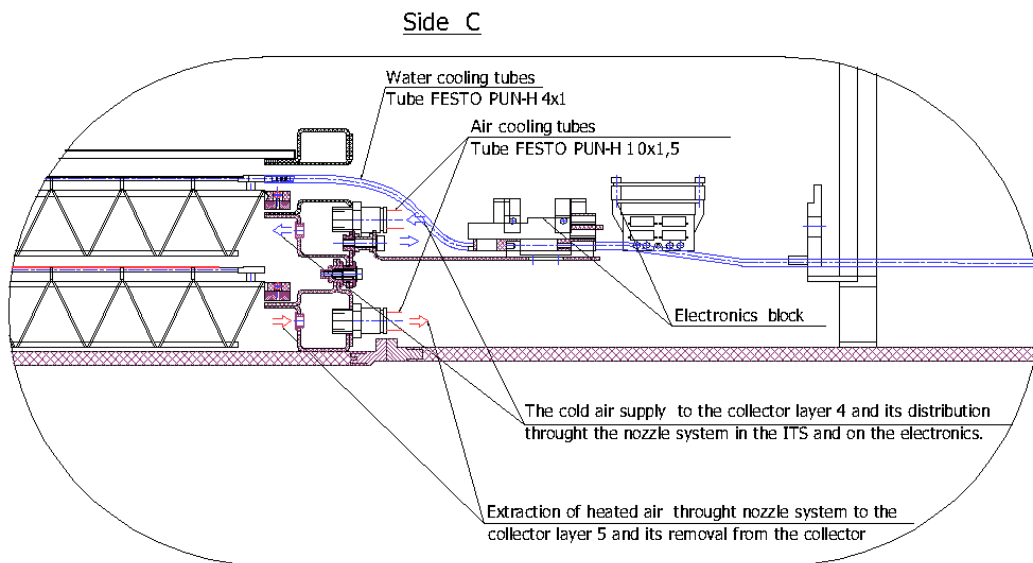


Figure 3.15: Air flow direction in layers 4 and 5 from side C.

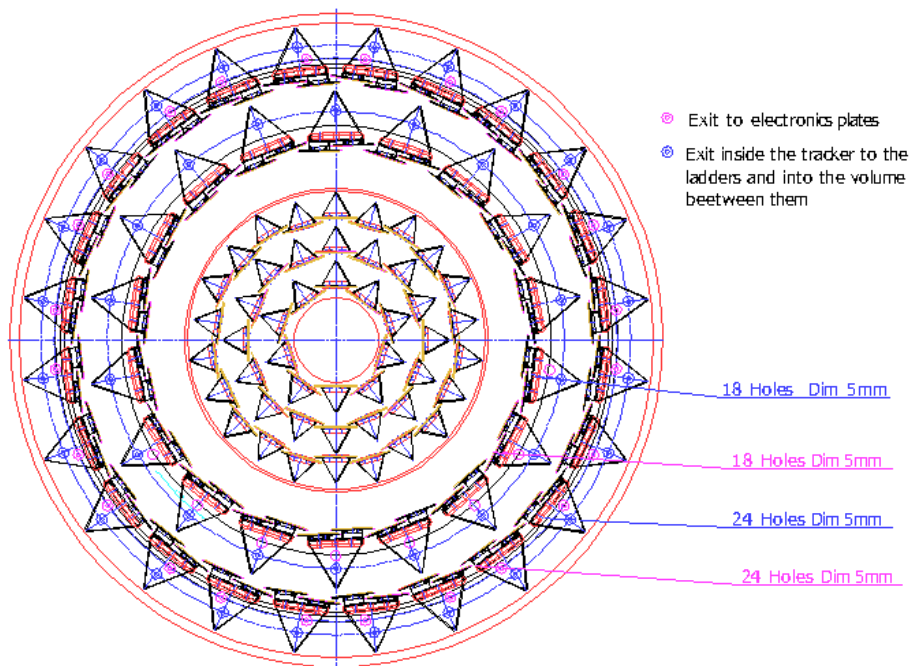


Figure 3.16: Location of nozzles on manifolds Side A.

853 3.2.4 Outer barrel FPC

854 The FPC of the OB Module interconnects 14 Pixel Chips arranged in two rows. Each row of
855 seven chips is treated as an independent array in terms of power distribution and is driven
856 by a master chip located at the end for the bi-directional data exchange.

857 These chips will be connected to the FPC in order to provide:

- 858 • The connection to power and ground;
- 859 • The connection to the external control and readout electronics;
- 860 • The connection between master and slave chips within the OB-Module;
- 861 • The connection to other chip structures (substrate and p-well).

862 All the lines consist of $100\ \mu\text{m}$ wide strips; the distance between strips of the differential
 863 pairs is $200\ \mu\text{m}$ (pitch). The nominal differential impedance of the differential lines is $10\ \Omega$.

864 Finally the flexible circuit includes a line for biasing the substrate and p-well of the chips.
 865 Digital and analog power planes are hosted on the top layer, while the ground planes are
 866 accommodated on the bottom layer of the FPC circuit.

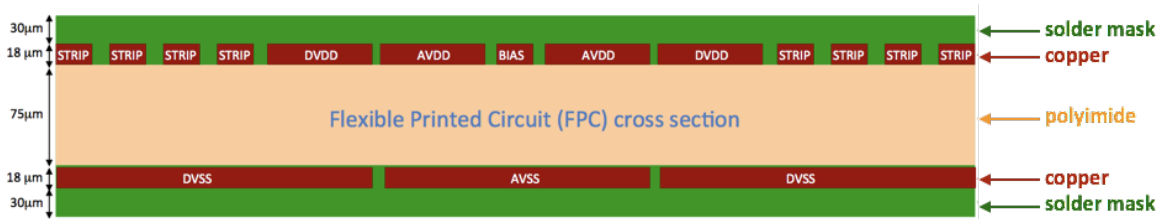


Figure 3.17: Schematic view of a cross section of the central part of the FPC circuit.

867 All master chips on one Half-Stave long row, i.e. four or seven depending on the Layer,
 868 receive the clock and configuration signals from the end of the Stave on a common differential
 869 pair and, after regeneration inside the chips themselves, distribute them to the remaining six
 870 chips in a Module row. The seven chips of a Module row are connected in daisy-chain mode,
 871 which refers to the respective master chip. The master chips send data on two independent
 872 differential pairs to the first chip of the adjacent Module and to the first chip of the following
 873 Module, thus allowing skipping a Module in case of failure. The serialized data of a Half-
 874 Stave-long row are transmitted to a readout link located at the end of Stave by the outermost
 875 master chip; each Half-Stave is served by two readout links. The proposed scheme, which
 876 provides a reasonable level of redundancy against single chip failures or of an entire Module,
 877 has been implemented in the FPC layout shown in Fig. 3.17. An image of an FPC mock-up
 878 is shown in Figure 3.18.

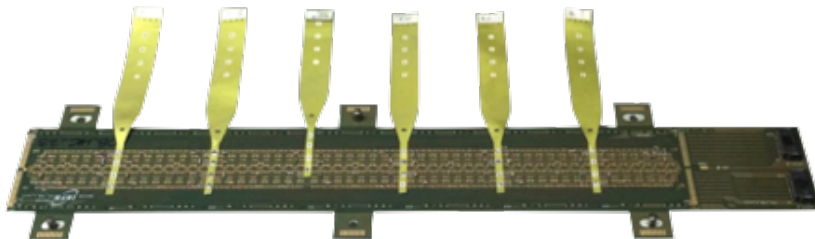


Figure 3.18: Flexible Printed Circuit mock-up. It includes the cross cables for power supply.

879 3.2.5 Pixel Chip to FPC connection

880 The electrical interconnection between the chips and the FPC is based on the standard wire
 881 bonding through the FPC vias (Fig. 3.26) [10](Ref. from Chapter 2). In order to account

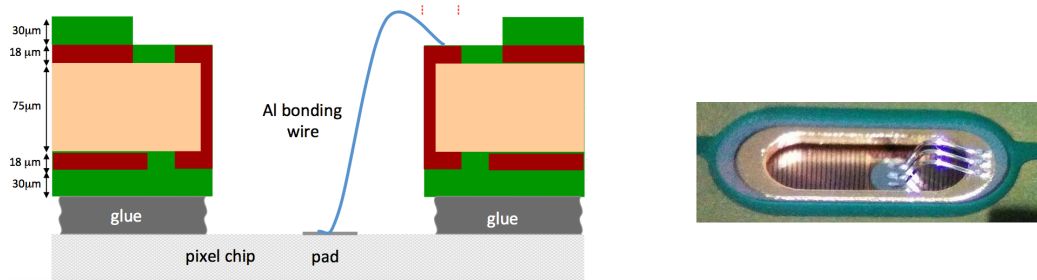


Figure 3.19: Cross section (left) and picture (right) of a FPC via with three bonding wires connected to the underlying chip pad.

882 for the clearance necessary for the wedge-bonding tool, the FPC vias have oblong shape
 883 (1.2 mm × 0.4 mm); in addition, 300 µm interconnection pads are implemented on the top
 884 top surface. Finally the wire bonding is performed using 25 µm aluminum wire (three wires per
 885 connection); a typical force of 11 g with a σ of 0.8 g is measured per wire.

886 3.2.6 Assembly procedures

887 3.2.6.1 Outer barrel HIC assembly

888 The outer barrel Hybrid Integrated Circuit (HIC) consists of an assembly of 14 Pixel Chips
 889 arranged in two rows interconnected to an FPC. A custom made automatic Module Assembly
 890 Machine (MAM¹) implementing dimension measurement, integrity inspection and alignment
 891 for assembly is used to achieve a reproducible accuracy and the required production speed in
 892 the various HIC assembly sites (Fig. 3.20). Using a screen-printing technique, very precise
 893 spots of Araldite 2011 (0.6 mm diameter) are applied on the FPC clamped on a gripper jig.



Figure 3.20: Module Assembly Machine at the STS department of LHEP at JINR.

¹ IBS Precision Engineering, <http://www.ibspe.com>

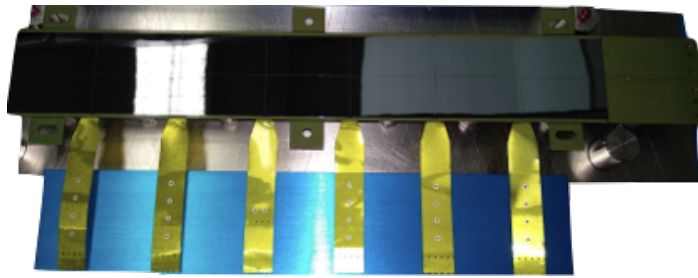


Figure 3.21: Outer Barrel Hybrid Integrated Circuit mock-up. The image shows the 14 chips already glued to the FPC after the alignment.

894 The stencil is manufactured by laser drilling the holes pattern in an adhesive film (90 μm
 895 thick). After chips have been aligned by the MAM onto the assembly table (AT) vacuum
 896 chuck with a position accuracy below 5 μm and a spacing of 150 μm , the FPC is overlapped
 897 precisely on top using a dedicated jig equipped with 3 mm ruby spheres which are engaged
 898 into alignment holes of the AT. Shims of 50 μm are used to compensate gap variations related
 899 to tolerances of tooling (planarity: $\pm 10 \mu\text{m}$) and components (FPC thickness: $\pm 10 \mu\text{m}$; chip
 900 thickness: 5 μm). The procedure has been validated by mechanical tests where on average
 901 a pull strength of 4.5 kg/chip and a peel strength of 300 g have been measured. Figure 3.21
 902 shows a mock-up of an already finished HIC module.

903

904 The HIC assembly steps may be summarized as follows:

- 905 1. The QR code of a selected chip tray (holding up to 23 chips) is scanned and after
 906 automatically reading the test data previously recorded on the database, each chip
 907 is categorized on-the-fly as “SILVER” or “BRONZE” according to cuts applied to 47
 908 parameters (Dead pixels, Fake Hit Rate, etc). This create a "chip map" that is
 909 automatically uploaded to the MAM.
- 910 2. The tray is physically loaded into the MAM and the alignment of 14 chips starts.
- 911 3. The Araldite glue is mixed on a dedicated mixer and spread on the FPC with the help
 912 of a gluing mask.
- 913 4. The FPC is placed (glued) on top of the already aligned chips with the help of dedicated
 914 jigs with a vacuum-holding system and ruby spheres-based alignment system.
- 915 5. After the glue has polymerized, the FPC and the chips are wire-bonded. Afterwards,
 916 the new HIC may be electrically tested.

917 The whole assembly process is tracked and document to the dedicated database by means
 918 of a customized HIC assembly interface.

919 3.2.6.1.1 HIC Test and characterization

920

921 During the whole assembly procedure, a detailed test protocol will be set in place to verify
 922 the electrical functionality and the mechanical integrity of each individual detector element
 923 before it is handed over to the following step.

924 In addition to the electrical and functional tests which ensure that the chips are operating
 925 correctly and are well connected to the FPC a visual and metrological inspection will be

926 carried out. The visual inspection ensures that no mechanical damage has been inflicted
927 during the assembly.

928 The testing of the assembled HICs is performed by means of an automated test system.
929 Readout and control is performed through a dedicated readout card which connects to the
930 HIC through a connector located on a tab of the flex printed circuit. The test system is
931 capable of powering the HICs by means of a power board which connects through spring-
932 loaded adaptors to the cross-cables of the HIC. The power board allows controlling all voltages
933 and reading back currents and voltages through the test software. The test program is divided
934 into a set of individual scans which are executed sequentially. The final classification of the
935 HIC is determined from:

- 936 • The number of working chips: chips that fail an initial basic communication test are
937 excluded from the test program.
- 938 • The result of the worst scan: scans are classified in *gold*, *silver*, *bronze* or *Not working*.
939 The classification of a HIC is determined by the worst scan result, e.g. to be classified
940 as *silver* a HIC has to pass all scans either *silver* or *gold*. Note that scans with back
941 bias are not considered for this criterion but for the next (see below).

942 The total classification of the HIC is determined according to table 3.5.

Table 3.5: HIC classification scheme. Any HIC resulting in a ‘CAT B’ classification is considered as not detector-grade

Worst Scan Result	Working Chips	Back Bias Working	HIC Classification
Gold	14	Yes	Gold
Silver	14	Yes	Silver
Bronze	14	Yes	Bronze
Gold, Silver or Bronze	13	Yes	Partially working
Gold, Silver or Bronze	<13	Yes	Partially working CAT B

943 Specifically, the HIC tests to be performed are:

- 944 • **Impedance Test:** aimed to identify any shorts that may occur between the voltage
945 supplies of the HIC (DVDD, AVDD & BIAS). Testing time around 1 minute and is
946 performed on each HIC individually.
- 947 • **Qualification Test:** it performs a series of scans and applies cuts to different
948 parameters for each scan in order to classify the HIC into one of the defined categories.
949 Testing time is around 1 hour and is performed on 1 HIC at a time.
- 950 • **Endurance Test:** it performs a series of power cycle scans on the HIC in order to
951 stress the electronics and classify the HIC accordingly. Testing time ca. 3 days. The
952 testing hardware may hold up to 10 HICs in parallel.

953 All the tests are performed using custom-developed software (scripts and GUIs)
954 that automatically read and write the data to the dedicated Construction Management
955 Information System (CMIS).

956 Figures 3.22 to 3.24 show the custom hardware for each test, courtesy of the ALICE-ITS
957 collaboration. For this purpose the HIC carrier plates and the test equipment have been
958 designed in such a way that the HICs are tested while inside their own carrier plates. These
959 same equipment (hardware and software) will be also acquired for the MPD-ITS project.

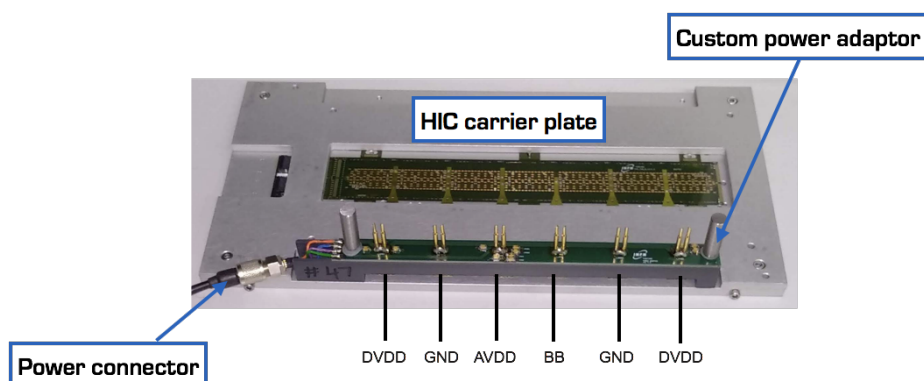


Figure 3.22: Impedance test setup.

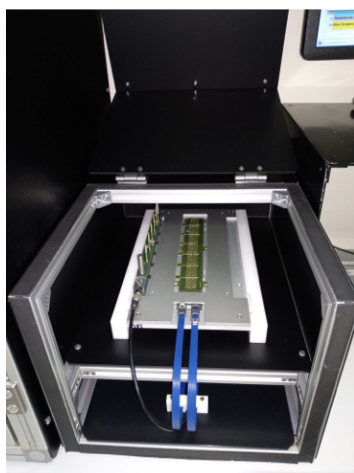


Figure 3.23: Qualification test box holding one HIC inside its carrier plate.



Figure 3.24: Endurance test box holding 10 HICs inside their carrier plates.

960 3.2.6.2 Outer Barrel Stave assembly

961 The assembly of the Outer Barrel Staves will be done following the technological and know-
 962 how transfer from ALICE-ITS2, including the optimized assembly procedures described in
 963 detailed in the *Outer Layer Stave assembly operational manual* compiled by the ALICE-ITS
 964 collaboration.

965 The assembly is performed by means of Coordinate Measuring Machines (CMM) from

966 Mitutoyo (Fig. 3.25) equipped with custom developed tools and jigs. This allows for the
 967 surveying of the assembly steps, with a HIC positioning precision within $10\ \mu\text{m}$ – $20\ \mu\text{m}$. One
 968 of such machines has already been bought and delivered to JINR’s LHEP. The rest of the
 969 customized jigs and tools will be also acquired for the production of the Staves.

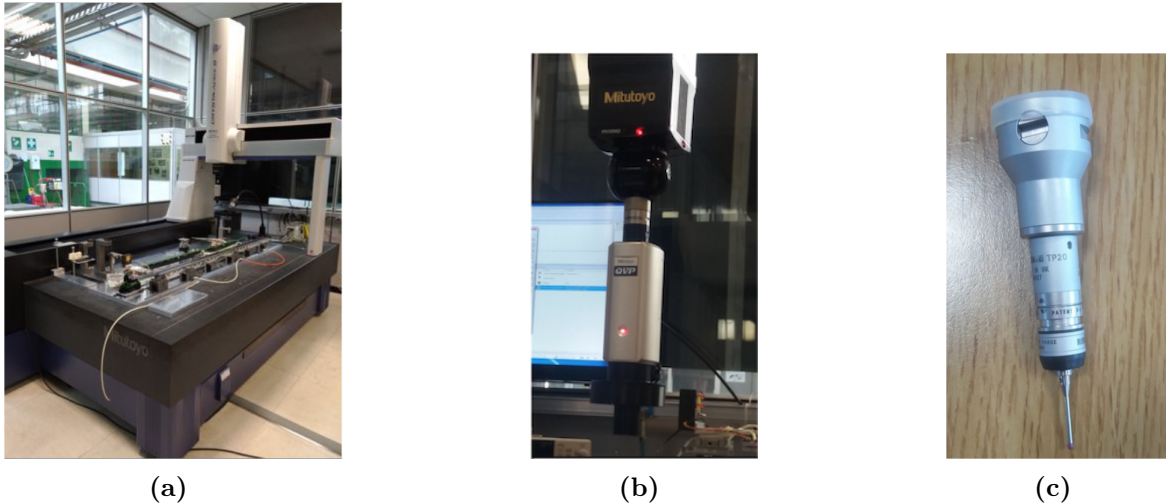


Figure 3.25: Coordinate Measuring Machine general view (a), Camera probe (b) and Touch probe (c).

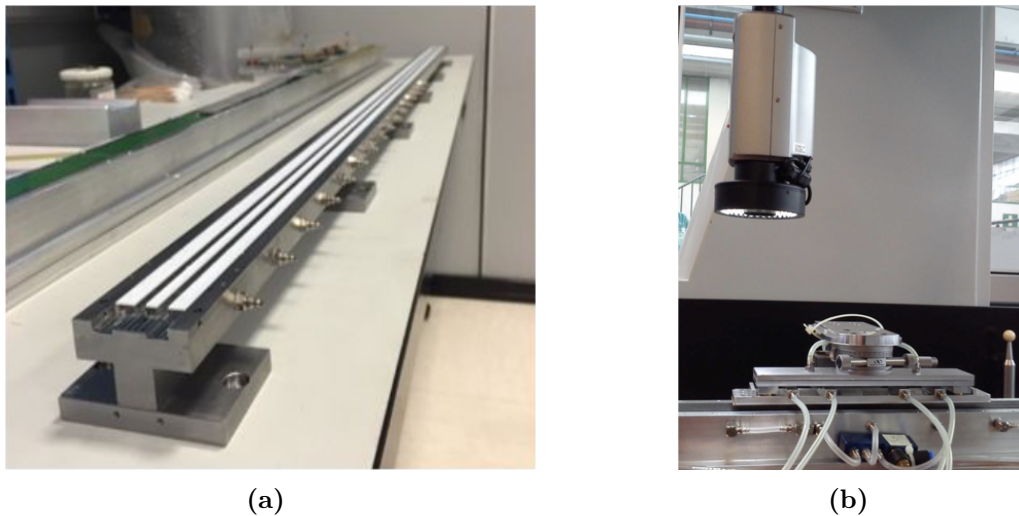


Figure 3.26: Half-Stave base (a) and Module-alignment station (b).

970 During the Stave production each Half-Stave (HS) will be assembled and tested separately
 971 and afterwards they will be sequentially attached to the Space Frame (SF). Each Half-
 972 Stave will be composed by seven HIC modules, which are first aligned on a dedicated jig
 973 (Fig. 3.26a), using a customized Module-alignment station (Fig. 3.26b). This jig contains a
 974 reference system at the two edges which is based on ruby spheres placed above the plane of
 975 the connectors at the ends of the Stave. All elements of the assembly tooling, as for instance
 976 the Module support base and the rails for the alignment, are built and mounted referring to
 977 this reference system. The same reference system is used to align and position every element
 978 of the Half-Stave, and afterwards the Stave itself.

979 The steps to be followed during the assembly procedure of the Outer Layers Staves may
 980 be summarized as follows:

- 981 1. Definition of a reference system for a correct positioning of the Modules on the Cold
982 Plate (CP) and aligning of the HS under the SF.
- 983 2. Verification of the CP planarity.
- 984 3. Electrical tests of the Modules before the alignment/gluing procedure to ensure their
985 correct functioning.
- 986 4. Glue deposition for gluing the Modules to the CP.
- 987 5. Alignment of the Modules with respect to the CP before permanently gluing them to
988 it.
- 989 6. Electrical tests of the Modules after the alignment/gluing procedure to ensure their
990 correct functioning.
- 991 7. Soldering of the Power Bus and the Back-Bias bus using the cross-cables already
992 soldered on the FPCs. This procedure has to be done on a different working table
993 with dedicated mechanical supports.
- 994 8. Testing of the correct functioning of the HS to ensure the correct functioning of the
995 entire system.
- 996 9. Alignment of the HS under the SF.
- 997 10. Gluing of the HS on the SF.

998 Figures 3.27 to 3.31 show the Stave assembly at different stages, courtesy of the ALICE-
999 ITS collaboration.

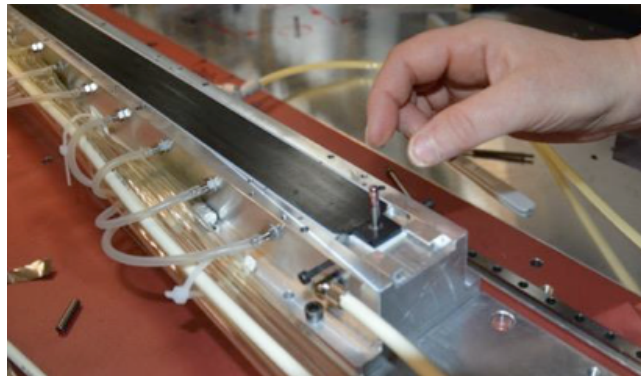


Figure 3.27: Cold Plate positioning.

1000 3.2.6.2.1 Stave Test and characterization

1001

1002 Similar to the one for the HICs, a well defined protocol for the Staves test and
1003 characterization will be followed in order to ensure the quality of detector-grade Staves which
1004 also allows to sort them on the Layers according to their performance. Ultimately, this
1005 protocol aims to minimize as much as possible the necessity of a future intervention for the
1006 replacement of a Layer component, which is both a delicate and time consuming tasks that
1007 involve other components of the MPD.

1008 Different from the HIC testing where most of the tests are performed at the end of the
1009 assembly, the Stave testing process will be performed after specific assembly steps of each
1010 Half-Stave before moving to the next step. It will consist of electrical tests to ensure the
1011 correct functioning of either the Stave's individual components or the entire Stave as a whole;

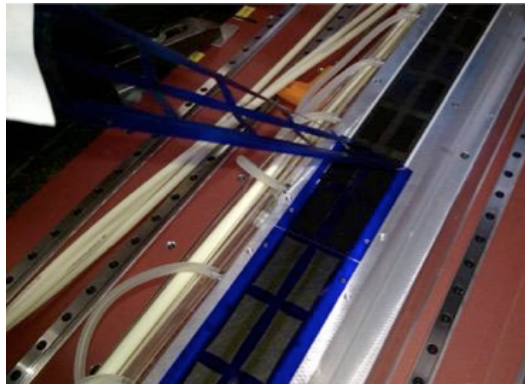


Figure 3.28: Cold Plate glue deposition.

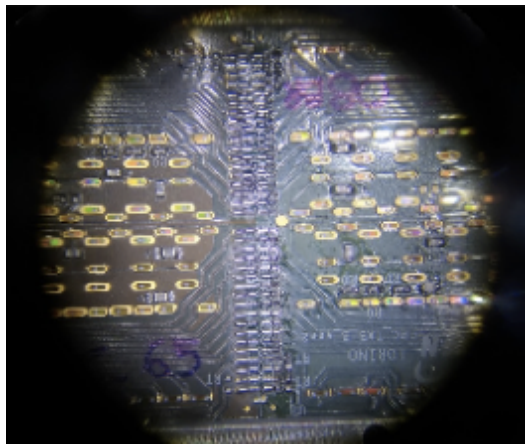


Figure 3.29: HIC to HIC alignment.



Figure 3.30: Space Frame gluing to the Cold Plate.

1012 but also on metrology measurements to guarantee that the geometrical dimensions and the
1013 flatness of the HIC and of the Staves are in agreement with the requirements for mounting
1014 on the Space Frame.

1015 The test protocol will include:

- 1016 • **HIC reception test:** To confirm a HIC is detector-grade just before start its assembly
1017 on a Half-Stave.

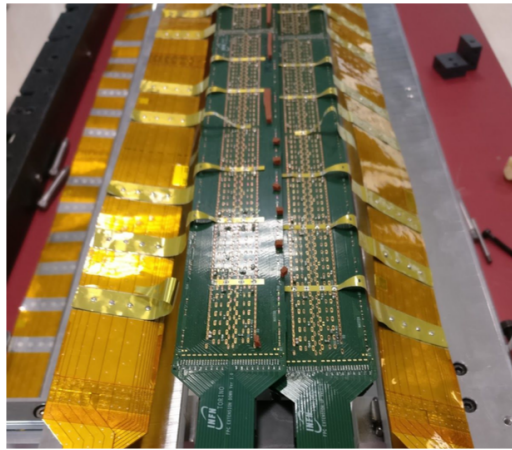


Figure 3.31: Full Stave with the two Half-Staves and the Power Buses.

- 1018 • **OB-HIC (fast) power test:** Fast power test after tab cut.
- 1019 • **HS test:** For the classification/characterization of the Half-Stave.
- 1020 • **Stave assembly – Final metrology:** Stave metrology with CMM.
- 1021 • **HS test with PB not folded:** For testing each Half-Stave just before folding the PB,
- 1022 which geometrically closes the Stave.
- 1023 • **HS test with PB folded:** For testing the correct functioning of each HS once the
- 1024 Power Buses have been folded.
- 1025 • **Stave reception:** For testing incoming Staves before assembly them on a Layer.

1026 3.2.7 The necessity for CMIS

1027 The ITS may be arguably considered the most ambitious and technologically complex of all
 1028 sub-detectors composing the MPD. The construction of its 2-layers Outer Barrel will benefit
 1029 from a novel technology developed by the ALICE experiment at CERN for the upgrade of
 1030 its own Inner Tracking System (ITS2) based on concentric cylindrical layers of 100 μm -thick
 1031 Monolithic Active Pixel Sensors produced with the 180 nm technology from TowerJazz. It
 1032 will consists of 42 Staves holding 588 HICs for a total of 8232 MAPS chips (~ 4.3 GigaPixels)
 1033 aligned with a precision $< 5 \mu\text{m}$, plus spares.

1034 The detector will be built as a joint effort of various institutions from Russia and China
 1035 with the production split among JINR and at least 3 other production sites in China. This
 1036 includes the shipping of detector components between the production sites, from individual
 1037 chips to fully functional Staves and the precise testing and characterization of each part at
 1038 different assembly stages, aiming for a detector-grade yield of 75 % for the Stave production
 1039 and 85 % for the HIC production.

1040 It is then mandatory to have in place a system that will allow for a fine-grained control
 1041 and continuous feedback of the whole detector production process. For this purpose a
 1042 Construction Management Information System (CMIS) will be setup which is an adaptation
 1043 of the same system used for the production of the ALICE-ITS2.

1044 CMIS is an Oracle-based all-around project management database system, that allows the
 1045 organization and follow-up of every aspect of the project. This includes (but is not limited to)
 1046 the human resources, the project organization and planning, as well as the current status and

1047 test results history of every component of the detector allowing for the direct interfacing of
 1048 the assembly and testing hardware/software to the construction database, so that information
 1049 ranging from the current location of a component in-transit to/from an assembly site down
 1050 to the final position of a single chip inside the detector along with the threshold and noise
 1051 values of each of its 512×1024 pixels will be available on the database.

1052 The system is produced and maintained by KYBERNETIKA s.r.o from Košice, Slovak
 1053 Republic and it is composed by a web-based user interface so that clients may access the
 1054 application server by means of standard web browsers (Fig. 3.32). It also includes an API
 1055 functions collection used for the automatic interfacing of the database with the production
 1056 and testing hardware. This system, which is actually a highly-modular framework that may
 1057 accommodate several projects in parallel, will be hosted at JINR's LIT and it might be
 1058 accessed either from inside JINR or from anywhere around the world as it is schematically
 represented in Figure 3.33 for the context of the MPD-ITS project.

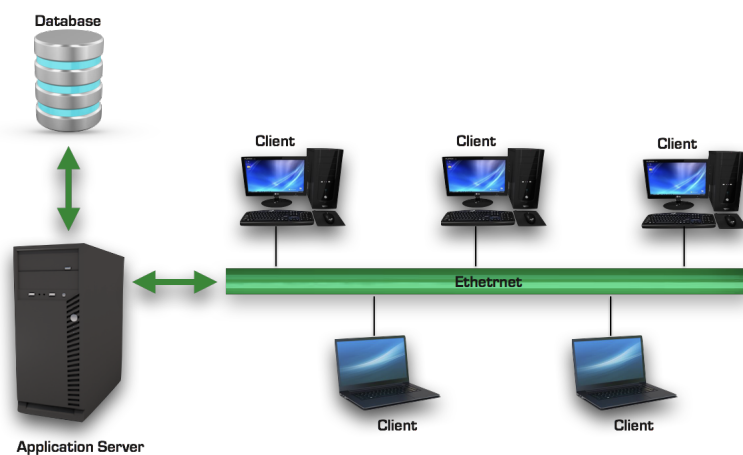


Figure 3.32: Web-based access to CMIS.

1059

1060 3.3 The MPD-ITS finalization after NICA LS1 (Stage-2: the 1061 Inner Barrel)

1062 At the Stage-2 the innermost layers of the ITS for the MPD installation at NICA will be
 1063 constructed using the most advanced developments that are being performed nowadays by
 1064 ALICE Collaboration for the future ITS-3 [1], [2]. The Letter of Intent for an ALICE ITS
 1065 Upgrade in LS3 (LoI) is available [7]. The aim is to build a nearly massless Inner Barrel
 1066 detector consisting of truly cylindrical layers based on curved wafer-scale ultra-thin silicon
 1067 sensors with MAPS technology. The new developments for the ITS3 for ALICE are based, in
 1068 particular, on the 65 nm TowerJazz technology for very thin $\sim 20 \mu\text{m}$ bent large area sensors.
 1069 The pixel size of the order of $\sim 10 \mu\text{m}$ will be used. The dramatically reduced material
 1070 budget, the optimized geometry of close proximity to the interaction point and high intrinsic
 1071 resolution will provide for ALICE at the LHC a significant advancement in the measurement
 1072 of short-lived particles and low-mass di-electrons which are amongst the main physics goals
 1073 of ALICE [3].

1074 The conceptual design is shown in Figure 3.34 [7].

1075 An intensive R&D is needed on the Stitching manufacturing of large area 65 nm-Chip

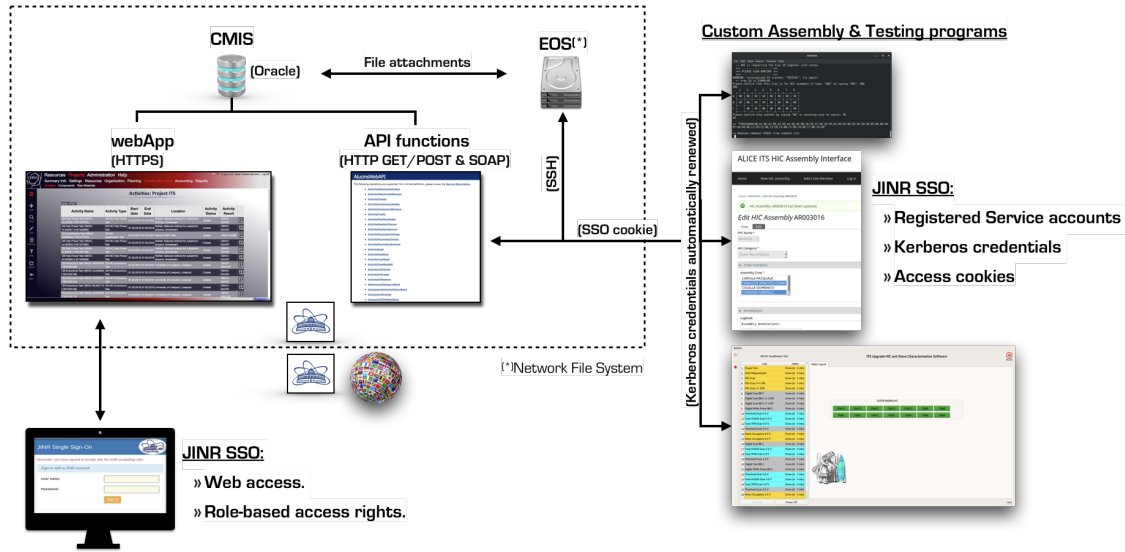


Figure 3.33: CMIS general composition and differentiated users/software access schema in the context of MPD-ITS project.

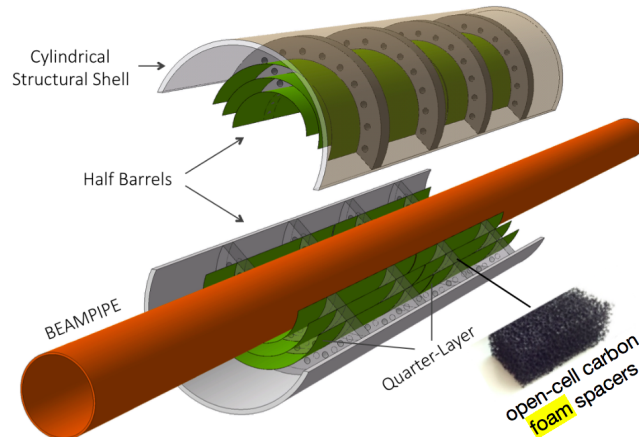


Figure 3.34: Layout of ALICE ITS3 based on thin large area bent sensors.

1076 and on the new MPD beam pipe with a small wall thickness ($\sim 500 \mu\text{m}$) and small diameter
 1077 (below 40 mm). This will allow to place the innermost MAPS layer as close as ~ 20 mm away
 1078 from the nominal beam position, while also reducing the material budget associated with
 1079 the beam pipe itself. The MPD-ITS may also benefit from the dedicated R&D currently
 1080 carried out by the ALICE collaboration on the new and extremely lightweight carbon fiber
 1081 support structures for the thin ($\sim 20 \mu\text{m}$) large area bent sensors (up to 280 mm length) [3].
 1082 The development of novel efficient gaseous cooling system of thin large area sensors is also
 1083 required in order to drain the heat from these novel sensors of $20 \text{ mW}/\text{cm}^2$ ($140 \text{ mW}/\text{cm}^2$
 1084 from the sensor's digital periphery).

1085 The expected pointing resolution of the new ALICE ITS3 based on these new sensors is
 1086 shown in Figure 3.35, [7].

1087 A similar performance may be expected for the MPD with a small (40 mm) beam-pipe
 1088 diameter, considering that its ultra lightweight Inner Barrel Vertex Detector will also consist
 1089 of thin ($\sim 20 \mu\text{m}$) bent large area sensors, arranged in perfectly cylindrical layers, featuring
 1090 an unprecedented low material budget of $X/X_0 \sim 0.05\%$ per layer. Although in the case of

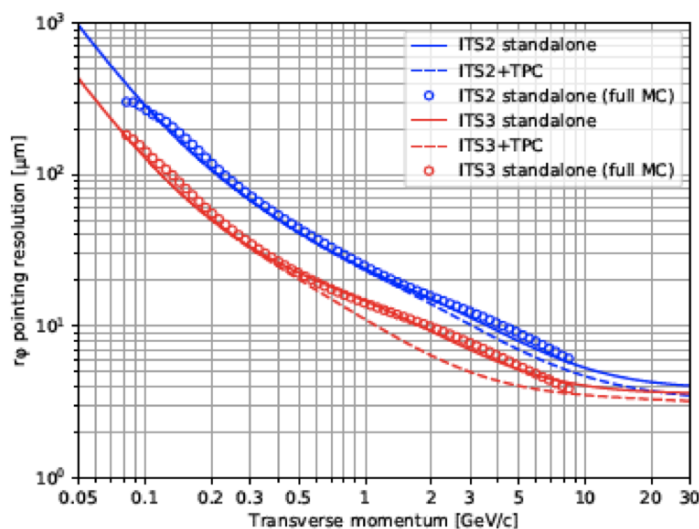


Figure 3.35: Projected pointing resolution of the ITS3 with the bent thin large area sensors (see text). The Figure is from [7].

1091 the Inner Barrel of the MPD, the final choice of the radii for the IB Layers will be done after
 1092 the final value of the beam-pipe diameter would be decided.

1093 In the context of the MPD-ITS, design and development of the extra-lightweight, state-
 1094 of-the-art support structures capable to ensure the high level of thermo- and mechanical-
 1095 stability of these large arrays of ultra-thin silicon sensors are among the challenges to be
 1096 met. In particular, the length of the MPD Inner Barrel (750 mm) is supposed to be more
 1097 than twice larger than the one for ALICE-ITS3 (280 mm) (Fig. 3.34). Therefore, a new
 1098 conceptual design for the MPD Inner Barrel layout is considered. The new IB extra-
 1099 lightweight support structures (ultra-light-weight CF space frames) will be developed with
 1100 the account of mechanical properties of the novel arrays of bent ultra-thin silicon sensors.
 1101 Another challenge is the efficient, very low speed, gas cooling system that will provide the
 1102 required functionality in terms of lack of vibrations of these thin large area sensors.

1103 The implementation of the advanced thin 65 nm CMOS detectors and of the updated
 1104 carbon fibre composite technologies to the MPD-ITS Inner Barrel will expand considerably
 1105 the heavy-flavour research physics programs of the MPD experiment at NICA, JINR, as it is
 1106 presented in Chapter 7.

1107 3.3.1 Possible variants for mechanics based on ALICE ITS3 modules 1108 developed at CERN

1109 The ALICE ITS project has recently begun the commissioning of its upgraded version (ITS2)
 1110 which includes a new IB consisting of three layers of 30 mm × 15 mm large and 50 μm-thick
 1111 silicon MAPS chips. However, a project for a further modernization of this Inner Barrel has
 1112 already started under the name of ITS3 with the goal of replacing the current IB with a more
 1113 performant one by 2024 – 2025. In doing so it is planned to:

- 1114 • install a new ALICE beam pipe of a smaller internal radius $R_{min} = 16$ mm and beryllium
 1115 wall thickness of $\Delta R = 0.5$ mm;
- 1116 • create an Inner Barrel consisting of three cylindrical sensor layers based on ultra-long

- 1117 (280 mm) and ultra-thin (20 μm) self-bent MAPS sensors made by the stitching method
 1118 [8];
- 1119 • ensure a high transparency of the detector with a material budget of $X/X_0 \approx 0.05\%$
 1120 by taking the readout and data-aggregation electronics out to the module's tip located
 1121 outside of the particle registration zone;
 - 1122 • reduce the energy consumption of the sensors to a maximum of 20 mW/cm² which will
 1123 allow to drop the use of water cooling by transferring the cooling system completely to
 1124 gas;
 - 1125 • ensure full mechanical compatibility of the Inner Barrel constructions ITS2 and ITS3
 1126 which guarantees the necessary installation accuracy.

1127 The listed features of the new detector are primarily oriented to place the sensors as close
 1128 as possible to the interaction point and to reduce the amount of material in the path of
 1129 secondary particles and their decay products. This will significantly increase the detection
 1130 efficiency of rare reaction products while allowing to extend the measurements to the region
 1131 of small transverse momentum of the particles.

1132 In the context of the MPD-ITS project, this same basic concept for the construction of
 1133 its own Inner Barrel may be applied, although the length of the barrel should be doubled
 1134 with minimum deterioration of the above listed properties for the new detector. A possible
 1135 structural solution to this problem is conceptually described in the following.

1136 It should be noticed that in parallel to the ALICE-ITS3 project there is an ongoing
 1137 R&D inside the MPD-ITS project for the development and production in China of large-area
 1138 MAPS. This R&D of MAPS for Inner Barrel is based on a 55 nm stitching CIS technology. It
 1139 is a large-area, low-material, low-power, high-speed pixel sensor chip that occupies the entire
 1140 wafer. It integrates charged particle detection, analog signal processing, A/D conversion and
 1141 digital signal processing on a single-chip. The first MPW had been submitted on June 25,
 1142 2021. The wafers will be delivered in June 2022. The die size is 6 mm x 5 mm, including 10
 1143 chips: readout architecture verification chip, diode and pixel test chip, PLL, Serilizer, DAC,
 1144 LDO, ADC, etc. Due to the delayed delivery of the first MPW, an alternative MPW based
 1145 on a 180 nm process will be submitted in March 2022 to accelerate the design.

1146 3.3.2 Mechanics and cooling system of the Inner Barrel

1147 The mechanical design of the MPD-ITS IB may consist of an external power case of complex
 1148 shape with an ultra light central part (Fig. 3.36). The right and left conical parts differ only
 1149 in the shells due to the conditions for the fixation of the power case to the fourth layer of the
 1150 MPD-ITS (Outer Barrel). Cables, electronics boards and gas cooling distribution system are
 1151 located in the conical elements. The main characteristics of the design are:

- 1152 • the length of the structure at the edges of the base sleeves is 1626 mm;
- 1153 • the length of the central thin part is 600 mm;
- 1154 • the diameter of the conical part is 267 mm;
- 1155 • the diameter of the central thin part is 77 mm;
- 1156 • the total assembly weight is 2 kg.

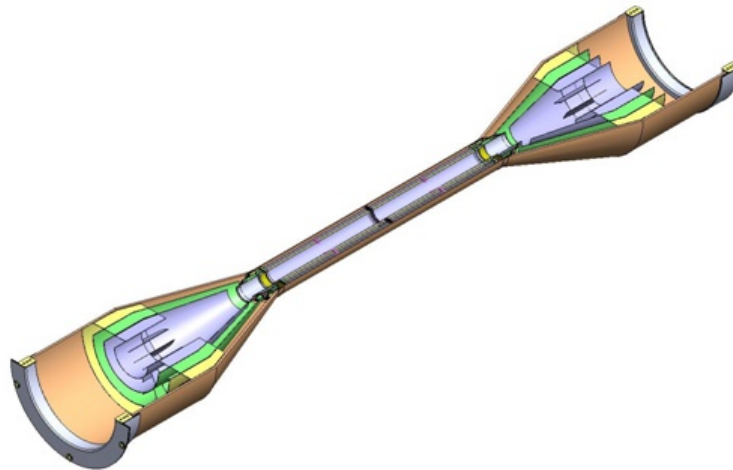


Figure 3.36: General view of the proposed IB.

1157

1158

1159 The central ultra-light part is a semi-cylindrical sandwich made out of a carbon composite
 1160 where the outer and inner shells are carbon fiber with a thickness of $100\ \mu\text{m}$ and the inner
 1161 part is AIREX foam with a density of $70\ \text{kg}/\text{m}^3$, along the edges of which precision elements
 1162 of the detectors layers support assemblies are glued.

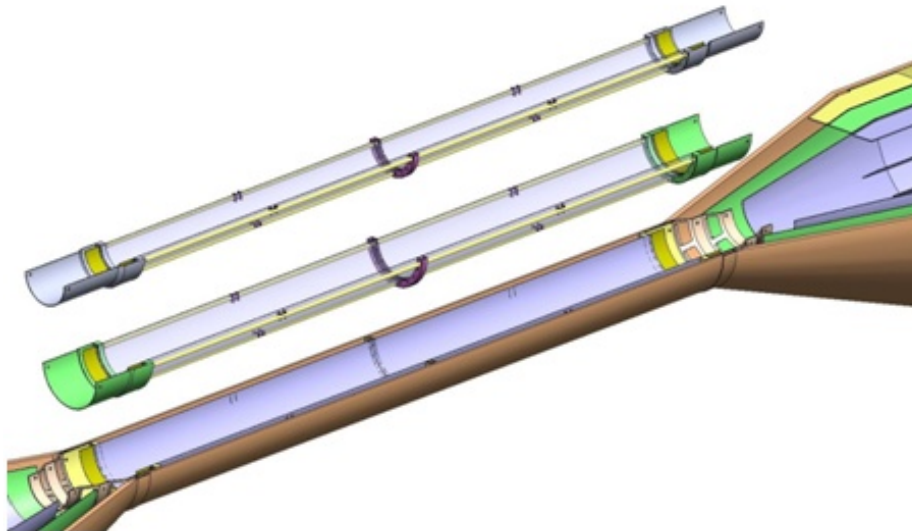


Figure 3.37: Break down of the IB layers to illustrate the IB assembly sequence

1163

1164

1165

1166

In order to optimize the structural elements it will be necessary to carry out R&D related
 to the rigidity calculations and the determination of the materials to be used for the tracker
 manufacturing. It is necessary to develop an assembly scenario and auxiliary devices for it
 which will provide assembly operations and control of the individual sensor layers.

1167 The complexity of developing the design of the detector assembly is to kept the sensor bent
 1168 along the radius in the same position and its precise fixation. An additional complication is
 1169 that the detection layer consists of two sensors placed oppositely along the axis of the beam
 1170 pipe. The linear size of the sensor is determined by the possibility of modern technology
 1171 for the manufacture of Si wafers with a diameter of more than 300 mm. This allows for the
 1172 production of sensors with a length of 280 mm. A solution to the problem of building the
 1173 Inner Barrel is the use of an ultra-light chassis made out of carbon composite materials for
 1174 each half-layer of the barrel.

1175 One possible design of such a chassis is shown in Figure 3.38. It consists of two supporting
 1176 half-cylinders (left and right) connected by carbon pipes made by weaving a high-modulus
 1177 carbon thread. The resulting chassis has three radial bearing surfaces: two at the edges and
 1178 one in the center. In addition a local supporting element may be put on each tube between
 1179 the extreme and central supports for holding the bent sensor in the correct position.

1180 It is assumed that the minimum wall thickness of the pipes will be between 0.1 mm and
 1181 0.15 mm. The mass of such a pipe 546 mm long with a diameter of 3 mm will be 1.6 g.



Figure 3.38: Possible design of the Inner Barrel chassis

1182 An alternative to this elements could be the use of three-sided space frames manufactured
 1183 using the well-known technology implemented for building the IB Staves of the ALICE ITS2
 1184 project. The design of such a miniature frame is shown in Figure 3.39. If a length of 270 mm
 1185 is considered, the weight of the frame is only 1 g. For the entire construction it is necessary
 1186 to use 2 frames which means an estimated 2 g mass of the supporting frames.

1187 3.3.3 Cooling system features of the MPD-ITS Inner Barrel

1188 With the planned heat dissipation of the detectors of the order of 20 mW/cm^2 as well as the
 1189 placement of the electronics for data readout at the outer edges of the sensors, it is possible
 1190 to use only an air-based cooling system and completely renounce of using water for cooling
 1191 the sensors in the particle registration zone. The MPD-ITS project already foresees a cross-
 1192 cutting gas blowing through the laminar flow of the 4th and 5th layers of the tracker so the
 1193 gas supply for the Inner Barrel will not be very difficult. For this purpose, additional holes
 1194 can be provided on each of the longitudinal supports of the carbon pipes (see Figure 3.40).

1195 It should be noted that additional R&D is required in order to optimize the design

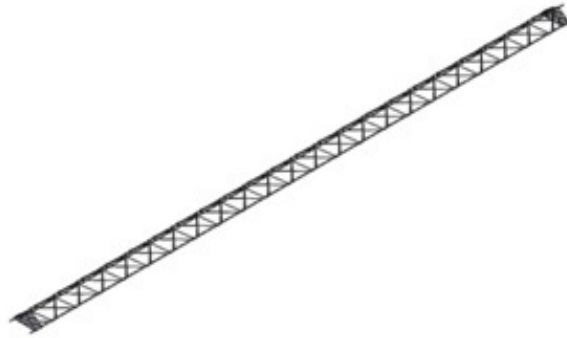


Figure 3.39: Three-sided Space Frame

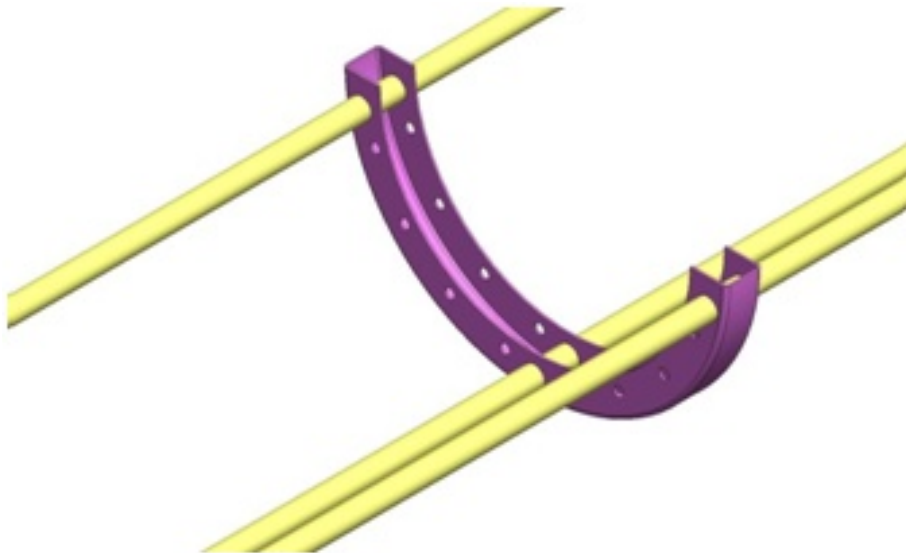


Figure 3.40: Miniature tube carriers adapter with holes for the cooling gas

1196 parameters, especially for its central part. Furthermore, it is assumed that in case of using
1197 space frames as connecting structures, only two of them will be used instead of three tubes
1198 which will reduce the mass of the substance in the core.

1199 The proposed configuration is feasible for manufacturing and allows to obtain a detachable
1200 design suitable for repair and replacement of detector assemblies of any layer. In addition,
1201 it could be considered to replace the material of the supporting elements with carbon foam
1202 which will further reduce the mass of the material used in the vicinity of the interaction
1203 diamond. On other hand, this will require additional research regarding the processing and
1204 operation of finished parts from carbon foam due to the possibility of constant formation of
1205 carbon dust.

1206 3.3.4 Back-up scenario for Stage-2 of the ITS construction

1207 The MPD-ITS project decided to seize the opportunity of benefit from the future ALICE-
 1208 ITS IB Staves (ITS3) currently under development, due to its potentialities of enhancing the
 1209 physics program foreseen with development of NICA by 2025. Anyhow, a back-up solution
 1210 for the Stage-2 is planned to be provided by the MPD Inner Barrel based on the well proven
 1211 180 nm MAPS technology developed by the ALICE collaboration.

1212 In this case the design of the mechanics of the tracker was carried out for two diameter
 1213 variants of the MPD beam pipe; diameters named *project* (40 mm) and *initial* (64 mm). This
 1214 accounts for the plans of launching the NICA collider with an “initial” beam pipe diameter
 1215 of 64 mm which after the adjustment of the machine will be replaced with a “project” beam
 1216 pipe of a smaller diameter. It is important to note that with all the provided replacements
 1217 for the beam pipe the mechanical structure of the tracker itself remains universal, and the
 1218 structure and parameters of the Outer Barrel are unchanged.

1219 The spatial position of the Staves in the layer is determined by the requirement of full
 1220 coverage of the cylindrical surface. Therefore, taking into account the fact that on the part
 1221 of the detector plate there is a so-called “dead zone” in which reading and buffering circuits
 1222 from a position-sensitive matrix are located, the design assumes a certain amount of detectors
 1223 overlapping in the layer. Specifically for this type of pixel detector the overlapping is 4.3 mm.
 1224 Figure 3.41 shows the ITS cross section for the Inner and Outer layers. The first three layers
 1225 of detector Staves IB, intended to ensure overlapping of the dead zones, are installed in a
 1226 staggered order in height for the *initial* and in the fan-shaped for the *project* version of ITS.
 1227 The Outer Barrel detectors (OB) have two detector panels installed at different heights.

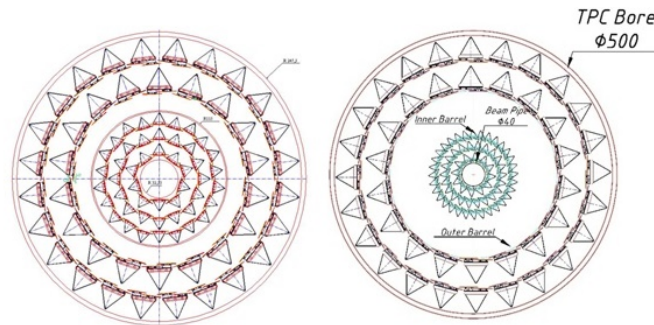


Figure 3.41: Schematic view of the ITS cross section in the *initial* version for beam pipe diameter of 64 mm (left) and in the *project* version for beam pipe with a diameter of 40 mm (right).

1228 Figure 3.42 shows schematic view of the tracker profile in the *project* version. The
 1229 geometric parameters of the position of detectors are given for the first 3 layers of both
 1230 versions of the tracker in Table 3.6 (*initial*) and Table 3.7(*project*). In both tables are
 1231 reported the radius from the center of the beampipe to the middle of the sensor (R_{min}), and
 1232 to the edge of the sensor (R_{max}). In the case of the *initial* version it can be see from Figure
 1233 3.42 (left) that on each Inner Barrel layer half of the sensors are place at a lower level and
 1234 the other half at a higher level, alternatively. That is why in Table 3.6 for each layer two
 1235 pairs of R_{min} and R_{max} values are provided, with the layers themselves named as i-1 and i-2
 1236 ($1 \leq i \leq 3$) corresponding to the sensors at level 1 or 2 respectively. On all staves ALTAI
 1237 sensors with an overall size of $15 \times 30 \text{ mm}^2$ are used. The dead zone of the detectors with a
 1238 width of 2 mm is located on the larger side of the sensor (30 mm) directed along the axis of
 1239 the beam.

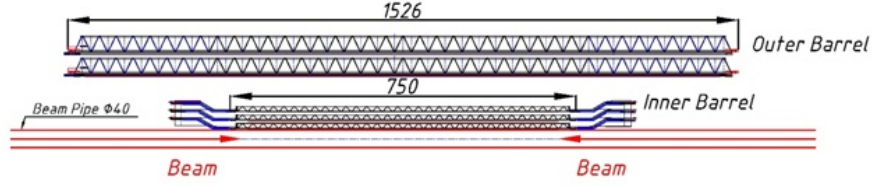


Figure 3.42: Schematic view of the tracker profile in the *project* version

Table 3.6: Geometrical parameters of the Inner Layers for the tracker *initial* variant.

Layer number	Number of Staves (pcs)	R_{min} (mm)	R_{max} (mm)	Length (mm)
1-1	5	35.45	38.50	902.9
1-2	5	40.45	43.16	902.9
2-1	8	62.50	64.28	902.0
2-2	8	66.45	68.13	902.9
3-1	11	88.40	89.72	902.9
3-2	11	92.33	93.55	902.9

Table 3.7: Geometrical parameters of all Layers for the tracker *project* variant.

Layer number	Number of Staves (pcs)	R_{min} (mm)	R_{max} (mm)	Length (mm)	Effective thickness (μm)	η
1	12	22.4	26.7	750	50	± 3.3
2	22	40.7	45.9	750	50	± 2.8
3	32	59.8	65.1	750	50	± 2.45
4 ^(*)	18	144.5	147.9	1526	700	± 2.3
5	24	194.4	197.6	1526	700	± 2.0

^(*) In the case of the Outer Barrel (layers 4&5) each Stave is composed by two Half Staves eachone with the same amount of sensors.

1240 Bibliography

- 1241 [1] D. Adamová et al., A next-generation LHC heavy-ion experiment,
1242 arXiv:1902.01211v2[physics.ins-det], 2 May 2019.
- 1243 [2] G. Feofilov, I. Altsybeev, E. Andronov, S. Belokurova, A. Erokhin, S. Igolkin, V.
1244 Kovalenko, T. Lazareva, N. Maltsev, K. Nametysheva, D. Nesterov, N. Prokofiev, D.
1245 Prokhorova, A. Merzlaya, A. Zarochentsev, A. Puchkov, V. Sandul, A. Rahmatullina, A.
1246 Seryakov, F. Valiev, V. Vechernin, V. Zhrebchevsky, Contribution from the Laboratory
1247 of Ultra-High Energy Physics of Saint-Petersburg State University (Russia) for the
1248 2020 update of the European Strategy for Particle Physics, "Heavy-flavour production
1249 in relativistic heavy-ion collisions and development of novel generation of extra-
1250 low-material-budget Vertex Detectors for future experiments at CERN and JINR",
1251 <https://indico.cern.ch/event/765096/contributions/3295619/>
- 1252 [3] M. Mager, on behalf of the ALICE collaboration, Upgrade of the ALICE ITS in LS3,
1253 PoS (Vertex2019) 040.
- 1254 [4] G. Trubnikov et al., Status of NICA Project at JINR. Proc. of International Particle
1255 Accelerator Conf. (IPAC 2014), Dresden, Germany, 2014, p. 1003-1005.
- 1256 [5] Technical Project of the NICA Complex. Dubna, 2015.
- 1257 [6] B. Abelev et. al and The ALICE Collaboration, Technical Design Report for the Upgrade
1258 of the ALICE Inner Tracking System, J. Phys. G: Nucl. Part. Phys. 41 (2014) 087002
- 1259 [7] ALICE Collaboration, Letter of Intent for an ALICE ITS Upgrade in LS3, 2019, CERN-
1260 LHCC-2019-018, LHCC-I-034
- 1261 [8] ALICE Collaboration, "ALICE ITS 3: the first truly cylindrical inner tracker",
1262 arXiv:2111.09689 [physics.ins-det]

1263 4 Support Structure and System 1264 Integration

1265 4.1 Services

1266 4.1.1 Cooling system for the MPD-ITS

1267 4.1.1.1 General description

1268 The main objectives of the cooling system are effective heat removal, as well as a high
1269 operating safety level. To reach these functionalities system should be carefully designed and
1270 suit these tasks. The fundamental feature of this system will be no leaks (leakless). Part
1271 of the system that will be inside the MPD solenoid should be operating below atmospheric
1272 pressure. Moreover, the system should be able to detect the leak and safely remove water
1273 from the damaged loop signaling the "power-off" command to the DCS. Cooling systems used
1274 in a similar experiment, as example ALICE experiment, have the same operating principles.
1275 The system that will be used in MPD experiments will inherit the design of the ALICE ITS
1276 cooling plants. However, it should be updated to suit standards nowadays. The main field
1277 of the upgrade will be electronic and control systems. In the next part of this chapter, there
1278 is a description of ALICE's cooling plants.

1279 4.1.1.2 ALICE cooling plant

1280 The ALICE cooling plant has been designed to provide the proper working condition for
1281 the ALICE-ITS detector, as well as for all associated systems. The cooling is realized by
1282 demineralized water in the temperature range of 18 °C to 23 °C. The temperature is controlled
1283 via a PLC (Programmable Logic Controller) PID (Proportional-Integral-Derivative) loop and
1284 3-way electric control valve installed on the primary cooling network side. The inverter, which
1285 controls the pump, ensures constant outlet pressure, despite the number of open loops. The
1286 system is responsible for cooling the following elements: the inner barrel, outer barrel mid-
1287 layer, outer barrel outer layer, and patch panel crates. The cooling system's design allows
1288 evacuating 14kW from the ITS detector's electronics and the detector itself.

1289 4.1.1.3 Concept of leakless cooling

1290 The concept of a liquid cooling system follows a leakless cooling scenario suggested [1] and
1291 successfully used [2] at CERN. The principle of under-pressure cooling is depicted in Fig.
1292 4.1. The cooling-liquid circuit is a closed circuit, which allows to operate all or part of
1293 the cooling lines below atmospheric pressure, especially inside the solenoid. The cooling-
1294 liquid tank is kept at under pressure, which by the proper choice of length and diameter
1295 of the return pipes and of the circulation-pump output pressure, ensures that the water
1296 pressure inside the detector is below atmospheric pressure. This has the obvious advantage
1297 of an active protection against the occurrence of leaks. In the MPD inside-magnet detectors
1298 case, the space constraints due to the extremely dense front-end readout does not allow
1299 space-consuming high-pressure certified fittings. Therefore, simple silicon hoses without any
1300 special lock mechanism to couple to the cooling arteries are used. Though the connection

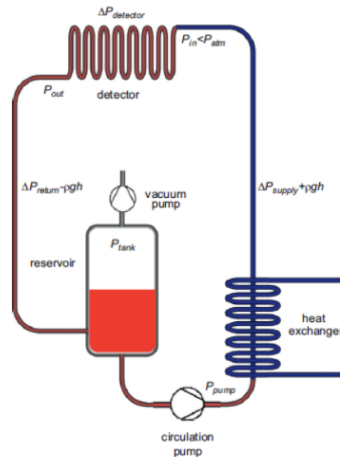


Figure 4.1: Principle of under-pressure operation [2].

1301 between the silicon hoses and the cooling tubes is usually tested to hold overpressure of 2.5
 1302 bar over an extended period (24h), they are mechanically fragile, e.g., against tears or cuts.
 1303 These considerations that led CERN LHC detectors to develop the sub-atmospheric ‘leakless’
 1304 technology for cooling circuits inside the volume of the momentum analysing magnet is more
 1305 detailed in [3].

1306 An apparent disadvantage of the sub-atmospheric ‘leakless’ technology is the limited range
 1307 of operation $P < 1$ bar. This implies that the allowed pressure ΔP loss, in the detector is
 1308 rather limited. The situation is further aggravated, in cases of TPC and ECAL, due to a
 1309 difference in height of about 8 m between the highest inlet and the cooling plant located on
 1310 the floor of the experimental hall. While the input pressure at each inlet can be adjusted
 1311 independently via balancing valves, initially this has not been foreseen for the return lines
 1312 such large-size detectors as TPC and ECAL since all detectors ‘see’ a combination of the
 1313 reservoir pressure, the hydrostatic pressure and the pressure loss in the return pipes. This
 1314 can result in very low pressure values in some of the return lines, which might cause a
 1315 cavitation phenomena that has to be avoided. Luckily for the ITS, its height spans is only
 1316 half a meter, which seems to simplify the task for tuning its leakless cooling system (LCS).

1317 4.1.1.4 The MPD ITS objects for cooling and the description of the cooling 1318 lines

1319 The MPD ITS objects for cooling are the 42 supermodules called “Staves” each one carrying
 1320 two cold plates to which the position sensitive modules called HICs are glued onto (Fig. 4.2).
 1321 These structures will be cooled by means of circulating demineralized water. The cooling
 1322 lines of 6 staves (12 cold plates) are grouped into a single “loop” with the help of manifolds
 1323 located in the Service Barrel of the ITS. The total number of cooling loops the ITS OB is 7
 1324 as shown on Fig. 4.3.

1325 The relevant information about the he material and diameter of the liquid cooling inlet
 1326 and outlet arteries used by ALICE ITS2 in the region of detector and outside is provided on
 1327 figures 4.4 and 4.5. Figure 4.6 shows the working principle of the control sensors of a loop
 1328 while Appendix .1 provides the exact schematics of the most recent cooling plant built by
 1329 the Engineering Department of CERN for the ALICE ITS2 project (Courtesy of the ALICE
 1330 Collaboration).



Figure 4.2: One of 42 OB MPD ITS staves cooling sections.

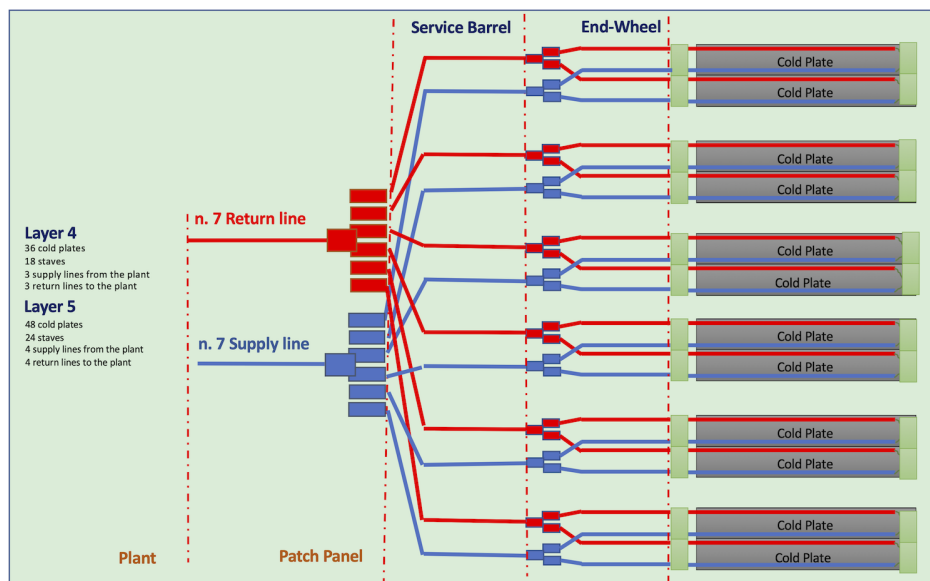


Figure 4.3: Cooling loops of the MPD ITS OB (Courtesy of the ALICE Collaboration).

1331 4.1.1.4.1 Leakless operation

1332

1333 To maintain the leakless operation, the vacuum pump keeps the reservoir pressure
 1334 below the atmospheric pressure. The pressure drop is minimized inside the detector and
 1335 return lines, contributing to maintaining the reservoir pressure level below atmospheric. In
 1336 case of any leak, the air infiltrates into the plant and accumulates on top of the reservoir.
 1337 The build-up pressure is measured, then PLC decides whether to stop the cooling or continue
 1338 the operation. The operation can continue if the leakage is below the threshold value. All
 1339 of those operations prevent the water from leaking. The leak may also occur in part in
 1340 between the pump and the detector inlet. This section is above the atmospheric pressure. In
 1341 such a case, the reservoir's level transmitter detects the loss and stops the circulator pump.
 1342 Stoppage of the circulator pump prevents the leakage of water by bringing the installation to
 1343 a sub-atmospheric pressure. Another possibility is shutting the loop where the leak occurs.
 1344 The system is designed in such a way that this operation can be done remotely.

1345 4.1.1.4.2 Operational modes

1346

1347 The system and its components can operate in different modes, which are listed below.

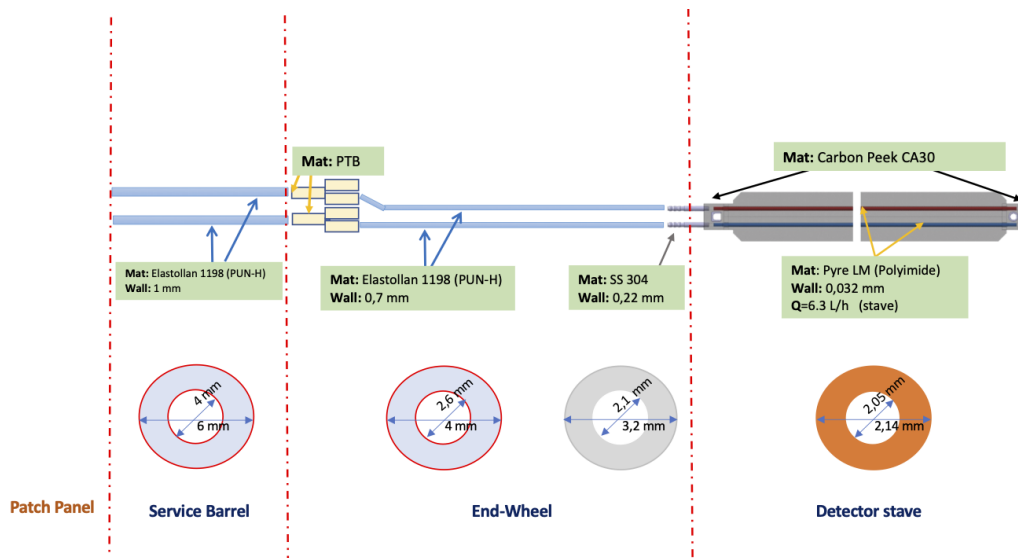


Figure 4.4: Specification of cooling arteries inside the Service Barrel (Courtesy of the ALICE Collaboration).

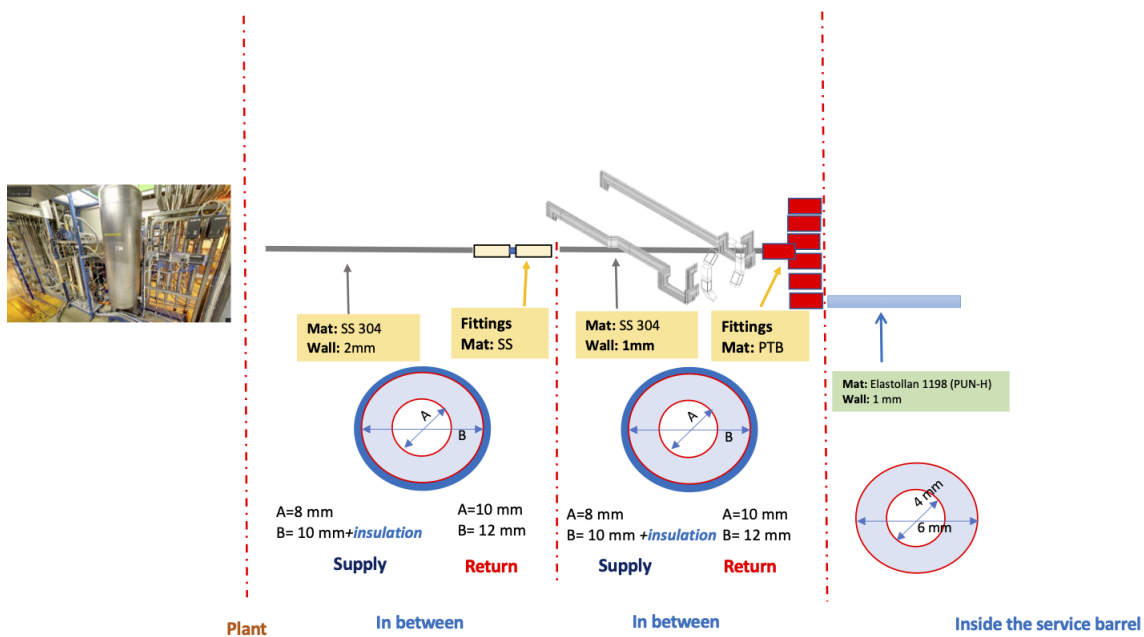


Figure 4.5: Specification of cooling arteries outside the Service Barrel (Courtesy of the ALICE Collaboration).

1348 1. Mode request

- 1349
- 1350
- 1351
- 1352
- 1353
- 1354
- **Stop mode** – each component is without power, in a safe fail mode, no regulations, nothing is running.
 - **Stand-by** – circulation is off, tank pressure is controlled, its level state is monitored. In this mode, the whole system (plant + piping + detector) is below atmospheric pressure. To be used for short cooling interruption or looking for leaks.

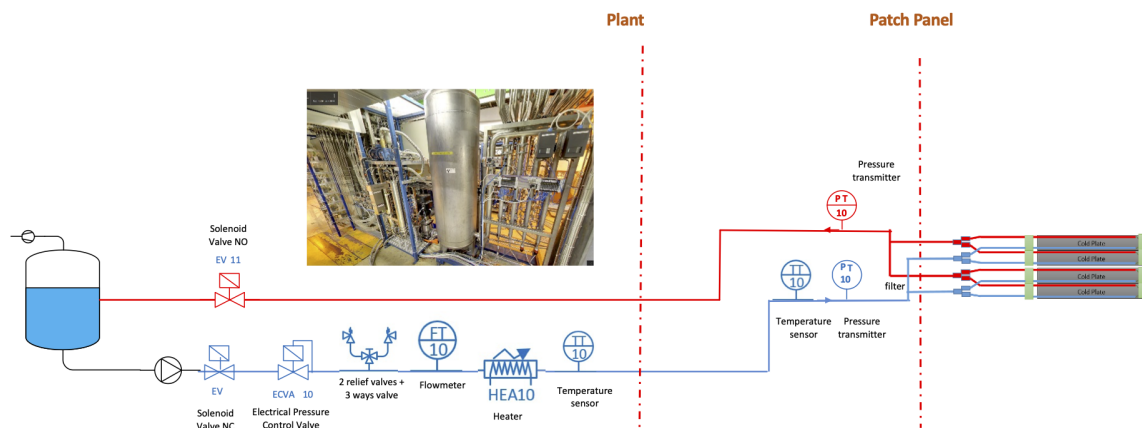


Figure 4.6: Working principle of the control sensors of a loop (Courtesy of the ALICE Collaboration).

1355 • **Run** – Water circulation with pressure and temperature control. It is possible to
 1356 control the temperature and pressure of the cooling plant. In this mode, only the
 1357 return pipes and part of the detector is in negative pressure. Any water leakage
 1358 should happen only in this mode.

1359 2. Loop Control

1360 Each loop is controlled independently. The three predefined states of the loops are:

1361

- 1362 • **Off** – the loop is closed, the injection valve is closed, and the return valves are open.
 1363 The circuit is connected to the tank pressure and keeps the leakless protection.
 1364 Pressure and temperature regulation are off.
- 1365 • **On** – the loop is open, injection and return valve are open. The water circulates.
 1366 Pressure regulation is on. PID loop responsible for the pressure and regulating
 1367 the pneumatic is on.
- 1368 • **Locked** – the loop is closed, injection and return valve are closed. The circuit
 1369 is not connected to the tank pressure. Pressure and temperature regulation are
 1370 off. This mode is used to isolate the leaking loop. In this mode, there is the risk
 1371 of overpressure and liquid leakage. The safety valve acts as the last overpressure
 1372 protection

1373 3. Temperature regulation

1374 Each manifold has a heater and a temperature sensor. In normal mode, PLC regulates
 1375 the temperature in the range of 18 °C to 23 °C. The cooling plant's temperature is
 1376 0.5 °C below the lowest temperature setting out of the cooling manifolds

1377 4. Pressure regulation

1378 Each manifold, has a pneumatic regulation valve and the pressure sensor. In normal
 1379 mode, PLC regulates the pressure to the user setpoint in the range of 0.5 bar and 1.5
 1380 bar. The cooling plant operates on one fixed pressure regulated via a PID loop that
 1381 acts on the pump speed.

1382 5. Tank Pressure regulation

1383 The water tank has a pressure sensor and a vacuum pump. In standby and run
 1384 operation, the PLC regulates pressure to a specific value. Usually, the value is between
 1385 0.6 to 0.96 bar. In case of any failure, the safety valve limits the pressure up to 1.5 bar.

1386 4.1.1.4.3 Alarms

1387

1388 The PLC controls all measured values. Therefore, it is responsible for sending alarm
1389 signals further that trigger an interlock or an alarm. Interlocks and alarms are divided into
1390 three types:

- 1391 • **Minor** – particular value is not in the normal range. There is no risk for the equipment
1392 nor humans. The system does not need to be interrupted. However, it requires
1393 investigation.
- 1394 • **Potentially dangerous for the material** – a particular value is not in the normal
1395 range. There is a risk for the installation, but not for the humans. The plant has to be
1396 switched to "standby" mode, and all loops have to be turned off.
- 1397 • **Potentially dangerous for humans** - a particular value is not in the normal range.
1398 There is a risk for the humans in the nearest vicinity of the installation. The plant has
1399 to be switched to "stop" mode, and all loops have to be turned off.

1400 4.2 The beam pipe

1401 One of the most critical elements of the NICA MPD project is the nine meters long thin-
1402 wall UHV-compatible beam pipe. Figure 4.7 shows a preliminary sketch drawing of it. The
1403 manufacturing of the beam pipe is a very complex and risky task for the MPD, which could
1404 turn out to be a stopper of the whole project since RF industry had never produced similar
1405 objects before.

1406 The LHC experiments gained enough experience in the design and production of similar
1407 unique pipes, with rare ends made out of Aluminum while the central part is made out of
1408 Beryllium. The typical minimum wall thickness reached so far is 800 um for both, Beryllium
1409 and Aluminum parts.

1410 So far, USA-based company “Materion” is the only one able to produce such a unique
1411 component. Unfortunately, under the policy of the sanctions imposed to Russia, NICA is
1412 not allowed to make a contract with “Materion” and is currently developing the technology
1413 for producing the beam pipe somewhere else. Russian industry is capable of producing the
1414 Beryllium part of the beam pipe but meets technological challenges for the production of the
1415 Aluminum parts with the required thickness and, especially, for assembling all parts together
1416 UHV-tight. German industry is heavily involved in the EXFEL project at DESY and has
1417 already built thin wall aluminum beam pipes of relatively small dimensions. We are proposing
1418 our German partners to further developing this technology jointly and to build the beam pipe
1419 for the MPD in Germany. To that end, a specific item is included in the list of the GSI-NICA
1420 in-kind cooperation plan.

1421 4.3 Installation and removal

1422 A description of the mechanics and service environment for ITS detectors is given in this
1423 section along with the installation and removal procedure of the entire ITS structure. A
1424 general overview is shown in Figure 4.8. The mechanical structures supporting the Staves,
1425 the water and air-cooling systems, the cable duct systems, the cooling system pipes and
1426 vacuum pipe support systems are highly integrated and they will be considered sequentially.
1427 To facilitate the construction and utilization of its structure, the ITS has a connector on the
1428 horizontal plane.

1429 4.3.1 Basic system requirements

1430 The placement of mechanical elements of the ITS structure observes the following criteria:

- 1431 • minimization of materials bulk in the measurement zone;
- 1432 • guaranteeing high accuracy and log-term stability for the detector positioning;
- 1433 • providing high accuracy on the detector positioning relative to both, the TPC and beam
1434 pipe;
- 1435 • placement of the ITS inner-most layer at a minimum distance from the wall of the beam
1436 pipe;
- 1437 • guaranteeing its thermomechanical stability during its entire lifetime;
- 1438 • simplicity and accessibility to control the ITS elements;
- 1439 • ease of assembly and disassembly of the detector layers and detector Staves.

1440 The main body of each half of the ITS is composed by two cylinder-shaped carbon shells
1441 (external and internal) with 1.2 mm and 5 mm of Rocacell foam in between and aluminum-
1442 alloy flanges glued at the edges.

1443 To support the detector Staves, hollow clamps are fixed to the edges of the body and flat
1444 supports equipped with ruby balls are glued in pairs with high accuracy to the wings of the
1445 clamps. Such a design allows the installation of detector arrays with high accuracy and also
1446 guarantees a stable position for disassemble or replacement of the arrays (Fig. 4.9).

1447 To ensure a high accuracy on the aggregation and positioning of the Staves, their supports
1448 have a round hole at one end (for positioning in two directions) and an elongated one at the
1449 other end, allowing some movement in the axial direction. Staves from layer 4 are assembled
1450 on clamps of similar design with ruby supports, but they do not have a rigid body and
1451 are assembled on a special assembly stand. The rigidity of the structure is ensured by the
1452 assembly itself.

1453 Layers No. 1, 2 and 3 are assembled in a similar way. The Staves of layer No. 3 are
1454 installed in a casing, and the Staves of layers 2 and 1 are assembled according to a frameless
1455 scheme. The detector layers are connected to each other by means of precision clamps. The
1456 complete ITS enclosure assembly also includes left and right service enclosures and connector

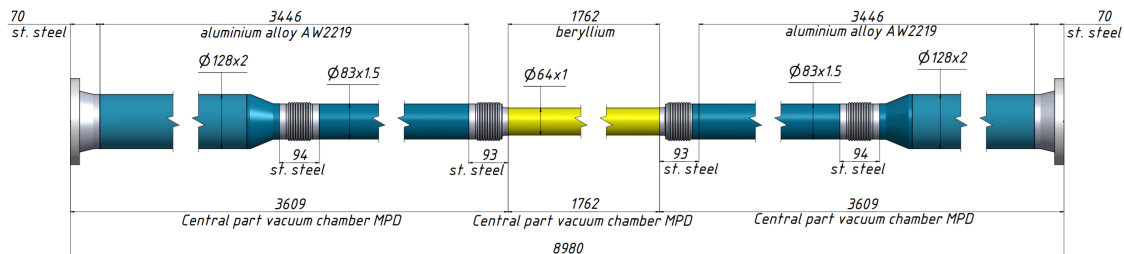


Figure 4.7: A tentative design of the MPD beam pipe. There is no indication of the vacuum equipment at the rare ends of the beam pipe. According to the integration scenario the beam pipe is baked at the vacuum stand and filled-in with dry Neon and only then is shipped to the assembly stand c/o the MPD ITS team.

1457 block housings. The total assembly length is 4220 mm. A general view of this element is
1458 shown in Figure 4.10.

1459 The service housings contain pipe supports, FFD detector supports, cable fasteners, pipes
1460 for water- and air-cooling systems and electronics unit supports. All supporting elements have
1461 windows on the periphery for fixing cables and pipes from the cooling systems. The blocks
1462 of connectors are used to accommodate power connectors, connectors signal circuits, as well
1463 as pipes of water and air-cooling systems. The cables of the FFD detector block are output
1464 through the central hole of the connector block.

1465 4.3.2 Assembly operations sequence

1466 ITS assembly is performed in a clean room according to the following sequence:

- 1467 • the housing units of the lower and upper cases are assembled;
- 1468 • in service buildings, elements for fixing electronics blocks are attached to the walls;
- 1469 • air- and water-cooling pipes are attached and fastened;
- 1470 • power-supply cables and signal cables are placed with the connectors attached in the
1471 housing of the connector block;
- 1472 • the Staves of layer No. 5 are installed and connected to the corresponding cables and
1473 pipes of the cooling systems;
- 1474 • a block Staves of layer 4 is assembled on a separate assembly stand. Layer 4 is installed
1475 in the assembly housing and cables and pipes routing is performed;
- 1476 • assembly of layers 1, 2 and 3 is performed as a separate block and then installed to the
1477 block as well;
- 1478 • FFD lower detector blocks are mounted in the lower case block;
- 1479 • the beam pipe is installed;
- 1480 • FFD upper detector blocks are installed;
- 1481 • half-cases are assembled together using guide pins and rigidly fastened with screws on
1482 the planes of the clamps and the planes of the connector block.

1483 To install the ITS beam pipe setup, additional technological housings are attached to
1484 the connector blocks of the detector assembly. Technological housings are equipped with
1485 additional support elements for holding the beam pipe. A general view of such an assembly
1486 is shown in Figure 4.11

1487 When fully assembled, the setup is a round container that allows to install the ITS into
1488 the NICA facility by means of rail guides with trolleys. With this configuration, no support
1489 for the beam pipe is required. A schematic diagram of the installation process is shown in
1490 Figure 4.12.

1491 After fixing the container in the required position, the housing supports are set on the
1492 right and left, rigidly fixing the position of the detector assembly to the TPC frame on
1493 one side, and by a sliding fit on the other side. After fixing, the container is sequentially
1494 disassembled, so:

- 1495 • top technological housings are removed;
- 1496 • the pipe is hung out and fixed on previously prepared supports;

- 1497 • the lower technological housings are removed;
- 1498 • rail guides are dismantled;
- 1499 • the beam pipe is connected to the vacuum system.

1500 4.3.3 MPD Inner Tracking System installation procedure

1501 Due to the limited space available, the mounting of the Inner Tracking System in the working
1502 position inside the TPC at the MPD is a challenging task. The clam-shell design of the ITS for
1503 the MPD, similar to that of ALICE ITS, simplifies the general assembly of two half-cylinder
1504 modules of the ITS around the beam-pipe. However, the task is more complicated further
1505 by the demand to keep the central positioning of this low diameter, thin wall thickness, very
1506 long and rather fragile central section of the MPD beam-pipe. Besides, the existing space
1507 inside the TPC does not allow to use rails for the ITS sliding in/out.

1508 Therefore, a different approach is proposed here. The MPD installation scenario,
1509 presented below for the ITS, ensures the robust mounting and dismounting of specific, rather
1510 complex, central barrel composed of the Inner Tracking System, the beam-pipe central section
1511 of 1.7 m in length, the Fast Forward Detector (FFD) and services including power and data
1512 cables, cooling and air-ducts.

1513 The approach is based on the modular design of the so-called insertion container. It is
1514 designed to meet the requirements of

- 1515 (i) assembly of the detectors (ITS and FFD),
- 1516 (ii) services inside the insertion container,
- 1517 (iii) fixation of the beam-pipe central section, and
- 1518 (iv) positioning all systems inside the TPC.

1519 All modules of the insertion container are designed in a clam-shell shape, a general view
1520 of one of the MPD-ITS service barrels in a clam-shell design is shown in the Figure 4.13. The
1521 insertion container is composed of several barrels with specific functionality. For example,
1522 the service barrels at both ends of the ITS detector barrel, are designed for mounting loops
1523 of signal and power cables, power converters, distribution manifolds, liquid and air cooling
1524 tubes, etc (see Fig. 4.14). Components for fixation of detector systems, services and beam-
1525 pipe are shown in yellow.

1526 The design of the inside the volume of the insertion container provides the opportunity to
1527 change the modules of the MPD detector systems and/or of the beam-pipe. In all cases the
1528 procedure of mounting/dismounting of detectors inside the inner part of the TPC is similar.

1529 The positioning inside the TPC of the insertion container with the integrated detector
1530 systems and services and containing the beam-pipe central section, requires additional tooling
1531 to provide the movement of the whole assembly in (or out) the TPC. This tooling assumes
1532 external supporting rails mounted outside the MPD on both sides during the operation with
1533 the insertion container (see Fig. 4.15).

1534 Schematics of the final assembly of the ITS inside the TPC is shown in the Figure 4.16

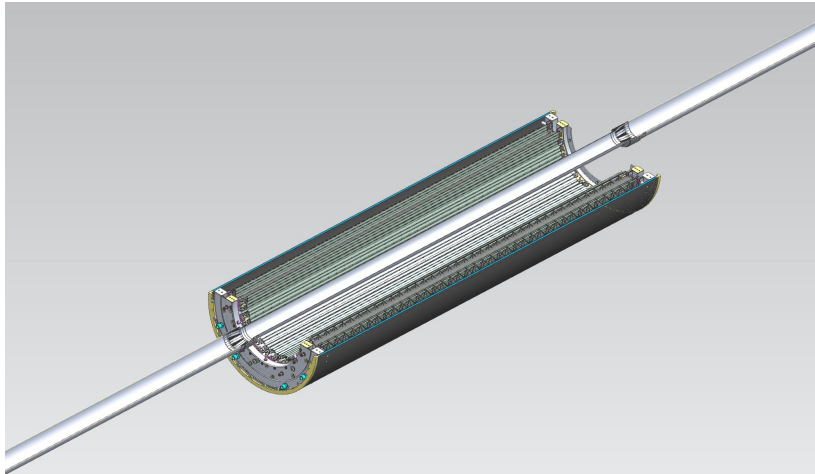
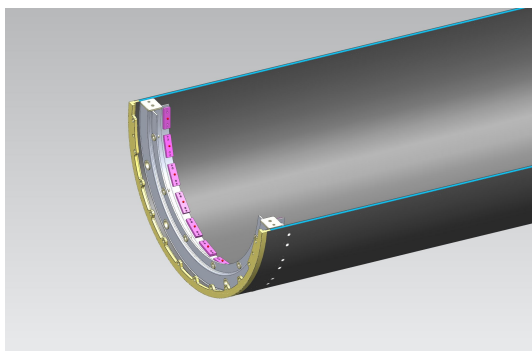
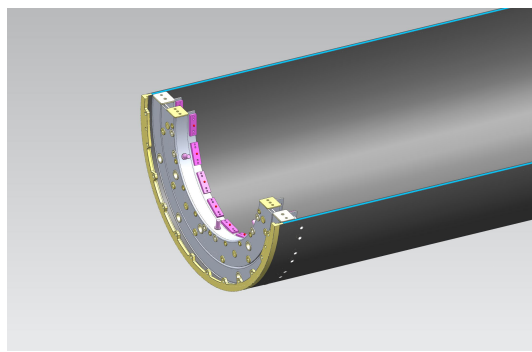


Figure 4.8: General overview of the mechanics for installing the ITS layers (internal supports are not depicted).



(a)



(b)

Figure 4.9: ITS outer case element for layer 5 (a) and 4 (b).

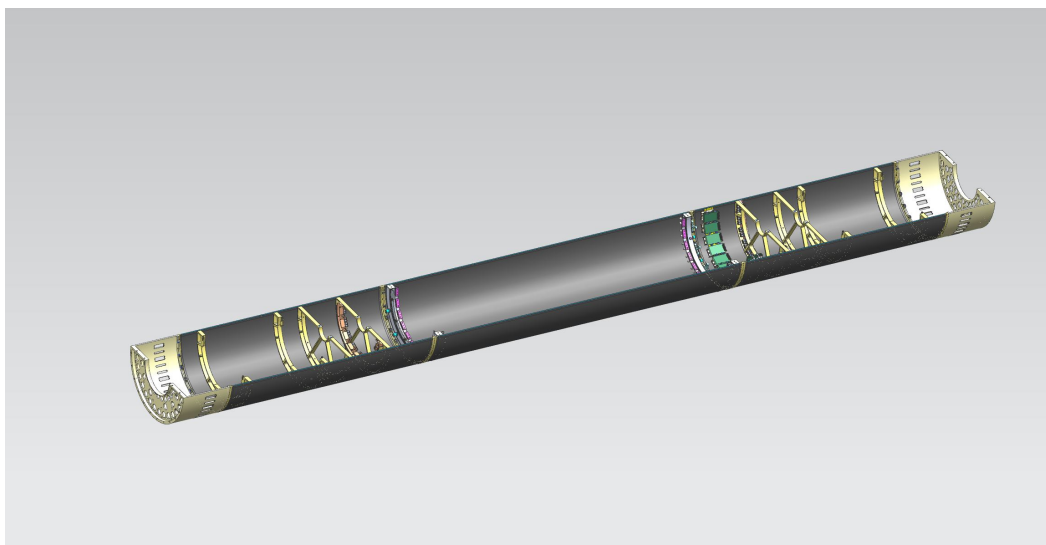


Figure 4.10: General view of the ITS case assembly.

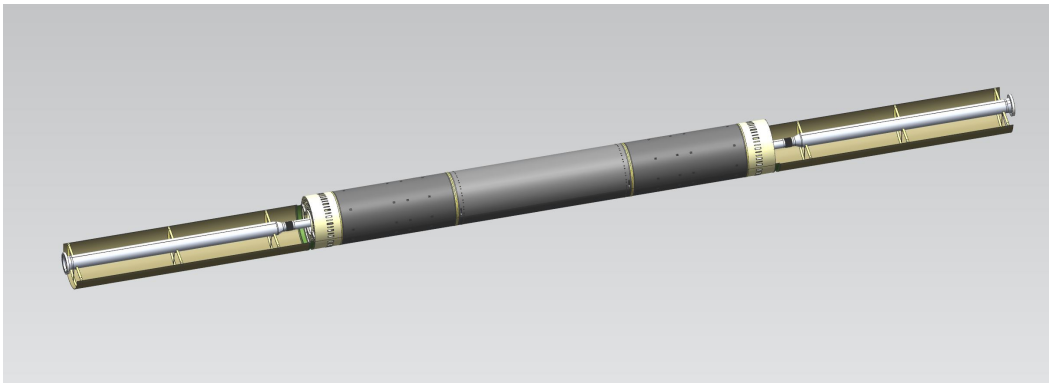


Figure 4.11: General view of the insertion container. For convenience, the upper parts of the technological barrels are not shown.

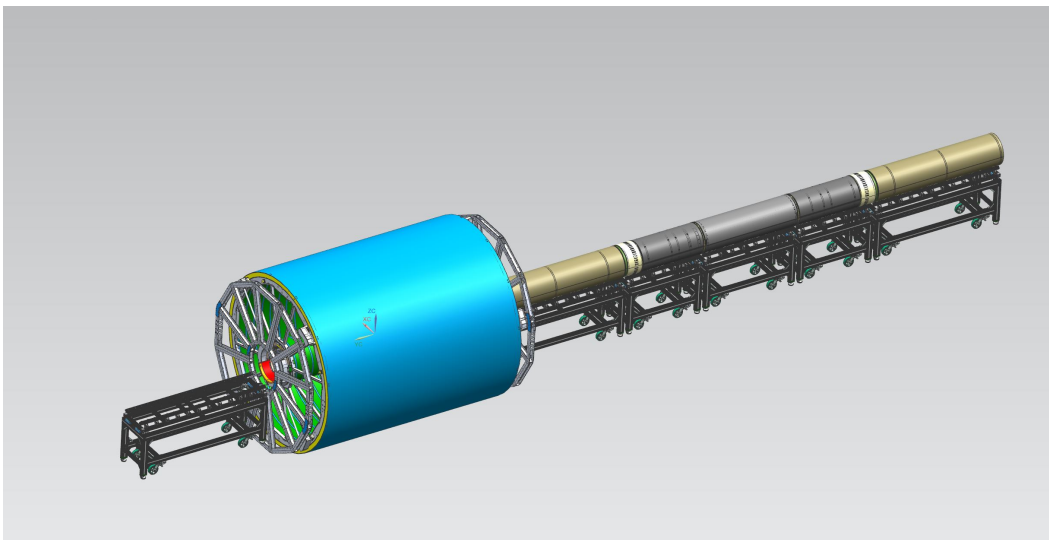


Figure 4.12: Installation of the insertion container of the MPD-ITS into the TPC bore.

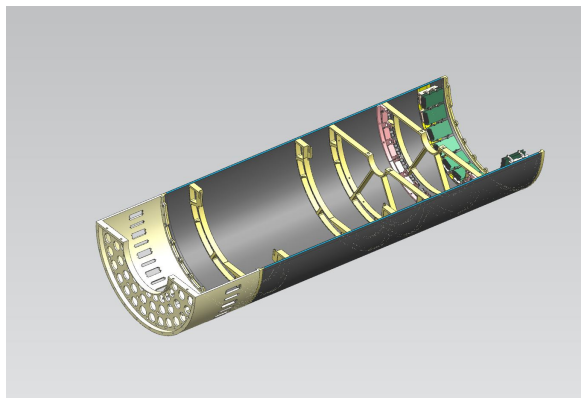


Figure 4.13: General view of one half of the MPD-ITS service barrel cases in a clam-shell design.

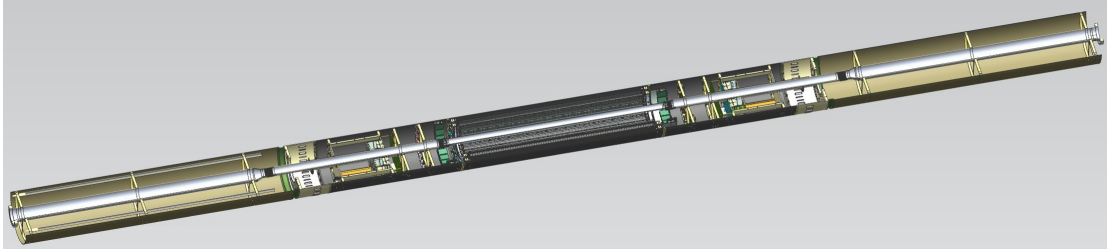


Figure 4.14: General view on half of the MPD-ITS insertion container with ITS and FFD detector systems mounted.

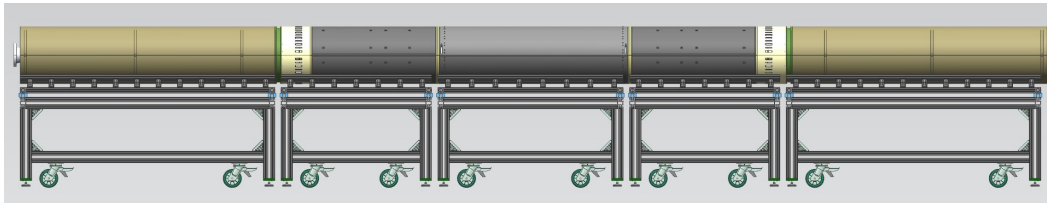


Figure 4.15: MPD-ITS insertion container on the supporting rails.

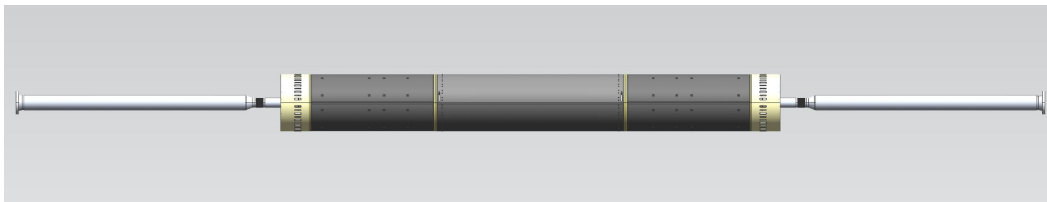


Figure 4.16: Final geometry of the ITS insetion container inside the TPC.

1535 Bibliography

- 1536 [1] P.Bonneau, M.Bosteels, "Liquid cooling systems (LCS2) for LHC detectors.",
1537 <https://cds.cern.ch/record/434520>
- 1538 [2] J. Alme, Y.Andres, H.Appelshauser et al., "The ALICE TPC, a large 3-dimensional
1539 tracking device with fast readout for ultra-high multiplicity events.", Nucl. Instr. And
1540 Meth. in Phys. Res. A622(2010)316–367
- 1541 [3] M.Pimenta dos Santos., "ALICE TPC Readout Chambers Cooling System.", CERN-
1542 ST/CV-2003-490540, 2003.

5 The DAQ System

5.1 Radiation environment

The evaluation of the radiation environment of the MPD-ITS was done using the FLUKA code version 2-11.2x-8. For this purpose a simplified geometry of the ITS consisting of five concentric cylindrical layers was defined inside the geometry of the MPD. The *Total particle fluence (1-MeV n equivalent in Si)* and *Dose rate* were calculated along the radius of the setup for two main zones of interest, the full MPD and the ITS regions. For the ITS region the Dose and Fluences were estimated in 5 layers defined in Table 5.1.

Table 5.1: ITS layers as defined for the FLUKA simulations

Layer	Radius (cm)	Lenght (cm)
1	2.2	75.0
2	4.1	75.0
3	6.0	75.0
4	14.5	152.6
5	19.4	152.6

The conditions of the simulations are described below.

Geometry set-up

The simulated geometry is shown in a 2D projection in Figure 5.1 where the following regions were defined:

1. Solenoid based on the MPDroot geometry.
2. Pipe:
 - middle section(150 cm in length centered at the MPD IP) was defined as a Be tube with an inner and outer radii of 1.9 cm and 2 cm, respectively;
 - outer sections were defined as Al tubes with an inner and outer radii of 3.9 cm and 4 cm, respectively.
3. Simplified TPC detector based on the MPDroot geometry version v7.
4. Simplified FFD detector.
5. FHCAL calorimeters with 44 modules each (each module was implemented as a single homogeneous material.)
6. ECal was implemented as a single homogeneous material.

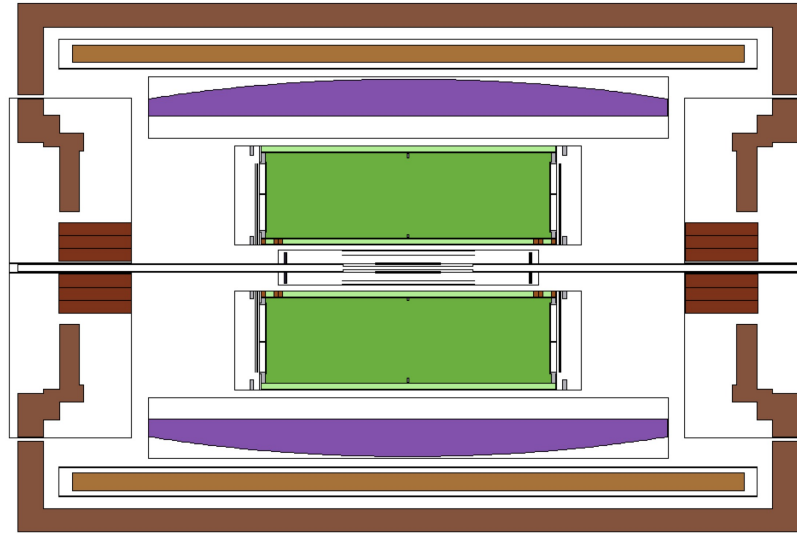


Figure 5.1: Implemented MPD geometry for FLUKA simulations.

1566 Primary events

1567 A file from DCM-QGSM event generator for minimum-bias Au-Au collision at
 1568 $\sqrt{S_{NN}}=11$ GeV/n was converted to be read by FLUKA as a source of primary events. A
 1569 total of 10^4 primary events were used in the simulation. The beam was specified to have
 1570 the Gaussian profile defined by standard deviation $\sigma=60$ cm in the beam-line direction Z
 1571 (Fig.5.2-left panel) with beam particles uniformly distributed over a 2 mm-radius circle in
 1572 the X-Y plane at the MPD IP (Fig.5.2-right panel).

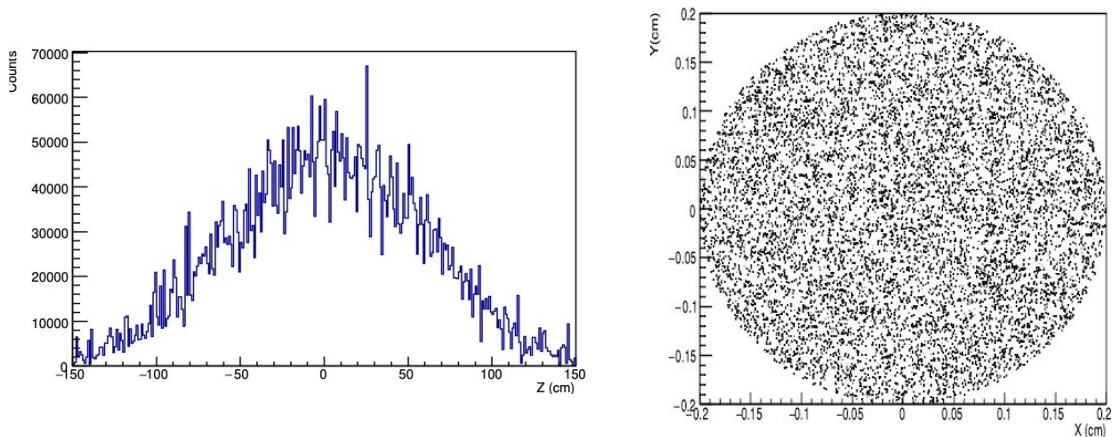


Figure 5.2: Left: Beam Gaussian profile along the beam-pipe. Right: Beam cross section.

1573 5.1.1 Radiation levels in the detector regions

1574 The results of the simulations are shown in figures 5.3 to 5.5 for the 5 layers of the ITS and in
 1575 figures 5.6 to 5.8 for the whole MPD setup. As it can be seen from figure 5.5 the TID rate for
 1576 the two OB layers is of the order of 5×10^{-5} Rad/s. Assuming a yearly running time for the
 1577 MPD of 50%, it is around 10 kRad over 10 years which represents a complete non radiation-

1578 hard environment. As so, figure 5.8 shows a very low dose rate of about 10^{-9} Rad/month in
 1579 the area just above the MPD yoke where the ITS readout electronic will be placed.

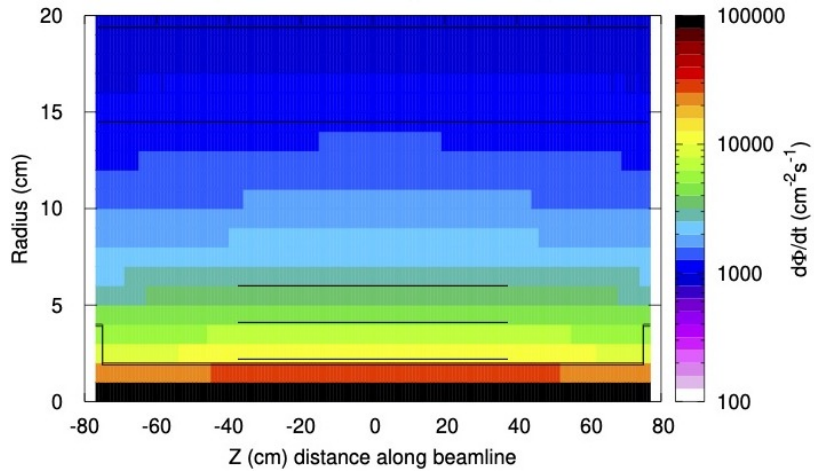


Figure 5.3: Total particle fluence on the ITS regions.

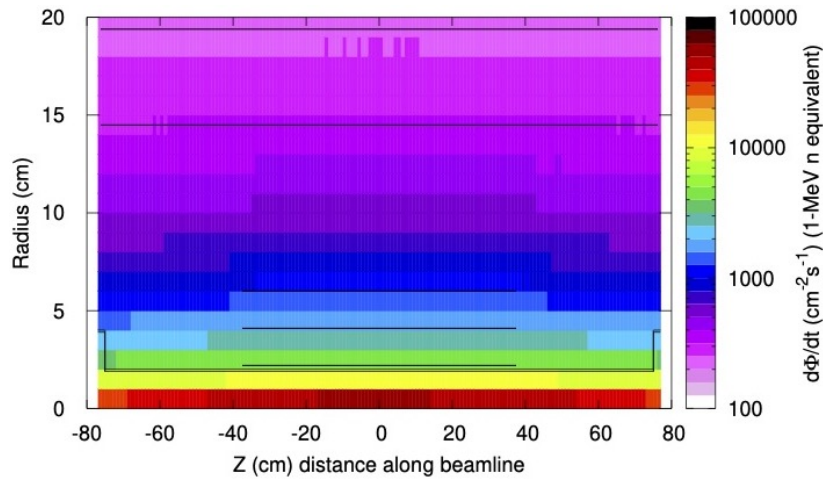


Figure 5.4: Total particle fluence on the ITS regions (1-MeV n equivalent in Si).

1580 5.2 Sensors layout and interconnections

1581 The MPD-ITS is divided into two main regions, Inner (3 layers) and Outer (2 layers), each
 1582 characterized by a different mechanical arrangement of the sensors around the beam axis.
 1583 From the readout electronic point of view, what what is important is that the different
 1584 operating mode of the sensors in such regions and the different speed of the data streams,
 1585 which depends on the physics implementation of the data bus.

1586 5.2.1 Inner Layers

1587 All references, in this section, to the Inner layers refer to the back-up solution for the Stage-2
 1588 is planned to be provided by the MPD Inner Barrel based on the well proven 180nm MAPS
 1589 technology developed by the ALICE collaboration.

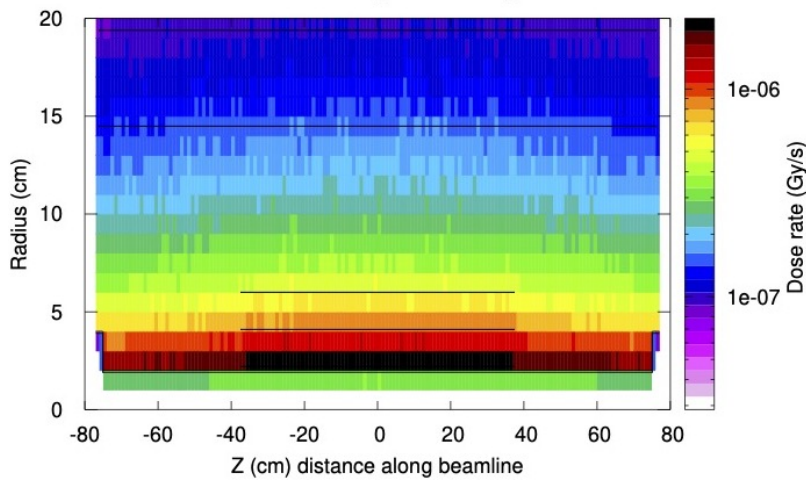


Figure 5.5: Dose rates on the ITS regions.

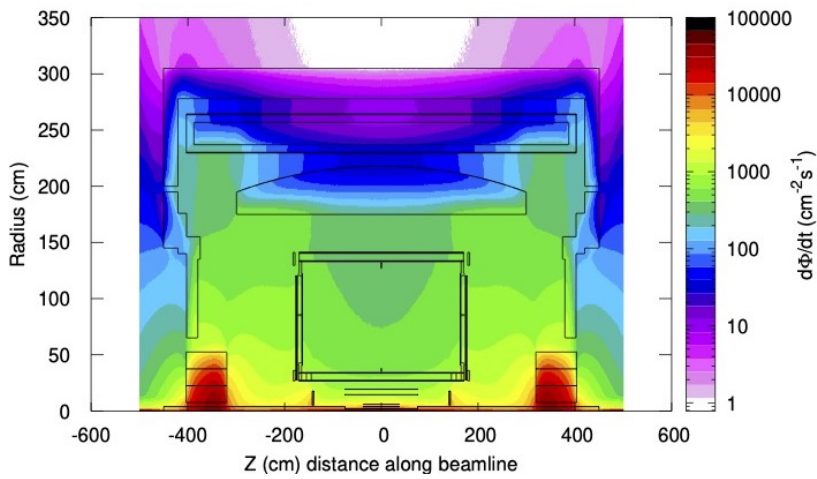


Figure 5.6: Total particle fluence on the MPD.

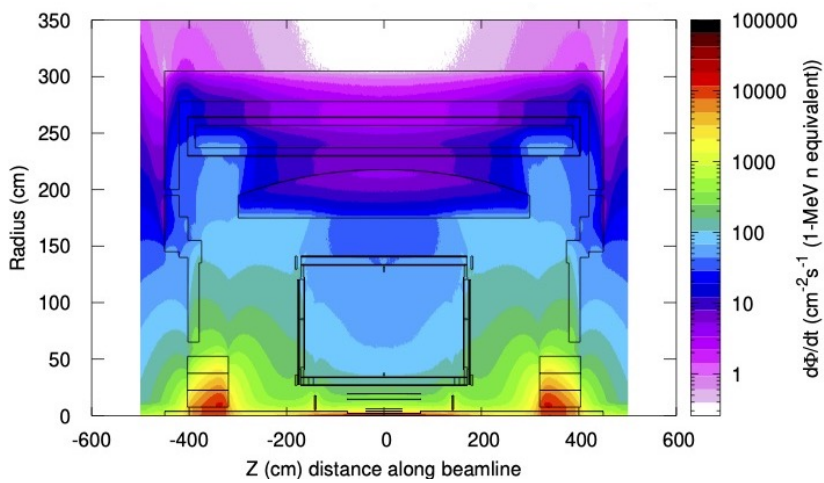


Figure 5.7: Total particle fluence on the MPD (1-MeV n equivalent in Si).

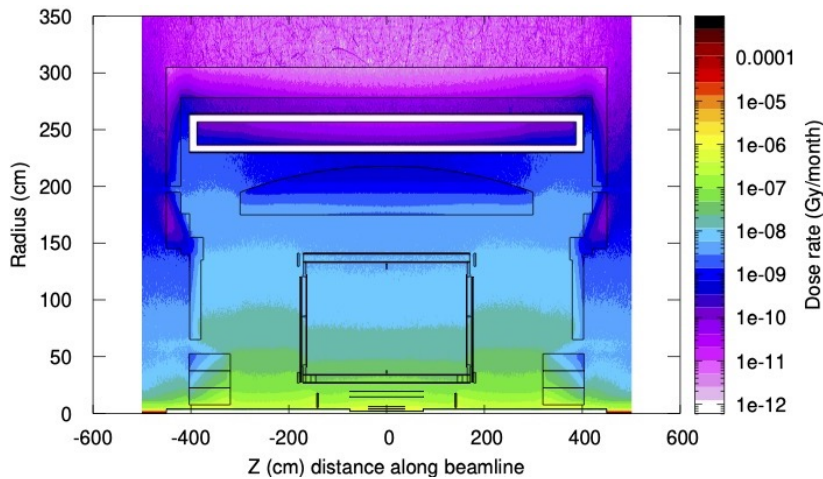


Figure 5.8: Dose rates on the MPD.

1590 The three innermost layers are composed by a different number of identical staves, each
 1591 one supporting nine chips. Each chip has dedicated bus lines to receive and send data from/to
 1592 the Readout Electronics.

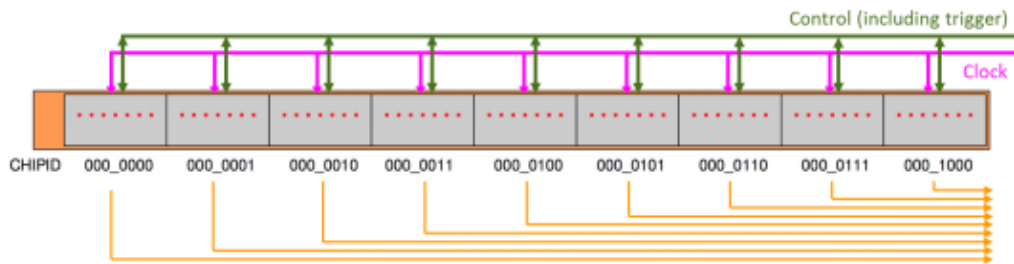


Figure 5.9: Inner Layers stave sensors and connections schematic.

1593 Figure 5.9 illustrates all the links connecting the sensors with the readout electronics.
 1594 The clock link (purple) is a mono-directional multi-drop differential connection running at 40
 1595 MHz. The control link (green) is a bi-directional multi-drop differential connection mastered
 1596 by the Readout Electronics which can run up to 40 Mb/s. The control link will also carry the
 1597 trigger, as a special, high priority packet. During acquisition time the control line will just
 1598 carry the trigger and some slow control commands; while the detector is not running it mainly
 1599 be used for reading back sensors status and parameters for setup and control purposes.

1600 Orange lines in Figure 5.9 represent the high-speed data lines, which are point-to-point,
 1601 one way differential links connecting each sensor directly to the Readout Electronic.

1602 5.2.2 Outer Layers

1603 A module is composed by two rows of seven sensors, and each row has a master sensor which
 1604 communicate with the outside world, while the other six chips share a bus to send and receive
 1605 data to/from the master. The master chip will have a digital interface identical to the Inner
 1606 Layers chips, therefore the control lines will be identical. With reference to Figure 5.10,
 1607 the clock link (purple) is a mono-directional multi-drop differential connection running at 40
 1608 MHz. The control link (green) is a bi-directional multi-drop differential connection mastered
 1609 by the Readout Electronics which can run up to 40 Mb/s. The control link will also carry

1610 the trigger, as a special, high priority packet. During acquisition time the control line will
 1611 just carry the trigger and some slow control commands, while it will be used for reading back
 1612 sensors status and parameters for setup and control purposes.

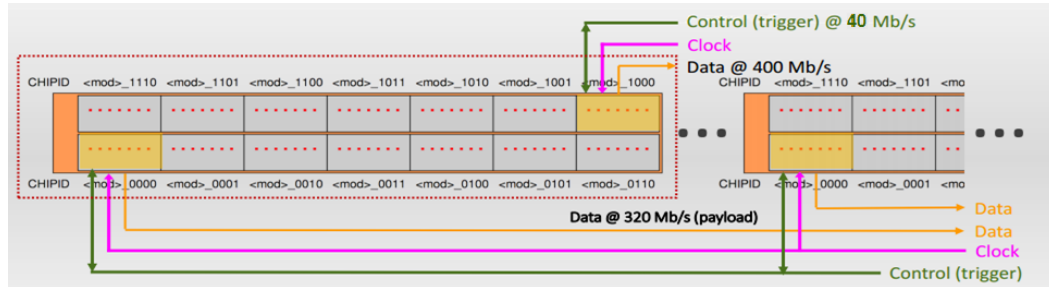


Figure 5.10: Outer Layers stave sensors and connections schematic.

1613 Data lines will be again a point-to-point differential link connected directly to the Readout
 1614 Electronics. The slave sensors communicate with the master by a dedicated, 4-bit single ended
 1615 bus connecting the master and the six slaves. The Outer Modules by staves carrying two
 1616 rows of seven modules each (Figure 5.10).

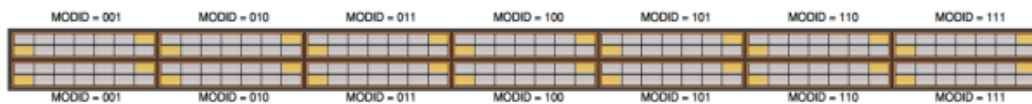


Figure 5.11: Outer Layers stave modules arrangement (master sensors in orange).

1617 5.2.3 Links and connections

1618 The topologies illustrated in the previous section requires the signal to and from the sensor to
 1619 travel through a bus for the full length of the stave at which end a copper link will connect it
 1620 to the Readout Electronic. Simulations (communication line models) and early prototyping
 1621 did show how the main limit for high-speed communication comes from the bus, while the
 1622 copper links (about 8-meter-long for all the layers) play a lesser role (but not negligible for
 1623 the faster inner layers link).

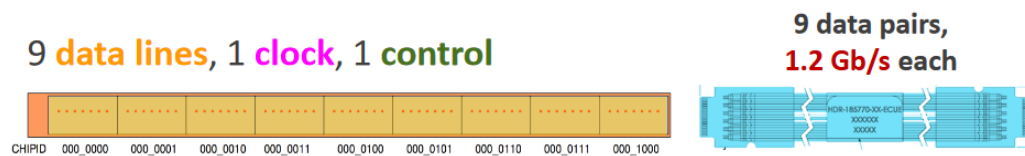


Figure 5.12: Inner layer links

1624 The important thing for this general system overview is that the bandwidth available to
 1625 transmit the data is limited to 1.2 Gb/s for the Inner Layers link, and to 400 Mb/s for the
 1626 Outer Layers link, where the much longer bus is the bottleneck.

1627 Table 5.2 summarizes the foreseen links per each layer and the total data bandwidth. The
 1628 rated values are all maximal system design values, not actual average values, which should
 1629 stay sensibly lower to ensure smooth operations.

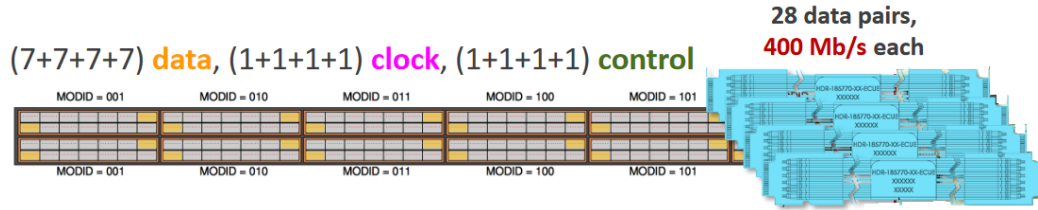


Figure 5.13: Outer layer links

Table 5.2: Copper links count and capacity summary (max design values).

Layer	Staves	Links per stave	Links bandwidth [Gb/s]	Links payload [Gb/s]	Bandwidth per stave [Gb/s]	Payload per stave [Gb/s]	Bandwidth per layer [Gb/s]	Payload per layer [Gb/s]
0	5	9	1.2	0.96	10.8	8.64	54	43.2
1	8	9	1.2	0.96	10.8	8.64	86.4	69.12
2	11	9	1.2	0.96	10.8	8.64	118.8	95.04
3	18	28	0.4	0.32	11.2	8.96	201.6	161.28
4	24	28	0.4	0.32	11.2	8.96	268.8	215.04
Total							729.6	583.64

1630 5.3 Readout Electronics

1631 5.3.1 Overview

1632 The Readout Electronics (RE) interfaces the sensors on the staves of the different layers to the
 1633 readout, control and trigger systems of the MPD. On the detector side, it collects the high-
 1634 speed data streams from the sensors and re-organize them to optimize the data transmission
 1635 through the e-links used by the Common Readout Unit (CRU). It also manages the control
 1636 lines which distribute the trigger, the clock and the slow control commands. The Readout
 1637 Electronic also performs auxiliary functions like the power supply lines monitoring to quickly
 1638 detect and interrupt latch-up states. On the experiment side, the RE feeds the CRU with
 1639 the MPD-ITS data and collects slow control commands and trigger signals.



Figure 5.14: Readout electronic main components.

1640 Other than signals management and flow control, the Readout Electronics is responsible
 1641 for managing the following tasks:

- 1642 • Trigger filtering, i.e. managing triggers too close in time to be successfully accepted by
 1643 the sensor.
- 1644 • Busy signal dealing with sensor/modules not able to handle a trigger.
- 1645 • Data labelling to associate data from the sensor with received trigger before sending
 1646 them to the CRU.
- 1647 • Monitoring the sensor status by recognizing a specific code-word in the data stream.
- 1648 • Generating the necessary clock/trigger patterns for the sensor, depending which
 1649 operation mode is selected (continuous/triggered).
- 1650 • Perform power monitoring to deal with latch-up states of the sensors.

1651 Figure 5.15 synthetizes the main functions the Readout Electronic will implement and
 1652 the data flow to/from the detector and the CRU.

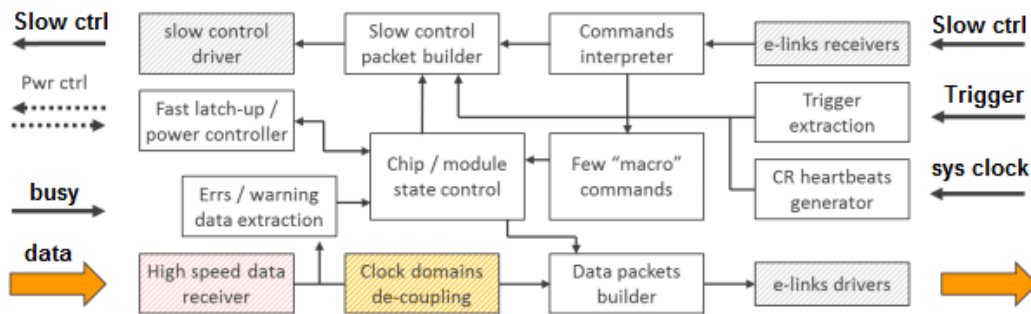


Figure 5.15: Readout Electronics main functions.

1653 The MPD-ITS will be readout and controlled by a cluster of Readout Units (RUs)
 1654 which will control, trigger and read each single sensor in the detector. The RUs receives
 1655 control commands and delivers data directly from/to the CRU via the MPD implementation
 1656 of the CERN Versatile Link. To maximize modularity, a single RU design will serve the
 1657 whole detector; the only difference between RUs attached to different layers being firmware
 1658 parameters. The current baseline architecture for the RU is sketched in Figure 5.16 where
 1659 only the most important connections are reported.

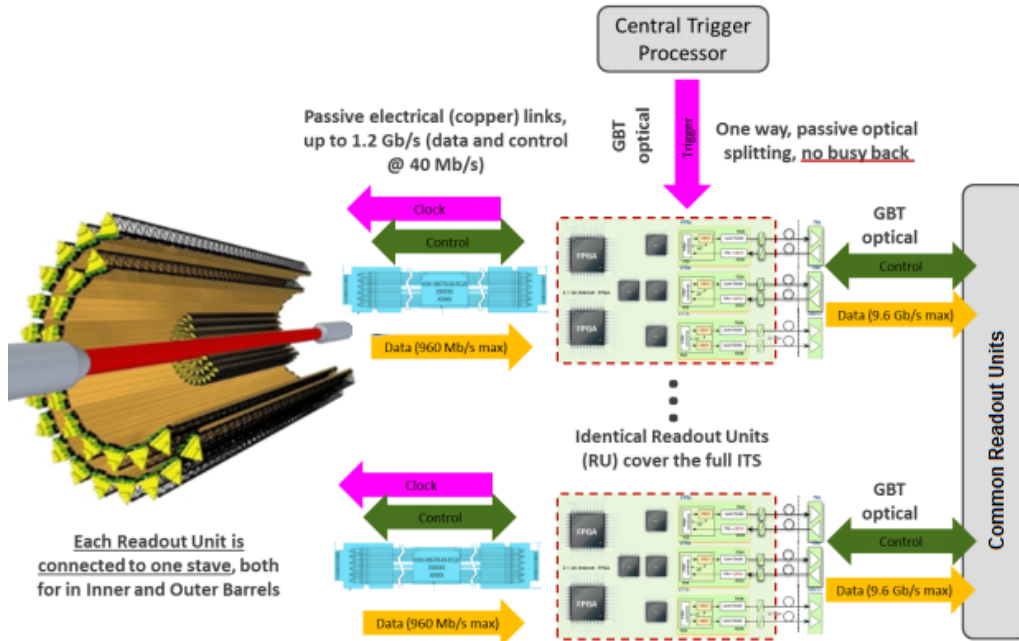


Figure 5.16: Readout Unit (RU) modular implementation.

1660 5.3.2 NICA-MPD ITS Readout Unit

1661 5.3.2.1 Structure of NICA-MPD ITS Outer Layer readout electronics

1662 The function of NICA-MPD-ITS RU is to implement the control and readout of the
 1663 Monolithic Active silicon Pixel Sensor (MAPS) of the ITS Outer Layers and to send the
 1664 data to the data acquisition system via high-speed serial interfaces.

1665 Since ITS is not involved in triggering, the RU only needs to passively receive the trigger
 1666 signal from the trigger system, and then generate the corresponding control signal to send
 1667 to the detector's ALTAI chip after receiving a valid trigger signal to start the data readout
 1668 process.

1669 The structure of the readout system is shown in the diagram below. The core component
 1670 of the system is the RU module, which is connected to the detector module via a cable and
 1671 sends control signals to the ALTAI chip on the one hand and receives data from the ALTAI
 1672 chip on the other. Then the processed data will be delivered to CRU via the GBT interface.
 1673 The diagram is shown in Figure 5.17.

1674 The effective data rate of the GBT interface is set at 3.2 Gbps with an effective rate of
 1675 320 Mbps (after 8b/10b) per channel of serial data stream, so that up to 10 ALTAI serial
 1676 interfaces can be connected to each GBT interface. Given the data transfer and the need
 1677 for trigger communication, three GBT fiber optic interfaces are designed on each RU module

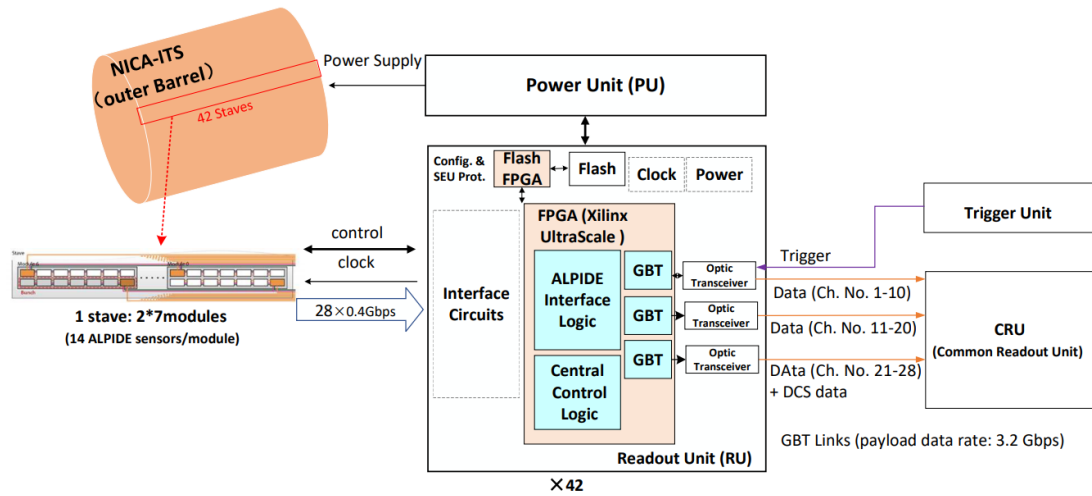


Figure 5.17: Structure of the readout system.

1678 which are used to send ALTAI data to the CRU and to receive trigger and clock signals from
 1679 the trigger unit.

1680 Besides, the RU module needs to communicate with the Detector Control System (DCS)
 1681 via the interface of the CRU. To simplify the system design, this function will be implemented
 1682 using one of the GBT interfaces for communication. The downlink fiber channel of the GBT
 1683 interface is used for the transmission of the DCS data; the uplink channel, which is responsible
 1684 for only 8 ALTAIs serial data, has a margin of data bandwidth (640 Mbps) and is used for
 1685 the transmission of uplink DCS information.

1686 5.3.2.2 RU module design

1687 5.3.2.2.1 Technical approach

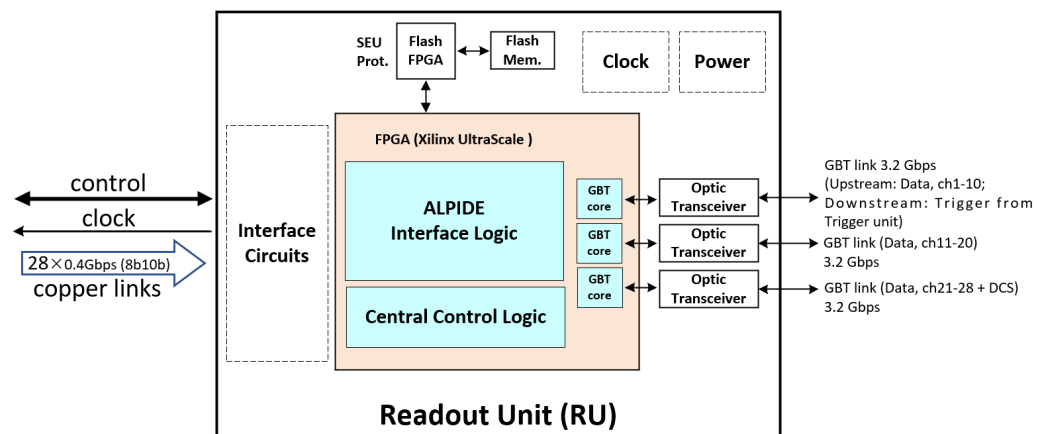


Figure 5.18: FPGA-based RU design solution.

1688 As mentioned above, the function of RU is ALTAI readout and packetized data transfer.
 1689 In this project, we considered two approaches to implement RU. The first technical approach

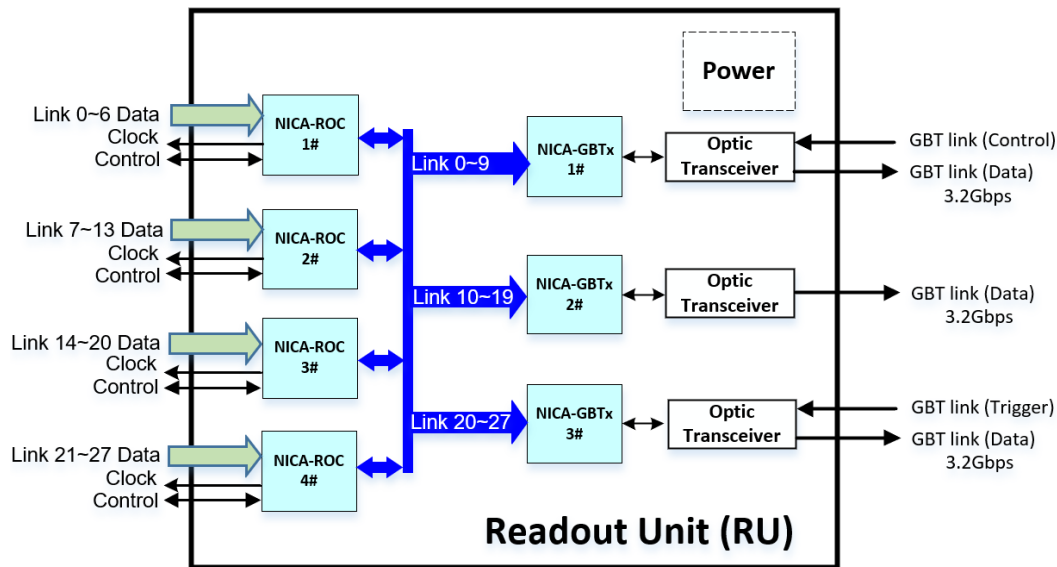


Figure 5.19: ASIC-based RU design solution.

1690 is based on FPGA implementation using FPGAs to complete data receiving, assembly, and
 1691 sending out. The other technical approach is based on ASIC implementation where NICA
 1692 ASICs are expected to be used to implement the main functions of the RU. The design
 1693 schemes of the two technical routes are shown in Figures 5.18 and 5.19.

1694 5.3.2.2.2 ALTAI data readout

1695 ALTAI is one of the MAPS chips originally designed for the upgrade of the CERN LHC
 1696 experiment ALICE-ITS using the Tower Semiconductor LTD. Towerjazz 0.18 μm CMOS
 1697 process.

1698 The structure of the final version of ALTAI, is shown in Figure 5.20 [1]. The single-chip
 1699 includes a total of 512 rows \times 1024 columns of pixels, with a pixel size of approximately
 1700 29.24 μm \times 26.88 μm , and its sensitive area is 30 mm \times 13.8 mm. Together with the width
 1701 of the peripheral circuitry at the bottom of 1.2 mm, the ALTAI's total width is 15 mm.

1702 The ALTAI chips use a global shutter readout, i.e. all pixels in the whole chip are shaped
 1703 and over-threshold screened at the same time and hit data latching is done under the control
 1704 of a trigger signal. When hit data is latched in the cache cell of any pixel, the front-end
 1705 readout circuitry automatically reads it out immediately under the control of the memory
 1706 selector signal. The front-end readout circuitry, which includes Priority Encoder and zero
 1707 compression, is shared between every two rows of pixels and transmits the latched data to
 1708 the periphery readout circuitry at the bottom of the chip after encoding with a high-speed
 1709 serial bus bandwidth of up to 1.2 Gbps and an effective trigger rate of up to 100 kHz - 200
 1710 kHz.

1711 ALTAI's data readout interface is divided into two groups. One is an 8-bit parallel readout
 1712 interface used in Single Data Rate (SDR) mode in which 8 bits are used, or in Double Data
 1713 Rate (DDR) mode in which only the lower 4 bits are used. The other set of interface outputs
 1714 8b/10b encoded high-speed serial data via a LVDS differential pair.

1715 In this project, 28 pairs of high-speed serial data will be transferred to RU separately.
 1716 After packing through the internal GBT logic of FPGA, the data will be sent out to CRU
 1717 from the high-speed transceiver.

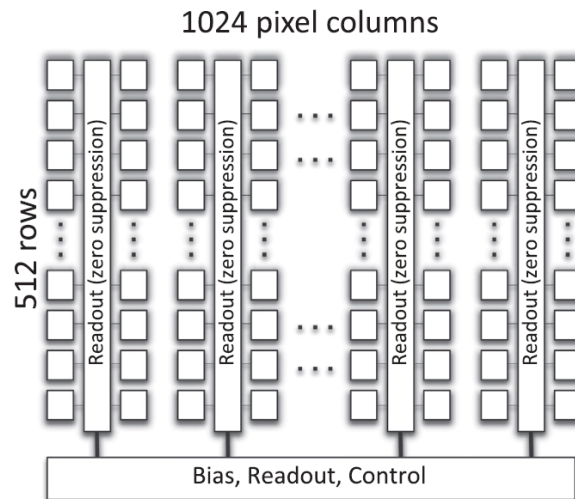


Figure 5.20: ALTAI chip structure.

1718 5.3.2.2.3 ALTAI control

1719 The next sections (1.3.2.2.3-1.3.2.2.5) elaborate the FPGA-based RU scheme, while the
 1720 ASIC-based readout scheme is specifically presented in "1.3.4.1 NICA_ROC". Due to the
 1721 complex structure of ALTAI, the number of pixels, and its register configuration parameters
 1722 up to 500,000, it is a significant task to achieve online configuration of ALTAI working
 1723 parameters. The configuration parameters will be generated by the DCS system and the
 1724 configuration data will be sent to the CRU via GBT interface, then to the FPGA on the RU
 1725 via the GBT downlink and finally distributed to the individual ALTAI chips.

1726 In this project, the control signals of ALTAI are transferred from the CRU to the high-
 1727 speed data transceiver of FPGA in RU, then processed by the FPGA logic, and finally fed
 1728 to each Stave. Since the control and clock signals at the ALTAI are MLVDS, a chip is used
 1729 to convert the LVCMOS signals to MLVDS signals. Besides, an uplink and downlink fiber
 optic interface is reserved for busy signal. The block diagram is shown in Figure 5.21.

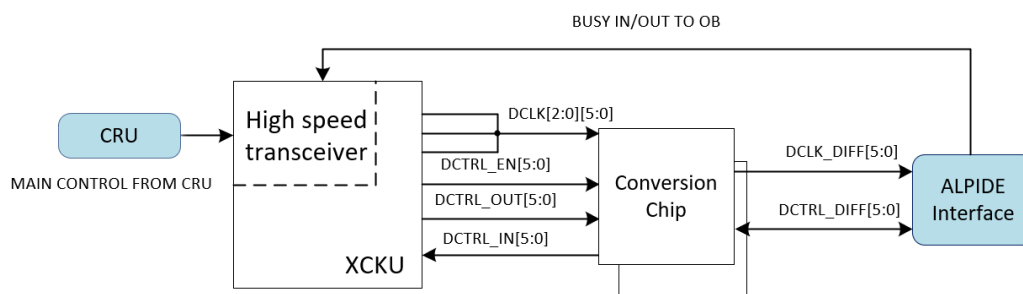


Figure 5.21: ALTAI control.

1730

1731 5.3.2.2.4 Configuration and Scrubbing of FPGA

1732 First, for RU design, the radiation dose where RU resides is very low, so it is not necessary
 1733 to consider the TID caused by electrons, but we still implement anti Single-Event Upset (SEU)
 1734 design to enhance the reliability of the electronics. In this regard, on the one hand, TMR

1735 (triple-mode redundancy) and even automatic error correction design are adopted for critical
 1736 configuration registers, critical global control signals, and critical data memories; on the other
 1737 hand, error detection (or error correction) design is adopted for important data streams.

1738 Second, the SRAM-type Xilinx's UltraScale series FPGA is used as the main FPGA
 1739 (i.e. the XCKU FPGA in Figure 5.22) in RU for implementing large-scale, high-performance
 1740 digital logic. However, to prevent it from SEU, a flash-type FPGA (immune to SEU) is
 1741 added outside the main FPGA, as shown in the figure below. The scrub control signals are
 1742 used for the scrubbing operation, while the 8-bit select map signal is used to indicate which
 1743 region of the main FPGA will be scrubbed, and the GPIOs & DP IOs are the ports for the
 1744 bit stream transfer between the main FPGA and the flash FPGA. Switches are also reserved
 1745 to ensure the customized and fast transfer of configuration information. The configuration
 1746 of the FPGA is stored in the flash memory, and the flash FPGA periodically reads back
 1747 configuration information from the master FPGA and verifies it. Once an SEU error is
 1748 found, that part of logic will be reconfigured, while the logic function of the FPGA remains
 1749 unchanged during this process. The block diagram is shown in Figure 5.22.

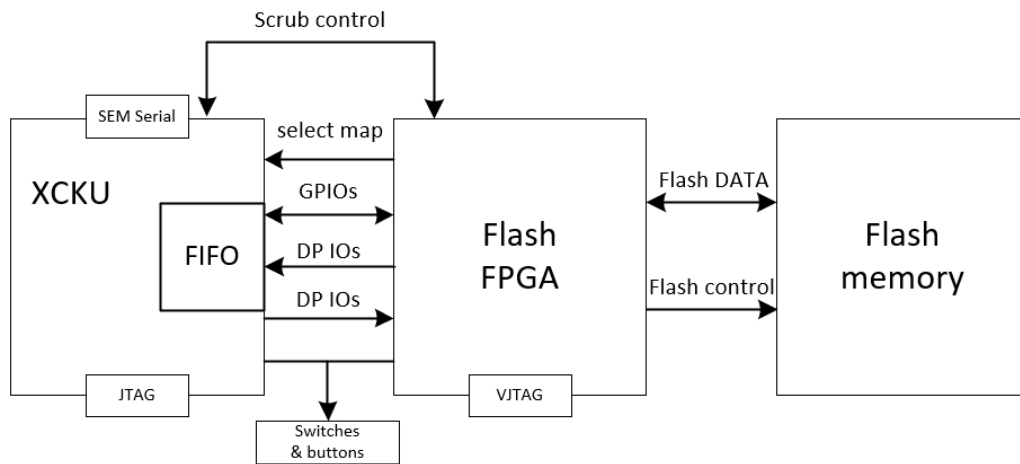


Figure 5.22: Configuration and Scrubbing.

1750 Finally, as shown in Figure 5.22, because Xilinx FPGA has an automatic error correction
 1751 function Soft Error Mitigation (SEM), a serial port is reserved for connecting with a PC
 1752 to achieve the effect of supervision and scrubbing as described in its official manual.

1753 5.3.2.2.5 High-speed data interface

1754 In this project, the high-speed data interface between the RU module and the back-end
 1755 data acquisition system is proposed to be implemented using the GBT link proposed by
 1756 CERN. The background of GBT generation is that the strong radiation environment brought
 1757 by the high-energy particle collision after the LHC upgrade has put forward the demand
 1758 for irradiation tolerance performance for the front-end electronics, and the long-distance
 1759 transmission between the front-end electronics and the back-end electronics is prone to bit
 1760 error. For this reason, CERN conducted development of GBT, to ensure the reliability of
 1761 the data transmission in high radiation environments. The outcome includes an radiation
 1762 tolerant GBT chipset, the GBT frame, a data format that enables data error detection,
 1763 and the GBT-FPGA core, a code containing the functions of the GBT chip which can be
 1764 implemented in FPGAs.

1765 The data transfer process between the front-end electronics and the back-end data

1766 acquisition system based on the GBT protocol is shown in Figure 5.14. The left side is
1767 the front-end electronics of the detector, which consists of an radiation tolerant electronics
1768 chipset (e.g. CERN's GBTx chip, or other ASIC chips conforming to the GBT protocol),
1769 or FPGAs containing the similar functionality; the right side is the CRU and CTP, which
1770 consists of commercial devices. The long-distance bidirectional data transmission between
1771 the CRU & CTP and the front-end electronics is accomplished through a Versatile Link with
1772 a data rate of 4.8 Gbps and a user data rate of 3.2 Gbps.

1773 Besides, the RU have a serial interface to the Power Unit (PU) which is described in the
1774 following sub-section. And one RU controls two PUs, with RU as the master to initiate read
1775 and write process.

1776 5.3.3 NICA-MPD ITS Power Unit

1777 5.3.3.1 Structure of the power system in ITS Outer Layer of NICA

1778 Power Board (PB) is designed for powering the ALTAI staves. Each PB consists of two
 1779 PUs including a Power Unit Right (PUR) and a Power Unit Left (PUL). The structure of
 1780 the power system for the ITS Outer Layer is shown in Figure 5.23. A CAEN power supply
 1781 system powers the PUs that in turn supply power to the staves and monitor them. PUs are
 1782 controlled and monitored by RUs through a serial interface, as mentioned above.

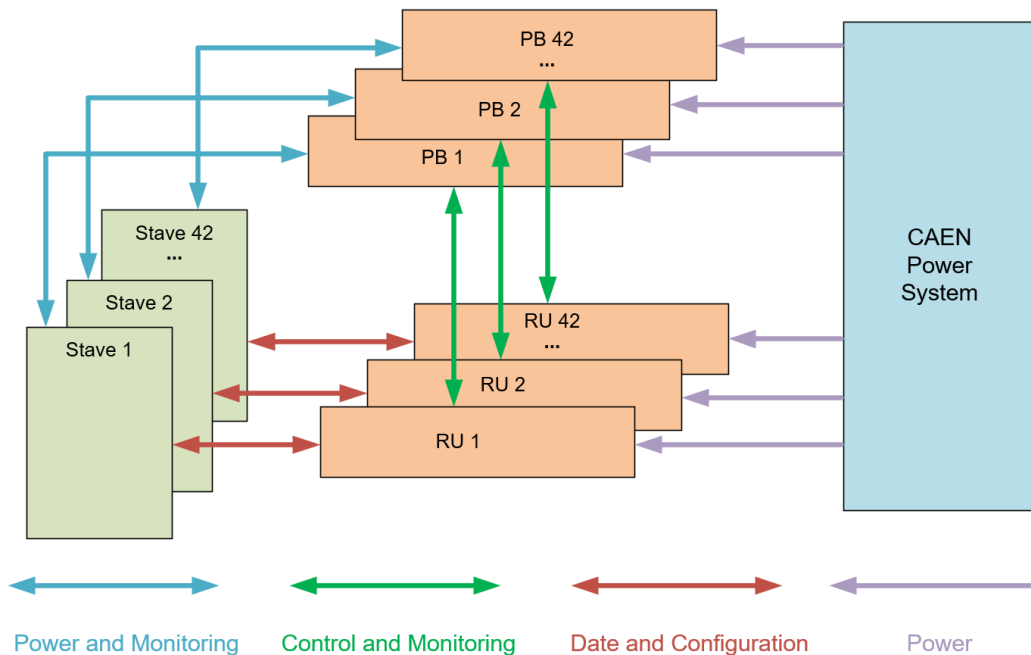


Figure 5.23: The structure of the power system in NICA.

1783 5.3.3.2 Functionality of the PU

1784 PU supplies 1.8 V positive power, as well as negative power used as bias for the staves. The
 1785 Low Dropout Regulator (LDO) used in PU should have low noise. Besides, high current
 1786 capability should be taken into consideration during positive LDO selection.

1787 In addition to supplying power to the staves, PU is also controlled by RU through the
 1788 serial interface to implement the following functions:

- 1789 • Separate enabling of power channels and bias channels;
- 1790 • Adjusting the power supply voltage separately;
- 1791 • Adjusting the bias voltage in one PU;
- 1792 • Over current protection with adjustable threshold on each power channel;
- 1793 • Overheat protection on each PU;
- 1794 • Monitoring of voltage, current and temperature.

1795 In NICA, we consider taking use of VersaModule Eurocard (VME) crates (VME 6023-
 1796 913) to integrate PBs and RUs. There are 3 slots for 6U/160mm VME64 cards and 17 slots
 1797 for 9U/400mm VME64 cards in one crate. A total of 9 VME crates are needed for the ITS
 1798 Outer Layer. The arrangement of RUs and PBs is shown in Table 5.3 and Figure 5.24.

Table 5.3: Arrangement of RUs and PBs.

	Number of Staves Number of RUs	Number of PB	Location of (RU+PB) in four frames of crates
L3	18	18	(5+5) (5+5) (5+5) (3+3)
L4	24	24	(5+5) (5+5) (5+5) (5+5) (4+4)

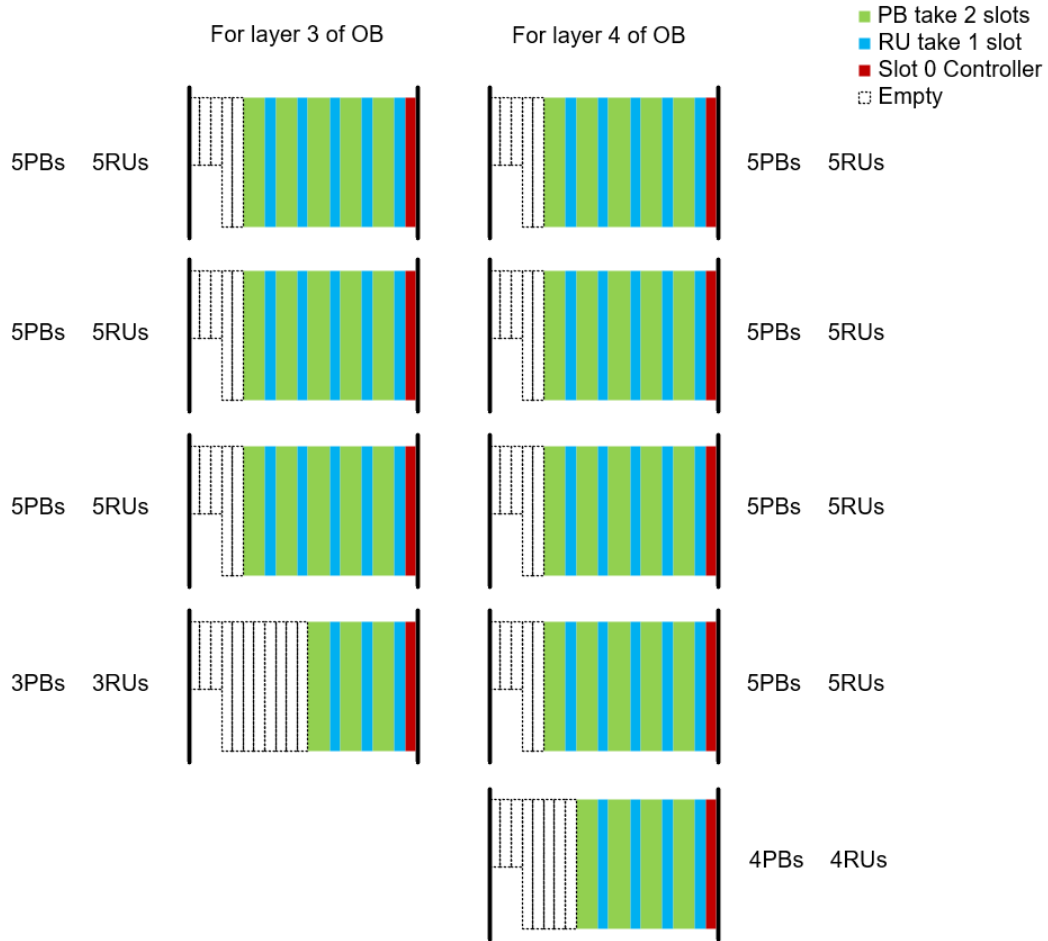


Figure 5.24: Arrangement of RUs and PBs.

1799 5.3.3.3 PB module design

1800 In reference of the structure of the PB in ALICE, one PB consists of two functionally identical
 1801 and operationally indistinguishable Power Units (PUR and PUL) referenced to the same
 1802 ground. The circuitry on each PU is distributed mainly to three power domains: two positive
 1803 voltage domains and one negative voltage domain. Each PU generates 16 nominally 1.8 V
 1804 power supply voltages with high current strength and 4 additional negative voltage outputs
 1805 with low current strength that are used as bias for the staves. The PUR receives input power

1806 from the external CAEN power supply, and the PUL receives input power from the PUR.
 1807 The block diagram of PB is shown in Figure 5.25. When the PU supplies power to the Outer
 1808 Layers, a PU provides 7-way positive voltage analog power supplies, 7-way positive voltage
 1809 digital power supplies and 3-way negative voltage bias outputs.

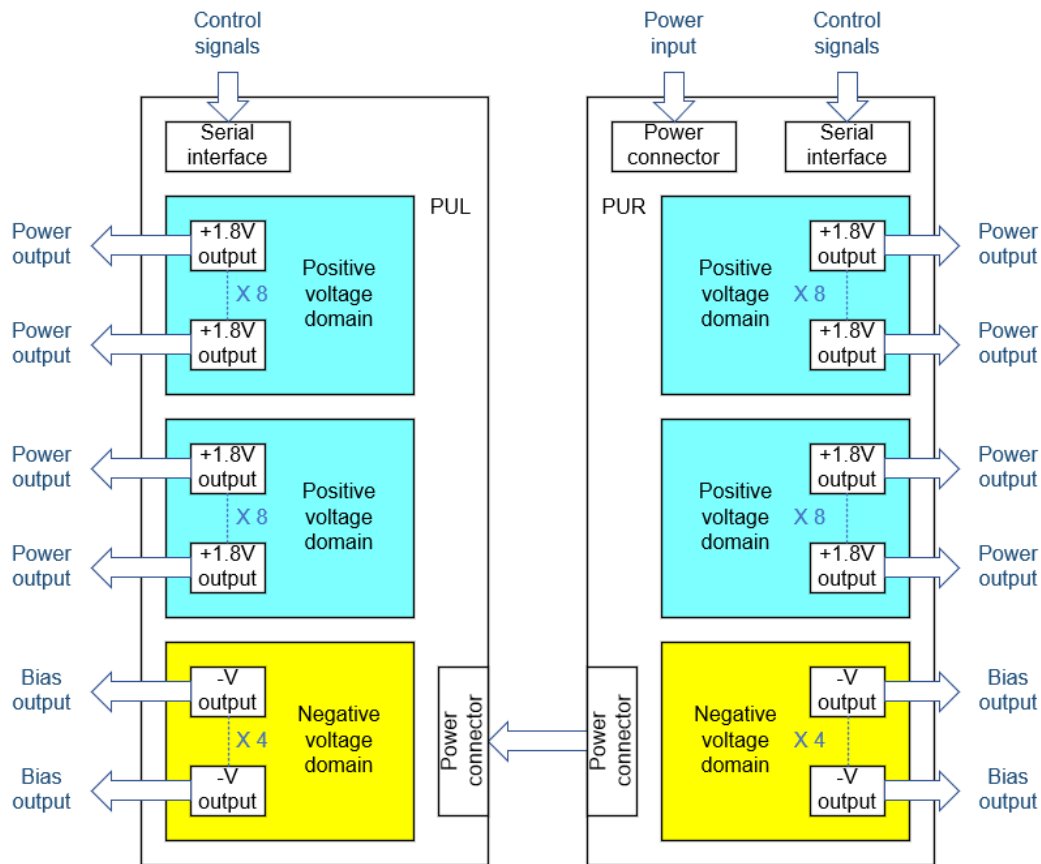


Figure 5.25: The scheme of PB.

1810 CAEN power system provides PUs with positive voltage power and negative voltage
 1811 power. The positive voltage power is directly supplied by CAEN A3009PS. The first negative
 1812 voltage power in the same VME crate is supplied by CAEN A2519, and the rest is supplied
 1813 by the daisy chain. The power input connection is shown in Figure 5.26.

1814 In order to achieve heat dissipation during normal operation, heat exchanger is equipped.
 1815 The temperature of each PU can also be monitored by an on-board temperature sensor. Each
 1816 PU is equipped with multiple LEDs on the front panel to indicate the status of each part,
 1817 which helps to identify possible problems.

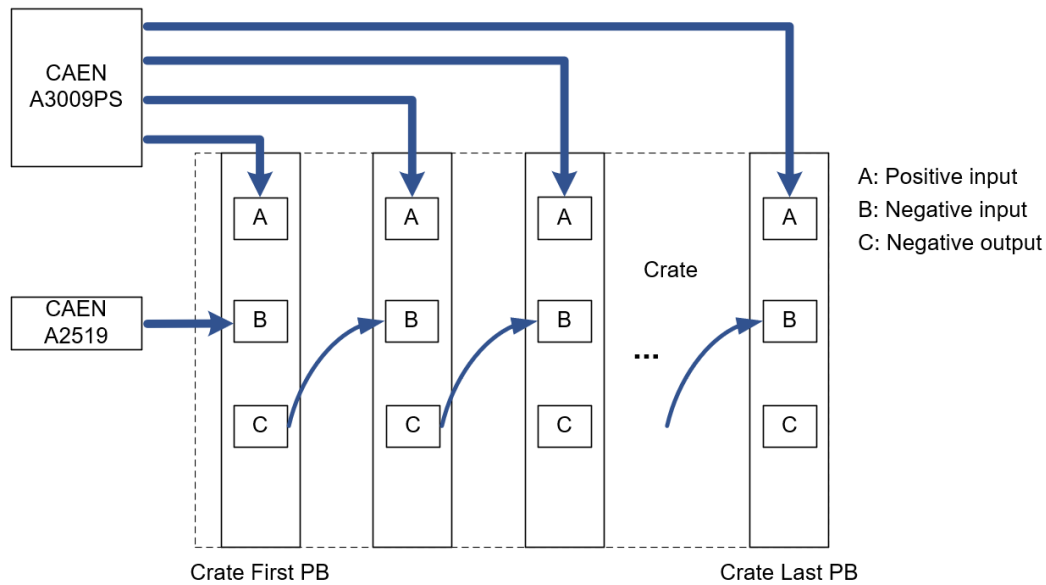


Figure 5.26: Power input connection.

1818 5.3.4 NICA ASICs

1819 As a second approach to implement the readout electronics for the outer barrel of ITS, a
 1820 series of ASICs (NICA_ROC, NICA_GBTx, NICA_LD and NICA_TIA) is also planned to
 1821 be developed as shown in Figure 5.27. All these ASICs would be located on the RU board.

1822 NICA_ROC is being designed to concentrate the output data of front-end ALTAI chips
 1823 and transfer the packaged data to the following NICA_GBTx ASIC. It also receives control
 1824 commands, clocks, and trigger signals from the backend and distributes them to ALTAI chips.

1825 NICA_GBTx is a high-speed bidirectional data interface ASIC for optical links. It
 1826 receives multichannel data from the front-end (NICA_ROC), performs scrambling, encoding,
 1827 frame building and serializing as the main function for the up-link direction. And it also
 1828 receives high-speed serial data from the back-end, performs CDR (Clock and Data Recovery),
 1829 deserializing, decoding and distributing to the front-end as the main function for the down-link
 1830 direction.

1831 NICA_LD (Laser Driver) and NICA_TIA (Transimpedance Amplifier) are two analog
 1832 ASICs that would be integrated together with the laser and PD (Pin Diode) in the customized
 1833 optical transceiver module. NICA_LD receives the high-speed up-link serial data from
 1834 NICA_GBTx and amplifies the signal to drive the laser. NICA_TIA receives the down-
 1835 link serial signal from the pin diode, and amplifies the signal to NICA_GBTx, so that the
 1836 data can be further processed in NICA_GBTx. These four ASICs will be introduced in
 1837 the following sections.

1838 5.3.4.1 NICA_ROC

1839 As depicted in Figure 5.28, the NICA_ROC will aggregate data from up to 8 ALTAIs. Each
 1840 ALTAI data connection is a 400 MHz serial link in the outer barrel mode with the data
 1841 being 8b/10b encoded. The input data from each channel needs to be recovered, decoded,
 1842 preprocessed and buffered. For flexibility, the crossbar routes the 8 input channel data to
 1843 different sDACT captures for packaging and reformatting. And the connection between
 1844 NICA_ROC and NICA_GBTx is based on the HSSI (High-Speed Serial Interface) protocol
 1845 (such as the E-LINK interface).

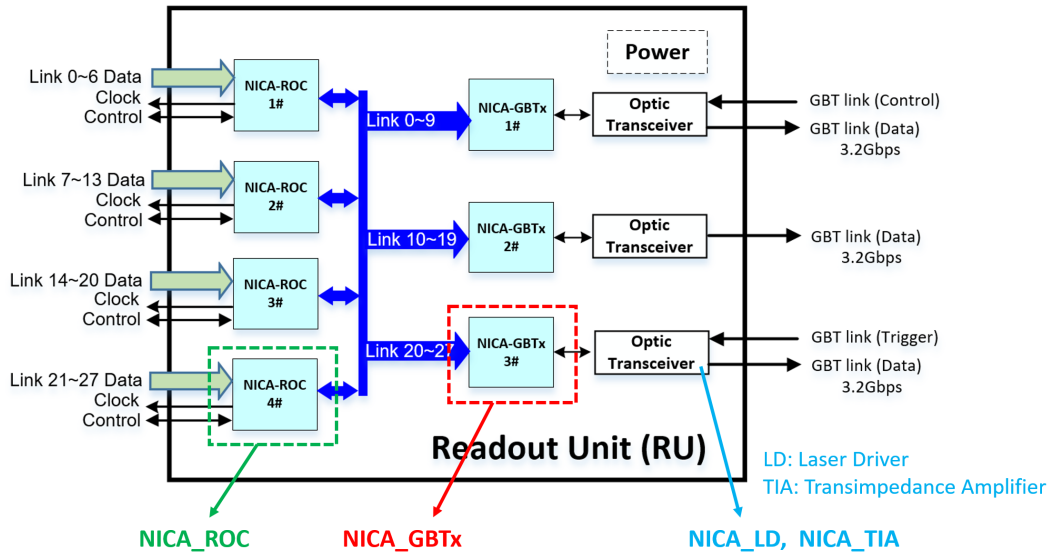


Figure 5.27: ASICs in the readout electronics system.

1846 For the TTC (Timing, Trigger and Control) data flow path, the NICA_ROC receives TTC
 1847 information from the Common Readout Unit (CRU) and the trigger system and forwards
 1848 them to the ALTAI chips. The PLL in NICA_ROC receives a synchronous clock signal from
 1849 the back-end system via GBTx and fans out the clock to ALTAIs and data transfer blocks
 1850 after in-chip phase modulation.

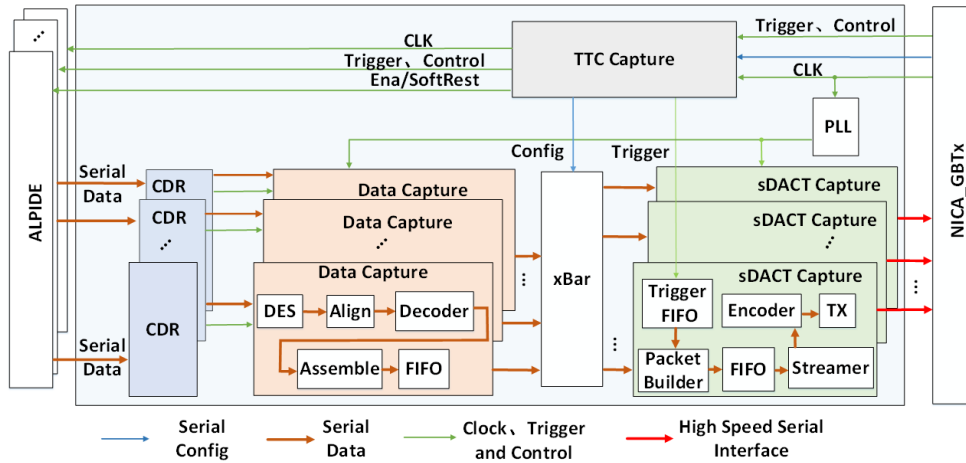


Figure 5.28: Block diagram of NICA_ROC structure.

1851 **5.3.4.1.1 Data Capture block**

1852 The Deserializer (DES) in the Data Capture block converts the serial data to 10-bit
 1853 parallel data and the Comma Align block monitors the presence of the comma character
 1854 K28.5 in the DES output stream. Once this character is identified, the proper boundary can
 1855 be settled, and the synchronization is achieved between ALTAI and NICA_ROC.

1856 The aligned data is decoded by an 8b/10b decode circuit with 10-bit input and 8-bit
 1857 output, and the 8-bit words from decoder are further assembled into 32-bit words in the

1858 Assembler block. With 4-bit additional message added, finally, 36-bit words are sent to the
 1859 FIFO.

1860 The FIFO stores the 36-bit words and implements the clock domain crossing between 400
 1861 MHz and 40 MHz. The diagram is shown in Figure 5.29

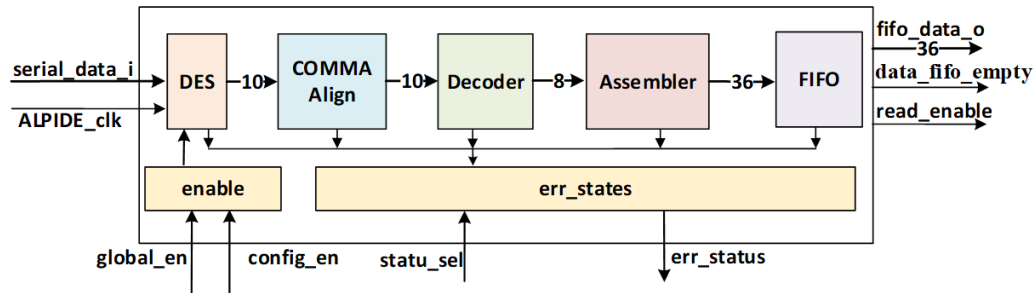


Figure 5.29: Block diagram of Data Capture.

1862 5.3.4.1.2 xBar block

1863 The xBar block is a fully combinational logic circuit that routes 8 Data Capture modules
 1864 to 8 sDACT capture block in a full-mesh network. The connection between the Data
 1865 Capture block and the sDACT capture block can be configured according to the application
 1866 requirement. The xBar block consists of 8 DMUXes on Data Capture side and 8 MUXes on
 1867 sDACT side. Figure 5.30 shows a simplified structure.

1868 Each sDACT receives 8 configuration bits corresponding to the destination Data Capture
 1869 blocks. For example, if the sDACT 0 is connected to Data Capture 0, Data Capture 5 and
 1870 Data Capture 7, the configuration bits received by sDACT 0 will be 1010_0001. Because at
 1871 a certain moment, each sDACT can connect only one Data Capture, another 3 configuration
 1872 bits are sent to each sDACT representing the current connection.

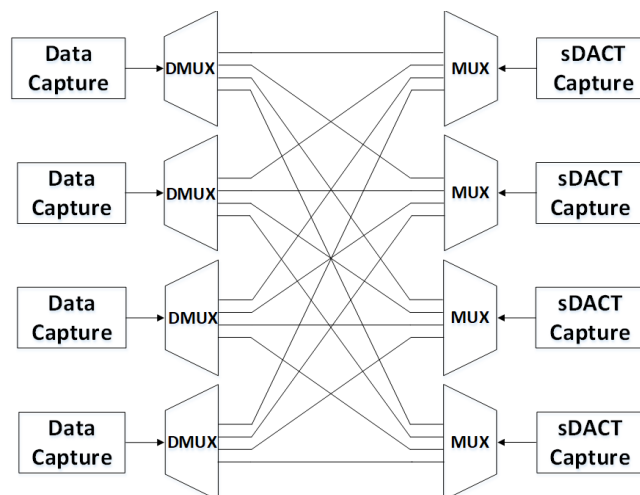


Figure 5.30: Simplified block diagram of the xBar structure.

1873 5.3.4.1.3 sDACT Capture block

1874 sDACT Capture block receives data from data capture block through xBar, forms data
 1875 packets based on the trigger signal received by TTC Capture block. After receiving the trigger
 1876 signal, the data packaging process starts. The sDACT capture reads data from the connected
 1877 data capture FIFO in a circular manner, and the trigger ID, packet header (SOP) and packet
 1878 trailer (EOP) are added to the data packet. Besides, the busy_on and busy_off flags also
 1879 inserted in the data stream according to the busy status of ALTAI and NICA_ROC.

1880 After 8b/10b encoding, the output data is sent out of the chip by a parallel-to-serial
 1881 conversion block. The final output port uses E-LINK protocol to match with the back-end
 1882 GBT ASIC.

1883 The diagram is shown in Figure 5.31

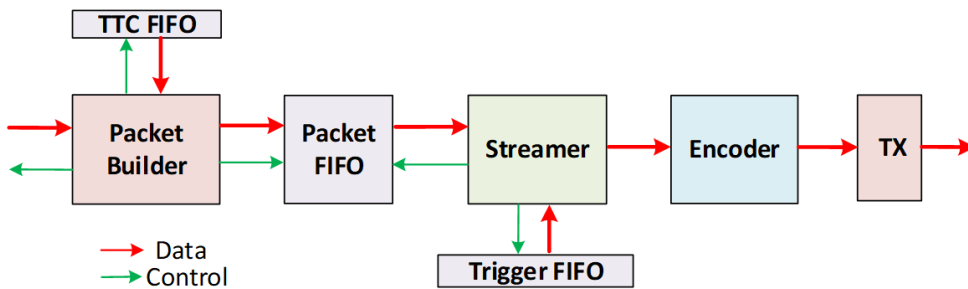


Figure 5.31: Structure of the sDACT block.

1884 5.3.4.1.4 TTC Capture block

1885 The TTC Capture receives clock, trigger and control signals and forwards to ALTAI chips
 1886 and other blocks in the NICA_ROC. For control data path, the serial input is DDR on the
 1887 40 MHz clock, resulting in an 80 Mbps data stream. The TTC Capture extracts ALTAI
 1888 configuration words and NICA_ROC configuration words from the control data stream
 1889 respectively, and also transmits back the status of ALTAI and NICA_ROC to CRU. For
 1890 trigger data path, once the trigger signal is received, the corresponding trigger ID will be
 1891 stored in the Trigger FIFO, which will be used to mark data packets. When the busy signal
 1892 in NICA_ROC is valid, the trigger signal will be masked.

1893 5.3.4.2 NICA_GB Tx and NICA_LD/TIA

1894 The NICA_GB Tx and NICA_LD/TIA are chipsets that constitutes the complete
 1895 electrical functions of a high-speed bidirectional optical data transmission system. The
 1896 NICA_GB Tx serves as the data interface chip mainly performing the encoding/decoding,
 1897 serializing/deserializing tasks. The NICA_LD/TIA are two analog AISCs that would be
 1898 respectively integrated with the laser and pin diode in the optical transceiver module. Figure
 1899 5.32 depicts the bidirectional optical data transmission system with these three ASICs.

1900 5.3.4.2.1 NICA_GB Tx

1901 The NICA_GB Tx receives multi-channel data from the front-end (NICA_ROC),
 1902 processes the parallel data to the encoded high-speed serial data for the uplink transmission.
 1903 And for the downlink direction, it receives the data stream from back-end, decodes the data
 1904 and distributes to the front-end.

1905 Currently the NICA_GB Tx is planned to be compatible with the GB Tx to some extent.
 1906 An internal block structure of the NICA_GB Tx is shown in Figure 5.33 revealing the main
 1907 functions of the AISC. It is mainly composed of the D-Link interface, data phase control,

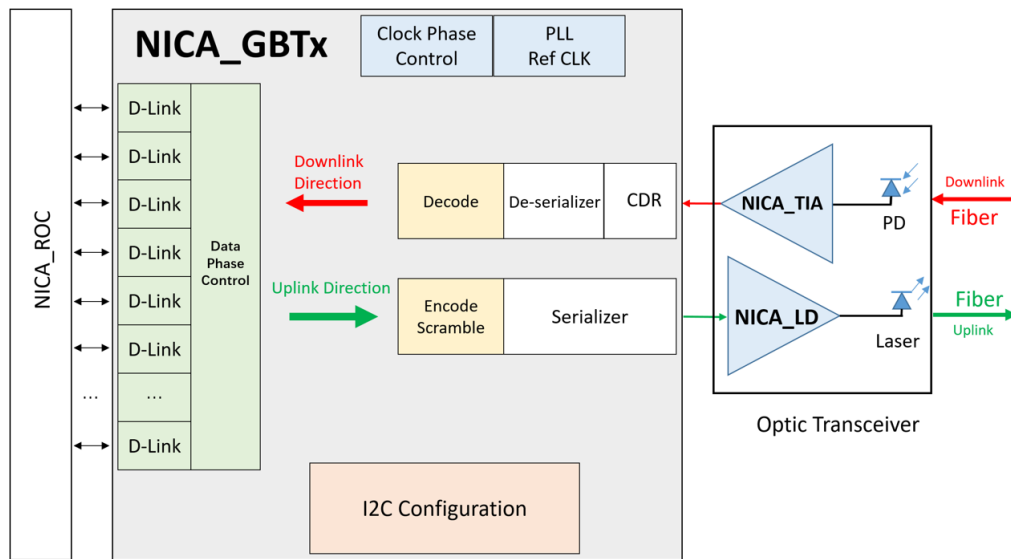


Figure 5.32: Bidirectional optical transmission system with NICA_GBTx, NICA_LD/TIA.

1908 phase lock loop (PLL), clock phase control, encoder/decoder, serializer/deserializer and clock
 1909 data recovery (CDR) sub-modules.

1910 The D-Link is a universal Tx/Rx interface to/from the front-end. To be compatible with
 1911 the GBTx chip, each D-Link will consist of three signal lines (differential pairs): differential
 1912 clock, differential downlink data output (to NICA_ROC and front-end), differential uplink
 1913 data input (from NICA_ROC). The Data phase control module together with each D-link
 1914 is used to adjust/align the phase of the input data (uplink) for reliable sampling within the
 1915 NICA_GBTx. The encode/decode modules perform the digital function of the ASIC, the
 1916 data protocol is currently planned to follow the GBTx data frame that is adopted in the
 1917 ALICE readout system.

1918 The serializer submodule receives parallel data from the encode module, and transforms
 1919 to the high speed serial signal as the final output of the NICA_GBTx in the uplink direction.
 1920 The deserializer submodule receives serial downlink data, transforms the serial data back to
 1921 the parallel data for the decode submodule. The downlink data will finally be recovered after
 1922 decoding and then send to the front-end via D-Link. The CDR circuit will also be integrated
 1923 within the deserializer to recover the clock from the downlink data. Besides, an independent
 1924 PLL submodule would also be included within the NICA_GBTx. It will generate internal
 1925 clock through the external reference clock, and the generated clock can also be distributed
 1926 to the front-end via D-Link for the clock synchronization consideration.

1927 More specifications and details for each submodule need to be decided and added here
 1928 after further joint discussion from the system level.

1929 5.3.4.2.2 NICA_LD

1930 NICA_LD is a laser driver ASIC located at the uplink direction as shown in Figure
 1931 5.32. It receives high speed serial data from NICA_GBTx, amplifies and transfers it to the
 1932 current signal to driver laser in the optical transceiver module. Figure 5.34 demonstrates the
 1933 block diagram of the NICA_LD prototype under design. In the current prototype design,
 1934 NICA_LD is a four channel array laser driver that would work with a four channel laser array
 1935 (VCSEL Array). In this case, one optical transceiver module can provide four independent

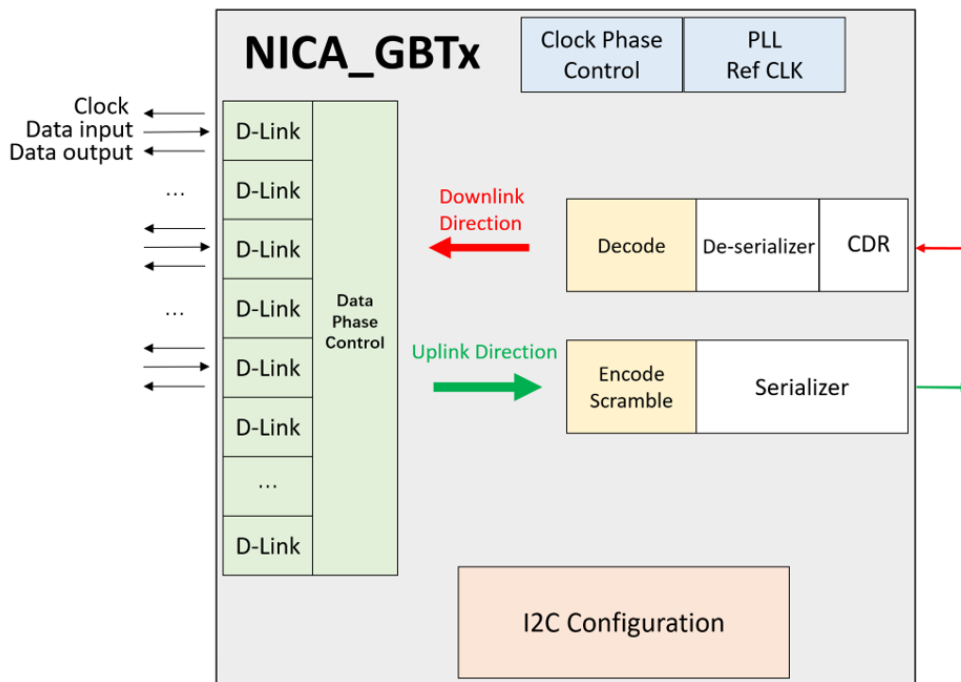


Figure 5.33: Block diagram of NICA_GBTx.

1936 optical transmit channels. However, the final form and channel number of the NICA_LD
 1937 will be decided and updated here after further discussion from the system level.

1938 It mainly consists of the pre-driver stage and the output driver stage. The pre-driver
 1939 stage, working as a limiting amplifier (LA), receives the high speed differential signals (CML
 1940 signals normally) and amplifies them to suffice magnitude with high enough bandwidth. The
 1941 output driver stage would transfer the differential voltage signals to the single-end current
 1942 signal for driving the laser outside the chip.

1943 The vdd12 and vdd25 power supplies shown in Figure 5.34 are currently compatible with
 1944 the GBLD laser driver from CERN. It may change according to the power supply conditions
 1945 at the system level.

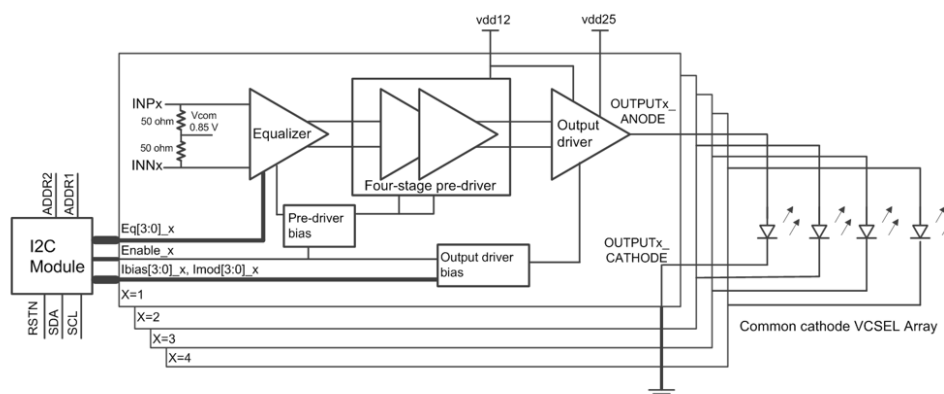


Figure 5.34: Current block diagram of NICA_LD prototype.

1946 5.3.4.2.3 NICA_TIA

1947 NICA_TIA is an analog transimpedance amplifier ASIC located at the downlink direction
 1948 as shown in Figure 5.32. It receives high speed serial data (small current signal) from PD
 1949 in the optical module, amplifies and transfers it to the differential voltage signals (CML signals).
 1950 Figure 5.35 illustrates the block diagram of the NICA_TIA prototype under design. Similar
 1951 to the current NICA_LD prototype, NICA_TIA adopts also the four channel array form,
 1952 which will work with a four channel PD array. The final form and channel number of the
 1953 NICA_TIA will also be decided by further discussion.

1954 The main submodules of the NICA_TIA are TIA core and limiting amplifier as shown in
 1955 Figure 5.35. The TIA core directly receives the small current signal from PD and performs
 1956 the transimpedance amplify to obtain the voltage signal at the first step. The following
 1957 limiting amplifier would further amplify the signal using the differential stages. The final
 1958 output driver stage is a CML driver to deliver the standard CML logic output.

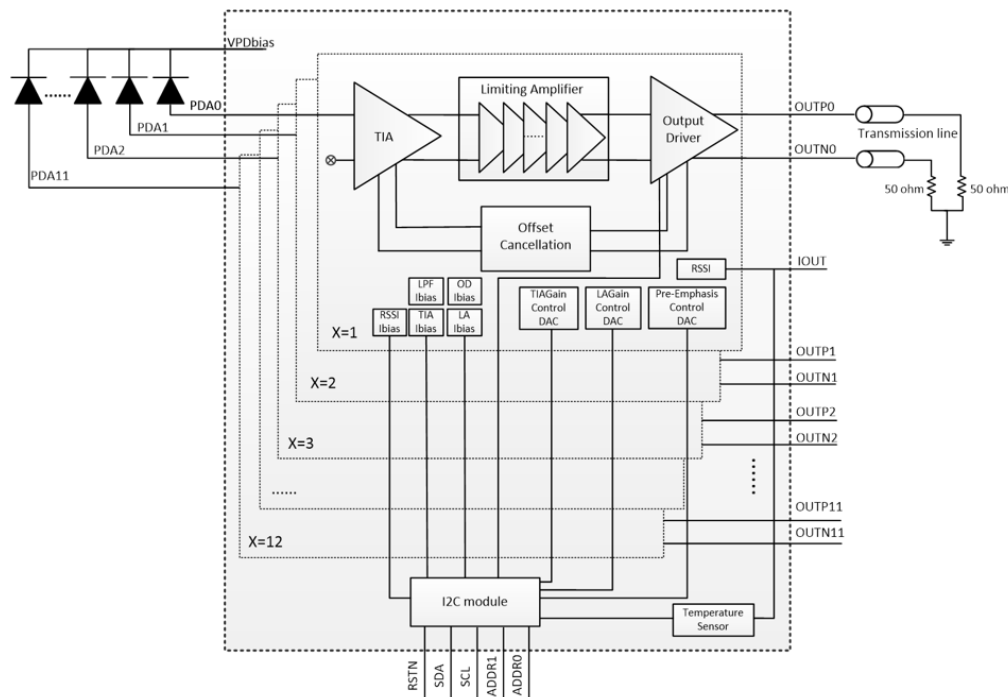


Figure 5.35: Current block diagram of NICA_TIA prototype.

1959 Bibliography

- 1960 [1] ALICE collaboration, ALPIDE: the Monolithic Active Pixel Sensor for the ALICE ITS
1961 upgrade, Nuovo Cimento C 41 (2018) 91. 3 p.

1962 6 The detector control system of ITS

1963 6.1 Tasks of the ITS management and control system

1964 The MPD is a modern experimental setup with complex sub-detectors, one of which is the
1965 Inner Tracking System (ITS). During the collection of experimental data, it is necessary to
1966 monitor the state of the working systems of the ITS in an automated mode. It is also essential
1967 to control and monitor the configurations of the data acquisition system in express-offline
1968 mode, including storage, management and visualization of the settings of the components of
1969 the readout electronics and trigger (voltage thresholds, time delays, etc.). The status of the
1970 ITS systems and the configuration of the data acquisition system directly affect the quality
1971 of the recorded data, which also needs to be monitored.

1972 One of the main components that ensure a failure-free operation of the detection
1973 subsystems is the so-called “slow” control system, which performs the functions of controlling
1974 and monitoring the nodes of a physical installation. The reliability and correct operation
1975 of the MPD and its electronic components depend on the control and management systems
1976 for the main parameters of the equipment: supply voltage, current consumption of modules
1977 and their individual functional units, temperature of microcircuits, environmental humidity
1978 and a number of other parameters. Monitoring and control of all the indicated parameters is
1979 performed by the Detector Control System (DCS), which allows to control the detector as a
1980 whole, as well as its subsystems, and to respond to errors that may occur, avoiding critical
1981 states of devices.

1982 The DCS should provide:

- 1983 • continuous and safe sub-detector control;
- 1984 • uniform interface to all sub-detectors and elements of technical infrastructure;
- 1985 • turning the sub-detectors on and off;
- 1986 • changeable configuration of electronics;
- 1987 • synchronization of all control and monitoring processes;
- 1988 • control of installation parameters, generation of alarm and warning messages;
- 1989 • archiving of the controlled and monitored MPD parameters;
- 1990 • safe operation of the MPD.

1991 The processing system must meet the most stringent requirements for control systems
1992 and research automation and be certified for a high level of security, which simplifies the
1993 overall certification of the control system.

1994 The Supervisory Control And Data Acquisition (SCADA) system for processing,
1995 visualizing and storing data should be suitable for use in large and complex applications
1996 with high demands on scalability, reliability and security, and should provide implementation
1997 of special user functions.

1998 The ALICE experimental setup at CERN is used as a prototype for design of the MPD.
1999 In particular, many systems of the MPD ITS are either copies or modified versions of the
2000 ones of the ALICE ITS. The structure and solutions used in DCS of MPD ITS closely follow
2001 the DCS of ALICE ITS.

2002 The ITS DCS will be a part of the general MPD DCS. It is based on WinCC OA software
2003 platform developed by ETM company, owned by Siemens AG [1], and uses the JCOP [2]

and UNICOS [3] software framework containing common tools and components of control systems developed by collaboration of CERN experiments.

6.2 Architecture of the ITS management and control system

The ITS DCS will control the operation of the power supply system, the cooling system and the front-end electronics. It is a subsystem of the general MPD DCS, but it should be able to work autonomously for maintenance and troubleshooting operations. For that it should store locally all necessary configuration data, and its local operator's GUI should have the relevant design. A finite state machine (FSM), describing the ITS, should be included in the ITS DCS.

The MPD detector control system assumes a three-level hierarchical structure. The two upper levels of the control system are based on SCADA. These levels contain one system per sub-detector and one root control node. To ensure convenience in working with the nodes of the control system, several User Interfaces (UI) are used, connected to each node and running on separate computers. Thus, each of these additional control computers has the ability to execute window panels of several distributed subsystems.

The lower level of the hierarchy of the control system consists of server computers that provide exchange with sub-detector equipment in order to offload the upper-level computing power from the equipment polling procedures performed on a low-level communication protocol that require significant computer time. SCADA should only receive filtered result information containing only relevant data.

The general scheme of ITS DCS control is depicted in Figure 6.1.

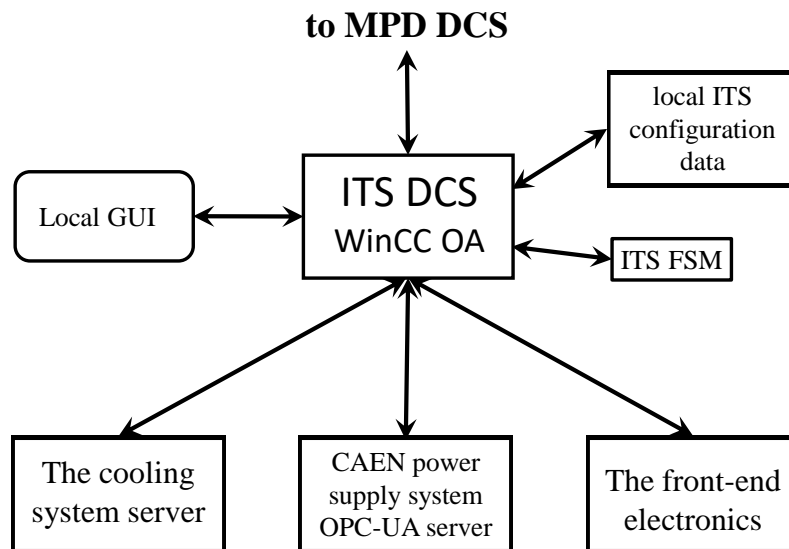


Figure 6.1: Scheme of the ITS DCS.

6.3 Main components of the ITS DCS

6.3.1 Low Level Interfaces (DIM, OPC)

The developed communication interfaces (communication servers) must correspond to an increased data transfer rate, since the transmitted data volume will be quite large.

2029 Communication interfaces should be able to be flexibly configured when replacing and
 2030 disconnecting electronics modules.

2031 The lower level of the hierarchy of the control system consists of server PCs that provide
 2032 exchange with sub-detector equipment. The server should be able to debug and test the
 2033 system at a low level and should allow to see the flow of information in the I/O system.
 2034 If the communication protocol with the equipment is complex, it is necessary to develop a
 2035 hardware emulator that will simplify the diagnosis of the problem and troubleshooting.

2036 The Object Linking and Embedding (OLE) Process Control protocol is based
 2037 on Component Object Model/Distributed Component Object Model (COM/DCOM)
 2038 technology. The Distributed Information Manager protocol (DIM) was developed at CERN.
 2039 The DIM software package includes the WinCC OA API managers for both the DIM client
 2040 and server. The DIM addresses variables by their name. The sub-detector must have its own
 2041 domain to provide internal exchange between servers and clients.

2042 Programs that provide exchange with hardware should be compiled executable modules
 2043 that are “hardware servers”.

2044 6.3.2 Control of the ITS Power Supply System

2045 CAEN low voltage power supply system provides power for the MPD ITS. A scheme of the
 2046 power supply control chain is depicted in Figure 6.2. The ITS DCS communicates with the
 2047 JCOP OPC-UA server running on a LINUX PC via OPC-UA protocol.

2048 The server communicates with the CAEN software running on A4548 CPU installed in
 2049 SY4527 mainframe crate of the power supply system. A proprietary communication protocol
 2050 built on top of the IP is used, with Ethernet being the physical link. The server is, actually,
 2051 an interface between the OPC-UA and CAEN protocols.

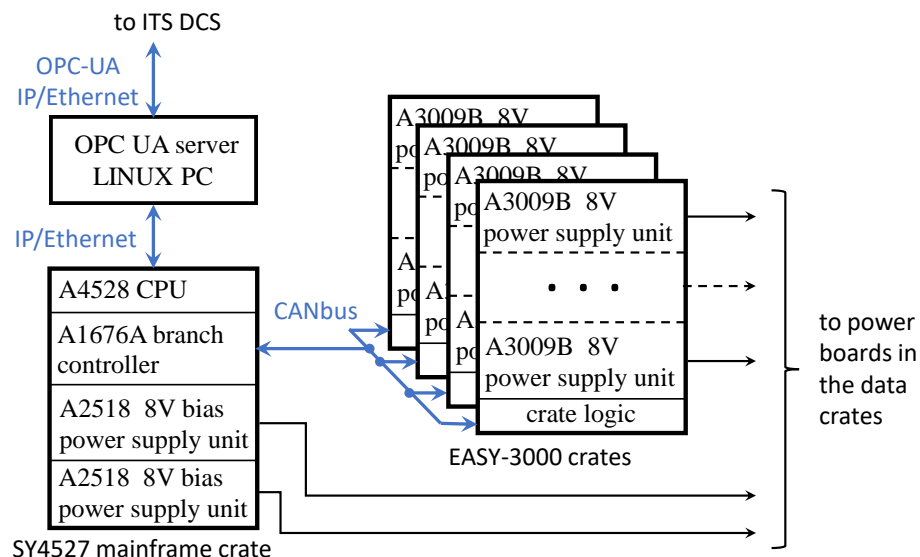


Figure 6.2: The ITS power supply control.

2052 A4548 CPU controls the A2518 power supply units, installed directly in the mainframe
 2053 crate, via the local bus. The units supply bias voltages for the sensors.

2054 16 units of multichannel A3009B power supply will be used to provide power for analog
 2055 and digital circuits of the ITS outer barrel pixel sensors. They will be installed in 4 CAEN
 2056 EASY-3000 crates close to the MPD, in environment with magnetic field and radiation. The

2057 crates are connected via CANbus to A1676A branch controller in the mainframe crate, and
 2058 are visible to its A4528 CPU via the mainframe local bus.

2059 6.3.3 Control of the ITS Frontend Electronics

2060 The frontend control subsystem of the ITS DCS controls the ITS power boards and the pixel
 2061 detector chips.

2062 The power boards (PB) are powered from the CAEN power supply units. The PBs convert
 2063 and split the voltages to several power channels and feed the power supply lines that go to
 2064 the ITS staves. The DCS allows to monitor and adjust the voltages, and turn the power
 2065 lines on and off. The control data are transmitted via I2C interface connecting the PB to the
 2066 readout unit (RU), which, in turn, relays the control data further to the ITS DCS.

2067 The frontend control subsystem also controls about 9000 pixel detector chips, and that
 2068 is why it is the most complex part of the ITS DCS. The chips are sophisticated devices with
 2069 complex internal structure and require elaborated configuration and control operations. Each
 2070 single chip should be individually configured depending on the ITS operation mode.

2071 The chip control data are transmitted over a serial line using half-duplex protocol. Several
 2072 chips may be connected to the same line forming a serial bus. Two types of serial lines are
 2073 used: a local line, connecting several chips to each other within a flexible printed circuit
 2074 (FPC) on which they are installed, and a “global” line that connects chips to the readout unit
 2075 located outside of the MPD volume. The global line is implemented as copper differential line
 2076 with length of several meters and a bandwidth of 80 Mbits/sec. The RU of the ITS outer
 2077 barrel drives 4 differential control lines connected to a single stave.

2078 The ITS outer barrel chips are connected hierarchically. Only one of each seven chips (the
 2079 master) is connected to the global line. The other six ones (the slaves) are connected to the
 2080 master via a “local” serial line. The master relays the control data with a relevant address
 2081 between the global line and the slave.

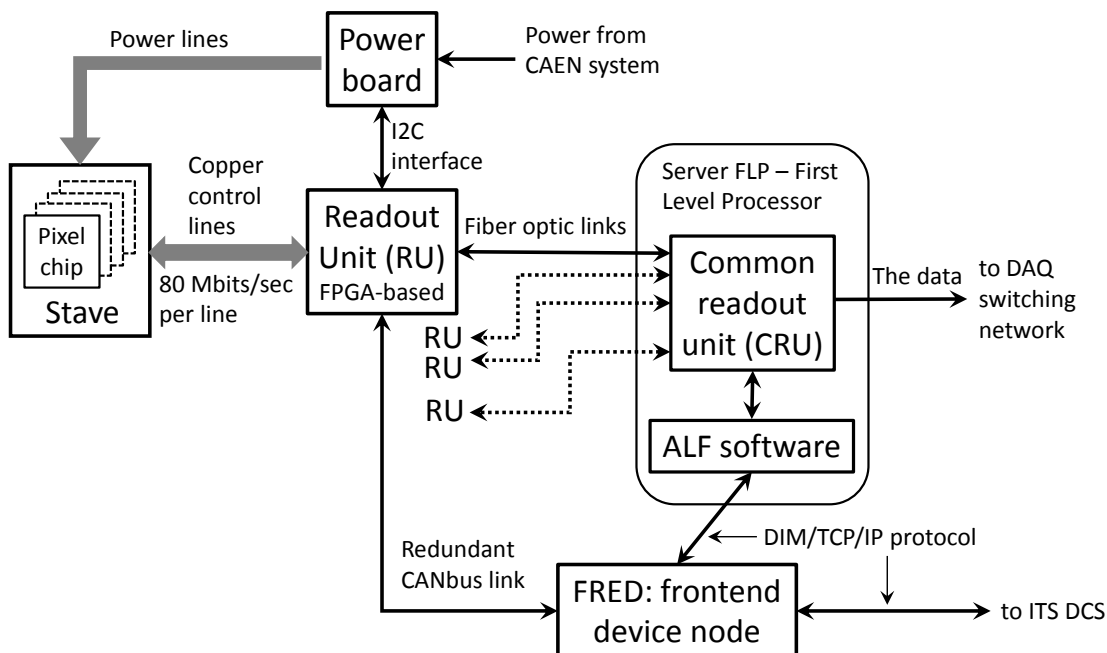


Figure 6.3: The single stave control scheme.

2082 The control chain of an ITS stave is depicted in Figure 6.3. The stave control serial lines
2083 are connected to circuits of the RU which provides two uplink data paths.

2084 The first path is used at normal ITS operation. The control data are transmitted together
2085 with the detector raw data via the optical link between the RU and the common readout unit
2086 (CRU). The data multiplexing is performed by the RU firmware at one end of the link, and,
2087 at another end, by the CRU firmware and software running in the CRU board server – the
2088 First Level Processor (FLP). Then, the control data are relayed via DIM protocol further to
2089 the ITS DCS frontend node FRED.

2090 The second control data path is redundant. It is implemented with a CANbus link
2091 that connects the RUs with the corresponding FRED node in bypass of FLP. The CANbus
2092 bandwidth is by orders of magnitude less than the one of RU-CRU fiber-optics link. However,
2093 it allows to perform basic control operations when FLPs are down and enhances the safety
2094 of ITS operation.

2095 The FRED is a software entity that serves as an interface between WinCC OA and the
2096 ITS frontend electronics. The ITS DCS sees FRED as a WinCC OA device server. The DCS
2097 may command FRED to set the frontend electronics parameters like voltages, thresholds,
2098 timing etc. and may retrieve the frontend status data like temperature, currents, errors.
2099 FRED converts the DCS commands into low level command sequences that are transmitted
2100 via the serial control data links to the frontend electronics. The conversion between the DCS
2101 high level commands and the low level frontend commands is a CPU-intensive procedure.
2102 Hence, FRED takes the computational load of the WinCC OA.

2103 6.3.4 Control of the ITS Cooling System

2104 For a temperature system, which is an autonomous part and programmed using
2105 Programmable Logic Controller (PLC), the Data Integration Protocol (DIP) is used as low-
2106 level communication interface.

2107 6.3.5 Alert System

2108 The ITS DCS should continuously monitor all required parameters, compare them to
2109 threshold values and issue warning signals on the central alarm screen if a safety threshold
2110 is exceeded and programmatically processes these signals. Warnings from both, the lower
2111 and upper sides of the monitored value may be of three levels, depending on the degree of
2112 deviation from the norm: Warning (Warning), Error (Error), Fatal (Alarm). Certain operator
2113 actions should be provided for each level, as it is shown in Figure 6.4.

2114 The warning system consists of settable threshold values for sensors, warning classes, and
2115 warning messages displayed on the central alarm screen. The threshold values of the sensors
2116 may change over time, therefore, a software interface is required that allows to easily and
2117 quickly change the threshold values in all recipes, not only to system experts, but also to
2118 those on duty for the sub-detector.

2119 To prevent emergency conditions and failure of nodes, it is planned to develop special
2120 software that will automatically turn off the high-voltage and low-voltage power supply
2121 systems of the sub-detector upon receipt of a certain number of warning messages of the
2122 “Alarm” level.

2123 The threshold values of all monitored sensors and alarm messages should be clearly
2124 documented, which includes a description of each alarm and the required actions of the
2125 person on duty for this alarm.

Definitions: *Came and Went*

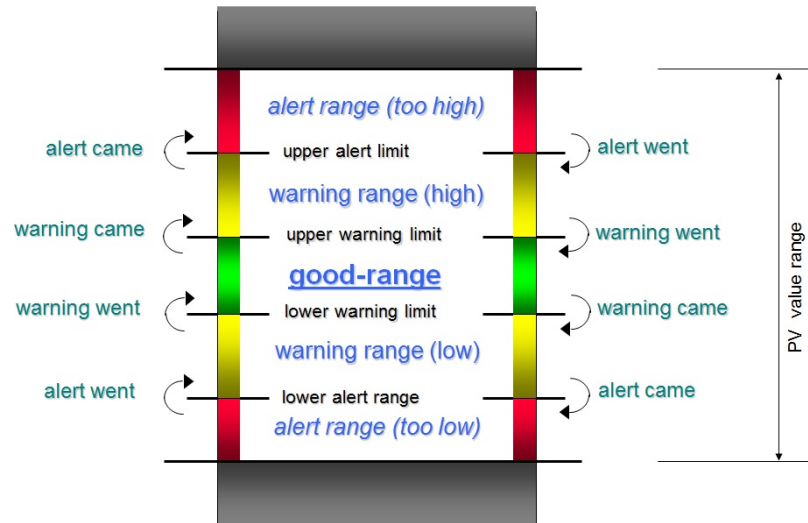


Figure 6.4: Schema of the ITS DCS alarm system.

2126 6.3.6 ITS monitoring system

2127 Monitoring software should provide:

- 2128 • view trends of any controlled parameter;
- 2129 • convenient graphical menu, providing:
 - 2130 – any time interval for viewing a trend;
 - 2131 – any scaling and graph view;
 - 2132 – the ability to save the graphs in a format convenient for physical processing;
 - 2133 – the ability to determine the physical location of the monitored sensor.

2134 6.3.7 Databases (Condition DB, Configuration DB)

2135 Databases should provide:

- 2136 • authorized connection to databases (Condition DB, Configuration DB);
- 2137 • archiving of all monitored parameters;
- 2138 • the set of the ITS configurations may be modified by the configuration editor;
- 2139 • the ability to save the sub-detector configuration;
- 2140 • the ability to store and quickly load sets of HV and LV values when changing the
- 2141 operating mode;
- 2142 • the selection of parameters from the configuration database is performed by the client
- 2143 executing the request in accordance with the selected data set mode.

2144 **6.3.8 System Access (remote and local) and access control.**

2145 User access to computers of the control and monitoring system should be carried out both
2146 locally and remotely. Access control must be protected. Login with a password or a list of
2147 experts allows a certain level of management. Logging in without a password allows only for
2148 visual observation without intervention in management.

2149 Each user with administrator rights has the ability to change login rights and passwords.
2150 The following features will be provided for this: *Log Out*, *Log In*, *Tools*, *Change Password*,
2151 *Administration*, and *Help*.

- 2152 1. *Log Out* - exit the current user mode.
- 2153 2. *Log In* - logging in a new user. In this case, the current user mode will be closed.
- 2154 3. *Tools* - allows you to find a specific user or see the current users of subsystems.
- 2155 4. *Change Password* - change the password of the current user.
- 2156 5. *Administration* - provides access to administration / management functions on the basis
2157 of levels "Users", "Groups", "Domains".
- 2158 6. *Help* - help on the component Framework Access Control.

2159 The *Domains* level allows you to create and modify system domains. A domain named
2160 ITS will be created specifically for users of the ITS project, and will include the following
2161 user groups:

- 2162 • *ITS_developer* - users with full access to all system components. Such users can modify
2163 the existing code as desired, add and remove detector subsystems, start FSM, and
2164 change the state of system components.
- 2165 • *ITS_expert* - users who have the right to change the states of system components, if
2166 the developer gave them the opportunity to do so.
- 2167 • *ITS_operator* - has the same rights as *ITS_expert*.
- 2168 • *ITS_observer* - an observer who has the right only to monitor the current state of the
2169 system, but is not allowed to change its state in any way.

2170 By default, all members of the ITS collaboration have *observer* status for all ITS
2171 subsystems.

2172 Bibliography

- 2173 [1] ETM website: <https://www.wincoo.com>
- 2174 [2] CERN JCOP Project: <https://jcop.web.cern.ch>
- 2175 [3] CERN UNICOS Project: <https://unicos.web.cern.ch>

7 Detector Performance

7.1 The MPD TPC in a nutshell

The Time-Projection Chamber (TPC) is the main tracking detector of the MPD central

barrel and its basic design parameters are summarized in Table 7.1.

Table 7.1: Basic parameters of the TPC.

Parameter	Value
Length of the TPC	340 cm
Vessel outer radius	140 cm
Vessel inner radius	27 cm
Drift volume outer radius	133 cm
Drift volume inner radius	34 cm
Drift volume length	163 cm (each half)
HV electrode	Membrane at the center of the TPC
Electric field strength	140 V/cm
Magnetic field strength	0.5 T
Drift gas	90% Ar+10% Methane
Gas amplification factor	104
Drift velocity	5.45 cm/ μ s
Drift time	<30 μ s
Temperature stability	<0.5 $^{\circ}$ C
Number of readout chambers	24 (12 per each End-plate)
Segmentation in φ	30 $^{\circ}$ C
Pad size	5 \times 12 mm ² and 5 \times 18 mm ²
Number of pads	95232
Pad raw numbers	53
Zero suppression	up to 90%
Maximal event rate	<7 kHz (Lum. 10 ²⁷)
Electronics shaping time	180–190 ns
Signal-to-noise ratio	30:1
Signal dynamical range	10 bits
Sampling rate	10 MHz
Sampling depth	310 time buckets
Resolution of two tracks	1 cm

It is the detector for 3-dimensional precise tracking of charge particles and will provide:

- an overall acceptance of $\eta < 1.2$;

- a momentum resolution for charge particles under 3% in the transverse momentum range $0.1 < p_T < 1$ GeV/c;

- a resolution of two tracks of about 1 cm;

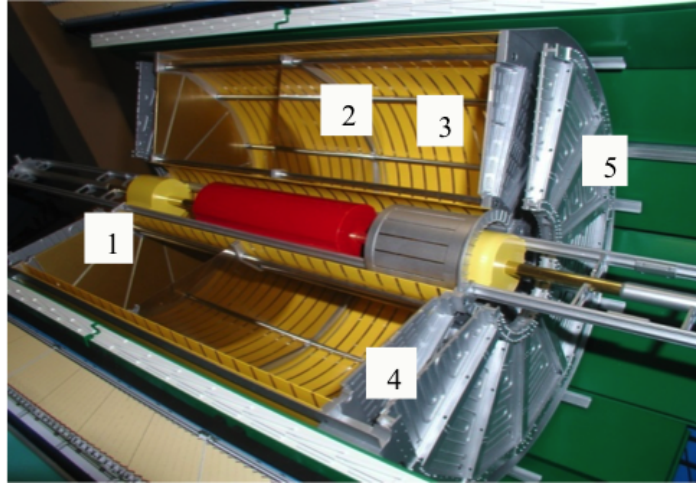


Figure 7.1: MPD-TPC mock up. 1-MWPC; 2-HV electrode; 3-Field cage; 4-Flange with MWPCs and FEE electronics; 5-End cap thermal screen. .

- 2185 • Hadron and Lepton identification by dE/dx measurements with a resolution better than
2186 8%.

2187 These requirements must be satisfied at the NICA design luminosity with event rate
2188 about 7 kHz and maximum charged particle multiplicity up to 1000 tracks in central Au-Au
2189 collisions.

2190 Track reconstruction is based on drift time and $r\varphi$ coordinate measurement of primary
2191 ionization clusters created by charge particle. In order to minimize the error in the absolute
2192 track point position measurement by TPC, it is necessary to take into account both,
2193 static and time-dependent distortions in the drift path of the ionization cloud. The static
2194 distortions are the result of non-uniformities in the magnetic (\vec{B}) and electric (\vec{E}) fields. The
2195 time-dependent distortions may result from the changes in gas performance, environmental
2196 variables (temperature or atmospheric pressure), or from spontaneous failures.

2197 The TPC consists of four cylinders (C1-C4) manufactured by the Russian industry from
2198 composite materials (Fig. 7.1). This approach results in cylinders with small radiation length
2199 (0.4 g/cm^2) and enough strength along the axial direction (in the worst case, the deformation
2200 in the middle of the cylinder at a load of 80 kg is less than 100 μm). Two aluminum flanges
2201 interconnect all four cylinders. Nitrogen gas (N_2) is blown through the gap between C1-C2
2202 and C3-C4 as a protection against high-voltage discharges and prevention from H_2O and O_2
2203 diffusion into the drift volume of the TPC.

2204 The central high-voltage electrode membrane divides the drift volume into two parts
2205 and creates the necessary electric field strength for the drift of the generated electron-ion
2206 clusters to the TPC end-caps (Fig. 7.1, pos. 2). The membrane is produced with the 110 μm
2207 Mylar film. The non-uniformity of the magnetic field must be not worse than $\vec{B}r/\vec{B}z \sim 10^{-4}$.
2208 The Field cage (Fig. 7.1, pos. 3) is symmetrical with respect to the high-voltage electrode
2209 consisting of 112 pairs of 13 mm-wide mylar strips (outer and inner structures) stretched on
2210 special rods with the same pitch and an accuracy of 50 μm . The high-voltage electrode is
2211 connected to the nearest mylar strip by a resistor, and each subsequent strip is connected
2212 to the next one by a resistor. This chain forms a HV divider from -24 kV (high voltage
2213 electrode) to zero (TPC end-caps).

2214 The main subsystems of TPC include:

- 2215 • Readout Chambers (ROC);

- 2216 • Gas System;
- 2217 • Laser Calibration System;
- 2218 • Cooling System;
- 2219 • FEE, Readout and DAQ;
- 2220 • DCS;
- 2221 • HV and LV systems.

2222 7.2 Simulations of the TPC-ITS tracking system

2223 This section presents the results of modeling the functionality of the MPD tracking system
2224 including the TPC and the ITS, as well as the basic algorithms for the track reconstruction.

2225 7.2.1 ITS Pointing resolution for different beam pipe diameters

2226 The spatial resolution of the design of the MPD-ITS was evaluated in the framework of the
2227 simplified code developed by the ALICE collaboration which allows the tracking of charged
2228 particles through cylindrical silicon layers with a specified radiation length. At each step
2229 of the tracking in a layer with a given radius, a covariance noise matrix is calculated which
2230 takes into account multiple scattering that degrade the angular resolution when moving to
2231 the next layer.

2232 The characteristics of the MPD-ITS silicon layers with an average radius r for the
2233 configuration used in the calculations are presented in Table 7.2.

Table 7.2: Modelling parameters for a 5-layer ITS with a 40 mm beryllium beam pipe (MPD-ITS).

Layer number	r (mm)	$\sigma(r\varphi)$ (μm)	X/X_0 (%)
beam pipe	20.0	-	0.22
1	24.6	4.0	0.30
2	43.3	4.0	0.30
3	62.5	4.0	0.30
4	146.2	4.0	0.30
5	196.0	4.0	0.30

2234 The dependence of the spatial resolution of the MPD-ITS on the transverse momentum of
2235 pions, protons, and kaons, the main charged decay products of strange and charmed particles,
2236 is shown in Figure 7.2

2237 The deterioration of the spatial resolution in the region of small transverse momenta is
2238 due to an increase in the Moliere angle defined by the equation [2]:

$$\theta = \sqrt{2} \frac{13.6 \text{ MeV}}{\beta c p} Z \sqrt{\frac{X}{X_0}} \left[1 + 0.038 \ln\left(\frac{X}{X_0}\right) \right], \quad (7.1)$$

2239 where p is the particle momentum, $c\beta$ is its velocity, Z is the charge, X is the thickness
2240 of the substance and X_0 is the radiation length.

2241 As it can be seen from Figure 7.2, the spatial resolution of the 5-layer ITS for pions with
2242 a transverse momentum of 300 MeV/s is 60 μm , and for kaons and protons with the same
2243 transverse momentum, the spatial resolution is 100 μm and 160 μm , respectively. Such a

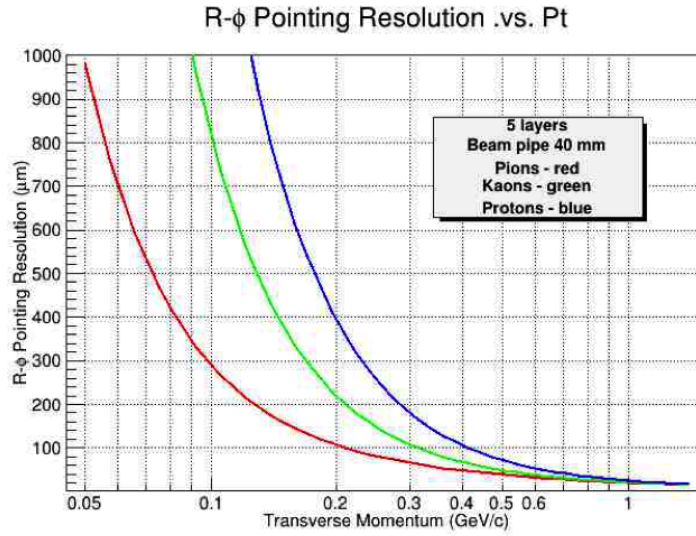


Figure 7.2: Dependence of the spatial resolution of MPD-ITS on the transverse momentum of pions (red line), kaons (green line) and protons (blue line).

2244 resolution would allow for reconstructing the decay vertex of charmed D_0 mesons through the
 2245 channel $D_0 \rightarrow K^- + \pi^+$ (average path length $\lambda = 123 \mu\text{m}$) with small transverse momenta up to
 2246 to 500 MeV/s. Two other configurations were evaluated for the same five layers of MAPS but
 2247 assuming a beam pipe diameter of 50 mm (configuration ITS5-50) and 60 mm (configuration
 2248 ITS5-60), respectively.

2249 The geometrical parameters of the IT5-50 and IT5-60 models are shown in Table 7.3,
 2250 and a comparison of the dependence of the spatial resolution on the transverse momentum
 2251 of the pions for all three models with 5 layers is shown in Figure 7.3. As it can be seen,
 2252 the use of a beam pipe diameter with a 40 mm would significantly improve the spatial
 2253 resolution of particles with a small transverse momentum which is especially important for
 2254 the reconstruction of the decay vertices of short-lived charmed particles.

Table 7.3: Geometrical parameters of two 5-layer models IT5-50 and IT5-60 (50 mm and 60 mm beam pipe diameter, respectively).

Layer number	IT5-50 r (mm)	IT5-60 r (mm)	IT5-50 & IT5-60	
			$\sigma(r\phi)$ (μm)	X/X_0 (%)
beam pipe	25.0	30.0	-	0.22
1	35.0	40.0	4.0	0.30
2	67.4	69.4	4.0	0.30
3	91.3	104.3	4.0	0.30
4	146.2	146.2	4.0	0.30
5	196.0	196.0	4.0	0.30

2255 7.2.2 ITS momentum resolution

2256 The dependency of the momentum resolution on the transverse momentum of protons, pions
 2257 and kaons, of the 5-layers ITS for a beam pipe with a diameter of 40 mm is shown in Figure
 2258 7.4. The simulation was performed using the same code as for the spatial resolution. The
 2259 input parameters of the ITS model used in the calculations are shown in Table 7.2. The

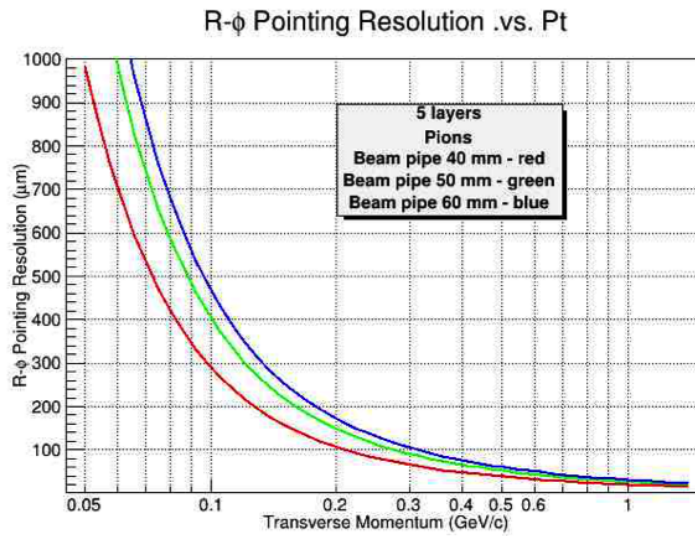


Figure 7.3: Pion track pointing resolution for of a 5-layer ITS and a beam pipe with a diameter of 40 mm (red line), 50 mm (green line) and 60 mm (blue line).

2260 particles were tracked in a magnetic field of 0.5 T.

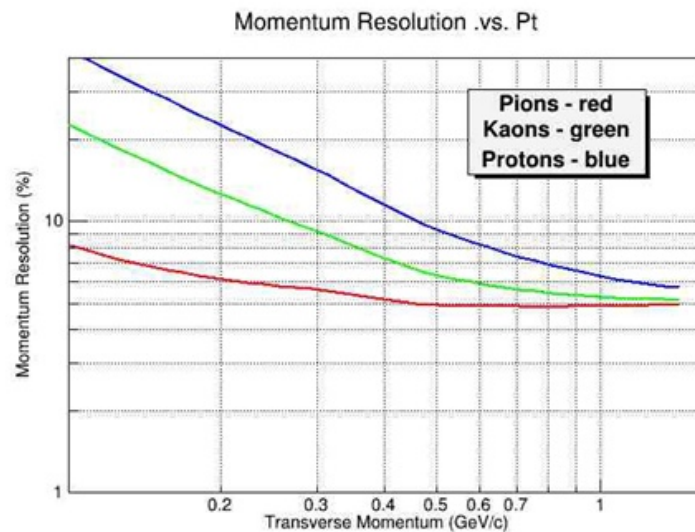


Figure 7.4: Dependence of the momentum resolution of the IT5-40 on the transverse momentum of pions (red line), kaons (green line) and protons (blue line).

2261 As it can be seen from Figure 7.4, the momentum resolution of pions remains almost
 2262 constant value of 5% over a wide range of p_T . On the other hand, for heavier particles (kaons
 2263 and protons) the resolution deteriorates at low p_T values and reaches a level of 5% only at
 2264 $p_T > 1$ GeV/c.

2265 7.2.3 ITS+TPC simulation tools

2266 The simulation of the MPD ITS+TPC tracking system was carried out using the MpdRoot
 2267 software [3] the main interfaces and components of which are shown in Figure 7.5. The

2268 GEANT software package integrated into the MpdRoot provides the Monte Carlo (MC)
 2269 transport of particles delivered by a suitable event generator. At the transport step an
 2270 output file is generated with information on the coordinates of all particle tracks falling into
 2271 the sensitive volume of the detectors. At the reconstruction step the detector responses are
 2272 formed and charged particle tracks are searched using the Kalman filter method [4].

2273 The generation of the signal from the pixel detectors required for the track reconstruction
 2274 was performed using a hit-producer software module specially developed for this purpose.
 2275 This module converts MC transport data into the digitized response of the detector providing
 2276 a connection between the MC points of the tracks falling into the detector and the information
 2277 read out from the detector by electronic circuits. In the case of pixel sensors, this information
 2278 is the column and row numbers for the corresponding pixel in the pixel matrix on which the
 2279 charge is released due to the passage of a charged particle through the detector.

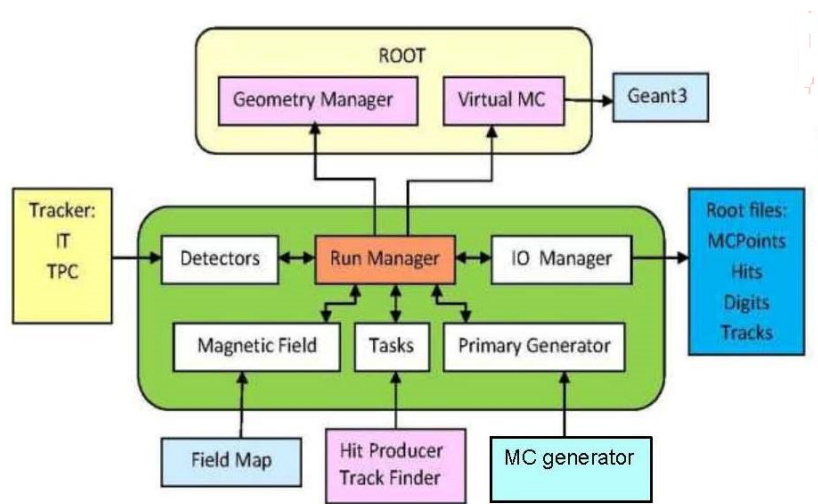


Figure 7.5: The software environment of MpdRoot.

2280 The track reconstruction procedure includes two stages: track search [4] and track fitting
 2281 [5]. The track search is based on the Kalman filter algorithm which begins by selecting a
 2282 cluster in the initial layer of detectors and then attaches the cluster in the next layer, and
 2283 so on layer by layer. The tracks found in the TPC by a large number of clusters (~ 40) are
 2284 then extended to the ITS. After the candidate tracks that match all possible combinations
 2285 of different clusters in the same layers are selected, they are fitted to choose the best track
 2286 with the minimum value of χ^2 .

2287 7.2.4 ITS+TPC track reconstruction efficiency

2288 The tracking efficiency of the MPD tracking system including the TPC and the project
 2289 configuration (ITS5-40), was estimated with MpdRoot using the QGSM [1] central event
 2290 sample of 10^5 Au+Au collisions at $\sqrt{S_{NN}}=9$ GeV. The efficiency of the track reconstruction
 2291 of charged primary particles as a functions of their transverse momentum p_T is shown in
 2292 Figure 7.6. As it can be seen the reconstruction efficiency of proton and pion tracks is
 2293 close to 100 %, starting from $p_T > 200$ MeV/c, while the Kaon track reconstruction efficiency
 2294 reaches 90 % at $p_T > 400$ MeV/c.

2295 The track reconstruction efficiency of secondary particles was estimated on the example
 2296 of pions and protons formed as a result of the decay of Λ -hyperons in the channel $\Lambda \rightarrow$
 2297 $\pi^- + p$. For this purpose 5×10^3 events of central Au + Au collisions at $\sqrt{S_{NN}}=9$ GeV

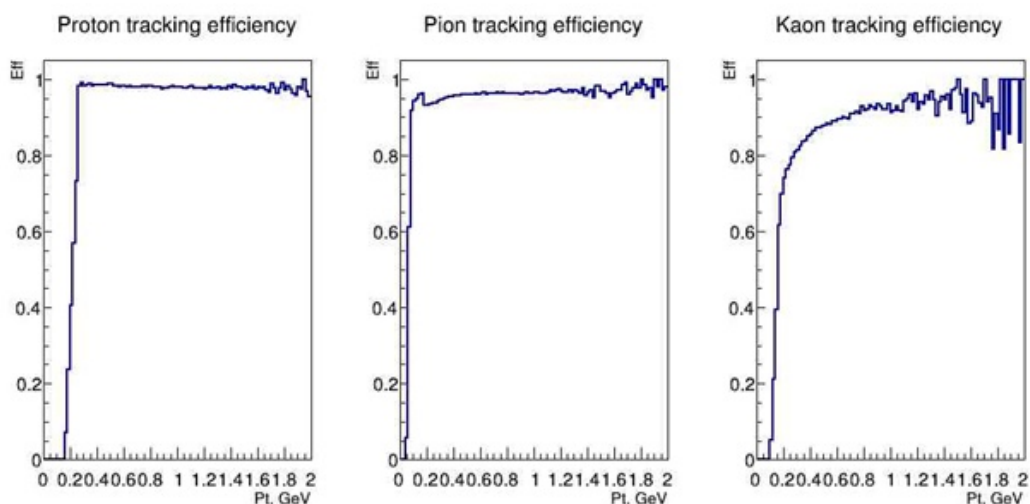


Figure 7.6: Track reconstruction efficiency of primary tracks for protons, pions and kaons generated in 10^5 events of central Au+Au collisions at $\sqrt{S_{NN}}=9$ GeV as a function of their transverse momentum.

2298 were processed with the formation of about 20 Λ in every event. Figures 7.7 and 7.8 show
 2299 the transverse momentum distribution of the generated and reconstructed decay products of
 2300 Λ -hyperons, as well as the dependency of their tracks reconstruction efficiency on the particle
 2301 transverse momentum. It can be seen that the tracking algorithm used provides reliable track
 2302 reconstruction of the secondary pions and protons reaching an efficiency level of 90 % at p_T
 above 150 MeV/c and 400 MeV/c respectively.

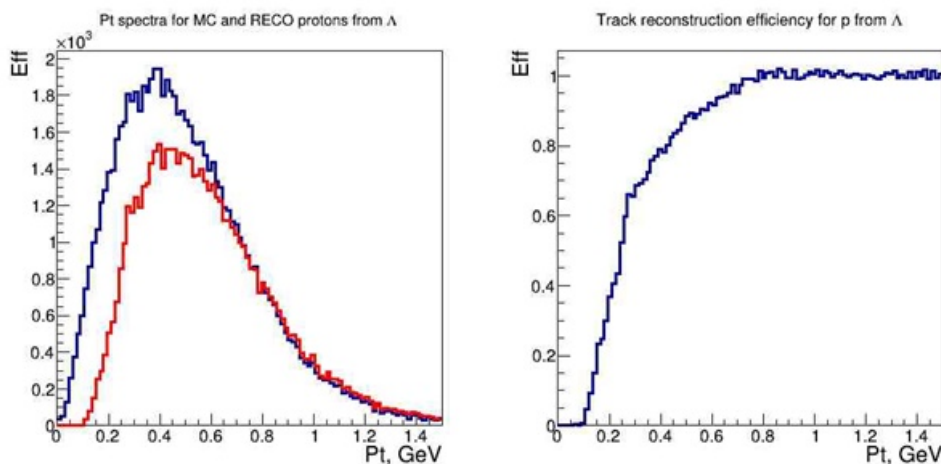


Figure 7.7: p_T distribution of the generated (blue) and reconstructed (red) protons from the Λ decay (left) and the reconstruction efficiency of their tracks depending on p_T (right)

2303

2304 7.2.5 Phase space coverage for protons and pions

2305 The reconstructed tracks of protons and pions formed in 10^4 events of central Au + Au
 2306 collisions at $\sqrt{S_{NN}}=9$ GeV and simulated using the QGSM generator were considered in order
 2307 to estimate the phase space covered by the ITS + TPC tracking system. Along with the tracks

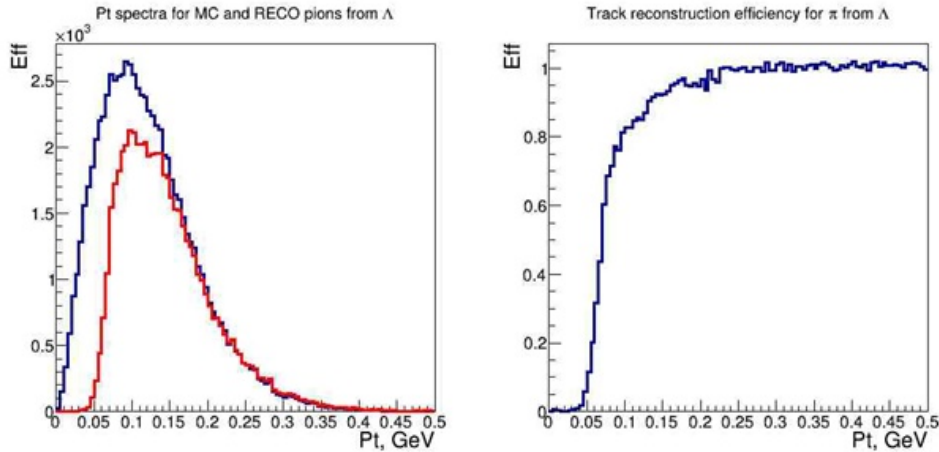


Figure 7.8: p_T distribution of the generated (blue) and reconstructed (red) pions from the Λ decay (left) and the reconstruction efficiency of their tracks depending on p_T (right)

2308 of particles coming from the vertex of the nuclei interactions the tracks of secondary pions
 2309 and protons, the decay products of Λ -hyperons, were analyzed. 2-dimensional distributions
 2310 on the rapidity–transverse momentum plane are shown in Figure 7.9 for primary particles and
 2311 in Figure 7.10 for secondary particles. As it can be seen the proposed TPC+ITS setup has
 2312 a sufficient coverage to study both the longitudinal and transverse distributions of primary
 2313 and secondary particles.

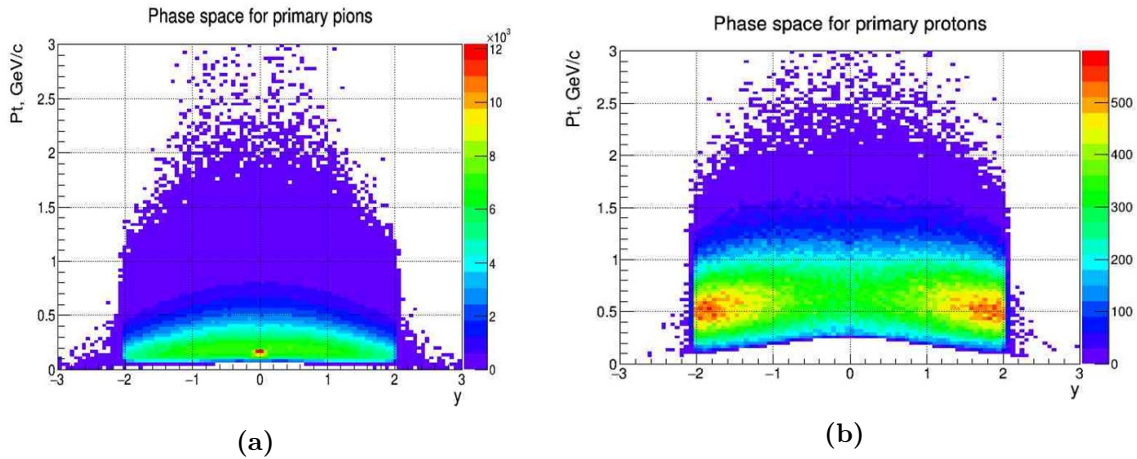


Figure 7.9: y - p_T phase space of primary pions (a) and protons (b) covered by TPC+ITS setup.

2314 7.2.6 Vector finder algorithm for TPC+ITS track reconstruction

2315 The current MPD track reconstruction method is based on the Kalman filter in the TPC. Its
 2316 simple extension to the ITS is not adequate to fully exploit the potential of the MAPS-based
 2317 detector, therefore such a method can not be considered as a good tool to study the ITS
 2318 performance. That is why another Vector Finder algorithm, based on the cellular automaton
 2319 approach [7] was developed. The main idea of the method is to run a combinatorial search of
 2320 hit pairs belonging to the same track using a priori constraints to reduce the combinatorics.
 2321 Presumably, such a method should produce good results for tracks with relatively small

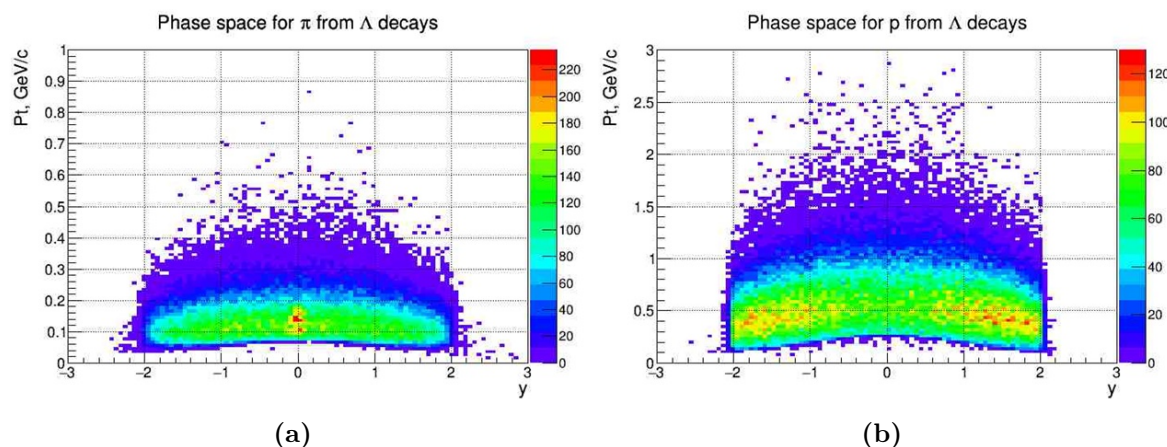


Figure 7.10: y - p_T phase space of secondary pions (left) and protons (right) from Λ decays covered by TPC+ITS setup.

2322 number of hits per track as is the case for the stand-alone ITS tracking.

2323 The "Vector Finder" algorithm [8] is an optimized combinatorial search that uses
 2324 information about the angular positions of hits in the transverse (ϕ) and longitudinal (θ)
 2325 projections relative to the beam axis to construct track candidates.

2326 In the longitudinal plane the magnetic field directed along Z does not affect the track
 2327 trajectory and the track is close to a straight line. Therefore in order to extend the candidates
 2328 for the tracks for each next layer of the detector, an "angular window" $epsphi$ of constant size
 2329 is used, as shown in Figure 7.11. In the transverse projection, the candidate for the tracks
 2330 should be close to the arc of a circle, the radius of which is determined by the transverse
 2331 momentum of the particle creating the track. The size of the angular window $epsphi$ is
 2332 inversely proportional to the current estimated transverse momentum of the particle, as
 shown in Figure 7.12.

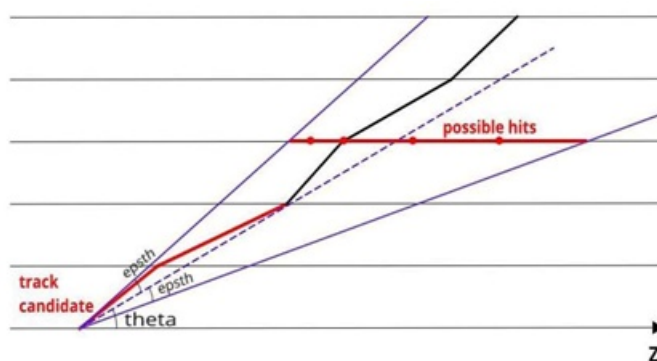


Figure 7.11: Choosing of angular window for tracks in longitude plane

2333

2334 For analysis of particles momentum, a minimum of 3 hits is needed. The 1st hit for the
 2335 primary track is the interaction point (see Figure 7.13). The illustrations for the schematic
 2336 projections of the tracks presented in Figures 7.11 and 7.13 are made for the version of the
 2337 algorithm that constructs the candidate for the tracks starting from the interaction point.
 2338 Currently it is used the algorithm version which starts to build candidates for tracks from
 2339 the last layer of the detector.

2340 The track reconstruction algorithm for the 5-layer ITS is as follows:

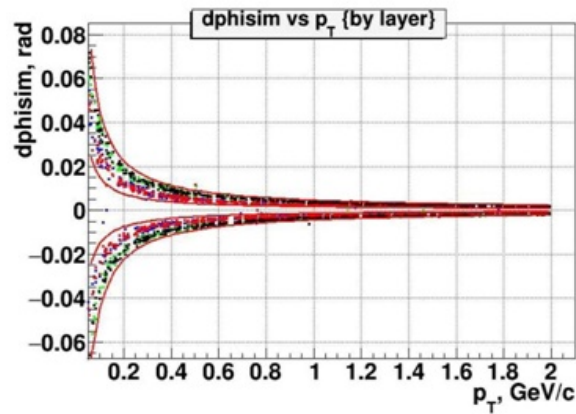


Figure 7.12: Choosing of angular window for the track in the transverse plane

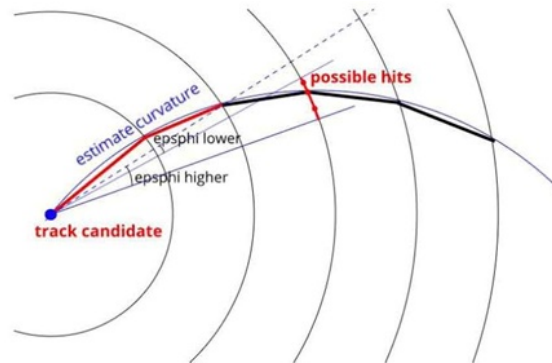


Figure 7.13: Projection of the track on the transverse plane for the particle momentum analysis

- 2341 1. The initial candidates for the tracks are built backwards starting from their hits in the
2342 last layer of the detector.
- 2343 2. For the remaining layers of the detector (1 - 4) the hits are organized into multimap
2344 structures, where they are sorted by transverse and longitudinal angles (for each layer
2345 there are two multimaps for transverse and longitudinal angles, respectively).
- 2346 3. For each track candidate:
 - 2347 • the transverse momentum is estimated for layers 1-3 (at least 3 hits are needed,
2348 including the interaction point to estimate the track curvature). For layer number
2349 4 the angular windows are taken in a very large size in order to guarantee the
2350 inclusion of all possible candidates for the tracks;
 - 2351 • the dimensions of the angular window in the transverse and longitudinal
2352 projections are calculated and the corresponding hits are extracted from the related
2353 multimap, resulting in two sets of hits; those that went into the angular window
2354 for the transverse projection and those for the longitudinal projection;
 - 2355 • the two sets (angular and longitudinal) are intersected and for each hit in the
2356 resulting intersection set a new track candidate is created for the next detector
2357 layer.

2358 The tracking algorithm was implemented as part of MpdRoot framework for the 5-layer
 2359 geometry of the ITS detector. The algorithm was tested using UrQMD event generator for
 2360 central Au + Au collisions at $\sqrt{S_{NN}}=9$ GeV.

The quality of the tracking is shown on Figure 7.14.

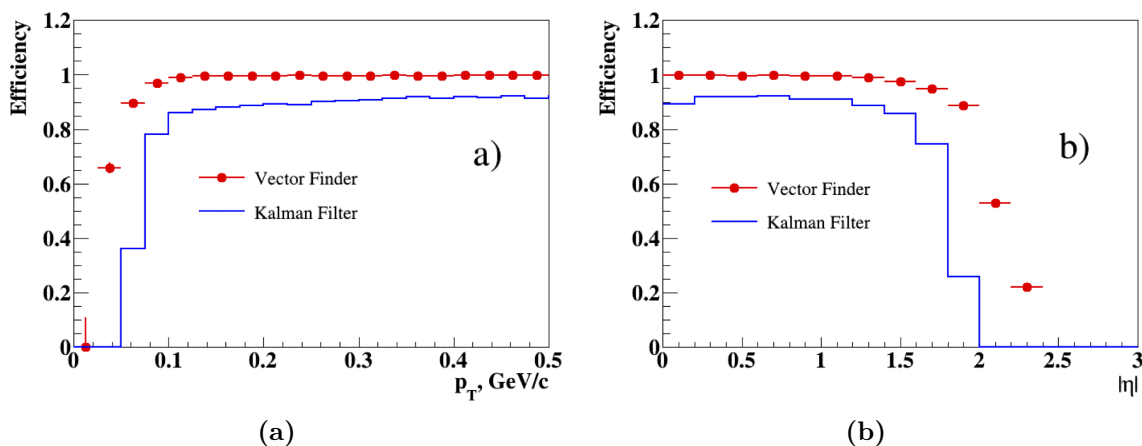


Figure 7.14: Vector Finder vs Kalman Filter track reconstruction efficiency comparison: efficiency vs p_T at $|\eta| < 1.2$ (a) and efficiency vs $|\eta|$ at $Pt > 0.1$ GeV/c (b) .

2361

2362 Matching procedure for ITS and TPC tracks

2363

2364 After reconstructing the tracks in the ITS it is necessary to match them with those
 2365 from the TPC. The following special match-up procedure was developed for this:

- 2366 1. Extrapolate TPC and ITS tracks to a cylinder around the beam line such that the ITS
 2367 detector is located inside the cylinder and the TPC detector is left outside (i.e., the
 2368 cylinder lies in between the two detectors).
- 2369 2. Update z (longitudinal projection) and $rphi$ (transverse projection) coordinates of the
 2370 tracks using the extrapolations from point 1.
- 2371 3. For each track from ITS find the set of TPC tracks with coordinates z and $rphi$ within
 2372 the given window from the parameters of the ITS track (see Figure 7.15)
- 2373 4. Extend the TPC track with hits from the corresponding ITS track if they match each
 2374 other sufficiently (χ^2 metric is used to verify compliance)
- 2375 5. If no TPC tracks were found within the specified parameter window, the ITS track is
 2376 added by default. If several matches were found for one TPC track, it is necessary to
 2377 choose the best match using the special quality function:

$$quality = N_{hits} + (100.0 - \min(\chi^2, 100.0))/101.0 \quad (7.2)$$

2378 where N_{hits} is the number of hits in the track.

2379 The matching procedure was tested on events received using the UrQMD generator. The
 2380 resulting dependencies of the efficiency on p_T and on η are shown in Figure 7.16.

2381 The key differences in the reconstruction of secondary tracks are the following:

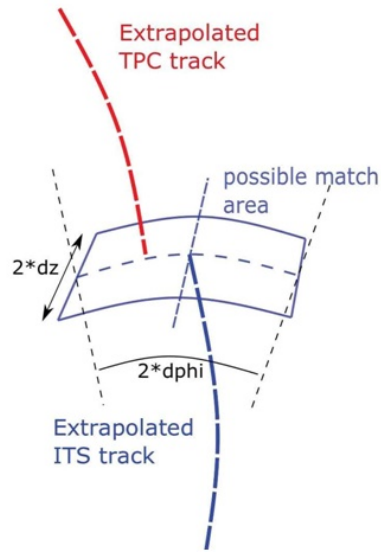


Figure 7.15: Scheme of ITS and TPC tracks matching

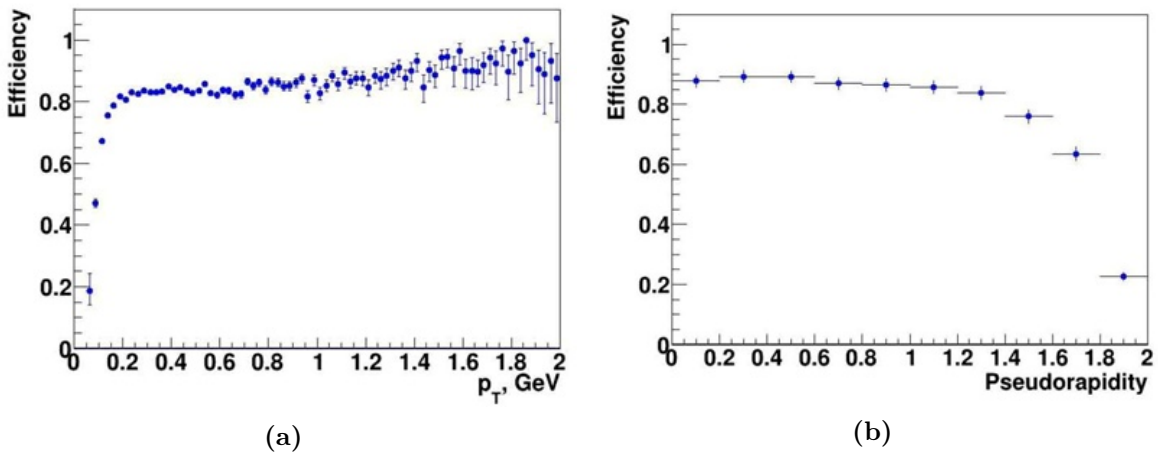


Figure 7.16: Dependency of matching efficiency for primary tracks on p_T at $|\eta| < 1.2$ (a) and on $|\eta|$ at $p_T > 0.1$ GeV/c (b) .

- 2382 1. It is impossible to use the interaction point as a “dummy hit” for estimating the
 2383 momentum of a particle. Thus, in order to evaluate the momentum and determine the
 2384 size of the angle cuts, it is necessary to look through at least 3 layers of the detector.
- 2385 2. The angular coordinates of the hits in the longitudinal section of the detector are
 2386 not useful to restore tracks in this case. Therefore instead of *theta* coordinates, the
 2387 coordinates of the hits along the *z* axis are used. Since the track still remains close
 2388 to the straight line in the longitudinal projection, the difference in the *z* coordinate
 2389 between the hits of the track at adjacent levels should be proportional to the distance
 2390 between the layers of the detector within some possible error margin which is fixed on
 2391 both sides of the calculated hit location.

2392 The results of restoring secondary tracks for a set of 100 events generated by the UrQMD
 2393 generator with the parameters indicated above are shown in Figure 7.17.

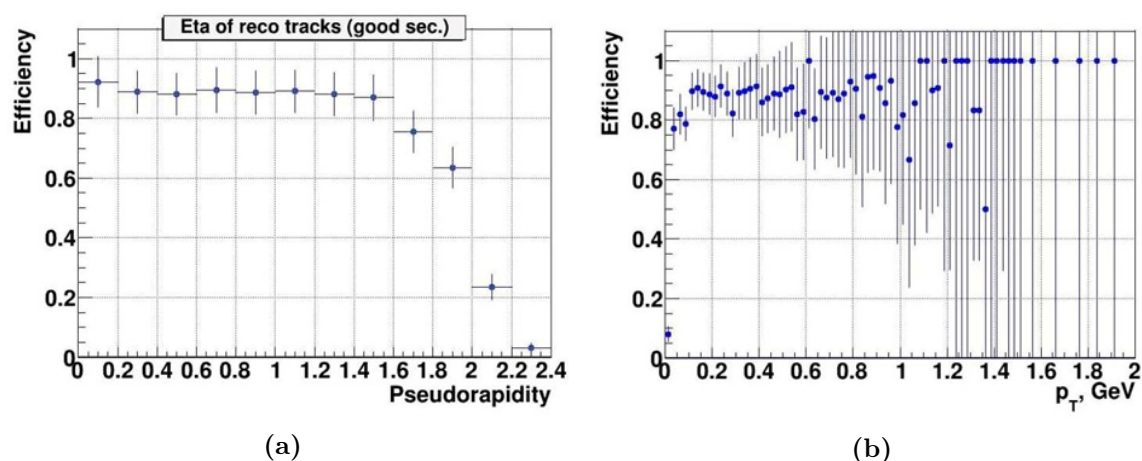


Figure 7.17: Dependency of secondary tracks reconstruction efficiency on p_T (left) and pseudo-rapidity (right) .

2394 7.3 Conclusions

2395 The main functional capabilities of MPD ITS+TPC tracking system resulting from the
2396 computer simulations may be summarized as follows:

- 2397 • The estimated spatial resolution of the ITS *project* version consisting of 5 coaxial
2398 cylindrical layers of pixel sensors around a beam pipe with a diameter of 40 mm shows
2399 that it is similar to that of the upgraded inner tracker system of the ALICE facility. Such
2400 resolution provides the possibility of reconstructing the decay vertices of the short-lived
2401 charmed D^+ and D^0 mesons having a decay length of 312 μm and 123 μm , respectively.
- 2402 • The momentum resolution of the ITS *project* version for pions, protons and kaons which
2403 are the main decay products of strange and charmed particles remains not worse than
2404 10 % in a wide range of transverse momentum p_T down to 400 MeV/c, and for pions it
2405 reaches the level of 5 % at $p_T > 400$ MeV/c.
- 2406 • Estimation of the reconstruction efficiency of charged hadron tracks in the MPD
2407 tracking system including TPC and the *project* version of ITS, reaches a 95 % level
2408 for primary protons and pions starting from $p_T > 200$ MeV/c. For secondary pions and
2409 protons a level of 90 % efficiency is achieved at $p_T > 150$ MeV/c and $p_T > 400$ MeV/c,
2410 respectively.
- 2411 • The analysis of the phase space covered by the MPD tracking system for primary
2412 protons and pions indicates their reliable registration in the pseudo-rapidity range $|\eta| <$
2413 2, defined by the acceptance of the MPD tracking system.

2414 Bibliography

- 2415 [1] A. Mastroserio et al., "Simulation tools for the its upgrade", ALICE Internal Note at
2416 'http://aliceinfo.cern.ch/ITSUpgrade/sites/aliceinfo.cern.ch.ITSUpgrade/
2417 files/documentsUpgrade_IN.pdf', 2012.
- 2418 [2] G.R.Lynch and O.I.Dahl. "Approximations to multiple Coulomb scattering", Nucl. Instr.
2419 Meth. B 58 (1991) 6.
- 2420 [3] MpdRoot Software. <http://git.jinr.ru/nica/mpdroot>
- 2421 [4] Fruehwirth R., "Application of Kalman filtering to track and vertex fitting", Nucl. Inst.
2422 Meth. A., 2662, 1987, V. 262. p.444-450.
- 2423 [5] Billoir P. Track fitting with multiple scattering: a new method, Nucl. Inst. Meth. A.,
2424 2668, 1984. V.225 (2). p.352-366.
- 2425 [6] Gudima KK, Mashnik SG, Sierk A. J . User Manual for the Code LAQGSM, Los Alamos
2426 National Laboratory Report. LA-UR-01-6804. Los Alamos. 2001.
- 2427 [7] V. Akishina and I. Kisel, J. Phys. Conf. Ser.599, 012024 (2015)
- 2428 [8] D.A. Zinchenko, A. I. Zinchenko, E. G. Nikonov. "Vector Finder — a toolkit for track
2429 finding in the MPD experiment", Particles and Nuclei, Letters. T 18. No 1(233) C. 134.
2430 2021.

8 Physics Performance

2432 This chapter presents the results of studying the identification capability of the MPD tracking
 2433 system composed by the TPC and the ITS for the reconstruction of the decay of strange and
 2434 charmed particles produced in $\sqrt{S_{NN}} = 9$ GeV.

2435 The simulations were carried out for various ITS configurations differing in the number
 2436 of detector layers used and the beam pipe diameter. Section 8.2 presents the results of the
 2437 hyperons reconstruction with an ITS version consisting of only two outer layers of MAPS
 2438 (Outer Barrel) and a beam pipe diameter of 64 mm. The reconstruction of both strange and
 2439 charmed particles with the 5-layers ITS including the Outer and Inner Barrels and a beam
 2440 pipe with a diameter of 40 mm and 64 mm is considered in section 8.3.

2441 8.1 Simulation methods

2442 Reliable identification of short-lived charmed particles can be performed by determining the
 2443 invariant mass of their decay products. So, for an efficient reconstruction of decay vertices
 2444 close to the interaction point an inner tracking system with high pointing resolution is
 2445 needed. The identification of specific decay pattern is difficult due to the presence of a
 2446 large combinatorial background related to all charged particles emerging from the primary
 2447 collision vertex. This background is especially large ($S/B \sim 1:10^3$) in heavy ion collisions.
 2448 Therefore, the measurement of the yields of charmed mesons and baryons should be based
 2449 on a highly efficient reconstruction of the secondary decay vertex of short-lived particles.

2450 The identification ability of the MPD ITS during the reconstruction of strange and
 charmed particles was assessed in the MpdROOT framework

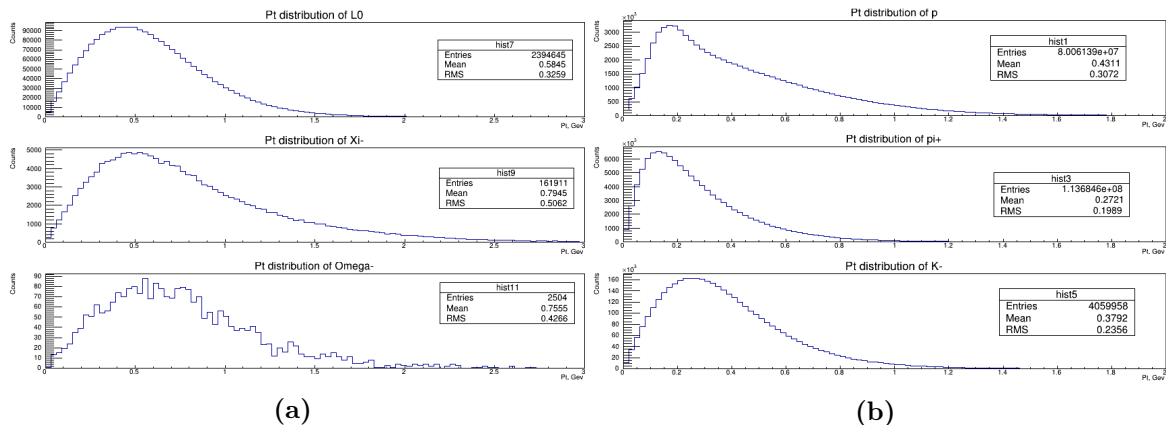


Figure 8.1: Transverse momentum spectra of Λ , Ξ^- and Ω^- hyperons and charged particles p, π and K, generated by QGSM in 10^5 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV.

2451

2452 The QGSM event generator, based on the quark-gluon string model [1], was used
 2453 to generate nucleus-nucleus collisions events at the energies of the NICA collider
 2454 ($\sqrt{S_{NN}} = 4 \div 11$ GeV). Figure 8.1 shows the transverse momentum distributions of strange
 2455 particles generated in 10^5 central ($b < 4$ fm) collisions at $\sqrt{S_{NN}} = 9$ GeV, as well as the

2456 transverse momentum spectra of charged particles conforming the combinatorial background
 2457 during the reconstruction of hyperons in the decay channels indicated in Table 8.1.

2458 Pure signal events corresponding to decays of multi-strange and charmed particles (see
 2459 Table 8.1) were generated by tuning the thermal generator [2] to the energy of NICA collider.

Table 8.1: The decay channels of strange and charmed particles used for their reconstruction in the MPD tracking system.

Hadron	Mass (MeV/cm ²)	Average path length $c\tau$ (mm)	Decay channel	BR (%)
Λ	1115.68 ± 0.01	78.9	$\pi^- + p$	63.9
Ξ^-	1321.71 ± 0.07	49.1	$\pi^- + \Lambda^0$	99.9
Ω^-	1672.45 ± 0.29	24.6	$K^- + \Lambda^0$	67.8
D^+	1869.62 ± 0.20	0.312	$\pi^+ + \pi^+ + K^-$	9.13
D^0	1864.84 ± 0.17	0.123	$\pi^+ + K^-$	3.89
D_s^+	1968.474 ± 0.032	0.150	$\pi^+ + K^+ + K^-$	5.49

2460 A strict set of criteria for signal selection corresponding to real particle decays is used to
 2461 suppress a large combinatorial background in Au + Au central collisions. The topology of the
 2462 decay of short-lived particles into charged hadrons defines the following selection parameters:

- 2463 • the distance of closest approach between the tracks of decay products and the primary
 2464 vertex of interaction of colliding nuclei (*dca*);
- 2465 • the distance between the tracks of daughter particles at the vertex of the decay of the
 2466 parent particle (*distance*);
- 2467 • the path length of the parent particle from the point of its formation to the decay point
 2468 (*path*);
- 2469 • angle between the vector connecting the primary and secondary vertex, and the vector
 2470 of the reconstructed momentum of the parent particle (*angle*).

2471 The cut values of the selection parameters were optimized for each type of particle based
 2472 on the requirement of maximum significance $\frac{S}{\sqrt{S+B}}$, where S and B are the number of signal
 2473 and background events. The short-lived hadrons were identified by appearance of the peak
 2474 corresponding to the parent particle in the invariant mass spectrum of its decay products in a
 2475 certain hadron channel. MC-identification of tracks was used, although in a real experiment
 2476 it will be based on information about the time of flight from the TOF detectors and the
 2477 specific energy losses of charged particles in the TPC.

2478 8.2 First stage ITS simulation: Outer Barrel + Beam Pipe 2479 $\varnothing 64$ mm

2480 This section presents estimations of identification ability of the MPD tracking system which
 2481 includes TPC plus the ITS Outer Barrel (two layers of MAPS) adopted for a beam pipe
 2482 with a diameter of 64 mm. Outer Barrel of ITS will be installed during the first debugging
 2483 phase of the MPD facility operation. Estimates of the reconstruction efficiency of Λ , Ξ and
 2484 Ω^- -hyperons for such configuration of the tracking system are presented below.

2485 8.2.1 Λ -hyperons

2486 The reconstruction of Λ -hyperons was performed for 5×10^4 central Au + Au collisions at
 2487 $\sqrt{S_{NN}} = 9$ GeV simulated using the QGSM generator. In order to extract the signal from the
 2488 invariant mass spectrum $M(\pi^-, p)$ of Λ decay products the following criteria were used:

$$dca(p) > 0.45 \text{ cm} \ \& \ dca(\pi^-) > 1.25 \text{ cm} \ \& \ path(\Lambda) > 3.0 \text{ cm} \ \& \ distance(\pi^-, p) < 0.7 \text{ cm} \ \& \ angle(\Lambda) < 0.09 \text{ rad.} \quad (8.1)$$

2489 The spectrum was approximated by the sum of a Gaussian function with a width σ and a
 2490 polynomial function. The area of the spectrum under the curve of the polynomial function
 2491 in the interval $\pm 2\sigma$ around the peak determines the level of the background (B), and the
 2492 integral with respect to the Gaussian distribution in the same interval provides an estimate
 2493 of the number of reconstructed Λ hyperons. It should be noted that the described algorithm
 2494 was used to select the signal in the invariant mass spectrum for all reconstructed strange and
 2495 charmed particles.

2496 The results of reconstruction are shown in Figure 8.2a. As it can be seen the extraction
 2497 of Λ signal with the given configuration of the Inner Tracking System can be performed with
 2498 an efficiency of 3.9% and a signal-to-noise ratio of 3.6.

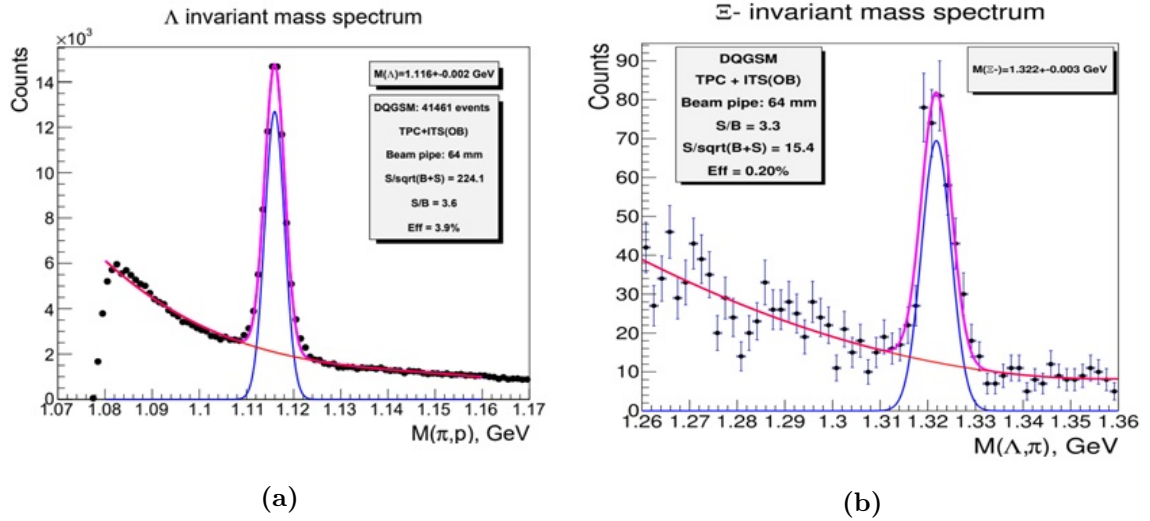


Figure 8.2: Signals of Λ (a) and Ξ^- (b) in the invariant mass spectrum $M(\pi^-, p)$ extracted from 5×10^4 central Au+Au collisions at $\sqrt{S_{NN}} = 9$ GeV (purple line - full spectrum, blue line - signal, red line - residual combinatorial background).

2499 8.2.2 Ξ^- -hyperons

2500 The extraction of the Ξ^- - hyperon signal is a more difficult task compared to the
 2501 reconstruction of Λ -hyperon, since they are characterized by an order of magnitude smaller
 2502 multiplicity in central Au+Au collisions at NICA energies. At the same time the cascading
 2503 nature of their decay leads to a larger number of topological selection criteria ($\Xi^- \rightarrow \pi^- + \Lambda \rightarrow$
 2504 $\pi^- + p$). As a result, the following set of selection criteria was obtained:

$$angle(\Lambda) < 0.08 \text{ rad} \ \& \ distance(p, \pi^-) < 0.35 \text{ cm} \ \& \ distance(\Lambda, \pi^-) < 0.45 \text{ cm} \ \& \ angle(\Xi^-) < 0.045 \text{ rad} \ \& \ dca(\pi^-) > 0.85 \text{ cm} \ \& \ dca(p) > 0.3 \text{ cm.} \quad (8.2)$$

2505 In addition, the cut by the invariant mass of Λ particle was applied to the Λ candidates
 2506 selected during the Λ particle reconstruction: $M(\pi p) = \text{MPDG}(\Lambda) \pm 6\sigma$. The cut values for
 2507 the given selection parameters (Eq. 8.2) were chosen so that the significance level reached a
 2508 maximum for each parameter with fixed values for the remaining parameters.

2509 The invariant mass spectrum $M(\pi^-, \Lambda)$ for Ξ^- candidates obtained after applying all the
 2510 cuts considered is shown in Figure 8.2b. As it can be seen the Ξ^- reconstruction efficiency is
 2511 0.20% with a signal-to-noise ratio of 3.3.

2512 8.2.3 Ω^- -hyperons

2513 The reconstruction of Ω^- -hyperons was performed using the mixed events method which
 2514 assumes that signal and background events are processed separately and then reduced to
 2515 the same statistics and summed up. This method not only allows to increase statistics
 2516 during reconstruction of particles with low multiplicity without a significant increase in
 2517 computational resources, but also makes it easier to find the optimal selection parameters for
 2518 extracting useful events.

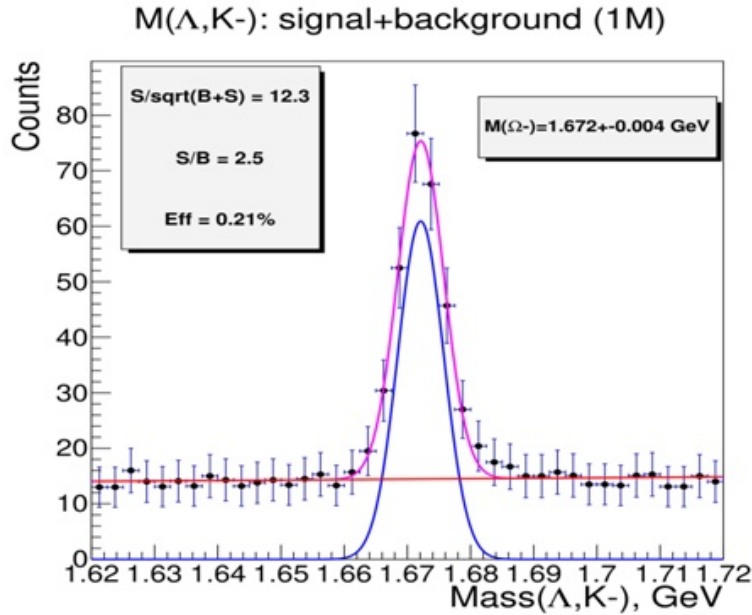


Figure 8.3: Signal of Ω^- -hyperons in the invariant mass spectrum extracted in 10^6 central Au + Au collisions = 9 GeV (purple line - full spectrum, blue line - signal, red line - residual combinatorial background).

2519 To estimate efficiency of the Ω^- reconstruction 10^6 signal events corresponding to the
 2520 decay channel $\Omega^- \rightarrow \Lambda^0 + K^-$ were generated with the thermal generator, while for the
 2521 background 10^5 events of central Au + Au collisions at an energy of $\sqrt{S_{NN}} = 9$ GeV were
 2522 generated by the QGSM generator.

2523 Taking into account the cascade nature of the Ω^- decay, selection criteria similar to the
 2524 case of Ξ^- -hyperons were chosen to extract their signals. The cuts for the selection parameters
 2525 were set according to the maximum of the significance function $\text{Sign}(a)$ for each parameter

2526 a

$$\text{Sign}(a) = \int_0^a \frac{S}{\sqrt{S+B}} da \quad (8.3)$$

resulting the following values:

$$\begin{aligned} &Mass(\Omega) > 1.62 \text{ GeV} \ \& \ Mass(\Omega) < 1.72 \text{ GeV} \ \& \ Mass(\Lambda) > 1.110 \text{ GeV} \ \& \\ &Mass(\Lambda) < 1.122 \text{ GeV} \ \& \ angle(\Lambda) < 0.1 \text{ rad} \ \& \ angle(\Omega) < 0.12 \text{ rad} \ \& \\ &distance(\Lambda, K) < 0.34 \text{ cm} \ \& \ distance(p, \pi) < 0.42 \text{ cm} \ \& \ dca(\Omega) < 0.56 \text{ cm} \ \& \\ &dca(K) > 0.5 \text{ cm} \ \& \ dca(\Lambda) > 0.4 \text{ cm} \ \& \ path(\Lambda) > 6.0 \text{ cm} \ \& \ path(\Omega) > 2.2 \text{ cm}. \end{aligned} \quad (8.4)$$

2527 The invariant mass spectrum obtained after applying the cuts from Eq. 8.4 to signal events
 2528 was reduced taking into account the multiplicity of Ω^- hyperons and the branching ratio of
 2529 the given decay channel and then it was added to the background spectrum normalized to
 2530 10^6 central Au+Au collisions. The multiplicity of Ω^- in central Au+Au collisions at the
 2531 NICA collider energies is 10^{-1} hyperon/event according to theoretical estimations [3]. The
 2532 resulting spectrum is shown in Figure 8.3 and it can be seen that the Ω^- reconstruction
 2533 efficiency is 0.21 % at a significance level of 12.3.

2534 8.3 Project ITS simulation: Outer Barrel + Inner Barrel

2535 This section presents the identification capability of the MPD tracking system, including
 2536 the TPC and the project version of the 5-layer ITS, when reconstructing decays of strange
 2537 and charmed particles produced in central Au+Au collisions at $\sqrt{S_{NN}} = 9 \text{ GeV}$. The
 2538 reconstruction efficiency of hyperons as well as D mesons in the ITS + TPC tracking system
 2539 with a beam pipe diameter of 40mm is estimated in section 8.3.1. Two methods were used
 2540 to extract the signals of the charmed particles in the invariant mass spectrum of the decay
 2541 products: the classical method of topological cuts (TC) and the method of multivariate data
 2542 analysis (MVA). Section 8.3.3 contains a comparison of the reconstruction results for two
 2543 configurations of 5-layer ITS adapted for a beam pipe diameter of 40 and 64 mm, respectively.

2544 8.3.1 Strange particle reconstruction with a beam pipe diameter of 40 mm

2545 8.3.1.1 Λ -hyperons

Figure 8.4 shows the invariant mass spectrum $M(\pi^- p)$ of Λ decay products obtained in 10^5
 central Au+Au collisions at $\sqrt{S_{NN}} = 9 \text{ GeV}$ which satisfies the following selection criteria:

$$\begin{aligned} &dca(p) > 0.3 \text{ cm} \ \& \ dca(\pi^-) > 0.3 \text{ cm} \ \& \ distance(\pi^-, p) < 0.5 \text{ cm} \ \& \ path(\Lambda^0) > 3.0 \text{ cm} \ \& \\ &angle(\Lambda^0) < 0.09 \text{ rad} \end{aligned} \quad (8.5)$$

2546 As it can be seen, the efficiency of Λ reconstruction with a 5-layer ITS configuration is
 2547 8 % with a signal-to-noise ratio of 11.3.

2548 8.3.1.2 Ξ^- -hyperons

2549 The efficiency of reconstruction of Ξ^- -hyperons was evaluated by extracting the signal in
 2550 10^5 central Au + Au collisions at $\sqrt{S_{NN}} = 9 \text{ GeV}$. The suppression of the combinatorial
 2551 background was carried out in accordance with the selection criteria dictated by the
 2552 kinematics of the cascade decay $\Xi^- \rightarrow \pi^- + \Lambda^0 \rightarrow \pi^- + p^+$

To reduce the combinatorial background the following dca values for the decay products
 of Ξ^- and Λ^0 were selected:

$$\begin{aligned} &dca(\pi^-) > 0.5 \text{ cm}, \ dca(p) > 0.5 \text{ cm for } \Lambda^0; \\ &dca(\pi^-) > 0.1 \text{ cm}, \ dca(\Lambda^0) > 0.1 \text{ cm for } \Xi^-. \end{aligned} \quad (8.6)$$

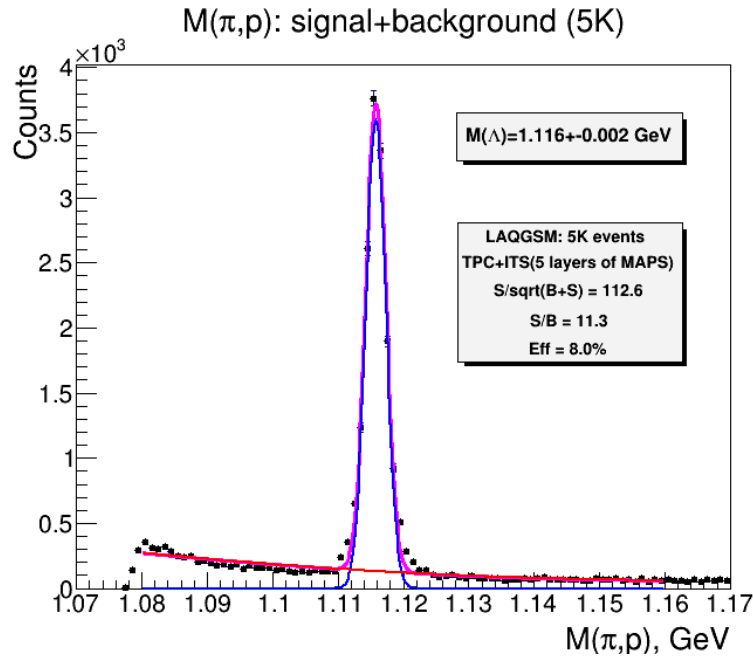


Figure 8.4: Λ^0 -hyperons invariant mass $M(\pi^-p)$ spectrum for 10^5 central Au + Au collisions at $\sqrt{s_{NN}} = 9$ GeV (purple line - full spectrum, blue line - signal, red line - residual combinatorial background).

2553 The distributions for the remaining selection parameters for signal and background events
 2554 and the corresponding significance functions are shown (Figs. 8.5 and 8.6). Based on these
 2555 plots the following cut values were selected:

$$\begin{aligned} distance(\pi^-, p) < 0.05 \text{ cm} \ \& \ distance(\Lambda^0, \pi^-) < 0.2 \text{ cm} \ \& \ angle(\Lambda^0) > 0.02 \text{ rad} \ \& \\ angle(\Xi^-) < 0.05 \text{ rad} \end{aligned} \quad (8.7)$$

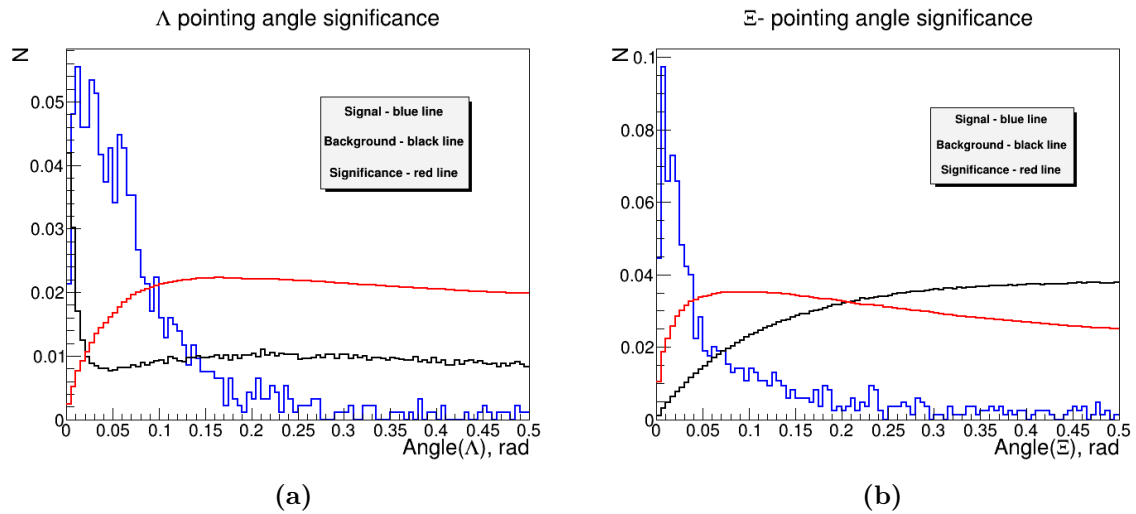


Figure 8.5: Distribution of parameter $angle(\Lambda^0)$ (a) and $angle(\Xi^-)$ (b) for signal and background events.

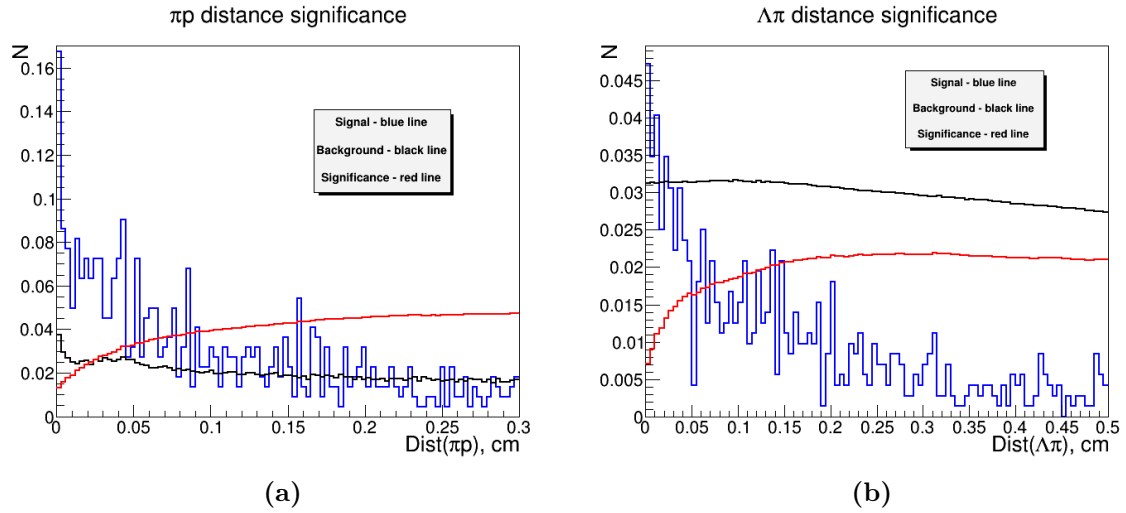


Figure 8.6: Distribution of parameters $distance(\pi, p)$ (a) and $distance(\Lambda, \pi)$ (b) for signal and background events.

2557 The invariant mass spectrum $M(\pi^-\Lambda^0)$ for Ξ^- -candidates built after applying all the
 2558 considered cuts is shown in Figure 8.7. The resulting signal-to-noise ratio of 24.4 makes it
 2559 possible the reconstruction of Ξ^- with an efficiency of 1.3%.

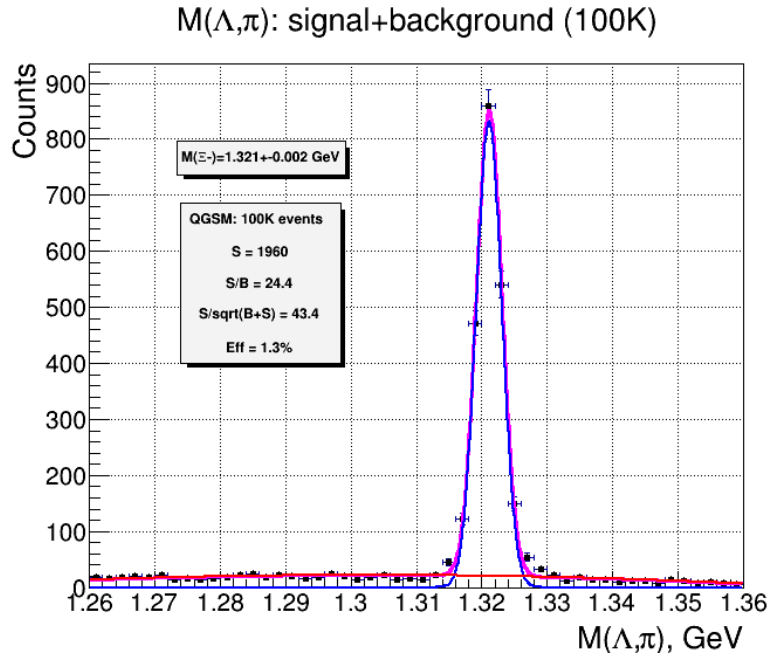


Figure 8.7: Ξ^- -hyperons signal on the invariant mass spectrum $M(\pi^-\Lambda)$ for 10^5 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV (purple line - full spectrum, blue line - signal, red line - residual combinatorial background).

2560 8.3.1.2.1 Ω^- -hyperons

2561

2562 The reconstruction method considered above for Ξ^- was used to extract Ω^- signals
 2563 in 10^5 events of central Au + Au collisions at energy $\sqrt{S_{NN}} = 9$ GeV. In this case, the
 2564 combinatorial background was suppressed by choosing the optimal cuts according to the

2565 same topological parameters as for Ξ^- (Eq. 8.6–8.7) but replacing the pions by kaons in
 2566 accordance with the kinematics of cascade decay $\Omega^- \rightarrow K^- + \Lambda^0 \rightarrow \pi^- + p^+$

Based on the maximum of the significance functions the following cut values were selected:

$$\begin{aligned} & dca(\pi^-) > 0.05 \text{ cm} \ \& \ dca(p) > 0.05 \text{ cm} \ \& \ dca(K^-) > 0.1 \text{ cm} \ \& \ dca(\Lambda^0) > 0.1 \text{ cm} \ \& \\ & \text{distance}(\pi^-, p) < 0.3 \text{ cm} \ \& \ \text{distance}(\Lambda^0, K^-) < 0.1 \text{ cm} \ \& \ \text{angle}(\Lambda^0) > 0.01 \text{ rad} \ \& \\ & \text{angle}(\Omega^-) < 0.015 \text{ rad} \ \& \ dca(\Omega^-) > 0.005 \text{ cm} \ \& \ \text{path}(\Lambda^0) > 5 \text{ cm} \ \& \ \text{path}(\Omega^-) < 8 \text{ cm}. \end{aligned} \quad (8.8)$$

2567 Figure 8.8a shows mass spectrum $M(K^-, \Lambda^0)$ for Ω^- -candidates built after applying the
 2568 cuts. It can be seen that statistics of 10^5 central Au + Au collisions at $\sqrt{S_{NN}} = 9 \text{ GeV}$
 2569 are insufficient for a reliable selection of Ω^- -hyperons. To increase the significance of Ω^-
 2570 reconstruction 10^6 pure signal events $\Omega^- \rightarrow K^- + \Lambda^0$ were processed in addition to the 10^5
 2571 background events.

2572 The invariant mass spectrum obtained by mixed events method (see Sec. 8.2.3) and
 2573 normalized to 10^6 central Au+Au collisions is shown in Figure 8.10. As a result the Ω^-
 2574 reconstruction efficiency is 1.5% at a significance level of 30.

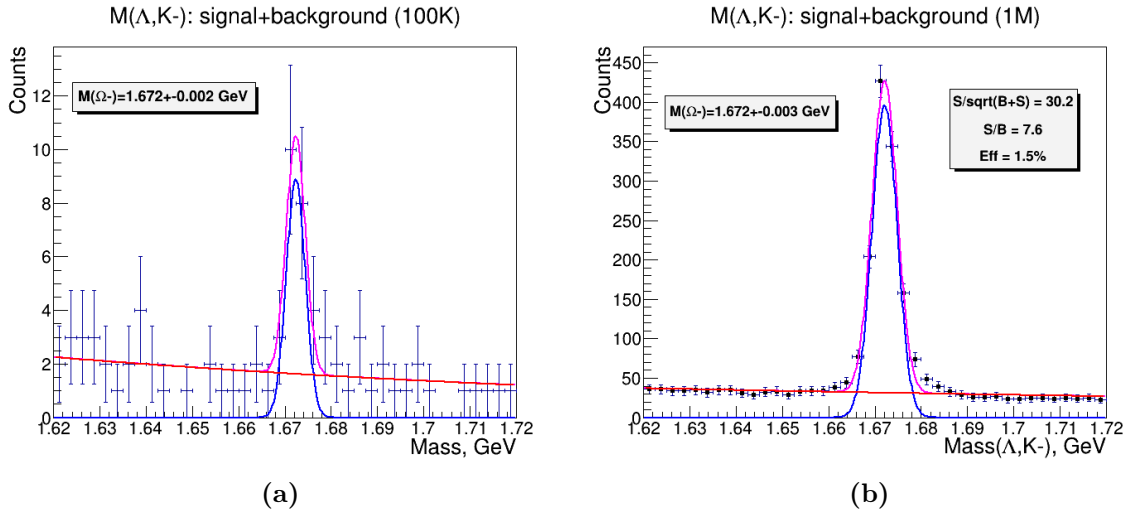


Figure 8.8: Ω^- -hyperons signal on the invariant mass spectrum $M(\pi^- \Lambda)$ for 10^5 (a) and 10^6 (b) central Au + Au collisions at $\sqrt{S_{NN}} = 9 \text{ GeV}$ (purple line - full spectrum, blue line - signal, red line - residual combinatorial background).

2575 8.3.2 Reconstruction of charmed particles.

2576 The identification ability of the MPD track system in the reconstruction of charmed particles
 2577 was evaluated using D^0 and D^+ -mesons as test case. For this purpose 10^6 signal decay-events
 2578 of $D^0 \rightarrow K^- + \pi^+$ and $D^+ \rightarrow K^- + \pi^+ + \pi^+$ and 10^5 background events of the central Au+Au
 2579 collisions at $\sqrt{S_{NN}} = 9 \text{ GeV}$ were processed. The selection of D signals from the invariant
 2580 mass spectrum of their decay products was carried out in two ways: the classical method of
 2581 topological cuts (TC) and the method of multivariate data analysis (MVA).

2582 8.3.2.1 Reconstruction of D -mesons by the TC method.

8.3.2.1.1 D^0 -mesons.

When reconstructing the decay vertex of the D^0 mesons, only the tracks of their decay products that were reconstructed by hits in all 5 layers of the ITS were selected. In

order to reduce the combinatorial background dca cuts were set to 2σ from the width of their distributions:

$$dca(K) > 0.012 \text{ cm} \ \& \ dca(\pi) > 0.012 \text{ cm}, \quad (8.9)$$

2583 the reconstructed distributions for $distance(\pi, K)$, $path(D^0)$ and $angle(D^0)$ of signal and
2584 background events and the corresponding significance functions are shown in Figures 8.9a –
2585 8.9c.

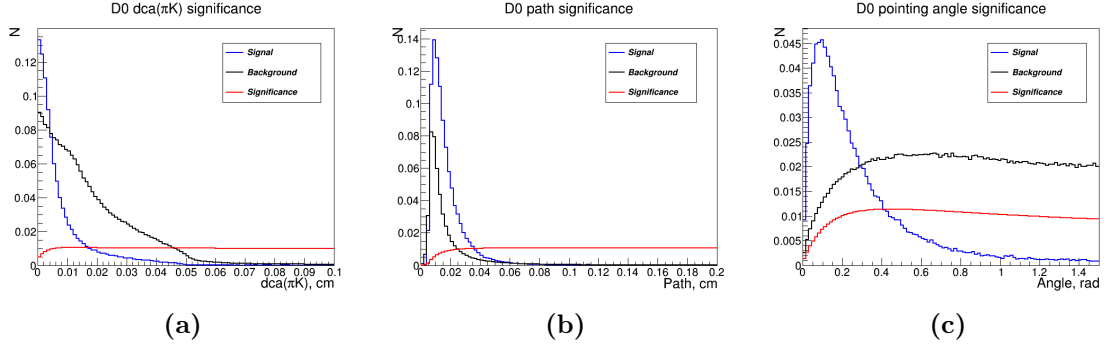


Figure 8.9: Distribution of parameters $distance(D^0)$ (a), $path(D^0)$ (b) and $angle(D^0)$ (c) for signal ($D^0 \rightarrow K^- + \pi^+$) and background Au+Au events.

Based on the maximum of the significance functions the following cuts were applied to signal and background events:

$$distance(\pi, K) < 0.019 \text{ cm} \ \& \ path(D^0) < 0.044 \text{ cm} \ \& \ angle(D^0) < 0.15 \text{ rad} \quad (8.10)$$

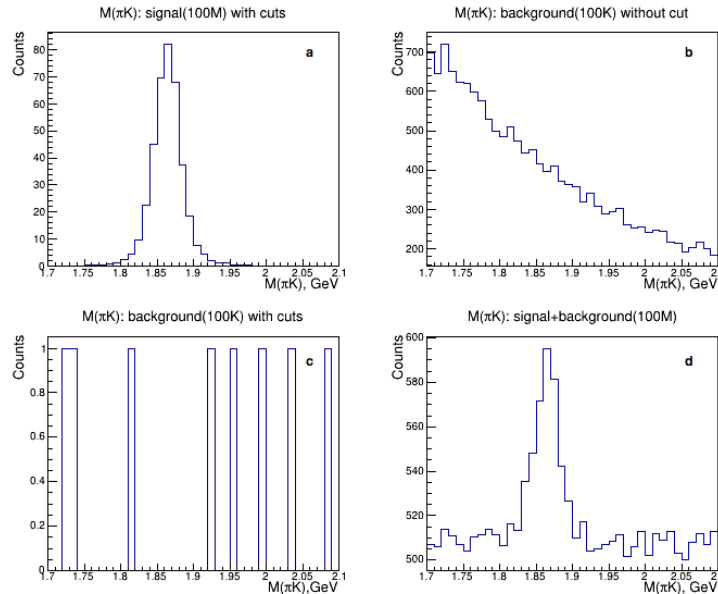


Figure 8.10: Invariant mass $M(K^- \pi^-)$ signal events spectra for 10^8 central Au + Au collisions after applying the cuts (a), for background events in 10^5 central Au + Au collisions before (b) and after (c) applying the cuts, and for the sum of spectra a and c scaled to the statistics of 10^8 central Au + Au events (d).

2587 Figure 8.10(a) shows the invariant mass $M(K^-\pi^+)$ signal spectrum that satisfies the
 2588 selection criterion from Eq. 8.9 and 8.10 scaled to statistics of 10^8 central Au+Au collisions
 2589 accounting for the multiplicity of D^0 -mesons and the probability of their decay to the channel
 2590 $D^0 \rightarrow K^- + \pi^+$. The multiplicity of D -mesons in central Au + Au collisions was estimated
 2591 using the dynamic model of the hadron string [4] resulting in 10^{-2} mesons/event at NICA
 2592 collider energies. The background spectrum in 10^5 events *before* and *after* applying the cuts
 2593 (Eq. 8.10) is shown in Figures 8.10(b),(c). The residual combinatorial background (Fig.
 2594 8.10(c)) was uniformly distributed over the chosen range and then scaled to statistics of 10^8
 2595 events with the addition of the statistical fluctuations. Figure 8.10(d) shows the resulting
 2596 spectrum obtained by adding the signal and background spectra normalized to 10^8 central
 2597 Au + Au collisions. Figure 8.11 shows the signal selection on a combinatorial background
 2598 with the same statistics. It can be seen that the reconstruction efficiency for D^0 is 0.8%
 2599 at a significance level of 5.3. The mass of reconstructed D^0 -mesons is in good agreement with
 2600 its PDG value (see Table 8.1).

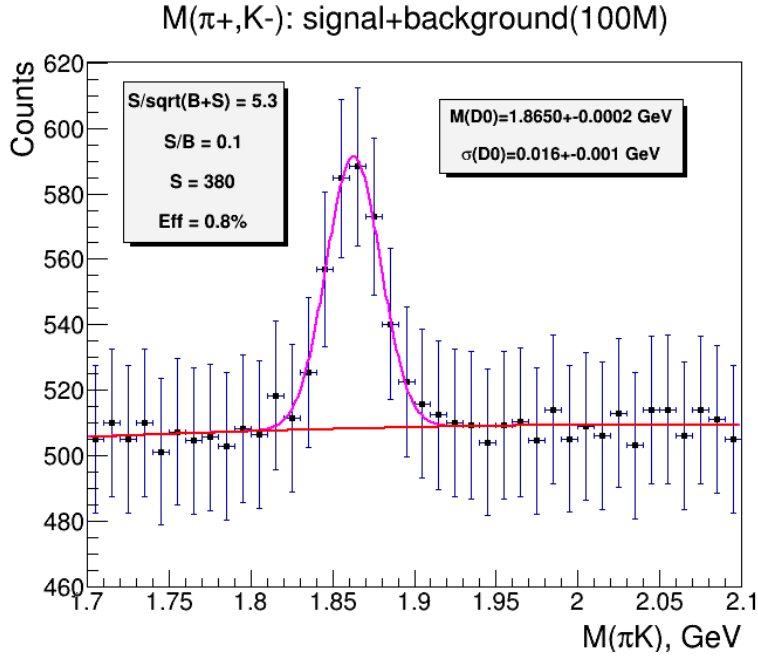


Figure 8.11: D^0 -mesons signal on the invariant mass spectrum $M(\pi^+K^-)$ for 10^8 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV (purple line - full spectrum, red line - residual combinatorial background).

8.3.2.1.2 D^+ -mesons.

To reconstruct the D^+ , the background was suppressed by applying selection criteria for the topological parameters related to the kinematics of three-particle decay $D^+ \rightarrow K^- + \pi^+ + \pi^+$. In this case, the parameter distance was determined as the sum of the shortest distances between each pair of tracks of the daughter particles at the decay point. To build the $\pi^+ + \pi^+ + K^-$ invariant mass spectrum, the cuts for the selection parameters were chosen according to the maximum value of the significance function (see Fig. 8.12) for each parameter:

$$\begin{aligned} dca(K) > 0.029 \text{ cm} \ \& \ dca(\pi) > 0.029 \text{ cm} \ \& \ distance < 0.06 \text{ cm} \ \& \\ path(D^+) < 0.11 \text{ cm} \ \& \ angle(D^+) < 0.15 \text{ rad} \end{aligned} \quad (8.11)$$

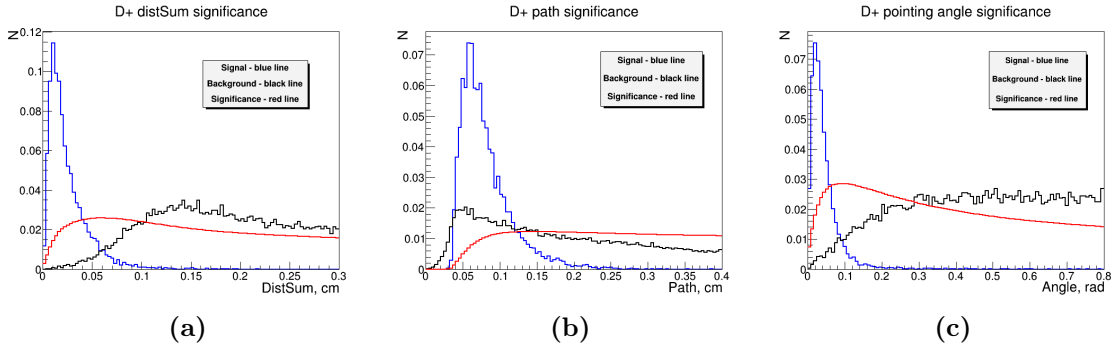


Figure 8.12: Distribution of parameters $distance(D^0)$ (a), $path(D^0)$ (b) and $angle(D^0)$ (c) for signal ($D^+ \rightarrow K^- + \pi^+ + \pi^+$) and background Au+Au events.

2601

2602 The resulting invariant mass spectrum normalized to 10^8 central Au + Au events and
 2603 satisfying the cut criteria (8.11) was built following the same procedure as described for
 2604 D^0 -mesons. Figure 8.13 shows the isolation of the D^+ signal extracted from the residual
 2605 combinatorial background. It can be seen that the D^+ reconstruction efficiency is 0.5% at a
 2606 significance level of 7.0, and the mass of reconstructed D^+ mesons is in good agreement with
 2607 its PDG value (see Table 8.1).

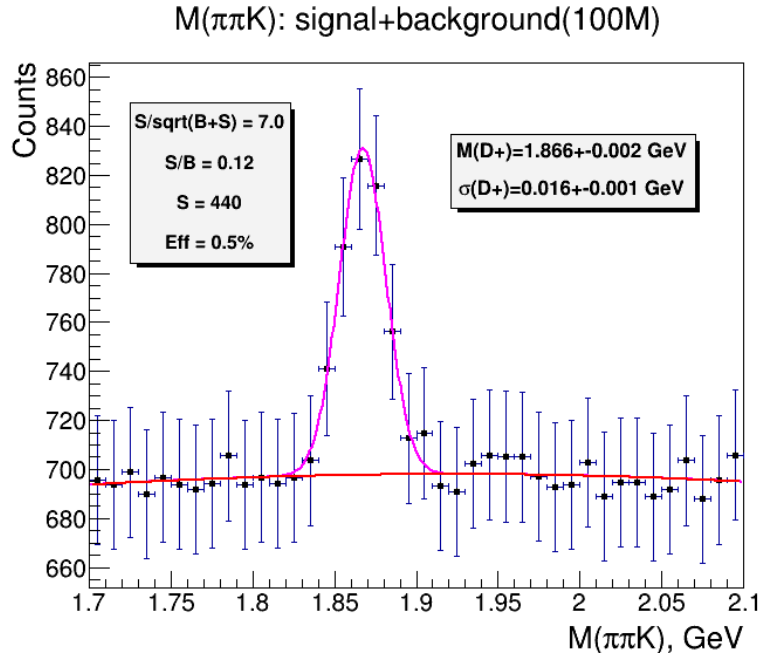


Figure 8.13: D^+ -mesons signal on the invariant mass spectrum $M(\pi^+\pi^+K^-)$ for 10^8 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV (purple line - full spectrum, red line - residual combinatorial background).

2608 8.3.2.2 Reconstruction of D -mesons by the MVA method

2609 The package for multivariate data analysis TMVA [5] integrated into the MpdROOT
 2610 environment provides several classification algorithms designed to solve the problem of
 2611 separating the signal from the background. A typical TMVA classification analysis consists
 2612 of two independent steps:

- 2613 1. Training phases, where multivariate analysis methods are tested and evaluated;
- 2614 2. Application phases, where the selected methods are applied to the specific classification
- 2615 problem for which the training was conducted.

2616 In the training phase, a relationship is first established between user data sets and MVA

2617 methods. Data for training and testing selected methods is presented in a tree format. The

2618 *TreeS* tree includes data that is known to correspond to a signal. The *TreeB* tree includes

2619 data that does not contain useful information, but corresponds to the background. The

2620 classification results for each registered MVA method are recorded in weighted files with N

2621 input variables V are mapped to the one-dimensional variable R (response): $V^N \rightarrow R$. At

2622 the analysis stage, the cut for this variable R is applied to a data set with an unknown

2623 composition of the signal and the background.

2624 Multivariate analysis was used to reconstruct D -mesons mesons. The input data was

2625 tested and evaluated using the BDT (Boosted Decision Tree) classifier.

2626 8.3.2.2.1 D^0 -mesons

2627 The same *path*, *distance* and *angle* variables used as selection parameters for the

2628 reconstruction of D^0 -mesons by the TC method were taken as the input data for the selected

2629 BDT classifier. The distributions of these variables in 10^6 signal and 10^5 background

2630 events are shown in Figure 8.14, while Figure 8.15 shows their various transformations:

2631 decorrelation (Deco), Gaussian (Gauss) and principal components analysis (PCA). The

2632 result of the input variable classification is shown in Figure 8.16.

2633

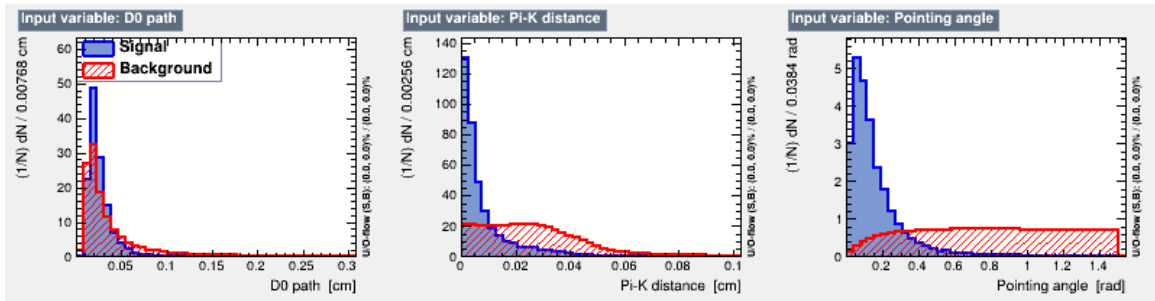


Figure 8.14: Distributions of input variables $path(D^0)$ (left panel), $distance(\pi^+K^-)$ (middle panel) and $angle(D^0)$ (right panel) for signal ($D^0 \rightarrow K^- + \pi^+$) and background (Au+Au) events.

2634 To separate the signal from the background the classifier response cut $BDTD_response$

2635 > 0.3 , was applied to signal and background events. After that, the signal and background

2636 invariant mass spectra of π^+K^- combinations were concatenated according to the procedure

2637 described in Sec. 8.3.2.1. The resulting spectrum normalized to 10^8 central Au+Au is shown

2638 in Figure 8.17. It can be seen that the D^0 reconstruction efficiency is 0.85 % at a significance

2639 level of 5.5, which is in full agreement with the results obtained by the classical method of

2640 topological cuts (see Figure 8.11).

2641 8.3.2.2.2 D^+ -mesons

2642 The reconstruction of D^+ by MVA method was carried out in the same way as for D^0

2643 mesons. The results of the classification of input variables $distance(\pi^+\pi^+K^-)$, $path(D^+)$ and

2644 $angle(D^+)$ with the application of the BDT method are shown in Figure 8.19, according to

2645 which the classifier cut was chosen as $BDTD_response > 0.25$. The invariant mass spectrum

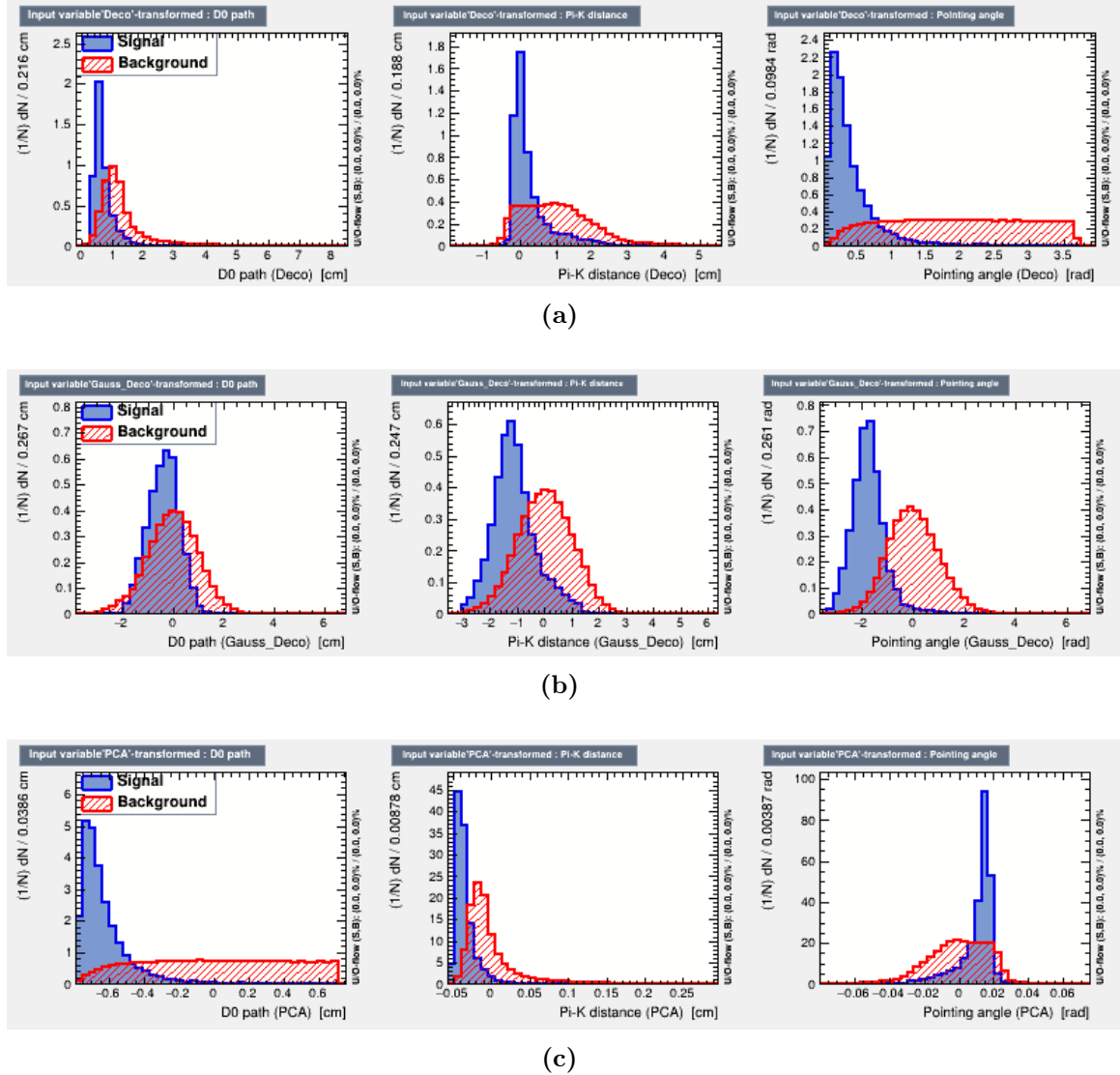


Figure 8.15: Distributions of input variables for signal ($D^0 \rightarrow K^- + \pi^+$) and background events after *decorrelation* (a), *Gaussian* (b) and *PCA* (c) transformations.

2646 of D^+ decay products normalized to 10^8 central Au+Au collisions is presented in Figure 8.20.
 2647 It is shown that the efficiency of D^+ reconstruction by MVA method is 1% at the significance
 2648 level 10.5. The comparison with the results obtained by TC method (see Figure 8.13) shows
 2649 that the use of multivariate analysis in the case of D^+ increases the reconstruction efficiency
 2650 by a factor of 2 at a higher level of significance.

2651 8.3.2.3 Transverse momentum spectra of reconstructed D mesons

2652 The normalized distributions of the transverse momentum p_T of D-mesons generated by
 2653 thermal generator and reconstructed with ITS+TPC tracking system are shown in Figure
 2654 8.21. It can be seen that p_T - spectra of reconstructed and generated D-mesons are in good
 2655 agreement. The observed shift of the average p_T for the reconstructed D-mesons toward large
 2656 values indicates that the reconstruction efficiency decreases with a decrease in the transverse
 2657 momentum of the D meson.

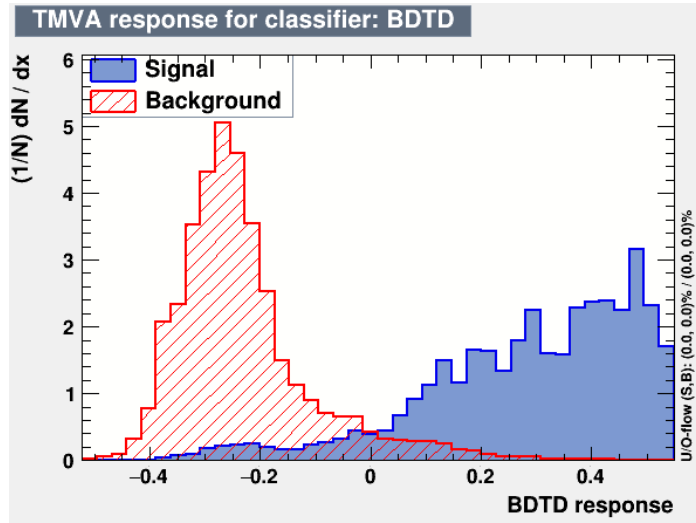


Figure 8.16: Distribution of BDT classifier responses to signal ($D^0 \rightarrow K^- + \pi^+$) and background (Au+Au) events.

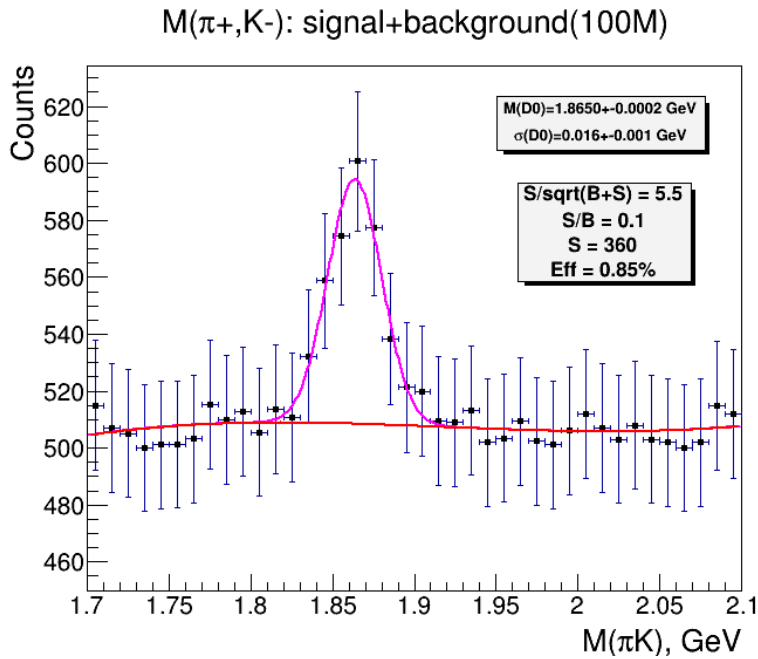


Figure 8.17: D^0 -meson signal on the invariant mass spectrum in 10^8 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV extracted by the MVA method (purple line - full spectrum, red line - residual combinatorial background).

2658 8.3.2.4 Yield of strange and charmed particles

2659 The obtained estimates values of the reconstruction efficiency ε of hyperons and D mesons
 2660 were used to evaluate their yields in the MPD experiment with the tracking system including
 2661 the TPC and the *project* version of the ITS.

2662 At the optimal luminosity of the NICA collider the Au+Au interaction rate will be about
 2663 $R = 8 \times 10^3$ events/s [6] and a fraction of central collisions with impact parameter less 4 fm is
 2664 $\delta = 0.1$. Taking into account the theoretical evaluation of the particle multiplicity M at NICA
 2665 collider energies [3, 4] and the branching ratio BR of the particle decay by the given channel

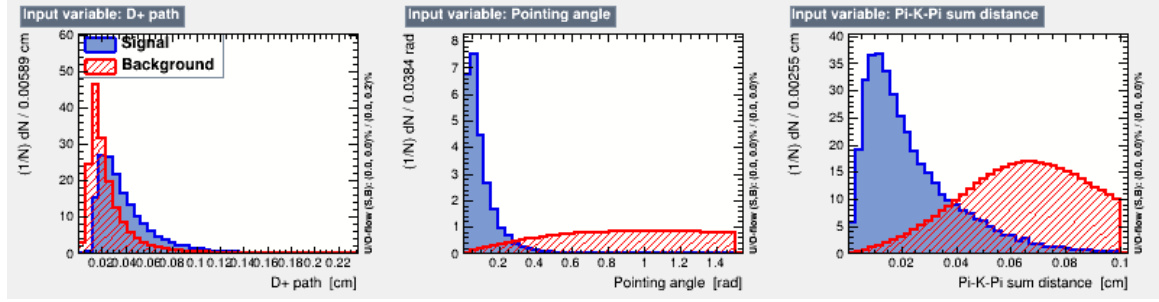


Figure 8.18: Distributions of input variables for signal ($D^+ \rightarrow K^- + \pi^+ \pi^+$) and background events.

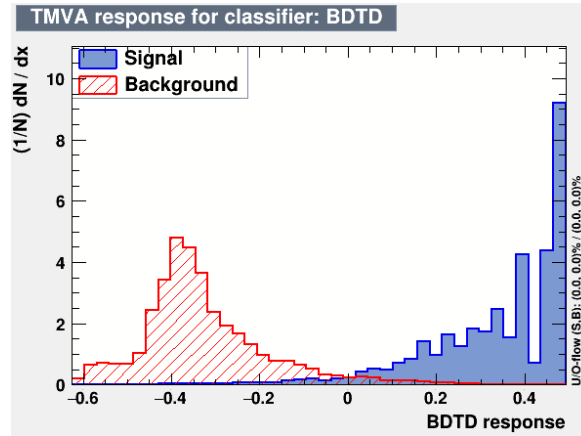


Figure 8.19: Distribution of BDT classifier responses to signal ($D^+ \rightarrow K^- + \pi^+ \pi^+$) and background events.

2666 (see Table 8.1) it is possible to calculate the particle yield in the MPD experiment during one
 2667 month ($T = 2.6 \times 10^6$ s) of the NICA collider continuous operation as $Y = R \cdot \delta \cdot M \cdot T \cdot \varepsilon \cdot BR$.
 2668 The evaluated yields of strange and charmed particles in central Au+Au collisions at $\sqrt{S_{NN}}$
 2669 = 9 GeV as well as the main reconstruction parameters are given in Table 8.2.

Table 8.2: Reconstruction parameters of strange and charmed particles in central Au+Au collisions at $\sqrt{S_{NN}} = 9$ GeV with the *project ITS*.

Particle	Λ	Ξ^-	Ω^-	D^0	D^+		
Reconstruction method	TC*	TC	TC	TC	MVA**	TC	MVA
Multiplicity	20	1.2	10^{-1}	10^{-2}	10^{-2}	10^{-2}	10^{-2}
Number of events	5×10^3	10^5	10^6	10^8	10^8	10^8	10^8
Efficiency [%]	8.0	1.3	1.5	0.80	0.85	0.50	1.0
Significance ($S/\sqrt{S+B}$)	112.6	43.4	30.2	5.3	5.5	7.0	10.5
S/B ratio (2σ)	11.3	24.4	7.6	0.10	0.10	0.12	0.14
Yield [particles/month]	2×10^9	3×10^7	2×10^6	6.5×10^3	7×10^3	10^4	2×10^4

* TC: topological cuts; ** MVA: multivariate analysis

2670 8.3.3 Strange and charmed particle reconstruction for a beam pipe 2671 diameter of 64 mm

2672 This section compares the identification capabilities of the ITS+TPC tracking system with a
 2673 beam pipe diameter of 40 mm and 64 mm when reconstructing strange and charmed particles.
 2674 The signals of hyperons and D-mesons in the invariant mass spectra of their decay products

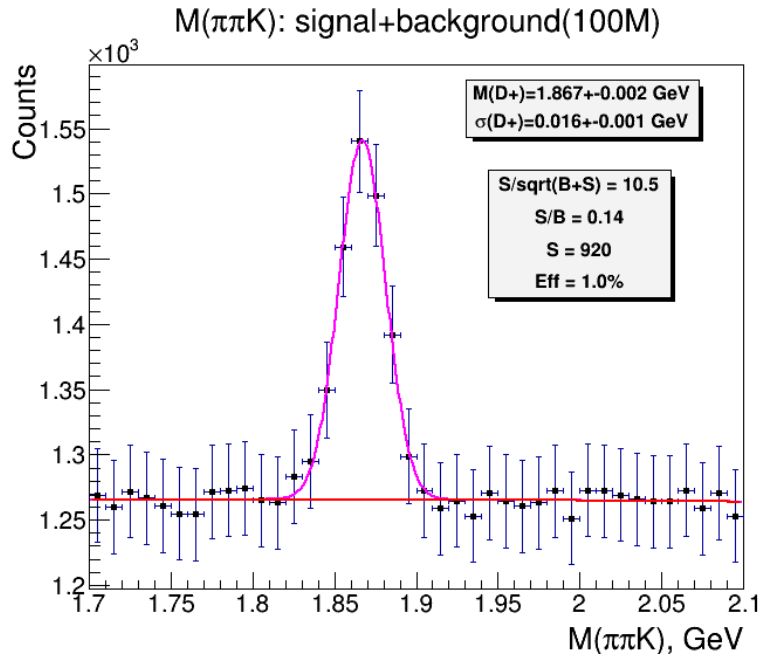


Figure 8.20: D^+ -meson signal in the invariant mass spectrum $M(\pi^+\pi^+K^-)$ extracted by the MVA method in 10^8 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV (purple line - full spectrum, red line - residual combinatorial background).

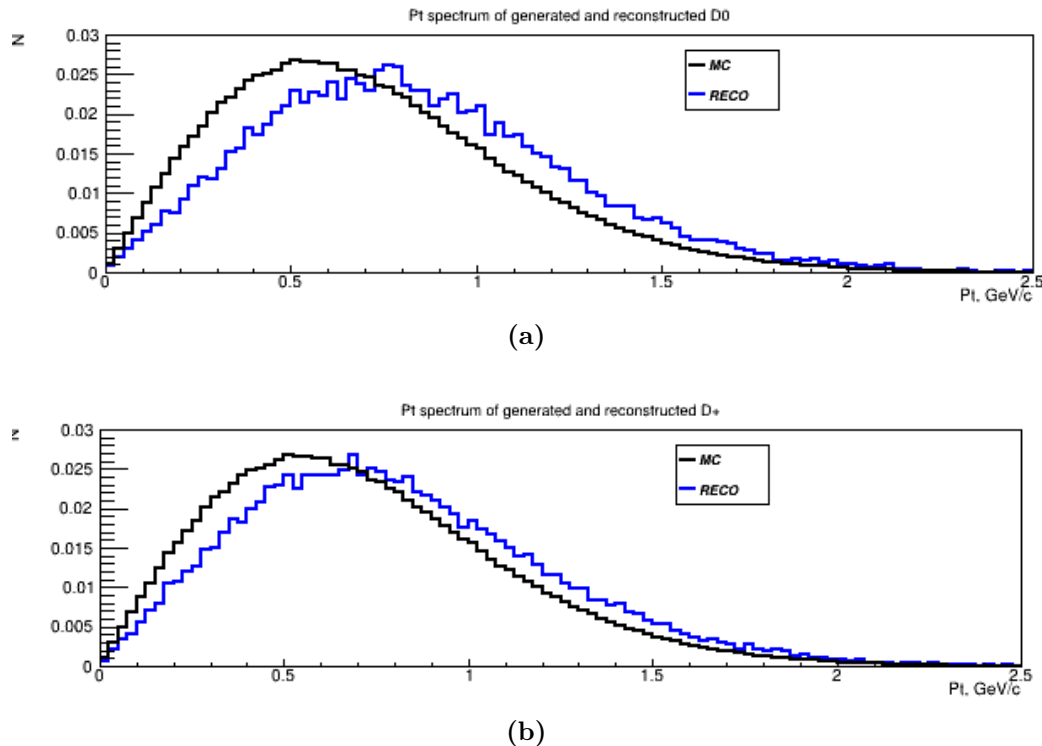


Figure 8.21: Transverse momentum distribution of generated (MC) and reconstructed (RECO) D^0 (top panel) and D^+ (bottom panel).

2675 with a 5 layer ITS and a beam pipe of \varnothing 64 mm (configuration ITS5-64) were extracted
 2676 using the same methods and the same statistics of Au+Au events as with the ITS adapted

2677 to a beam pipe \varnothing of 40 mm (configuration ITS5-40). The results of the reconstruction of
 2678 multi-strange hyperons and of D^+ mesons are presented in Table 8.3 and in Figures 8.22 and
 2679 8.23. As it can be seen from Table 8.3 the reconstruction quality of multi-strange hyperons
 2680 slightly deteriorates when increasing in the diameter of the beam pipe from 40 mm to 64 mm,
 2681 while the reconstruction efficiency of D mesons decreases by an order of magnitude making
 2682 it almost impossible to extract the signal with ITS5-64. The results obtained indicate that
 2683 for a reliable reconstruction of charmed particles collected with the required statistics, it is
 2684 necessary to reduce the diameter of the MPD beam pipe to an optimal value of 40 mm.

Table 8.3: Reconstruction parameters of the ITS + TPC tracking system of the MPD for strange and charmed particles in central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV for a beam pipe diameter of 40 mm and 64 mm.

Particle	Ξ^-		Ω^-		D^+		D^+	
Reconstruction method	TC		TC		TC		MVA	
Number of events	10^5		10^5		10^8		10^8	
Beam pipe diameter [mm]	40	64	40	64	40	64	40	64
Efficiency [%]	1.3	1.2	0.7	0.6	0.5	0.04	1.0	0.06
Significance (S/ $\sqrt{S+B}$)	43.4	42.5	3.7	3.5	7.0	0.9	10.5	0.9

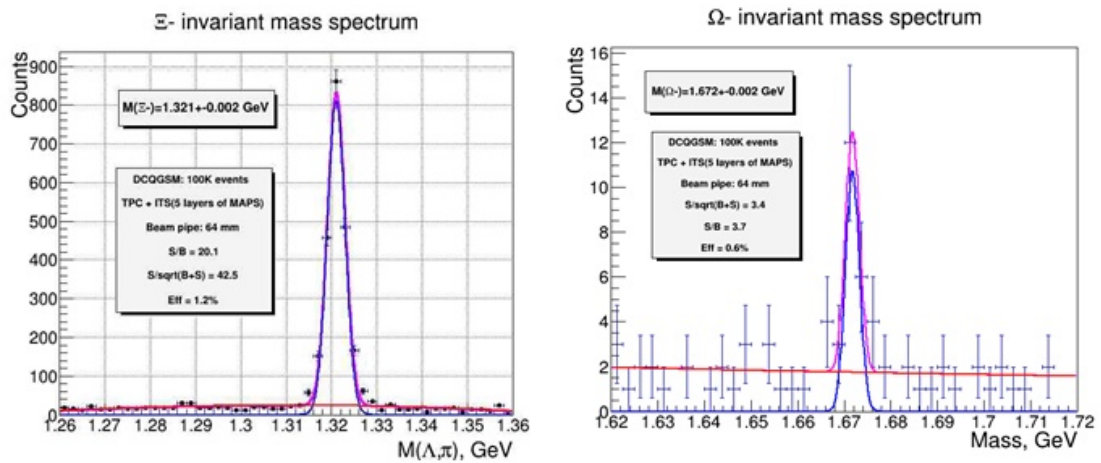


Figure 8.22: Multi-strange hyperon signal on the invariant mass spectrum for 10^5 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV for the ITS + TPC tracking system with a beam pipe diameter of 64 mm (purple line - full spectrum, red line - residual combinatorial background).

2685 8.3.4 Charmed particle reconstruction using Vector Finder tracking 2686 mechanism

2687 This section presents the identification capability of the MPD tracking system, including the
 2688 TPC and the *project* version of the 5-layer ITS when reconstructing decays of D mesons
 2689 using the Vector Finder (VF) tracking algorithm (see Section 7.2.6) instead of Kalman Filter
 2690 (KF) method. The extraction of D signals in the invariant mass spectra was carried out on
 2691 statistics of 10^8 central Au+Au collisions at $\sqrt{S_{NN}} = 9$ GeV by TC and MVA methods. The
 2692 reconstruction results are shown in Figure 8.24 and Table 8.4. As it can be seen from Table

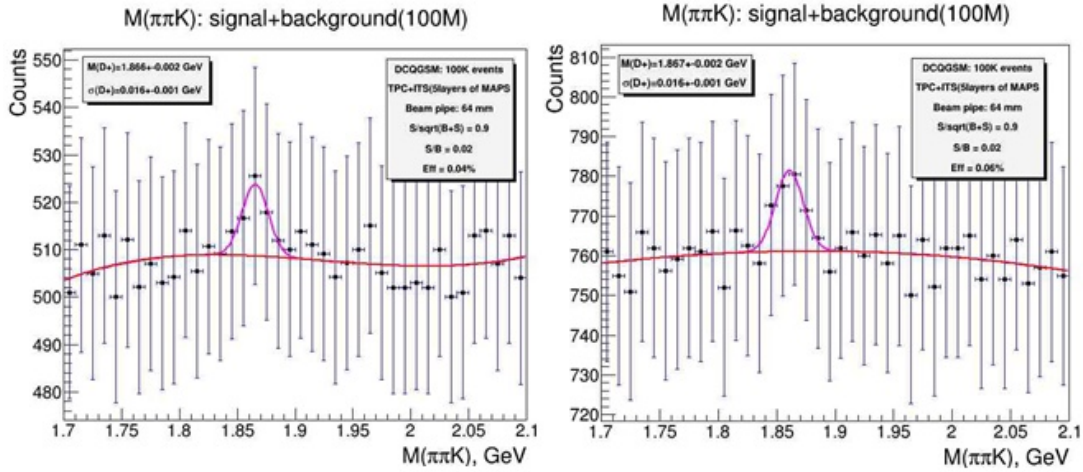


Figure 8.23: D^+ signal in the invariant mass spectrum extracted from 10^8 central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV in ITS + TPC tracking system with beam pipe diameter of 64 mm by TC method (left) and MVA method (right) (purple line - full spectrum, red line - residual combinatorial background).

2693 8.4 the use of VF mechanism allows us to reconstruct D with higher efficiency and at higher level of significance compared to KF technique.

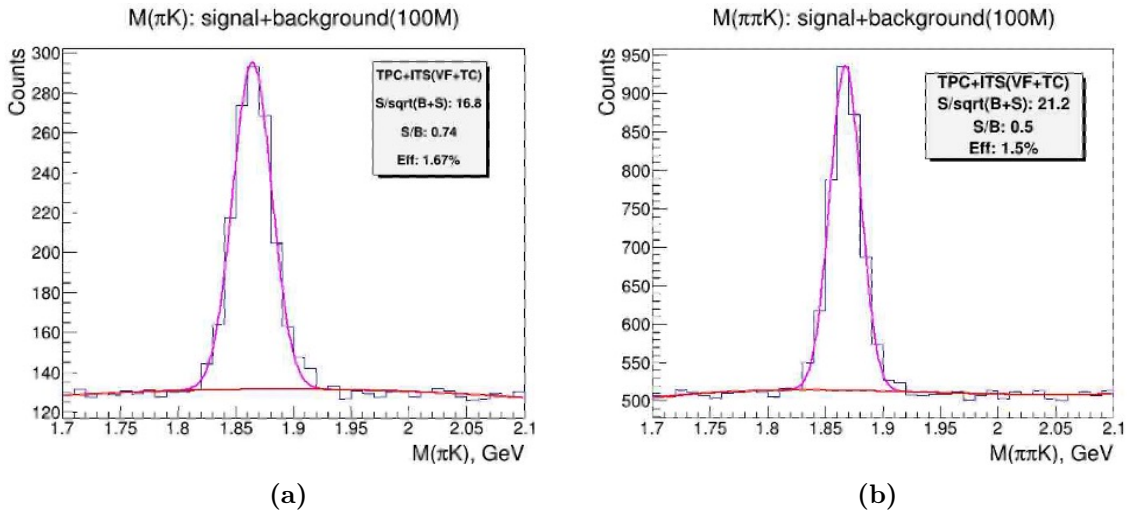


Figure 8.24: Signal of D^0 (a) and D^+ (b) in the invariant mass spectra extracted from 108 central Au+Au collisions at $\sqrt{S_{NN}} = 9$ GeV by TC method using VF tracking mechanism (purple line - full spectrum, blue line - signal, red line - residual combinatorial background).

2694

2695 8.4 Conclusions

2696 The identification capability of the MPD tracking system, which includes the time-projection
 2697 chamber (TPC) and the ITS vertex detector based on monolithic active pixel sensors, was
 2698 studied during reconstruction of strange and charmed particles produced in central Au+Au
 2699 collisions at $\sqrt{S_{NN}} = 9$ GeV. Three variants of the ITS were considered:

Table 8.4: Reconstruction parameters of the ITS + TPC tracking system of the MPD for strange and charmed particles in central Au + Au collisions at $\sqrt{S_{NN}} = 9$ GeV for a beam pipe with a diameter of 40 mm and 64 mm.

Particle	D^0				D^+			
	KF		VF		KF		VF	
Tracking method	TC	MVA	TC	MVA	TC	MVA	TC	MVA
Reconstruction method	TC	MVA	TC	MVA	TC	MVA	TC	MVA
S/B ratio	0.10	0.11	0.74	0.75	0.12	0.14	0.50	0.80
Significance	5.3	5.5	16.8	17.0	7.0	10.5	21.2	28.5
Efficiency [%]	0.80	0.85	1.67	1.70	0.5	1.0	1.5	2.0

- 2700 • the ITS-5-40 configuration consisting of 5 layers of pixel sensors (3 layers of the Inner
2701 Barrel + 2 layers of the Outer Barrel) and considering a pipe diameter of 40 mm (*project*
2702 variant);
- 2703 • the ITS-5-64 configuration consisting of 5 layers of pixel sensors (3 layers of the Inner
2704 Barrel + 2 layers of the Outer Barrel) and considering a beam pipe diameter of 64 mm
2705 (*intitial* variant);
- 2706 • the ITS-2-64 configuration consisting of 2 layers of pixel sensors of the Outer Barrel
2707 and considering a beam pipe diameter of 64 mm (*first stage of the project*).

2708 The *project* and *intitial* variants as well as the *first stage of the project* have been defined in
2709 Chapter 3.

2710 Estimates of the extraction efficiency of hyperons Λ , Ξ^- and Ω^- and charmed mesons D^0 ,
2711 D^+ from the invariant mass of charged decay products for the three configurations of vertex
2712 detector show that ITS-5-40, having the best spatial resolution, provides reliable detection
2713 with an efficiency of about 1 % for both multi-strange and charmed particles when collecting
2714 the relevant statistics of Au + Au collisions.

2715 On the other hand, for the configuration ITS-5-64 the efficiency of reconstruction of
2716 hyperons decreases by 10 %, while for D -mesons the efficiency of their reconstruction decreases
2717 by an order of magnitude which makes it almost impossible to register them at the same level
2718 of statistics. Therefore the study of the physics of heavy-flavour in experiments on nucleus-
2719 nucleus collisions at the NICA-MPD facility turns out to be promising assuming that the
2720 diameter of the MPD beam pipe is reduced to an optimum value of 40 mm.

2721 As for the version ITS-2-64 to be implemented as the first stage of the project, the
2722 extraction of multi-strange hyperons with the tracking system, including the TPC and only
2723 the Outer Barrel of the Internal Tracker, can be performed with an efficiency of 0.2 % which
2724 is sufficient to assess its identification capability at the debugging stage.

2725 Bibliography

- 2726 [1] Gudima KK, Mashnik SG, Sierk A. J . User Manual for the Code LAQGSM, Los Alamos
2727 National Laboratory Report. LA-UR-01-6804. Los Alamos. 2001.
- 2728 [2] Tawfik AN, Abbas E. Thermal Description of Particle Production in Au-Au Collisions
2729 at STAR Energies, Letters to ECHAYA. 2015. T12. No4. (195). s.818-831.
- 2730 [3] Blume C. Energy dependence of hadronic observables, J. Phys. G: Nucl. Part.Phys, 2005.
2731 V.31. P.S57-S68.
- 2732 [4] Cassing W., Bratkovskaya EL, Sibirtsev A, Open charm production in relativistic
2733 nucleus-nucleus collisions, Nucl. Phys. A, 2001, V.691 (3), p.753-778.
- 2734 [5] Hoecker A., Speckmayer P., Stelzer J., Therhaag J., von Toerne E., Voss H.
2735 TMVA4 - Toolkit for Multivariate Data Analysis with ROOT. arXiv:physics/0703039v5
2736 [physics.data-an]. 2009.
- 2737 [6] Kekelidze V.D., NICA project at JINR: status and prospects, JINST, 2017, V.12,
2738 P.C06012.

9 Project Organization and Time Lines

The MPD-ITS construction tasks will be distributed among the participating institutes from JINR and China under the supervision from CERN, as it is shown in Figure 9.1. This organization foresees the use of existing infrastructures in the institutes but also the setting up of new infrastructure for HIC and Stave assembly in both countries. To that purpose it is planned to use the existing Outer Barrel HIC assembly site on CCNU (Wuhan) and to set up another two identical HIC assembly centers in JINR (Russia) and IMP (China). Additionally, three Stave assembly sites will be set up in Russia (JINR) and China (CCNU and IMP), respectively. These centers will receive components either directly from industry or from other Institutes participating in the MPD-ITS Project

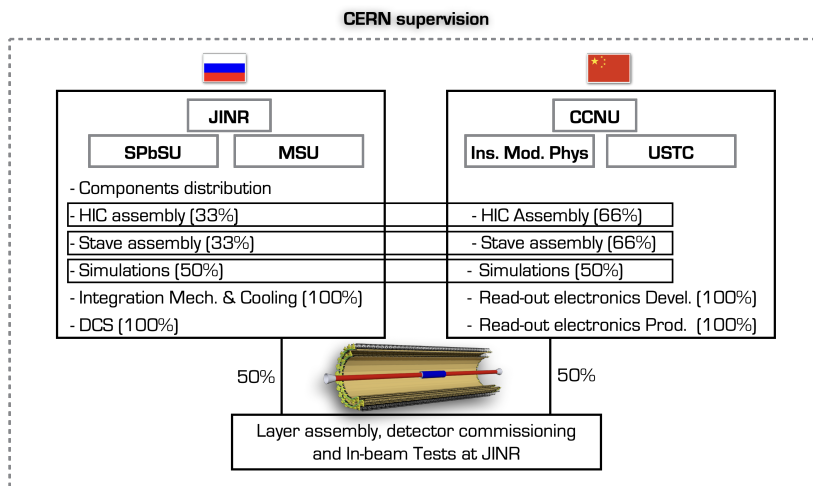


Figure 9.1: Scheme of ITS and TPC tracks matching

All detector elements (e.g. Pixel Chip, FPC, HIC) need a thorough quality control and require numerous acceptance tests. Following there is a short overview of the preliminary distribution of responsibilities for the construction of the MPD-ITS.

Pixel Chip. The Pixel Chip for the outer barrel (ALTAI) is based on the MAPS chips used for the recent upgrade the ALICE ITS Project and manufactured by TowerJazz, which is one of the world's leading companies in the field of CMOS imaging sensors. The characterization of the prototype circuits and of the final engineered full-scale chip is a major enterprise, which involves different groups: JINR, Kurchatov Institutue, CCNU, CERN, DISCO, Yonsei. The ALICE ITS Project will provide to TowerJazz the description of the Pixel Chip at the layout level, in the format of standard GDSII data stream, which will be used by the manufacturer to generate the photomask set. A total production of about 415 wafers, which has been estimated assuming a 50 % yield, will be manufactured in 3 tranches.

The Pixel Chip for the Inner Barrel is foreseen to be of the type "Large-area MAPS" which is currently under R&D at CERN and in parallel in China. In case this option would fail, the backup solution would be to use an ALTAI variant of the MAPS chips used for

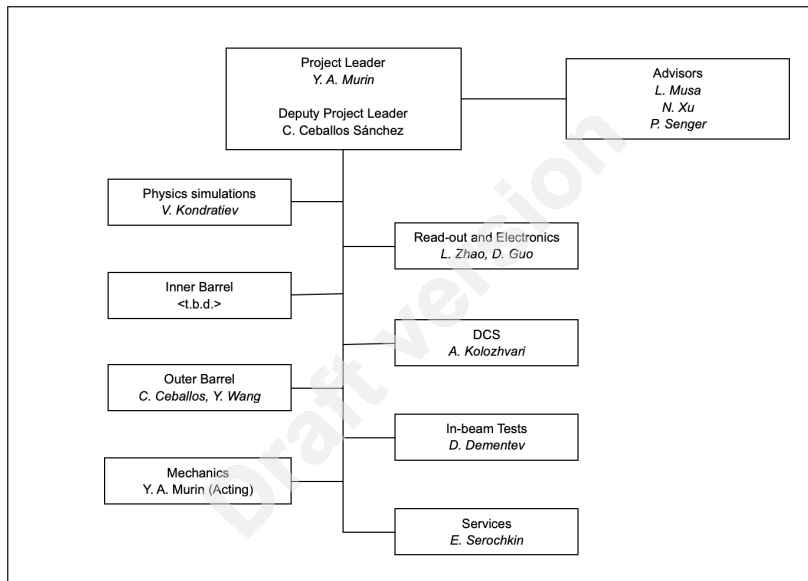


Figure 9.2: Management structure of the MPD-ITS project

2765 upgrade of the Inner Barrel of ALICE ITS.

2766 **Flexible Printed Circuit.** The FPC for the Outer Barrel (and the Inner Barrel
2767 in case of need) will be produced based on the final design used to produce the Outer (Inner)
2768 Barrel of the upgraded ALICE ITS and will be manufacture by the SwissPCB company.
2769 The metrological tests will be carried-out by the company Modus97 (Bologna, Italy) and the
2770 visual inspection and electrical test for the entire production will be done at JINR where the
2771 proper equipment and expertise for this purpose already exists.

2772 **Hybrid Integrated Circuit.** The construction, assembly and final test of the HICs and
2773 Staves for the Outer Barrel will be done split between JINR and Chinese institutions. We
2774 plan to construct a total of 42 Staves considering an additional 20 % of spares.

2775 **Inner Barrel.** The production of the Inner Barrel is foreseen to be done in China, based
2776 on large-area MAPS.

2777 **Layer and Service support mechanics.** The development of the Layer and Service
2778 Support Mechanics is coordinated by JINR. The Layer Support Mechanics is developed
2779 by JINR, including the insertion container and the insertion scenario for the placing and
2780 integration of the ITS, the FFD and the beam pipe of the MPD inside the bore of the TPC.

2781 **Read-out, power cables and patch panels.** The read-out electronics will be developed
2782 and produced mainly in China (USTC and CCNU), while the power and data cables and the
2783 patch panels will be produced by JINR.

2784 **Cooling plant and services.** The entire cooling system, including the cooling plant
2785 and the distribution of the cooling fluid to the detector circuits, will be developed at JINR.

2786 The management structure of the MPD-ITS project is shown in Figure 9.2 while Table
2787 9.1 reports the estimate cost for each major part of the project and their budgeting
2788 sharing between Russia and China. This table does not include neither the cost related
2789 to infrastructure nor to logics (import/export of components between Russia and China). It
2790 should be notice that regarding READOUT and INNER BARREL (large-area MAPS) the
2791 Chinese party will fund the R&D activities upto the prototype production in both cases while
2792 the Russian side will fund the series production and tests.

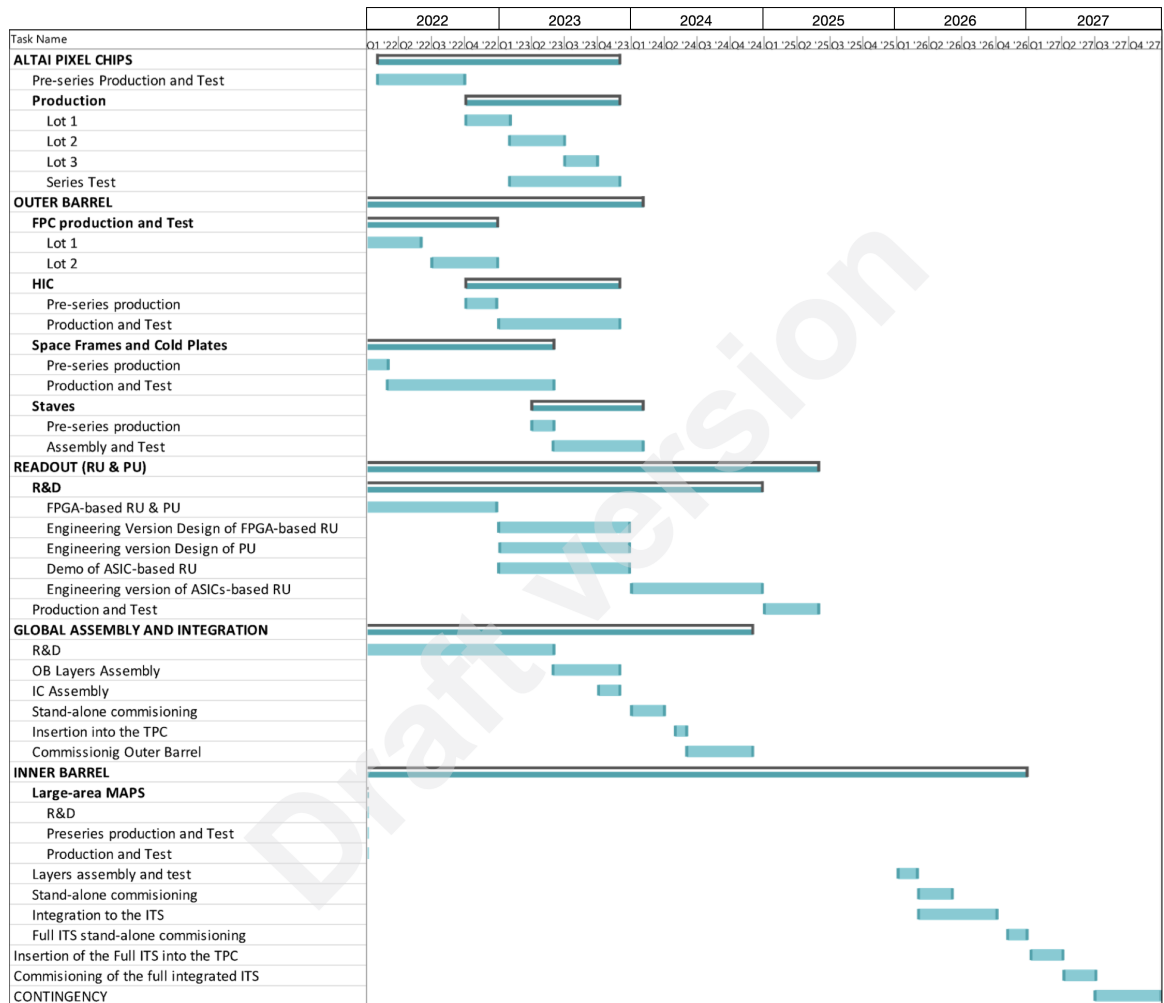
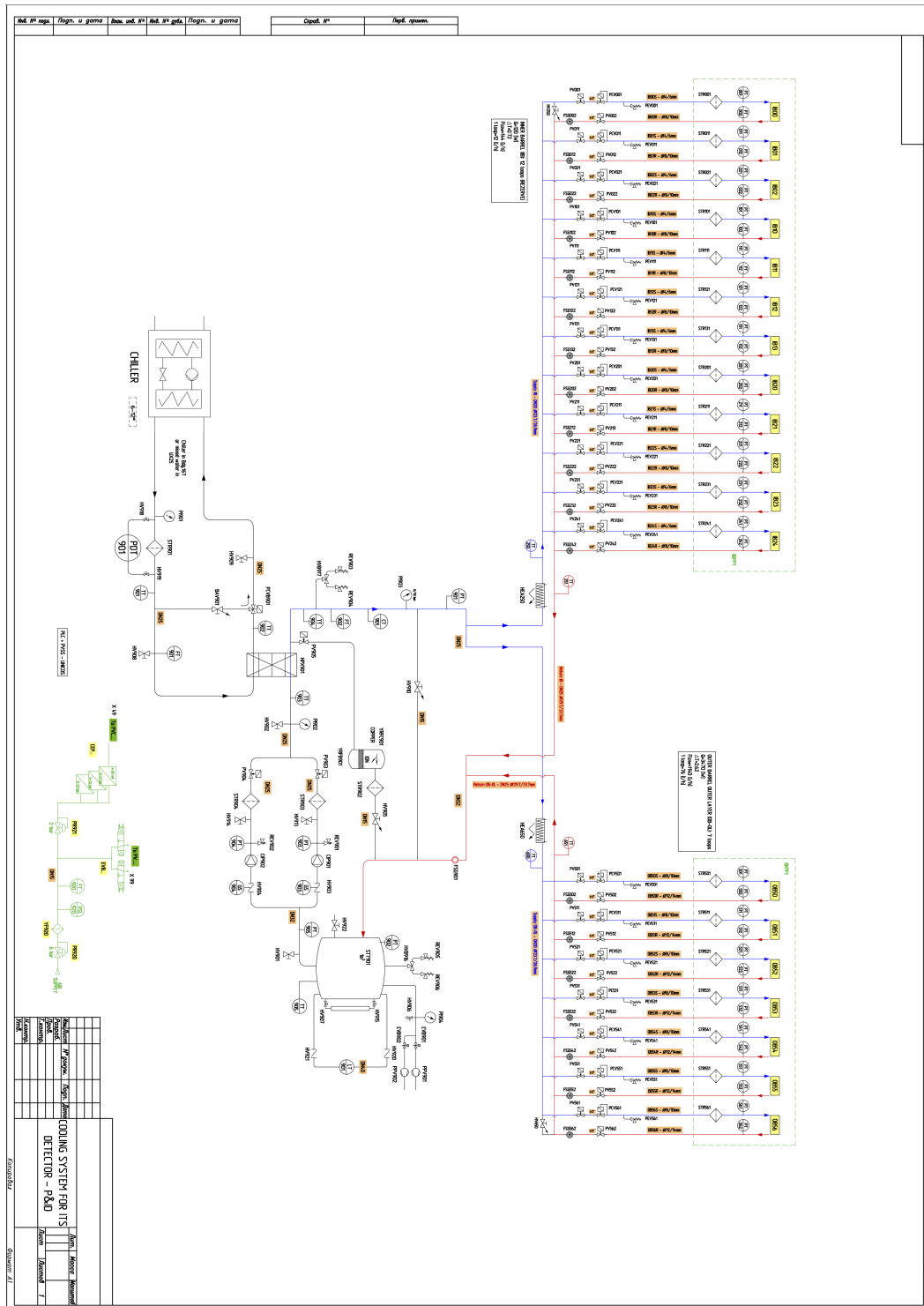


Figure 9.3: MPD-ITS Project timeline.

Table 9.1: Cost estimate and sharing of budgeting between Russia and China.

Item	Russia (k\$)	China (k\$)
ALTAI PIXEL CHIPS	1800	-
OUTER BARREL	1210.4	1466
READOUT	3315	1904.8
DCS	392	-
MECHANICS	1000	-
INNER BARREL	2000	2342.7
SERVICES	300	-
TOTAL	10017.4	5995.4

2793 .1 Appendix A - ALICE ITS2 leakless cooling system



2794 .2 Appendix B - Possibilities for the reduction of the beam 2795 pipe diameter

2796 NICA Collider

2797 The Nuclotron-based Ion Collider fAcility (NICA) [4] is a new accelerator complex being
2798 constructed at JINR. Two collider rings are designed and optimized to achieve the required
2799 luminosity at two interaction points (IP). The first IP is connected with Multipurpose detector
2800 (MPD) for the ion-ion ($^{197}_{79}\text{Au}^+$) collider experiments in the energy range of $1\div 4.5$ GeV/n.
2801 The second IP is aimed for the polarized proton-proton ($5\div 12.6$ GeV) and deuteron-deuteron
2802 ($2\div 5.8$ GeV/n) collisions. The collider lattice is based on the technology of super-ferric
2803 magnets developed in VBLHEP, JINR. The collider optics is optimized to obtain the required
2804 luminosity with the certain effects which set constraints on the lattice parameters: luminosity
2805 lifetime limitation by intrabeam scattering in a bunch (IBS), space charge tune shift, threshold
2806 of microwave instability, slippage factor optimization for efficient stochastic cooling, maximum
2807 required RF voltage amplitude. The first stage considers the $^{197}_{79}\text{Au}^+$ heavy ion mode of facility
2808 operation at center of mass energies of $\sqrt{S_{NN}}=4\div 11$ GeV. The developed optical structure
2809 of the collider will use two systems of beam cooling (electron and stochastic), and a special
2810 scenario of rings operation will provide the required average luminosity of 10^{27} cm $^{-2}$ s $^{-1}$ in
2811 each of the two colliding points.

2812 Optics

2813 The magnetic structure of the Collider [5] (sequence of dipoles, quadrupoles and correction
2814 magnets along the reference orbit of the each storage ring) conforms the magnetic optics for
2815 each of the circulating beams. The optical structure of the Collider ensures the fulfillment of
2816 the following requirements:

- 2817 • ensure the design peak value of the luminosity of the installation of $10^{26}\text{--}10^{27}$ cm $^{-2}$ s $^{-1}$
- 2818 • ensure that the luminosity lifetime is much longer (≥ 1 hr) than the beam preparation
2819 time (10 min);
- 2820 • on the other hand, the maximum luminosity suggests a compact perimeter;
- 2821 • large dynamic acceptance (both transverse and longitudinal);
- 2822 • a sufficiently small value of the beta function (β) at the IPs;
- 2823 • a certain ratio of the longitudinal length of the bunch length (σ_s) and β at the IPs;
- 2824 • the maximum possible number of bunches.

2825 Collider rings are in the form of a racetrack with a perimeter of 503.04 m (2 Nuclotron
2826 perimeters) and are located one above the other at a distance of 0.32 m. The basis of the
2827 magnetic system is composed of two-aperture dipole and quadrupole magnets of the Nuclotron
2828 type, quadrupole magnets of the final (before the meeting points) beam focusing and dipole
2829 magnets of the vertical beam separation system. A cell of the FODO type is selected as the
2830 basis of magnetic optics in the bending arcs. The phase advance of betatron oscillations in
2831 horizontal and vertical positions on one cell is 90° . In the long straight sections of the collider
2832 rings are:

- 2833 • MPD and SPD detectors;

- 2834 • elements of the injection system (septum and shock magnet) of beams;
- 2835 • beam dumping systems;
- 2836 • elements of a high-frequency accelerating system;
- 2837 • electron beam cooling system; devices for stochastic beam cooling (pick-up stations and
2838 kickers);
- 2839 • feedback system devices;
- 2840 • halo beam collimation system.

2841 Other equipments placed along the collider rings includes multipole magnetic correctors
2842 (dipole, quadrupole, sextupole and octupole) for the correction of imperfections of the
2843 magnetic field and beam dynamics, beam position monitors for measuring closed beam orbit
2844 distortions, vacuum equipment connection module.

2845 Collider luminosity

2846 For identical colliding beams with a round transverse cross section, the peak luminosity can
2847 be written in the form:

$$L = \frac{N_i^2}{4\pi\epsilon\beta^*} F_{coll} f_{HG}(\sigma_s, \beta^*) \quad (1)$$

2848 where N_i is the number of ions in a bunch, ϵ is the r.m.s. transverse emittance, β^* is the
2849 value of the Twiss amplitude function at the beam interaction point, σ_s is the longitudinal
2850 beam length, F_{coll} is the frequency of bunch collisions, and the so-called hour-glass effect
2851 (f_{HG}) is calculated by the equation:

$$f_{HG}(\sigma_s, \beta^*) = \frac{1}{\sqrt{\pi}} \int_{-\infty}^{+\infty} \frac{e^{-u^2} du}{1 + (u\sigma_s/\beta^*)^2}. \quad (2)$$

2852 The longitudinal size of the beam is chosen to concentrate the whole luminosity in the
2853 central part of the MPD detector. If the beam size σ_s is much less than the value of the
2854 beta function at the interaction β^* , the function f_{HG} is close to unity. However, a decrease
2855 in the longitudinal beam size leads to an increase in the peak current and, as a consequence,
2856 to a larger shift of the betatron frequency and probability of coherent instability. The value
2857 $\sigma_s=0.6$ m was taken for the collider as a compromise derivative. The maximum allowable
2858 number of bunches in each of the collider rings is limited by the requirement for the absence
2859 of spurious collisions in the interaction region and is equal to 22.

2860 The collider must maintain the design luminosity for a long time it takes to carry out a
2861 physical experiment. This process supposes the formation of a highly intense ion beam with
2862 a sufficiently low emittance. At the same time, it is required to provide the necessary lifetime
2863 of the beam. The maximum achievable lifetime is limited by the single scattering of ions at
2864 large angles by atoms of the residual gas. The design pressure of the residual gas in the beam
2865 chamber corresponds to a maximum beam lifetime of about 10 h. Effects of the space charge
2866 betatron tunes shift to the region of high order resonances, which can decrease the lifetime
2867 of an intense beam in the collider. At low particle energies, the strongest effect is that of the
2868 incoherent shift of the betatron frequency (the Laslett tune shift):

$$\Delta Q_{Las} = \frac{Z^2}{A} \cdot \frac{r_p N_i}{\beta^2 \gamma^3 4\pi\epsilon} \cdot F_{sc} F_b, \quad F_b = \frac{C_{ring}}{\sigma_s \sqrt{2\pi}}. \quad (3)$$

2869 where Z and A are the ion charge and mass, r_p is the classical proton radius, β and γ are
 2870 the relativistic Lorentz factors, F_b is the beam bunching factor, C_{ring} is the ring perimeter,
 2871 σ_s is the rms bunch length, and ε is the geometric transverse emittance. The second effect
 2872 is the betatron oscillation frequency shift due to particle scattering in the electromagnetic
 2873 field of the incoming bunch, the linear part of which is described by the so-called beam–beam
 2874 parameter:

$$\xi = \frac{Z^2}{A} \cdot \frac{r_p N_i (1 + \beta^2)}{4\pi\beta^2\gamma\varepsilon}. \quad (4)$$

2875 In practice, beam stability in the collider is estimated using the criterion of maximum
 2876 allowable total betatron frequency shift

$$\Delta Q_{total} = \Delta Q_{Las} + n_\xi \xi \leq 0.05, \quad (5)$$

2877 where $n_\xi = 2$ is the number of collision points and the limit shift value of 0.05 is chosen
 2878 with respect to the working point of the collider in the space of betatron frequencies. Here
 2879 it is assumed that space charge effects have no significant effect on the beam lifetime at a
 2880 smaller betatron frequency shift. Based on Eq. 1–3, the following dependences of luminosity
 2881 and frequency shift on the intensity and emittance of the beam may be written as

$$\begin{aligned} L &\propto \frac{N_i^2}{\varepsilon} f_1(E_i) f_{HG}, \\ \Delta Q &\propto \frac{N_i}{\varepsilon} f_2(E_i), \end{aligned} \quad (6)$$

2882 where E_i is the ion energy and f_1, f_2 are functions describing the energy dependences of the
 2883 parameters. The maximum luminosity of the collider is reached in the case where the intensity
 2884 and emittance of the beam corresponds to the limit with respect to the space charge. In this
 2885 operation mode of the collider, an increase in the beam intensity increases the luminosity
 2886 at a constant frequency shift. The frequency shift is maintained constant by increasing the
 2887 emittance proportionally to the beam intensity; then the luminosity depends linearly on the
 2888 number of ions. The maximum luminosity in this mode is reached when the phase volume of
 2889 the beam equals the ring acceptance at a total frequency shift corresponding to the chosen
 2890 maximum limit value of 0.05. This option of the collider operation called “space charge
 2891 domination mode” is described by the following relationships,

$$\begin{aligned} L &\propto \Delta Q_{total}^2 \cdot \varepsilon \cdot f_3(E_i) \cdot f_{HG}, \\ N_i &\propto \Delta Q_{total} \cdot \varepsilon \cdot f_4(E_i). \end{aligned} \quad (7)$$

2892 If the ion energy exceeds 3 GeV/n, the space charge domination mode can be optimized
 2893 by decreasing the equilibrium emittance and intensity of the beam, N (Fig. 4). In this
 2894 case, at a fixed peak luminosity, it is possible to work with a frequency shift below the
 2895 resonance boundary ΔQ_{total} . In this regime, the main total effect capable of limiting the
 2896 beam lifetime is the intrabeam scattering (IBS). The IBS leads to a diffusion growth of the
 2897 beam emittance, and suppressing it is what the electron or stochastic cooling is used for.
 2898 This “IBS domination mode” is characterized by the equilibrium between the beam heating
 2899 due to the IBS and beam cooling, which corresponds to the equality of characteristic times
 2900 of these processes: $\tau_{IBS} = \tau_{cool}$. Then, at a fixed luminosity, relationships 6 can be rewritten
 2901 in the form

$$\begin{aligned} N_i &\propto \sqrt{L \cdot \varepsilon} \cdot f_5(E_i, \beta^*, \sigma_s), \\ \Delta Q_{total} &\propto \sqrt{\frac{L}{\varepsilon}} \cdot f_6(E_i, \beta^*, \sigma_s) < \Delta Q_{max} (= 0.05). \end{aligned} \quad (8)$$

From these proportions it is seen that the minimum value of ΔQ_{total} corresponds to the maximum emittance ε , i.e., to the fulfilling of the acceptance by ions (Fig. 4). Table 2 presents beam parameters in the collider energy range of $1 \div 4.5$ GeV/n. The transverse emittances and momentum spread of the beam were calculated for the equality of times of IBS heating over all the three degrees of freedom. The table shows betatron frequency shifts corresponding to the stability criterion. These parameters allow to obtain the nominal luminosity $L=10^{27}$ cm⁻²s⁻¹ at $E_i=3 \div 4.5$ GeV/n.

Table 2: General parameters of the ring.

Parameter	Value		
Ring perimeter, [m]	503.04		
Number of bunches	22		
R.m.s. beam length, [m]	0.6		
β -function in IP, [m]	0.6		
Betatron tunes, Q_x/Q_y	9.44/9.44		
Chromaticity, Q'_x/Q'_y	-20/-20		
Ring acceptance, [$\pi \cdot$ mm·mrad]	40		
Momentum acceptance, $\Delta p/p$	± 0.010		
Critical factor, γ_{tr}	7.088		
Energy of $^{197}_{79}\text{Au}^+$ ions, [GeV/n]	1.0	3.0	4.5
Number of particles per bunch	2.8×10^8	2.7×10^9	2.9×10^9
R.m.s. momentum spread, $\Delta p/p$	0.6×10^{-3}	1.2×10^{-3}	1.6×10^{-3}
R.m.s. emittance, [$\pi \cdot$ mm·mrad]	1.1/1.1	1.1/1.1	1.1/0.9
Luminosity, [cm ⁻² s ⁻¹]	0.8×10^{25}	0.8×10^{27}	10^{27}
Betatron tune shifts, ΔQ	0.05	0.05	0.022
IBS rates, [s]	300	1100	3200

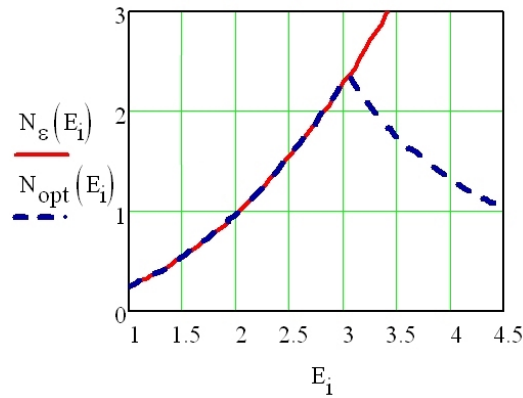
2908

2909 Beam cooling

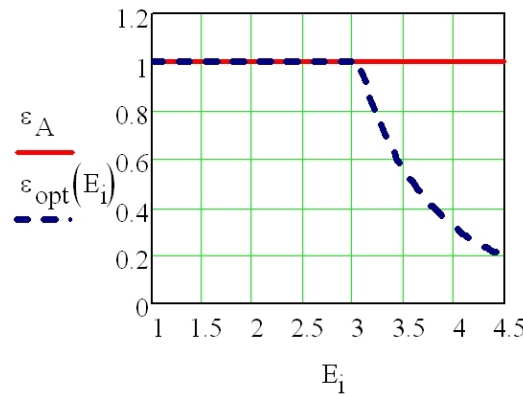
Applying cooling methods in the collider [5] aims, firstly, to the beam stacking by use of the stacking cooling procedure and, secondly, to keeping the luminosity during the experiment. The beam stacking in the collider is supposed to be implemented in the longitudinal phase space using the barrier voltage technique. This will provide the independent optimization of the beam intensity, number of bunches, control for the emittance, and momentum spread of particles during the formation of the beam. The aim of stacking can be reached using the electron or stochastic cooling system with technically implementable parameters due to the low linear density of particles. A numerical simulation of the beam stacking process with allowance for longitudinal forces of the space charge shows that this scheme yields an efficiency of no less than 90%. Both, electron and stochastic cooling systems must cover the entire energy range of the collider of $1 \div 4.5$ GeV/n and provide the maximum possible luminosity at low energies and a luminosity around 10^{27} cm⁻²s⁻¹ at high energies. During the equilibrium between the IBS and cooling, the luminosity lifetime is limited only by the interaction between ions and residual gas. The mean luminosity is close to the peak value, because the beam lifetime is much longer than the stacking time. At the same time, the cooling times are equal to IBS times for all degrees of freedom. To yield an increase in luminosity in the space charge domination mode at low energies, the cooling time must be much less than the IBS time.

The stochastic cooling (SC) is supposed to be used at energies from 3 to 4.5 GeV/n. At high collider energies, cooling times of the order of 500 s are achievable for the system of

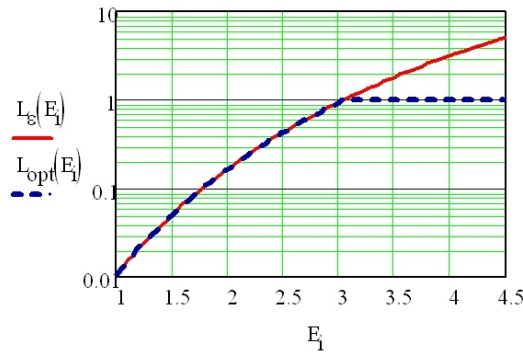
2929



(a)



(b)



(c)

Figure 4: (a) Number of ions in the beam, (b) beam emittance, and (c) luminosity as functions of the ion energy in two cases: *ring acceptance is completely filled with ions* (solid curves) and *limited luminosity* (dashed curves). The acceptance is $40 \pi \cdot \text{mm} \cdot \text{mrad}$. The dimensions of the quantities are as follows: $[N_i] = 10^9$, $[\epsilon] = \pi \cdot \text{mm} \cdot \text{mrad}$, $[L] = 10^{27} \text{ cm}^{-2} \text{ s}^{-1}$.

2930 stochastic cooling with a bandwidth of $2 \div 3$ GHz. The chosen optical structure of the ring
 2931 allows to find optimal positions for the pickup and kicker of the SC system when the partial
 2932 slip factor is sufficiently small when passing from the pickup to the kicker. In the chosen
 2933 Palmer method for the longitudinal cooling, the pickup is positioned in the rotating arc, i.e.,
 2934 in the dispersion region; the kicker is positioned in the long straight section. Using the SC
 2935 with a band of $3 \div 6$ GHz (or $2 \div 4$ GHz) provides cooling times that are shorter by a factor

2936 of two or three as compared to the times of heating due to the IBS. The system of electron
 2937 cooling is used to completely suppress the beam heating due to the IBS at low energies and to
 2938 ensure the collider operation in the space charge domination mode. At energies in range from
 2939 3 to 4.5 GeV/n, the calculated times of cooling are somewhat shorter than those expected for
 2940 the IBS and are comparable with times of stochastic cooling. However, at low energies, the
 2941 cooling times are shorter than IBS times approximately by a factor of 20. For this reason,
 2942 in the range of 1÷3 GeV/n, the electron cooling system is preferable for collider operation in
 2943 the space charge domination mode. However, when designing the electron cooling system, it
 2944 is necessary to take into account the problem of ion recombination.

2945 RF stations

2946 The formation of an ion beam in the Collider is carried out using three different RF systems
 2947 [5]. The first type is the “barrier” RF voltage station (RF-1), which is used to accumulate and
 2948 accelerate particles in the energy range from 1 to 4.5 GeV/n. This station creates a sequence of
 2949 accelerating and decelerating rectangular voltage pulses with an amplitude of up to 5 kV. The
 2950 RF-2 station of harmonic voltage works at the frequency of the 22nd harmonic of the particle
 2951 revolution frequency. The maximum voltage amplitude is 25 kV. In each ring of the collider
 2952 there will be four RF-2 stations, total accelerating voltage is 100 kV. The resonant frequency
 2953 of the resonator is tuned (depending on the experimental energy of 1÷4.5 GeV/n) within
 2954 11÷13 MHz. Stations of the third type RF-3 create a harmonic voltage at the 66th harmonic
 2955 of the particle revolution frequency in the accelerator with a maximum amplitude of 125 kV.
 2956 Eight RF-3 stations will stand in each ring, i.e. their total voltage is 1 MV. The resonant
 2957 frequency of the resonator is tuned (depending on the experimental energy of 1÷4.5 GeV/n
 2958) within 34÷39 MHz. Successive particle injection cycles ($^{197}_{79}\text{Au}^+$) from the Nuclotron are
 2959 accumulated in the Collider using RF-1. After the accumulation of the required number of
 2960 particles, the RF-2 system forms 22 bunches. The process is accompanied either by electron
 2961 or stochastic beam cooling. Beam grouping at the 66th harmonic of the revolution frequency
 2962 in the presence of an RF-2 with an amplitude of 100 kV with an adiabatic increase in the
 2963 total voltage of the RF-3 to the maximum value and cooling with a time of 100 s ensures the
 2964 formation of bunches with r.m.s. length of 0.6 m and a momentum spread as by design.

2965 Optics and beam parameters in the Interaction Region

2966 The collider optics are optimized to obtain the required luminosity with the certain effects
 2967 which set constraints on the lattice parameters namely the luminosity lifetime limitation by
 2968 intrabeam scattering in a bunch (IBS), the space charge tune shift, the maximum required
 2969 RF voltage amplitude and others. Optimized optical functions of the ring are shown in Figure
 2970 5 for betatron tunes of $Q_x/Q_y=9.44/9.44$ and $\beta^*(\text{IP})=0.6$ m. Amplitude functions along the
 2971 beam separation and interaction regions are given in Figure 6.

2972 Beam sizes are rapidly squeezed in interaction drift space according to $\sigma_{x,y}(s) =$
 2973 $\sqrt{\varepsilon_{\sigma,x,y}\beta_{x,y}(s)}$, where ε is the beam emittance (Tab. 2), $\beta = \beta^* + s^2/\beta^*$ is the function
 2974 from the IP to the final focus quadrupole. The 1σ , 3σ beam sizes and 6σ ring acceptance
 2975 are shown in Figure 7. These values are 0.8 mm, 2.3 mm and 4.6 mm respectively. **From**
 2976 **these considerations it seems safe enough for the colliding beams (possible closed**
 2977 **orbit distortions, required separation of the beams during accumulation) to have**
 2978 **a vacuum pipe diameter of 40 mm in the central part of the MPD.**

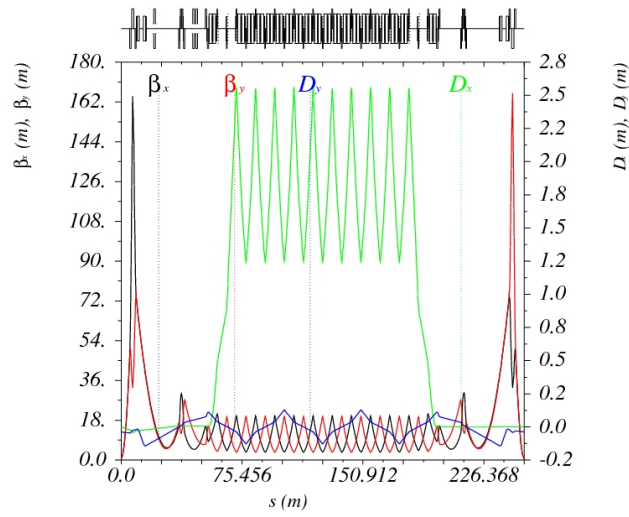


Figure 5: Linear amplitude and dispersion function of the collider (half a ring).

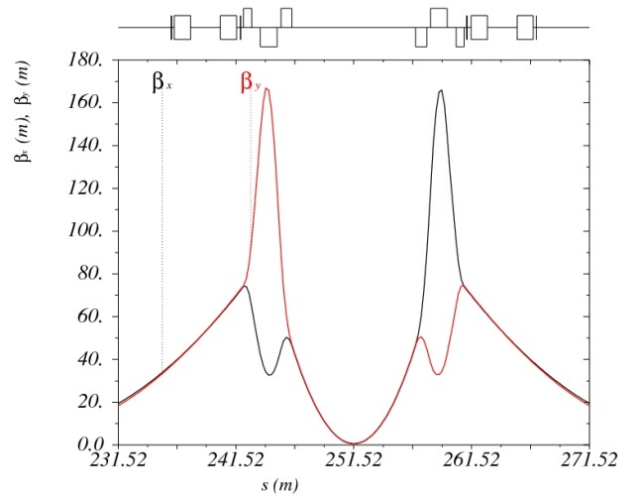
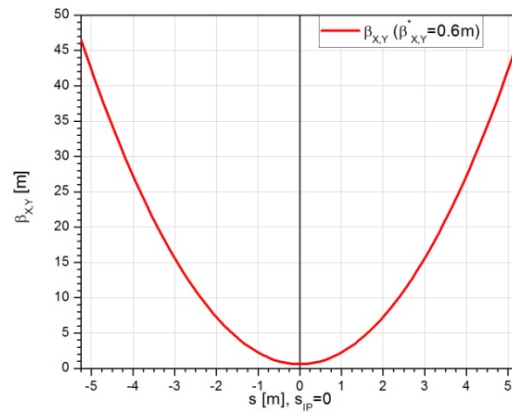
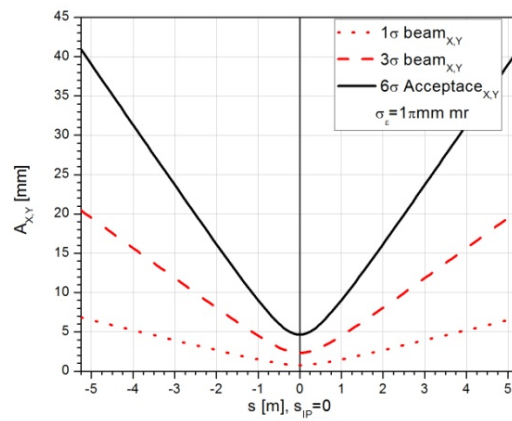


Figure 6: β -functions along the Interaction Region of the collider ring.



(a)



(b)

Figure 7: (a) β -functions and sizes of the colliding beams and (b) ring acceptance at the MPD location.